

## Description

The P91E0 is a highly programmable, multiple channel power management integrated circuit (PMIC) designed for the Intel® Atom® System-on-Chip (SoC) to meet the high performance requirements as well as to provide a high level of integration to minimize system board area and BOM cost.

The P91E0 includes sub-systems for voltage regulation, power sequencing management, analog-to-digital (A/D) conversion, GPIOs, PWMs and others. The P91E0 is controlled and programmed via an I2C interface that operates in conjunction with the SoC. There is also a SerialVID (SVID) interface between the SoC and the PMIC for controlling the VCC, VNN, and VDDQ voltage rails, supporting the VR12.1 and IMVP8 specification.

The P91E0 is capable of providing current levels sufficient for entry-level platforms with its internal regulators, and it is scalable to higher current requirements by adding IDT's unique Distributed Power Units (DPUs) (P9148) to source additional current for those DCDC rails.

Also included are 7 low drop-out regulators (LDOs) which are programmable over a wide output voltage range and offer output currents up to 550mA. These LDOs are designed for low noise, high PSRR, and excellent transient response.

The default output voltages of all regulators as well as device sequencing can be programmed in the one-time programmable (OTP) memory (at the factory) to adjust to nonstandard configurations. Contact IDT marketing for specific requirements.

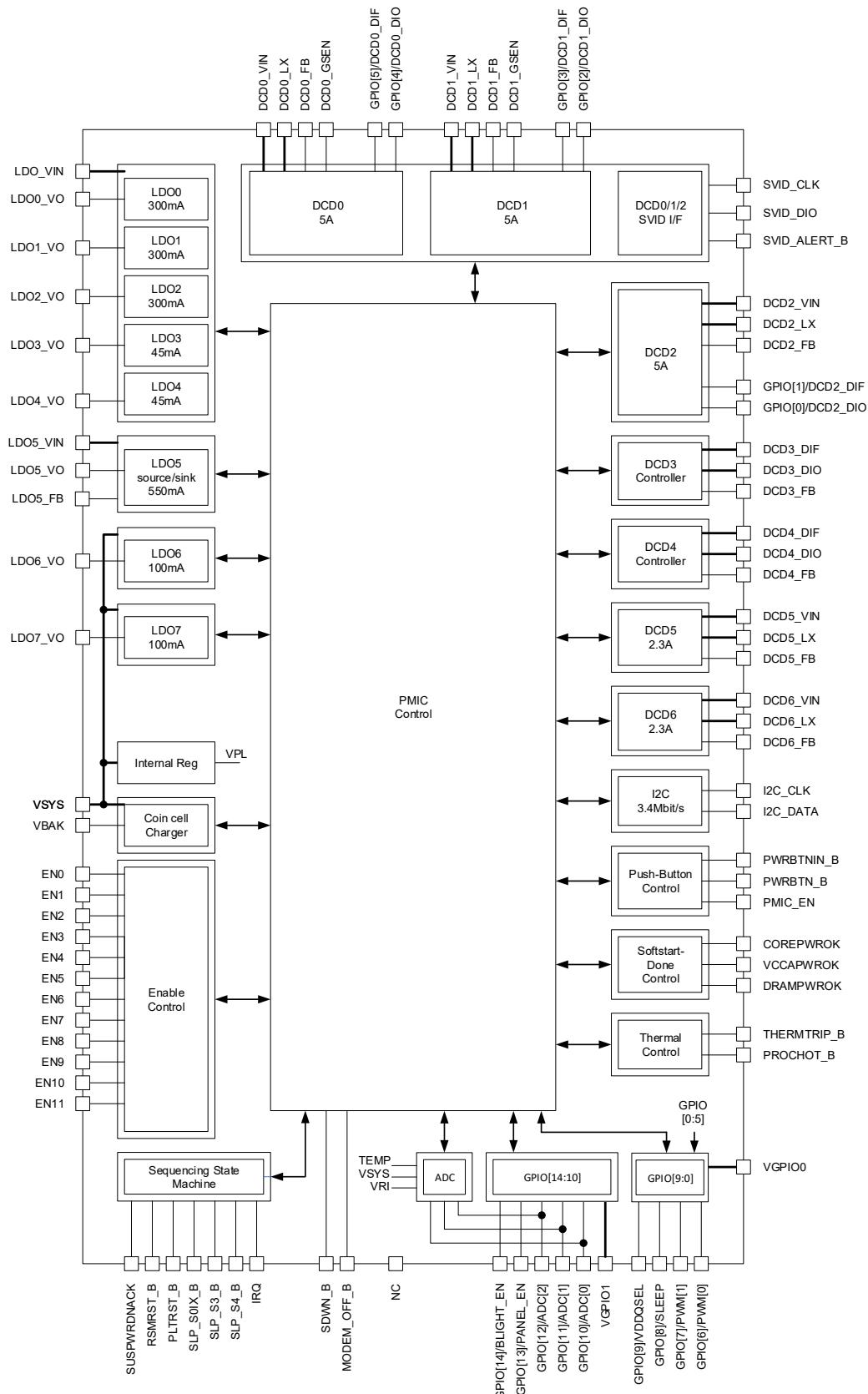
## Features

- Single 3.15V to 5.25V supply input
- 3 × SVID IMVP8/VR12.1 compatible 5A synchronous step-down switching regulators with DPU interface to support up to four additional 6A phases
- 2 × step-down switching controller with DPU interface to support up to four 6A phases
- 2 × 2.3A synchronous step-down switching regulators
- Programmable mode selection:
  - Automatic PWM/PFM Mode transition for high efficiency at light load or
  - PWM-Only Mode for low-noise applications
- 7 × (45mA to 300mA) linear regulators; LDO0, LDO1, and LDO2 have an optional pass switch feature
- 1 ×  $\pm 550\text{mA}$  V<sub>tt</sub> linear regulator LDO5
- 10-bit analog-to-digital converter (ADC) monitors internal and external voltages, currents, and temperature
- Host interface and system management
  - Interrupt controller with maskable interrupts
  - Reset function
  - Power control state machine
  - Programmable sequencing of output rails
  - High speed I2C interface (3.4MHz)
- Programmable enable outputs for external switches
- 15 × GPIOs
- -40°C to +85°C industrial temperature range
- Thermally-enhanced 9.0 × 9.0 × 0.85 mm 100-VFQFPN

## Typical Applications

- General Embedded Applications
- Print Imaging and Multi-function Printers
- μServers and Storage
- Industrial and Embedded Systems

## Block Diagram



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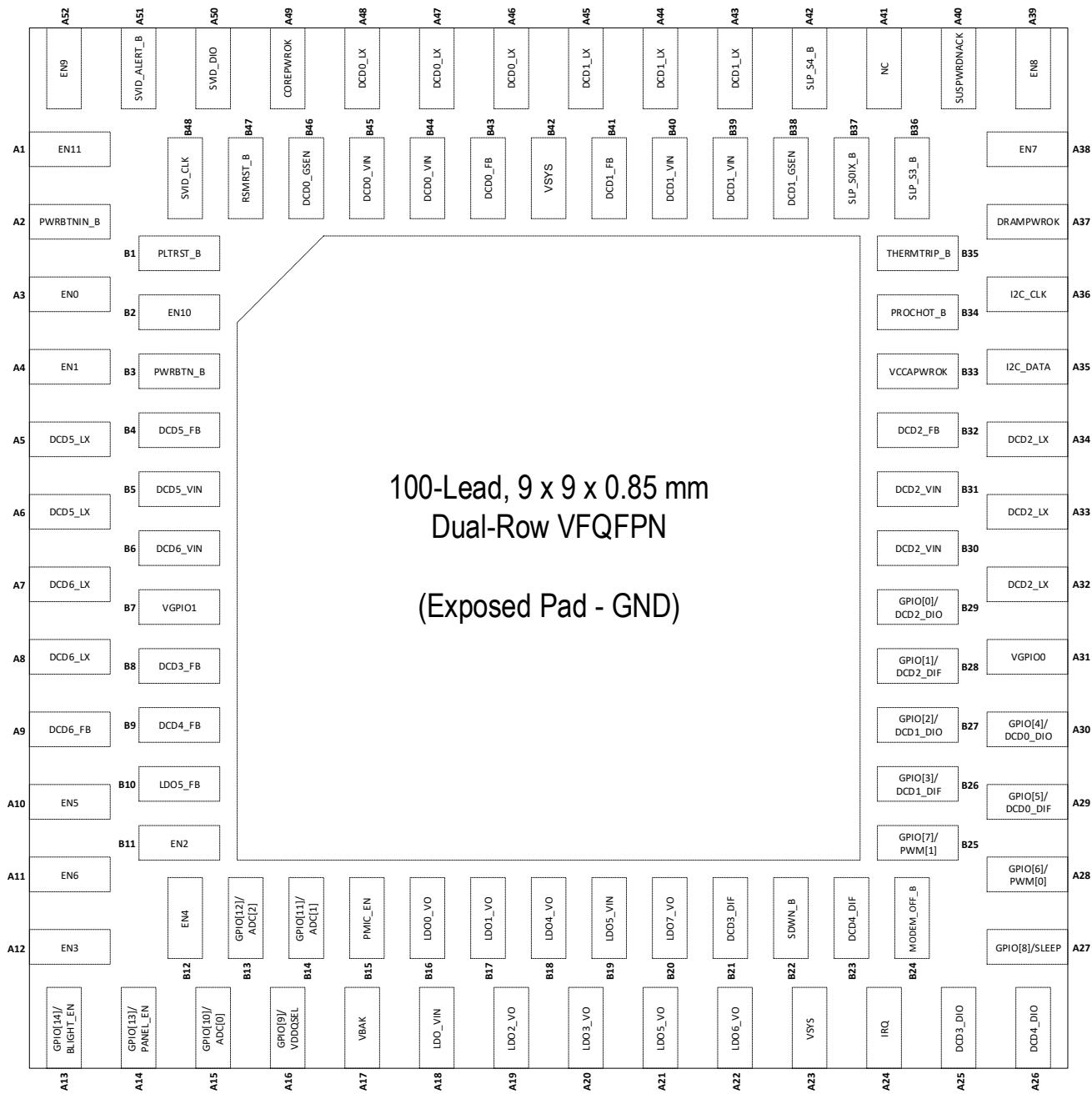
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# 1. Pin Assignments

**Figure 1. Pin Assignments for 9.0 × 9.0 × 0.85 mm 100-VFQFPN Package – Top View**



## 2. Pin Descriptions

**Table 1. Pin Descriptions**

| Pin Number | Name               | Type           | Description  |
|------------|--------------------|----------------|--|
| A1         | EN11               | Output         | Open drain output enable signal.   |
| A2         | PWRBTNIN_B         | Input          | System power button input (active-LOW). The button must be pressed for longer than 36ms (30ms typical) to turn on all the A-type power rails. If PWRBTNIN_B is used, PMIC_EN should be connected to GND. If PMIC_EN is used to power the P91E0 ON/OFF, the PWRBTNIN_B pin should be left floating (unconnected). |
| A3         | EN0                | Output         | Open-drain output-enable signal.   |
| A4         | EN1                | Output         | Open-drain output-enable signal.   |
| A5, A6     | DCD5_LX            | Output         | DCD5 switch node. This pin connects to the output inductor.  |
| A7, A8     | DCD6_LX            | Output         | DCD6 switch node. This pin connects to the output inductor.  |
| A9         | DCD6_FB            | Input          | Feedback voltage for DCD6. This pin must be connected to the output voltage of the DCD6.   |
| A10        | EN5                | Output         | Open-drain output enable signal.   |
| A11        | EN6                | Output         | Open-drain output enable signal.   |
| A12        | EN3                | Output         | Open-drain output-enable signal.   |
| A13        | GPIO[14]/BLIGHT_EN | Input / Output | General purpose input/output 14 or backlight enable output.  |
| A14        | GPIO[13]/PANEL_EN  | Input / Output | General purpose input/output 13 or LCD panel enable output.  |
| A15        | GPIO[10]/ADC[0]    | Input / Output | General purpose input/output 10 or ADC[0] input.   |
| A16        | GPIO[9]/VDDQSEL    | Input / Output | General purpose input/output 9 or DCD2 output voltage select.  |
| A17        | VBAK               | Output         | Coin-cell backup battery connection. If the VBAK is used, connect a 0.1µF capacitor (minimum) between VBAK and ground. If the VBAK function is not used, connect this pin to ground.   |
| A18        | LDO_VIN            | Input          | Input supply voltage for LDO0, LDO1, LDO2, LDO3, and LDO4.   |
| A19        | LDO2_VO            | Output         | Linear regulator 2 output terminal.  |
| A20        | LDO3_VO            | Output         | Linear regulator 3 output terminal.  |
| A21        | LDO5_VO            | Output         | Source-sink regulator 5 output terminal. Leave this pin floating if the function is not used.  |
| A22        | LDO6_VO            | Output         | Linear regulator 6 output terminal.  |
| A23, B42   | VSYS               | Input          | Input power supply powering the P91E0 internal circuitry. Connect a 2.2µF from this pin to ground. Place the capacitor as close as possible to VSYS.   |
| A24        | IRQ                | Output         | Interrupt request output.  |
| A25        | DCD3_DIO           | Input / Output | DCD3 regulator digital interface input/output signal. Connect to the DIO pin of the P9148, or leave open if unused.  |
| A26        | DCD4_DIO           | Input / Output | DCD4 regulator digital interface input/output signal. Connect to the DIO pin of the P9148, or leave open if unused.  |

| Pin Number    | Name             | Type           | Description  |
|---------------|------------------|----------------|--|
| A27           | GPIO[8]/SLEEP    | Input / Output | General purpose input/output 8 or Sleep Mode control signal.   |
| A28           | GPIO[6]/PWM[0]   | Input / Output | General purpose input/output 6 or PWM[0] output control signal.  |
| A29           | GPIO[5]/DCD0_DIF | Input / Output | General purpose input/output 5 or DCD0 regulator digital interface output.   |
| A30           | GPIO[4]/DCD0_DIO | Input / Output | General purpose input/output 4 or DCD0 regulator digital interface input/output.   |
| A31           | VGPIO0           | Input          | Input supply voltage for GPIO[0] to GPIO[9]. This pin must be connected to 1.8V voltage rail.  |
| A32, A33, A34 | DCD2_LX          | Output         | DCD2 switch node. This pin connects to the output inductor.  |
| A35           | I2C_DATA         | Input / Output | I2C data.  |
| A36           | I2C_CLK          | Input          | I2C clock.   |
| A37           | DRAMPWROK        | Output         | Active-HIGH, open-drain soft-start-done signal.  |
| A38           | EN7              | Output         | Open-drain output enable signal.   |
| A39           | EN8              | Output         | Open-drain output enable signal.   |
| A40           | SUSPWRDNACK      | Input          | Suspend power-down acknowledgment.   |
| A41           | NC               | –              | No connect   |
| A42           | SLP_S4_B         | Input          | Active-LOW input signal. When SLP_S4_B is connected to logic HIGH, all the “U” type power rails are enabled. When pulled LOW, the regulators are shutdown. |
| A43, A44, A45 | DCD1_LX          | Output         | DCD1 switch node. This pin connects to the output inductor.  |
| A46, A47, A48 | DCD0_LX          | Output         | DCD0 switch node. This pin connects to the output inductor.  |
| A49           | COREPWROK        | Output         | Active-HIGH soft-start-done-signal. Connect to the SOC_PWROK/COREPWROK input pin on the SoC IC.  |
| A50           | SVID_DIO         | Input / Output | SVID data input and open drain output. Note: Refer to Intel's Serial VID (SVID) protocol specification for details.  |
| A51           | SVID_ALERT_B     | Output         | SVID interrupt from the P91E0 to the SOC. Open-drain output.   |
| A52           | EN9              | Output         | Open drain output enable signal.   |
| B1            | PLTRST_B         | Input          | Platform reset is an active-LOW reset input signal from the SoC to the P91E0.  |
| B2            | EN10             | Output         | Open-drain output enable signal.   |
| B3            | PWRBTN_B         | Output         | Power button output signal. It is a level-shifted copy of the PWRBTNIN_B pin after the 30ms de-bouncing circuit.   |
| B4            | DCD5_FB          | Input          | Feedback voltage for DCD5. This pin must be connected to the output voltage of the DCD5.   |
| B5            | DCD5_VIN         | Input          | Input voltage for DCD5. Connect a bypass capacitor from this pin to ground.  |
| B6            | DCD6_VIN         | Input          | Input voltage for DCD6. Connect a bypass capacitor from this pin to ground.  |
| B7            | VGPIO1           | Input          | Supply voltage for GPIO[10] through GPIO[14]. This pin must be connected to 3.3V.  |
| B8            | DCD3_FB          | Input          | Feedback voltage for DCD3 controller. This pin must be connected to the output voltage of the DCD3.  |

| Pin Number | Name             | Type           | Description   |
|------------|------------------|----------------|---|
| B9         | DCD4_FB          | Input          | Feedback voltage for DCD4. This pin must be connected to the output voltage of the P9148.   |
| B10        | LDO5_FB          | Input          | Feedback voltage for LDO5. This pin must be connected to the output voltage of the LDO5. This pin is internally connected to LDO5_VO with $180\Omega$ .                               |
| B11        | EN2              | Output         | Open-drain output-enable signal.  |
| B12        | EN4              | Output         | Open-drain output-enable signal.  |
| B13        | GPIO[12]/ADC[2]  | Input / Output | General purpose input/output 12 or ADC[2] input.  |
| B14        | GPIO[11]/ADC[1]  | Input / Output | General purpose input/output 11 or ADC[1] input.  |
| B15        | PMIC_EN          | Input          | PMIC enable input. If PMIC_EN is used to power the P91E0 ON/OFF, the PWRBTNIN_B pin should be left floating (unconnected). If PWRBTNIN_B is used, PMIC_EN should be connected to GND. |
| B16        | LDO0_VO          | Output         | Linear regulator 0 output terminal.   |
| B17        | LDO1_VO          | Output         | Linear regulator 1 output terminal.   |
| B18        | LDO4_VO          | Output         | Linear regulator 4 output terminal.   |
| B19        | LDO5_VIN         | Input          | Input supply voltage for source-sink regulator LDO5. Tie to ground if this function is not used.  |
| B20        | LDO7_VO          | Output         | 1.8V regulator output terminal for DPS control interface and internal biasing.  |
| B21        | DCD3_DIF         | Output         | DCD3 switching regulator digital interface output signal. Connect to the DIF pin of the P9148 or leave open if unused.  |
| B22        | SDWN_B           | Output         | Shutdown warning. In the event of a system shutdown, the P91E0 issues a system shutdown warning to the modem.   |
| B23        | DCD4_DIF         | Output         | DCD4 switching regulator digital interface output signal. Connect to the DIF pin of the P9148 or leave open if unused.  |
| B24        | MODEM_OFF_B      | Output         | Active-LOW Modem Reset signal (see section 9.4.7).  |
| B25        | GPIO[7]/PWM[1]   | Input / Output | General purpose input/output 7 or PWM[1] output control signal.   |
| B26        | GPIO[3]/DCD1_DIF | Input / Output | General purpose input/output 3 or DCD1 regulator digital interface output.  |
| B27        | GPIO[2]/DCD1_DIO | Input / Output | General purpose input/output 2 or DCD1 regulator digital interface input/output.  |
| B28        | GPIO[1]/DCD2_DIF | Output         | General purpose input/output 1 or DCD2 regulator digital interface output.  |
| B29        | GPIO[0]/DCD2_DIO | Input / Output | General purpose input/output 0 or DCD2 regulator digital interface input/output.  |
| B30, B31   | DCD2_VIN         | Input          | Input voltage for DCD2. Connect two $10\mu F$ bypass capacitors from this pin to ground.  |
| B32        | DCD2_FB          | Input          | Feedback voltage for DCD2. This pin must be connected to the output filter of the regulator.  |
| B33        | VCCAPWROK        | Output         | Active-HIGH, open-drain soft-start-done signal.   |
| B34        | PROCHOT_B        | Output         | Active-LOW open-drain output signal.  |
| B35        | THERMTRIP_B      | Input          | Active-LOW thermal trip input signal. Catastrophic thermal event indicator to the P91E0 to shut off all power rails.  |
| B36        | SLP_S3_B         | Input          | Active-LOW input signal. When connected to logic HIGH, all the "S" type power rails are enabled. When pulled LOW, the regulators are shutdown.  |

| Pin Number | Name       | Type   | Description  |
|------------|------------|--------|--|
| B37        | SLP_S0Ix_B | Input  | Active-LOW input signal. When connected to logic HIGH, all the "SX" type power rails are enabled. When pulled LOW, the regulators are shutdown.  |
| B38        | DCD1_GSEN  | Input  | DCD1 ground sense pin.   |
| B39, B40   | DCD1_VIN   | Input  | Input voltage for DCD1. Connect two 10µF bypass capacitors from this pin to ground.  |
| B41        | DCD1_FB    | Input  | Feedback voltage for DCD1. This pin must be connected to the output filter of the DCD1.  |
| B42        | VSYS       | Input  | P91E0 input supply voltage. Connect a 2.2µF capacitor from this pin to ground. Place the capacitor as close as possible to VSYS.   |
| B43        | DCD0_FB    | Input  | Feedback voltage for DCD0. This pin must be connected to the output filter of the DCD0.  |
| B44, B45   | DCD0_VIN   | Input  | Input voltage for DCD0. Connect two 10µF bypass capacitors from this pin to ground.  |
| B46        | DCD0_GSEN  | Input  | DCD0 ground sense pin.   |
| B47        | RSMRST_B   | Output | Resume reset pin is an active-LOW soft-start-done signal.  |
| B48        | SVID_CLK   | Input  | SVID clock input.  |
| EPAD       | PGND       | Ground | Ground. This exposed pad is the connection for the current return path and is also used for thermal dissipation. Connect to PCB ground with sufficient vias to support the returned current and thermal requirement. |

### 3. Absolute Maximum Ratings

The absolute maximum ratings are stress ratings only. Stresses greater than those listed below can cause permanent damage to the device. Functional operation of the P91E0 at absolute maximum ratings is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

**Table 2. Absolute Maximum Ratings**

| Symbol          | Parameter                        | Conditions  | Minimum | Maximum | Units |
|-----------------|----------------------------------|---|---------|---------|-------|
| T <sub>J</sub>  | Junction Temperature             |   | -40     | +125    | °C    |
|                 | ESD – Human Body Model (HBM)     | All pins  | -1500   | +1500   | V     |
|                 | ESD – Charged Device Model (CDM) | All pins  | -500    | +500    | V     |
| Maximum Voltage |                                  | LDO_VIN, LDO5_VIN, VGPIO0, LDO0_VO, LDO1_VO, LDO2_VO, LDO3_VO, LDO4_VO, LDO5_VO, DCD0_FB, DCD1_FB, DCD2_FB, DCD0_DIO, DCD1_DIO, DCD2_DIO, DCD3_DIF, DCD3_DIO, DCD4_DIF, DCD4_DIO, GPIO[9:0] | -0.3    | 2.2     | V     |
|                 |                                  | GPIO[14:10]   | -0.3    | 3.6     | V     |
|                 |                                  | Maximum DC Voltage (t > 500ns):<br>DCD0_LX, DCD1_LX, DCD2_LX, DCD5_LX, DCD6_LX  | -0.3    | 6.0     | V     |
|                 |                                  | Maximum AC Voltage (t < 500ns):<br>DCD0_LX, DCD1_LX, DCD2_LX, DCD5_LX, DCD6_LX  | -1.2    | 6.5     | V     |
|                 |                                  | All other pins  | -0.3    | 6.0     | V     |
| Latch-up        |                                  | GPIO pins, Grade II   | –       | 40      | mA    |
|                 |                                  | All other pins, Grade II  | –       | 100     | mA    |

## 4. Thermal Characteristics

The maximum power dissipation is  $P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$  where  $T_{J(MAX)}$  is 125°C. Exceeding the maximum allowable power dissipation will result in excessive die temperature and the device will enter thermal shutdown.

**Table 3. Thermal Characteristics – 100-VFQFPN**

| Symbol             | Parameter   | Rating      | Units |
|--------------------|---|-------------|-------|
| $\theta_{JA}$      | Thermal Resistance Junction to Ambient [a], [b]         | 24.0        | °C/W  |
| $\theta_{JC(TOP)}$ | Thermal Resistance Junction to Top of the Case [a], [b] | 19.3        | °C/W  |
| $\theta_{JB(BOT)}$ | Thermal Resistance Junction to Exposed Pad [a], [b]     | 0.7         | °C/W  |
| $T_{J(MAX)}$       | Maximum Junction Temperature                            | 125         | °C    |
| $T_A$              | Ambient Operating Temperature (Industrial Range)        | -40 to +85  | °C    |
| $T_{STOR}$         | Storage Temperature                                     | -55 to +150 | °C    |
| $T_{LEAD}$         | Lead Temperature (soldering, 10s)                       | +300        | °C    |

- [a] The thermal rating is calculated based on a JEDEC standard 2S2P 4-layer board (114mm × 101mm in still air conditions with 2 oz. internal planes) and 5 × 5 mm EPAD soldered down and a 25 thermal via array to the internal plane.
- [b] Actual thermal resistance is affected by the printed circuit board (PCB) size, solder joint quality, layer count, copper thickness, air flow, altitude, and other unlisted variables.

## 5. Recommended Operating Conditions

**Table 4. Recommended Operating Conditions**

| Symbol         | Parameter  | Minimum | Typical | Maximum | Units |
|----------------|--|---------|---------|---------|-------|
| $V_{SYS}$      | P91E0 Input Voltage  | 3.15    | –       | 5.25    | V     |
| $V_{PVIN}$     | DCD0, DCD1, DCD2, DCD5, and DCD6 Power Stage Input Voltage | 2.80    | –       | 5.25    | V     |
| $V_{IN\_LDO}$  | LDO0, LDO1, LDO2, LDO3, LDO4 Input Voltage                 | 1.00    | 1.80    | 2.00    | V     |
| $V_{IN\_LDO5}$ | LDO5 Input Voltage   | 1.20    | 1.35    | 1.50    | V     |

## 6. Overview and Power Supply DC Characteristics

The P91E0 is an integrated power-management IC (PMIC) targeted for applications powered by a rechargeable battery or a regulated 3.15V to 5.25V system supply. However if the P91E0 has a P9148 DPU attached to any of the DCDx voltage output rails, operating from a 5V system supply is strongly recommended. The product offers seven configurable step-down converters capable of delivering up to 5.0A of load current for the memory, processor core, I/O, auxiliary, and pre-regulation for LDOs. In addition, the device includes 8 low-dropout (LDO) linear regulators that can be supplied from a battery or a regulated supply. The P91E0 is configured/controlled via I<sub>2</sub>C. Other features include 15 general purpose I/O (GPIO), push button control, integrated state machine for power sequencing, and thermal management.

There are six defined states that are determined by the behavior of the platform power rails, SoC sideband signals (COREPWROK, PLTRST\_B, SLP\_Sx\_B), and internal state machine modes. The states are G3, SoC-G3, SoC-S0, SoC-S0Ix, SoC-S3, and SoC-S4/S5. See section 9.3 for details.

Table 5 lists the regulators and their DC characteristics.

**Table 5. Overview of Power Supplies**

Note: See important notes at the end of the table.

| Regulator           | I <sub>OUT_DC</sub> [A] | I <sub>OUT_MAX</sub> [A] | I <sub>OUT_MAX</sub> with DPUs <sup>[a], [b] [A]</sup> | V <sub>IN</sub> Range (V) <sup>[c]</sup>                  | V <sub>O</sub> Range (V)                      | Output Inductance (L) and Capacitance <sup>[e]</sup> (C <sub>O</sub> )  |
|---------------------|-------------------------|--------------------------|--|---|---|---|
| DCD0 <sup>[d]</sup> | 4.0                     | 5.0                      | 29   | V <sub>SYS</sub> = V <sub>IN_DCD0</sub> = 3.15V to 5.25V  | SVID: 0.25V to 1.3V<br>Non-SVID: 1.1V to 1.9V | Factory-enabled load line (DCD0 and DCD1 default):<br>L <sub>5VIN</sub> = 0.47μH<br>C <sub>O_Total</sub> = 6 × 47μF<br>Refer to the DPU datasheet for additional C <sub>O</sub> . |
| DCD1 <sup>[d]</sup> | 4.0                     | 5.0                      | 29   | V <sub>SYS</sub> = V <sub>IN_DCD1</sub> = 3.15V to 5.25V  | SVID: 0.25V to 1.3V<br>Non-SVID: 1.1V to 1.9V |   |
| DCD2 <sup>[d]</sup> | 4.0                     | 5.0                      | 29   | V <sub>SYS</sub> = V <sub>IN_DCD02</sub> = 3.15V to 5.25V | SVID: 0.25V to 1.3V<br>Non-SVID: 1.1V to 1.9V | Factory-disabled load line (DCD2 default):<br>L <sub>5VIN</sub> = 0.47μH<br>C <sub>O</sub> = 3 × 47μF<br>Refer to the DPU datasheet for additional C <sub>O</sub> .               |
| DCD3_CTRL           | –                       | –                        | 24   | V <sub>SYS</sub> = 3.15V to 5.25V                         | 0.525V to 3.6V                                | C <sub>O</sub> = 3 × 47μF per DPU; see DPU datasheet for L  |
| DCD4_CTRL           | –                       | –                        | 24   | V <sub>SYS</sub> = 3.15V to 5.25V                         | 0.525V to 3.6V                                | C <sub>O</sub> = 3 × 47μF per DPU; see DPU datasheet for L  |
| DCD5                | 2.0                     | 2.3                      | –  | V <sub>SYS</sub> = V <sub>IN_DCD5</sub> = 3.15V to 5.250V | 0.525V to 3.375V                              | L <sub>3.3VIN</sub> = 0.68μH; L <sub>5VIN</sub> = 1.0μH<br>C <sub>O</sub> = 2 × 47μF  |
| DCD6                | 2.0                     | 2.3                      | –  | V <sub>SYS</sub> = V <sub>IN_DCD6</sub> = 3.15V to 5.25V  | 0.525V to 3.375V                              | L <sub>3.3VIN</sub> = 0.68μH; L <sub>5VIN</sub> = 1.0μH<br>C <sub>O</sub> = 2 × 47μF  |
| LDO0 <sup>[f]</sup> | 0.300                   | 0.325                    | –  | V <sub>LDO_VIN</sub> = 1.0V to 2.0V                       | 1.0V to 1.65V                                 | C <sub>O</sub> = 2.2μF  |
| LDO1 <sup>[f]</sup> | 0.300                   | 0.325                    | –  |   | 1.0V to 1.65V                                 | C <sub>O</sub> = 2.2μF  |
| LDO2 <sup>[f]</sup> | 0.300                   | 0.325                    | –  |   | 1.0V to 1.65V                                 | C <sub>O</sub> = 2.2μF  |
| LDO3                | 0.045                   | 0.045                    | –  |   | 1.0V to 1.65V                                 | C <sub>O</sub> = 1.0μF  |
| LDO4                | 0.045                   | 0.045                    | –  |   | 1.0V to 1.65V                                 | C <sub>O</sub> = 1.0μF  |

| Regulator | $I_{OUT\_DC}$ [A] | $I_{OUT\_MAX}$ [A] | $I_{OUT\_MAX}$ with DPUs <sup>[a], [b]</sup> [A] | $V_{IN}$ Range (V) <sup>[c]</sup> | $V_o$ Range (V)    | Output Inductance (L) and Capacitance <sup>[e]</sup> ( $C_o$ ) |
|-----------|-------------------|--------------------|--|-----------------------------------|--------------------|--|
| LDO5      | $\pm 0.550$       | $\pm 0.550$        | –  | $V_{LDO5\_VIN} = 1.2V$ to $1.5V$  | $V_{IN\_LDO5} / 2$ | $C_o = 22\mu F$  |
| LDO6      | 0.100             | 0.110              | –  | $V_{SYS} = 3.15V$ to $5.25V$      | 1.20V to 3.55V     | $C_o = 1.0\mu F$   |
| LDO7      | 0.100             | 0.110              | –  | $V_{SYS} = 3.15V$ to $5.25V$      | 1.80V              | $C_o = 1.0\mu F$   |

- [a] Ensure that the DPU's PVIN voltage is above PVIN UVLO (VUV) before VSYS reaches VSYS\_MIN.
- [b] PWRBTNIN\_B (or PMIC\_EN when used) should not be asserted until the DPU's PVIN voltage is above PVIN UVLO (VUV; see the DPU datasheet).
- [c] During power up ensure that the voltage seen by VSYS is monotonic, which can be achieved by adding an appropriate RC filter.
- [d] The SVID voltage range can be deselected by OTP or via I2C, and the mode of operation must be set to FPWM Mode when used with DPUs.
- [e] The output capacitor recommendation is for X5R, 20%, 0805 minimum case size. Derating of the ceramic capacitor due to operating conditions, such as bias voltage and temperature, should be considered as part of the component selection.
- [f] Can be configured as a pass switch.

## 7. Electrical Characteristics and Configuration

### 7.1 General Specification

$V_{SYS} = 5.0V$ ,  $T_J = -40^\circ C$  to  $+125^\circ C$ , unless otherwise noted. Typical values are at  $+25^\circ C$ .

**Table 6. Electrical Characteristics – PMIC VSYS, UVLO, Thermal Shutdown Threshold**

| Symbol          | Parameter                               | Conditions  | Minimum | Typical | Maximum | Units      |
|-----------------|---|---|---------|---------|---------|------------|
| $V_{SYS}$       | Input Voltage Range                     | –   | 3.15    | –       | 5.25    | V          |
| $I_Q(V_{SYS})$  | VSYS Quiescent Current                  | Device in SoC-G3 (OFF state)                          | –       | 7       | –       | $\mu A$    |
|                 |   | Device in SoC-S4/S5 state; all regulators powered-off | –       | 0.75    | 1.1     | mA         |
| $V_{SYS(UVLO)}$ | Under-Voltage Lock-Out (UVLO) Threshold | $V_{SYS}$ rising ( $V_{SYSREF_R}$ )                   | –       | 2.9     | –       | V          |
|                 |   | $V_{SYS}$ falling ( $V_{SYSREF_F}$ )                  | –       | 2.5     | –       | V          |
| $T_{SDN}$       | Thermal Shutdown                        | Temperature increasing, GBD <sup>[a]</sup>            | 125     | 132     | –       | $^\circ C$ |

- [a] GBD = Guaranteed by design.

## 7.2 Linear Regulators LDO0, LDO1, LDO2

**Table 7. Electrical Characteristics – LDO0, LDO1, LDO2**

$V_{SYS} = 5V$ ,  $V_{IN\_LDO} = 1.8V$ ,  $V_{OUT} = 1.5V$  (default), input capacitance  $C_{IN} = 10\mu F$ ,  $C_O = 2.2\mu F$ ,  $T_J = -40^\circ C$  to  $+125^\circ C$ , unless otherwise noted. Typical values are at  $+25^\circ C$ .

| Symbol                          | Parameter                     | Conditions  | Minimum | Typical | Maximum | Units       |
|---------------------------------|-------------------------------|---|---------|---------|---------|-------------|
| $V_{IN\_LDO}$                   | Input Voltage Range           | –   | 1.0     | 1.8     | 2.0     | V           |
| $V_o$                           | Programmable Output Voltage   | –   | 1.0     | 1.5     | 1.65    | V           |
| $I_{SHDN}$                      | Shutdown Current              | –   | –       | 0.5     | –       | $\mu A$     |
| $I_Q$                           | Quiescent Current             | No Load   | –       | 22      | –       | $\mu A$     |
|                                 | Regulation Voltage Accuracy   | –   | -2.0    | –       | +2.0    | %           |
| $\Delta V_{OUT}/\Delta V_{IN}$  | Line Regulation               | –   | –       | 1.0     | –       | ppm/V       |
| $\Delta V_{OUT}/\Delta I_{OUT}$ | Load Regulation               | –   | –       | 5.0     | –       | $\mu V/mA$  |
| $I_o$                           | Maximum Output Current        | –   | 300     | –       | –       | mA          |
| $I_{LIM}$                       | Current Limit                 | –   | 325     | –       | –       | mA          |
| $V_{DROP}$                      | Dropout Voltage               | $I_o = 300mA$   | –       | –       | 150     | mV          |
| PSRR                            | Power Supply Ripple Rejection | $V_{IN\_LDO} - V_o = 500mV$ , $I_o = 30mA$            |         |         |         |             |
|                                 |                               | < 200Hz   | –       | > 100   | –       | dB          |
|                                 |                               | 1kHz  | –       | 100     | –       |             |
|                                 |                               | 10kHz   | –       | 85      | –       |             |
|                                 |                               | 100kHz  | –       | 55      | –       |             |
| $e_n$                           | Output Noise Voltage          | $V_o = 1.5V$ , $I_o = 100\mu A$ , BW = 10Hz to 100kHz | –       | 28      | –       | $\mu VRMS$  |
| $R_{DIS}$                       | Output Discharge Resistance   | –   | –       | 10      | –       | k $\Omega$  |
| $T_{SSR}$                       | LDO Soft-Start Ramp Rate      | –   | –       | 30      | –       | mV/ $\mu s$ |

**Table 8. I<sup>2</sup>C Control Register – LDO0, LDO1, LDO2**

| Register Name | R/W | D7   | D6 | D5 | D4 | D3 | D2       | D1      | D0                | Initial Value     | Address |
|---------------|-----|------|----|----|----|----|----------|---------|-------------------|-------------------|---------|
| LDO0_CTL      | R/W | RSVD |    |    |    |    | LDO0_SEL | LDO0_EN | 00 <sub>HEX</sub> | 65 <sub>HEX</sub> |         |
| LDO1_CTL      | R/W | RSVD |    |    |    |    | LDO1_SEL | LDO1_EN | 00 <sub>HEX</sub> | 61 <sub>HEX</sub> |         |
| LDO2_CTL      | R/W | RSVD |    |    |    |    | LDO2_SEL | LDO2_EN | 00 <sub>HEX</sub> | 66 <sub>HEX</sub> |         |

| Bit    | Name     | Function   | Default |
|--------|----------|--|---------|
| D[7:2] | RSVD     | Reserved   | 0       |
| D[1]   | LDOx_SEL | ON/OFF selection bit:<br>0 = ON/OFF is controlled by the configured device sequence.<br>1 = ON/OFF is controlled by the D[0] bit of this register. | 0       |
| D[0]   | LDOx_EN  | Enable bit:<br>0 = OFF<br>1 = ON   | 0       |

**Table 9. ON/OFF Selection Bit Truth Table – LDO0, LDO1, LDO2**

| D[1] | D[0] | Sequencer Control | LDO |
|------|------|-------------------|-----|
| 0    | X    | SLP_x signal LOW  | OFF |
| 0    | X    | SLP_x signal HIGH | ON  |
| 1    | 0    | X                 | OFF |
| 1    | 1    | X                 | ON  |

**Table 10. I2C Output Voltage Setting – LDO0, LDO1, LDO2**

Note: Green shading indicates that the register values are loaded from the OTP memory.

| Register Name | R/W | D7   | D6 | D5 | D4                                    | D3 | D2 | D1 | D0 | Initial Value | Address |
|---------------|-----|------|----|----|---------------------------------------|----|----|----|----|---------------|---------|
| LDO0_VOUT     | R/W | RSVD |    |    | Output Voltage Setting (see Table 12) |    |    |    |    |               | OTP     |
| LDO1_VOUT     | R/W | RSVD |    |    | Output Voltage Setting (see Table 12) |    |    |    |    |               | OTP     |
| LDO2_VOUT     | R/W | RSVD |    |    | Output Voltage Setting (see Table 12) |    |    |    |    |               | OTP     |

**Table 11. I2C Sequencing Control Register – LDO0, LDO1, LDO2**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6 | D5        | D4 | D3         | D2 | D1 | D0 | Initial Value | Address           |
|---------------|-----|------|----|-----------|----|------------|----|----|----|---------------|-------------------|
| LDO0_GRP      | R/W | RSVD |    | LDO0_TYPE |    | LDO0_GROUP |    |    |    | OTP           | ED <sub>HEX</sub> |
| LDO1_GRP      | R/W | RSVD |    | LDO1_TYPE |    | LDO1_GROUP |    |    |    | OTP           | EE <sub>HEX</sub> |
| LDO2_GRP      | R/W | RSVD |    | LDO2_TYPE |    | LDO2_GROUP |    |    |    | OTP           | EF <sub>HEX</sub> |

| Bit    | Name       | Function   |     | Default |
|--------|------------|--|-----|---------|
| D[7:6] | RSVD       | Reserved   |     | 0       |
| D[5:4] | LDOx_TYPE  | Rail type selection bits:<br>00 <sub>BIN</sub> = "A" rail type.<br>01 <sub>BIN</sub> = "U" rail type.<br>10 <sub>BIN</sub> = "S" rail type.<br>11 <sub>BIN</sub> = "SX" rail type.   |     | OTP     |
| D[3:0] | LDOx_GROUP | Group Delay Bits<br>0000 <sub>BIN</sub> = Group 0<br>0001 <sub>BIN</sub> = Group 1<br>0010 <sub>BIN</sub> = Group 2<br>0011 <sub>BIN</sub> = Group 3<br>0100 <sub>BIN</sub> = Group 4<br>0101 <sub>BIN</sub> = Group 5<br>0110 <sub>BIN</sub> = Group 6<br>0111 <sub>BIN</sub> = Group 7<br>1000 <sub>BIN</sub> = Group 8<br>1001 <sub>BIN</sub> = Group 9<br>1010 <sub>BIN</sub> = Group 10<br>1011 <sub>BIN</sub> = Group 11<br>1100 <sub>BIN</sub> = Group 12<br>1101 <sub>BIN</sub> = Group 13<br>1110 <sub>BIN</sub> = Group 14<br>1111 <sub>BIN</sub> = Disabled | OTP |         |

**Table 12. LDO0, LDO1, and LDO2 Output Voltage Setting**

| V <sub>OUT</sub> | Decimal | Hexadecimal       | Binary               |
|------------------|---------|-------------------|----------------------|
| 1.000            | 0       | 00 <sub>HEX</sub> | 00000 <sub>BIN</sub> |
| 1.025            | 1       | 01 <sub>HEX</sub> | 00001 <sub>BIN</sub> |
| 1.050            | 2       | 02 <sub>HEX</sub> | 00010 <sub>BIN</sub> |
| 1.075            | 3       | 03 <sub>HEX</sub> | 00011 <sub>BIN</sub> |
| 1.100            | 4       | 04 <sub>HEX</sub> | 00100 <sub>BIN</sub> |
| 1.125            | 5       | 05 <sub>HEX</sub> | 00101 <sub>BIN</sub> |
| 1.150            | 6       | 06 <sub>HEX</sub> | 00110 <sub>BIN</sub> |
| 1.175            | 7       | 07 <sub>HEX</sub> | 00111 <sub>BIN</sub> |
| 1.200            | 8       | 08 <sub>HEX</sub> | 01000 <sub>BIN</sub> |
| 1.225            | 9       | 09 <sub>HEX</sub> | 01001 <sub>BIN</sub> |
| 1.250            | 10      | 0A <sub>HEX</sub> | 01010 <sub>BIN</sub> |

| V <sub>OUT</sub> | Decimal | Hexadecimal       | Binary               |
|------------------|---------|-------------------|----------------------|
| 1.275            | 11      | 0B <sub>HEX</sub> | 01011 <sub>BIN</sub> |
| 1.300            | 12      | 0C <sub>HEX</sub> | 01100 <sub>BIN</sub> |
| 1.325            | 13      | 0D <sub>HEX</sub> | 01101 <sub>BIN</sub> |
| 1.350            | 14      | 0E <sub>HEX</sub> | 01110 <sub>BIN</sub> |
| 1.375            | 15      | 0F <sub>HEX</sub> | 01111 <sub>BIN</sub> |
| 1.400            | 16      | 10 <sub>HEX</sub> | 10000 <sub>BIN</sub> |
| 1.425            | 17      | 11 <sub>HEX</sub> | 10001 <sub>BIN</sub> |
| 1.450            | 18      | 12 <sub>HEX</sub> | 10010 <sub>BIN</sub> |
| 1.475            | 19      | 13 <sub>HEX</sub> | 10011 <sub>BIN</sub> |
| 1.500            | 20      | 14 <sub>HEX</sub> | 10100 <sub>BIN</sub> |
| 1.525            | 21      | 15 <sub>HEX</sub> | 10101 <sub>BIN</sub> |
| 1.550            | 22      | 16 <sub>HEX</sub> | 10110 <sub>BIN</sub> |
| 1.575            | 23      | 17 <sub>HEX</sub> | 10111 <sub>BIN</sub> |
| 1.600            | 24      | 18 <sub>HEX</sub> | 11000 <sub>BIN</sub> |
| 1.625            | 25      | 19 <sub>HEX</sub> | 11001 <sub>BIN</sub> |
| 1.650            | 26      | 1A <sub>HEX</sub> | 11010 <sub>BIN</sub> |
| Pass switch      | ≥27     | ≥1B               |                      |

### 7.3 Linear Regulators LDO3, LDO4

**Table 13. Electrical Characteristics – LDO3, LDO4**

$V_{IN\_LDO} = 1.8V$ ,  $V_{OUT} = 1.2V$  (default),  $C_{IN} = 10\mu F$ ,  $C_O = 1.0\mu F$ ,  $T_J = -40^\circ C$  to  $+125^\circ C$ , unless otherwise noted. Typical values are at  $+25^\circ C$ .

| Symbol                          | Parameter                     | Conditions   | Minimum | Typical | Maximum | Units      |
|---------------------------------|-------------------------------|--|---------|---------|---------|------------|
| $V_{IN\_LDO}$                   | Input Voltage Range           |  | 1.0     | 1.8     | 2.0     | V          |
| $V_O$                           | Output Voltage Range          |  | 1.0     | 1.2     | 1.65    | V          |
| $I_{SHDN}$                      | Shutdown Current              |  | –       | 0.5     | –       | $\mu A$    |
| $I_Q$                           | Quiescent Current             | No Load  | –       | 20      | –       | $\mu A$    |
|                                 | Regulation Voltage Accuracy   |  | -2.0    | –       | +2.0    | %          |
| $\Delta V_{OUT}/\Delta V_{IN}$  | Line Regulation               |  | –       | 1.0     | –       | ppm/V      |
| $\Delta V_{OUT}/\Delta I_{OUT}$ | Load Regulation               |  | –       | 19      | –       | $\mu V/mA$ |
| $I_O$                           | Maximum Output Current        |  | 45      | –       | –       | mA         |
| $I_{LIM}$                       | Current Limit                 |  | 45      | –       | –       | mA         |
| $V_{DROP}$                      | Dropout Voltage               | $I_O = 50mA$   | –       | –       | 100     | mV         |
| PSRR                            | Power Supply Ripple Rejection | $V_{IN\_LDO} - V_O = 500mV$ , $I_O = 10mA$                   |         |         |         | dB         |
|                                 |                               | < 200Hz  | –       | > 100   | –       |            |
|                                 |                               | 1kHz   | –       | 100     | –       |            |
|                                 |                               | 10kHz  | –       | 85      | –       |            |
|                                 |                               | 100kHz   | –       | 55      | –       |            |
| $e_n$                           | Output Noise Voltage          | $V_O = 1.2V$ , $I_O = 100\mu A$ , Bandwidth = 10Hz to 100kHz | –       | 28      | –       | $\mu VRMS$ |
| $R_{DIS}$                       | Output Discharge Resistance   |  | –       | 10      | –       | k $\Omega$ |
| $T_{SSR}$                       | LDO Soft-Start Ramp Rate      |  | –       | 30      | –       | $mV/\mu s$ |

**Table 14. I2C Control Register – LDO3, LDO4**

| Register Name | R/W | D7 | D6 | D5 | D4   | D3 | D2 | D1       | D0      | Initial Value     | Address           |
|---------------|-----|----|----|----|------|----|----|----------|---------|-------------------|-------------------|
| LDO3_CTL      | R/W |    |    |    | RSVD |    |    | LDO3_SEL | LDO3_EN | 00 <sub>HEX</sub> | 5E <sub>HEX</sub> |
| LDO4_CTL      | R/W |    |    |    | RSVD |    |    | LDO4_SEL | LDO4_EN | 00 <sub>HEX</sub> | 60 <sub>HEX</sub> |

| Bit    | Name     | Function   | Default |
|--------|----------|--|---------|
| D[7:2] | RSVD     | Reserved   | 0       |
| D[1]   | LDOx_SEL | ON/OFF selection bit:<br>0 = ON/OFF is controlled by configured device sequence.<br>1 = ON/OFF is controlled by D[0] register. | 0       |
| D[0]   | LDOx_EN  | Enable bit:<br>0 = OFF<br>1 = ON   | 0       |

**Table 15. Selection Bit Truth Table – LDO3, LDO4**

| D[1] | D[0] | Sequencer Control | LDO3/4 |
|------|------|-------------------|--------|
| 0    | X    | SLP_x signal LOW  | OFF    |
| 0    | X    | SLP_x signal HIGH | ON     |
| 1    | 0    | X                 | OFF    |
| 1    | 1    | X                 | ON     |

**Table 16. I2C Output Voltage Setting – LDO3, LDO4**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7 | D6 | D5   | D4 | D3 | D2 | D1 | D0                                    | Initial Value | Address           |
|---------------|-----|----|----|------|----|----|----|----|---------------------------------------|---------------|-------------------|
| LDO3_VOUT     | R/W |    |    | RSVD |    |    |    |    | Output Voltage Setting (see Table 18) | OTP           | 16 <sub>HEX</sub> |
| LDO4_VOUT     | R/W |    |    | RSVD |    |    |    |    | Output Voltage Setting (see Table 18) | OTP           | 17 <sub>HEX</sub> |

**Table 17. I2C Sequencing Control Register – LDO3, LDO4**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6 | D5        | D4 | D3         | D2 | D1 | D0 | Initial Value | Address           |
|---------------|-----|------|----|-----------|----|------------|----|----|----|---------------|-------------------|
| LDO3_GRP      | R/W | RSVD |    | LDO3_TYPE |    | LDO3_GROUP |    |    |    | OTP           | F0 <sub>HEX</sub> |
| LDO4_GRP      | R/W | RSVD |    | LDO4_TYPE |    | LDO4_GROUP |    |    |    | OTP           | F1 <sub>HEX</sub> |

| Bit    | Name       | Function  |  | Default |
|--------|------------|---|--|---------|
| D[7:6] | RSVD       | Reserved  |  | 0       |
| D[5:4] | LDOx_TYPE  | Rail type selection bits:<br>00 <sub>BIN</sub> = "A" rail type.<br>01 <sub>BIN</sub> = "U" rail type.<br>10 <sub>BIN</sub> = "S" rail type.<br>11 <sub>BIN</sub> = "SX" rail type   |  | OTP     |
| D[3:0] | LDOx_GROUP | Group Delay Bits<br>0000 <sub>BIN</sub> = Group 0<br>0001 <sub>BIN</sub> = Group 1<br>0010 <sub>BIN</sub> = Group 2<br>0011 <sub>BIN</sub> = Group 3<br>0100 <sub>BIN</sub> = Group 4<br>0101 <sub>BIN</sub> = Group 5<br>0110 <sub>BIN</sub> = Group 6<br>0111 <sub>BIN</sub> = Group 7<br>1000 <sub>BIN</sub> = Group 8<br>1001 <sub>BIN</sub> = Group 9<br>1010 <sub>BIN</sub> = Group 10<br>1011 <sub>BIN</sub> = Group 11<br>1100 <sub>BIN</sub> = Group 12<br>1101 <sub>BIN</sub> = Group 13<br>1110 <sub>BIN</sub> = Group 14<br>1111 <sub>BIN</sub> = Disable |  | OTP     |

**Table 18. LDO3, LDO4 Output Voltage Setting**

| V <sub>OUT</sub> | Decimal | Hexadecimal       | Binary                |
|------------------|---------|-------------------|-----------------------|
| 1.000            | 0       | 00 <sub>HEX</sub> | 000000 <sub>BIN</sub> |
| 1.025            | 1       | 01 <sub>HEX</sub> | 000001 <sub>BIN</sub> |
| 1.050            | 2       | 02 <sub>HEX</sub> | 000010 <sub>BIN</sub> |
| 1.075            | 3       | 03 <sub>HEX</sub> | 000011 <sub>BIN</sub> |
| 1.100            | 4       | 04 <sub>HEX</sub> | 000100 <sub>BIN</sub> |
| 1.125            | 5       | 05 <sub>HEX</sub> | 000101 <sub>BIN</sub> |
| 1.150            | 6       | 06 <sub>HEX</sub> | 000110 <sub>BIN</sub> |
| 1.175            | 7       | 07 <sub>HEX</sub> | 000111 <sub>BIN</sub> |
| 1.200            | 8       | 08 <sub>HEX</sub> | 001000 <sub>BIN</sub> |
| 1.225            | 9       | 09 <sub>HEX</sub> | 001001 <sub>BIN</sub> |
| 1.250            | 10      | 0A <sub>HEX</sub> | 001010 <sub>BIN</sub> |
| 1.275            | 11      | 0B <sub>HEX</sub> | 001011 <sub>BIN</sub> |

| V <sub>OUT</sub> | Decimal | Hexadecimal       | Binary                |
|------------------|---------|-------------------|-----------------------|
| 1.300            | 12      | 0C <sub>HEX</sub> | 001100 <sub>BIN</sub> |
| 1.325            | 13      | 0D <sub>HEX</sub> | 001101 <sub>BIN</sub> |
| 1.350            | 14      | 0E <sub>HEX</sub> | 001110 <sub>BIN</sub> |
| 1.375            | 15      | 0F <sub>HEX</sub> | 001111 <sub>BIN</sub> |
| 1.400            | 16      | 10 <sub>HEX</sub> | 010000 <sub>BIN</sub> |
| 1.425            | 17      | 11 <sub>HEX</sub> | 010001 <sub>BIN</sub> |
| 1.450            | 18      | 12 <sub>HEX</sub> | 010010 <sub>BIN</sub> |
| 1.475            | 19      | 13 <sub>HEX</sub> | 010011 <sub>BIN</sub> |
| 1.500            | 20      | 14 <sub>HEX</sub> | 010100 <sub>BIN</sub> |
| 1.525            | 21      | 15 <sub>HEX</sub> | 010101 <sub>BIN</sub> |
| 1.550            | 22      | 16 <sub>HEX</sub> | 010110 <sub>BIN</sub> |
| 1.575            | 23      | 17 <sub>HEX</sub> | 010111 <sub>BIN</sub> |
| 1.600            | 24      | 18 <sub>HEX</sub> | 011000 <sub>BIN</sub> |
| 1.625            | 25      | 19 <sub>HEX</sub> | 011001 <sub>BIN</sub> |
| 1.650            | 26      | 1A <sub>HEX</sub> | 011010 <sub>BIN</sub> |

## 7.4 Linear Regulator LDO5

LDO5 is a source-sink linear regulator capable of delivering load currents as high as  $\pm 550\text{mA}$ . The output voltage is designed to regulate at  $V_{IN\_LDO5} / 2$ . The regulator is controlled either through the sequencing state machine or by I<sub>C</sub>.

**Table 19. Electrical Characteristics – LDO5**

$V_{IN\_LDO5} = 1.24\text{V}$ ,  $V_{OUT} = 0.620\text{V}$  (default).  $C_{IN} = 22\mu\text{F}$ ,  $C_O = 22\mu\text{F}$ ,  $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ , unless otherwise noted. Typical values are at  $+25^\circ\text{C}$ .

| Symbol         | Parameter                     | Conditions                                       | Minimum            | Typical | Maximum | Units         |
|----------------|-------------------------------|--|--------------------|---------|---------|---------------|
| $V_{IN\_LDO5}$ | Input Voltage Range           |  | 1.20               | 1.24    | 1.50    | V             |
| $V_{O\_LDO5}$  | Output Voltage                |  | $V_{IN\_LDO5} / 2$ |         |         | V             |
| $I_{SHDN}$     | Shutdown Current              |  | –                  | 1       | –       | $\mu\text{A}$ |
| $I_Q$          | Quiescent Current             | No Load  | –                  | 60      | 110     | $\mu\text{A}$ |
|                | Regulation Voltage Accuracy   | $-550\text{mA} \leq I_{LOAD} \leq +550\text{mA}$ | -5                 | –       | +5      | %             |
| $I_{(source)}$ | Maximum Source Output Current |  | 550                | –       | –       | mA            |
| $I_{(sink)}$   | Maximum Sink Output Current   |  | 550                | –       | –       | mA            |
| $R_{DIS}$      | Output Discharge Resistance   |  | –                  | 80      | –       | $\Omega$      |

**Table 20. I2C Control Register – LDO5**

| Register Name | R/W | D7 | D6 | D5   | D4 | D3 | D2 | D1       | D0      | Initial Value     | Address           |
|---------------|-----|----|----|------|----|----|----|----------|---------|-------------------|-------------------|
| LDO5_CTL      | R/W |    |    | RSVD |    |    |    | LDO5_SEL | LDO5_EN | 00 <sub>HEX</sub> | 58 <sub>HEX</sub> |

| Bit    | Name     | Function   | Default               |
|--------|----------|--|-----------------------|
| D[7:2] | RSVD     | Reserved   | 000000 <sub>BIN</sub> |
| D[1]   | LDO5_SEL | ON/OFF selection bit:<br>0 = ON/OFF is controlled by configured device sequence.<br>1 = ON/OFF is controlled by D[0] register. | 0 <sub>BIN</sub>      |
| D[0]   | LDO5_EN  | Enable bit:<br>0 = OFF<br>1 = ON   | 0 <sub>BIN</sub>      |

**Table 21. Selection Bit Truth Table – LDO5**

| D[1] |  | D[0] |  | Sequencer Control | LDO5 |
|------|--|------|--|-------------------|------|
| 0    |  | X    |  | SLP_x signal LOW  | OFF  |
| 0    |  | X    |  | SLP_x signal HIGH | ON   |
| 1    |  | 0    |  | X                 | OFF  |
| 1    |  | 1    |  | X                 | ON   |

**Table 22. I2C Sequencing Control – LDO5**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7 | D6   | D5        | D4 | D3         | D2 | D1 | D0 | Initial Value | Address           |
|---------------|-----|----|------|-----------|----|------------|----|----|----|---------------|-------------------|
| LDO5_GRP      | R/W |    | RSVD | LDO5_TYPE |    | LDO5_GROUP |    |    |    | OTP           | F2 <sub>HEX</sub> |

| Bit    | Name      | Function   | Default           |
|--------|-----------|--|-------------------|
| D[7:6] | RSVD      | Reserved   | 00 <sub>BIN</sub> |
| D[5:4] | LDO5_TYPE | Rail type selection bits:<br>00 <sub>BIN</sub> = "A" rail type.<br>01 <sub>BIN</sub> = "U" rail type.<br>10 <sub>BIN</sub> = "S" rail type.<br>11 <sub>BIN</sub> = "SX" rail type. | OTP               |

| Bit    | Name       | Function   |   |  | Default |
|--------|------------|--|---|--|---------|
|        |            | Group Delay Bits   |   |  |         |
| D[3:0] | LDO5_GROUP | 0000 <sub>BIN</sub> = Group 0<br>0001 <sub>BIN</sub> = Group 1<br>0010 <sub>BIN</sub> = Group 2<br>0011 <sub>BIN</sub> = Group 3<br>0100 <sub>BIN</sub> = Group 4<br>0101 <sub>BIN</sub> = Group 5<br>0110 <sub>BIN</sub> = Group 6<br>0111 <sub>BIN</sub> = Group 7 | 1000 <sub>BIN</sub> = Group 8<br>1001 <sub>BIN</sub> = Group 9<br>1010 <sub>BIN</sub> = Group 10<br>1011 <sub>BIN</sub> = Group 11<br>1100 <sub>BIN</sub> = Group 12<br>1101 <sub>BIN</sub> = Group 13<br>1110 <sub>BIN</sub> = Group 14<br>1111 <sub>BIN</sub> = Disable |  | OTP     |

## 7.5 Linear Regulator LDO6

**Table 23. Electrical Characteristics – LDO6**

$V_{SYS} = 5.0V$ ,  $V_{OUT} = 3.3V$ ,  $C_O = 1\mu F$ ,  $T_J = -40^{\circ}C$  to  $+125^{\circ}C$ , unless otherwise noted. Typical values are at  $+25^{\circ}C$ .

| Symbol                          | Parameter                     | Conditions   | Minimum | Typical | Maximum | Units       |
|---------------------------------|-------------------------------|--|---------|---------|---------|-------------|
| $V_{SYS}$                       | Input Voltage Range           |  | 3.15    | 5.0     | 5.25    | V           |
| $V_O$                           | Output Voltage Range          |  | 1.2     | 3.3     | 3.55    | V           |
| $I_{SHDN}$                      | Shutdown Current              |  | –       | 0.5     | –       | $\mu A$     |
| $I_Q$                           | Quiescent Current             | No Load  | –       | 20      | –       | $\mu A$     |
|                                 | Regulation Voltage Accuracy   |  | -2      | –       | +2      | %           |
| $\Delta V_{OUT}/\Delta V_{IN}$  | Line Regulation               |  | –       | 1       | –       | ppm/V       |
| $\Delta V_{OUT}/\Delta I_{OUT}$ | Load Regulation               |  | –       | 40      | –       | $\mu V/mA$  |
| $I_O$                           | Maximum Output Current        |  | 100     | –       | –       | mA          |
| $I_{LIM}$                       | Current Limit                 |  | 110     | –       | –       | mA          |
| $V_{DROP}$                      | Dropout Voltage               | $I_O = 50mA$   | –       | –       | 125     | mV          |
| PSRR                            | Power Supply Ripple Rejection | $V_{SYS} - V_O = 1V$ , $I_O = 30mA$                          |         |         |         | dB          |
|                                 |                               | < 200Hz  | –       | > 120   | –       |             |
|                                 |                               | 1kHz   | –       | 120     | –       |             |
|                                 |                               | 10kHz  | –       | 95      | –       |             |
|                                 |                               | 100kHz   | –       | 57      | –       |             |
| $e_n$                           | Output Noise Voltage          | $V_O = 3.3V$ , $I_O = 100\mu A$ ,<br>$BW = 10Hz$ to $100kHz$ | –       | 28      | –       | $\mu VRMS$  |
| $R_{DIS}$                       | Output Discharge Resistance   |  | –       | 10      | –       | k $\Omega$  |
| $T_{SSR}$                       | LDO Soft-Start Ramp Rate      |  | –       | 32      | –       | mV/ $\mu s$ |

**Table 24. I2C Control Register – LDO6**

| Register Name | R/W | D7 | D6   | D5 | D4 | D3 | D2 | D1       | D0      | Initial Value     | Address           |
|---------------|-----|----|------|----|----|----|----|----------|---------|-------------------|-------------------|
| LDO6_CTL      | R/W |    | RSVD |    |    |    |    | LDO6_SEL | LDO6_EN | 00 <sub>HEX</sub> | 6A <sub>HEX</sub> |

| Bit    | Name     | Function   | Default               |
|--------|----------|--|-----------------------|
| D[7:2] | RSVD     | Reserved   | 000000 <sub>BIN</sub> |
| D[1]   | LDO6_SEL | ON/OFF selection bit:<br>0 = ON/OFF is controlled by configured device sequence.<br>1 = ON/OFF is controlled by D[0] register. | 0 <sub>BIN</sub>      |
| D[0]   | LDO6_EN  | Control bit:<br>0 = OFF<br>1 = ON  | 0 <sub>BIN</sub>      |

**Table 25. Selection Bit Truth Table – LDO6**

| D[1] | D[0] | Sequencer Control | LDO6 |
|------|------|-------------------|------|
| 0    | X    | SLP_x signal LOW  | OFF  |
| 0    | X    | SLP_x signal HIGH | ON   |
| 1    | 0    | X                 | OFF  |
| 1    | 1    | X                 | ON   |

**Table 26. I2C Output Voltage Setting – LDO6**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Initial Value     | Address           |
|---------------|-----|------|----|----|----|----|----|----|----|-------------------|-------------------|
| LDO6_VOUT     | R/W | RSVD |    |    |    |    |    |    |    | 00 <sub>HEX</sub> | 18 <sub>HEX</sub> |

**Table 27. I<sub>C</sub> Sequencing Control – LDO6**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6 | D5        | D4 | D3         | D2 | D1 | D0 | Initial Value | Address           |
|---------------|-----|------|----|-----------|----|------------|----|----|----|---------------|-------------------|
| LDO6_GRP      | R/W | RSVD |    | LDO6_TYPE |    | LDO6_GROUP |    |    |    | OTP           | F3 <sub>HEX</sub> |

| Bit    | Name       | Function   |  | Default           |
|--------|------------|--|--|-------------------|
| D[7:6] | RSVD       | Reserved   |  | 00 <sub>BIN</sub> |
| D[5:4] | LDO6_TYPE  | Rail type selection bits:<br>00 = "A" rail type.<br>01 = "U" rail type.<br>10 = "S" rail type.<br>11 = "SX" rail type.   |  | OTP               |
| D[3:0] | LDO6_GROUP | Group Delay Bits<br>0000 <sub>BIN</sub> = Group 0<br>0001 <sub>BIN</sub> = Group 1<br>0010 <sub>BIN</sub> = Group 2<br>0011 <sub>BIN</sub> = Group 3<br>0100 <sub>BIN</sub> = Group 4<br>0101 <sub>BIN</sub> = Group 5<br>0110 <sub>BIN</sub> = Group 6<br>0111 <sub>BIN</sub> = Group 7 |  | OTP               |

**Table 28. LDO6 Output Voltage Setting**

| V <sub>OUT</sub> | Decimal | Hexadecimal       | Binary                |
|------------------|---------|-------------------|-----------------------|
| 1.00             | 0       | 00 <sub>HEX</sub> | 000000 <sub>BIN</sub> |
| 1.05             | 1       | 01 <sub>HEX</sub> | 000001 <sub>BIN</sub> |
| 1.10             | 2       | 02 <sub>HEX</sub> | 000010 <sub>BIN</sub> |
| 1.15             | 3       | 03 <sub>HEX</sub> | 000011 <sub>BIN</sub> |
| 1.20             | 4       | 04 <sub>HEX</sub> | 000100 <sub>BIN</sub> |
| 1.25             | 5       | 05 <sub>HEX</sub> | 000101 <sub>BIN</sub> |
| 1.30             | 6       | 06 <sub>HEX</sub> | 000110 <sub>BIN</sub> |
| 1.35             | 7       | 07 <sub>HEX</sub> | 000111 <sub>BIN</sub> |
| 1.40             | 8       | 08 <sub>HEX</sub> | 001000 <sub>BIN</sub> |
| 1.45             | 9       | 09 <sub>HEX</sub> | 001001 <sub>BIN</sub> |
| 1.50             | 10      | 0A <sub>HEX</sub> | 001010 <sub>BIN</sub> |
| 1.55             | 11      | 0B <sub>HEX</sub> | 001011 <sub>BIN</sub> |
| 1.60             | 12      | 0C <sub>HEX</sub> | 001100 <sub>BIN</sub> |

| <b>V<sub>OUT</sub></b> | <b>Decimal</b> | <b>Hexadecimal</b> | <b>Binary</b>         |
|------------------------|----------------|--------------------|-----------------------|
| 1.65                   | 13             | 0D <sub>HEX</sub>  | 001101 <sub>BIN</sub> |
| 1.70                   | 14             | 0E <sub>HEX</sub>  | 001110 <sub>BIN</sub> |
| 1.75                   | 15             | 0F <sub>HEX</sub>  | 001111 <sub>BIN</sub> |
| 1.80                   | 16             | 10 <sub>HEX</sub>  | 010000 <sub>BIN</sub> |
| 1.85                   | 17             | 11 <sub>HEX</sub>  | 010001 <sub>BIN</sub> |
| 1.90                   | 18             | 12 <sub>HEX</sub>  | 010010 <sub>BIN</sub> |
| 1.95                   | 19             | 13 <sub>HEX</sub>  | 010011 <sub>BIN</sub> |
| 2.00                   | 20             | 14 <sub>HEX</sub>  | 010100 <sub>BIN</sub> |
| 2.05                   | 21             | 15 <sub>HEX</sub>  | 010101 <sub>BIN</sub> |
| 2.10                   | 22             | 16 <sub>HEX</sub>  | 010110 <sub>BIN</sub> |
| 2.15                   | 23             | 17 <sub>HEX</sub>  | 010111 <sub>BIN</sub> |
| 2.20                   | 24             | 18 <sub>HEX</sub>  | 011000 <sub>BIN</sub> |
| 2.25                   | 25             | 19 <sub>HEX</sub>  | 011001 <sub>BIN</sub> |
| 2.30                   | 26             | 1A <sub>HEX</sub>  | 011010 <sub>BIN</sub> |
| 2.35                   | 27             | 1B <sub>HEX</sub>  | 011011 <sub>BIN</sub> |
| 2.40                   | 28             | 1C <sub>HEX</sub>  | 011100 <sub>BIN</sub> |
| 2.45                   | 29             | 1D <sub>HEX</sub>  | 011101 <sub>BIN</sub> |
| 2.50                   | 30             | 1E <sub>HEX</sub>  | 011110 <sub>BIN</sub> |
| 2.55                   | 31             | 1F <sub>HEX</sub>  | 011111 <sub>BIN</sub> |
| 2.60                   | 32             | 20 <sub>HEX</sub>  | 100000 <sub>BIN</sub> |
| 2.65                   | 33             | 21 <sub>HEX</sub>  | 100001 <sub>BIN</sub> |
| 2.70                   | 34             | 22 <sub>HEX</sub>  | 100010 <sub>BIN</sub> |
| 2.75                   | 35             | 23 <sub>HEX</sub>  | 100011 <sub>BIN</sub> |
| 2.80                   | 36             | 24 <sub>HEX</sub>  | 100100 <sub>BIN</sub> |
| 2.85                   | 37             | 25 <sub>HEX</sub>  | 100101 <sub>BIN</sub> |
| 2.90                   | 38             | 26 <sub>HEX</sub>  | 100110 <sub>BIN</sub> |
| 2.95                   | 39             | 27 <sub>HEX</sub>  | 100111 <sub>BIN</sub> |
| 3.00                   | 40             | 28 <sub>HEX</sub>  | 101000 <sub>BIN</sub> |
| 3.05                   | 41             | 29 <sub>HEX</sub>  | 101001 <sub>BIN</sub> |
| 3.10                   | 42             | 2A <sub>HEX</sub>  | 101010 <sub>BIN</sub> |
| 3.15                   | 43             | 2B <sub>HEX</sub>  | 101011 <sub>BIN</sub> |
| 3.20                   | 44             | 2C <sub>HEX</sub>  | 101100 <sub>BIN</sub> |
| 3.25                   | 45             | 2D <sub>HEX</sub>  | 101101 <sub>BIN</sub> |
| 3.30                   | 46             | 2E <sub>HEX</sub>  | 101110 <sub>BIN</sub> |

| V <sub>OUT</sub> | Decimal | Hexadecimal       | Binary                |
|------------------|---------|-------------------|-----------------------|
| 3.35             | 47      | 2F <sub>HEX</sub> | 101111 <sub>BIN</sub> |
| 3.40             | 48      | 30 <sub>HEX</sub> | 110000 <sub>BIN</sub> |
| 3.45             | 49      | 31 <sub>HEX</sub> | 110001 <sub>BIN</sub> |
| 3.50             | 50      | 32 <sub>HEX</sub> | 110010 <sub>BIN</sub> |
| 3.55             | 51      | 33 <sub>HEX</sub> | 110011 <sub>BIN</sub> |
| 3.60             | 52      | 34 <sub>HEX</sub> | 110100 <sub>BIN</sub> |
| 3.65             | 53      | 35 <sub>HEX</sub> | 110101 <sub>BIN</sub> |
| 3.70             | 54      | 36 <sub>HEX</sub> | 110110 <sub>BIN</sub> |
| 3.75             | 55      | 37 <sub>HEX</sub> | 110111 <sub>BIN</sub> |

## 7.6 Linear Regulator LDO7

LDO7 is an always-on LDO, mainly for supplying the 1.8V rated GPIO[9:0] through the VGPI00 input, which supplies the DIF/DIO interfaces for DCD3 and DCD4, MODEM\_OFF\_B, SDWN\_B, PWRBTN\_B, and IRQ output buffers. The LDO can also be used for general purposes, as long as the total output current is limited to below 100mA.

LDO is enabled once the PMIC is enabled, and it remains enabled until the PMIC powers down to the G3 state.

**Table 29. Electrical Characteristics – LDO7**

V<sub>SYS</sub>= 5.0V, V<sub>OUT</sub> = 1.8V, C<sub>O</sub> = 1μF, T<sub>J</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at +25°C.

| Symbol                               | Parameter                     | Conditions   | Minimum | Typical | Maximum | Units |
|--------------------------------------|-------------------------------|--|---------|---------|---------|-------|
| V <sub>O</sub>                       | Output Voltage Range          |  | –       | 1.8     | –       | V     |
| I <sub>SHDN</sub>                    | Shutdown Current              |  | –       | 0.5     | –       | μA    |
| I <sub>Q</sub>                       | Quiescent Current             | No Load  | –       | 20      | –       | μA    |
|                                      | Regulation Voltage Accuracy   |  | -2      | –       | +2      | %     |
| ΔV <sub>OUT</sub> /ΔV <sub>IN</sub>  | Line Regulation               |  | –       | 1       | –       | ppm/V |
| ΔV <sub>OUT</sub> /ΔI <sub>OUT</sub> | Load Regulation               |  | –       | 40      | –       | μV/mA |
| I <sub>O</sub>                       | Maximum Output Current        |  | 100     | –       | –       | mA    |
| I <sub>LIM</sub>                     | Current Limit                 |  | 110     | –       | –       | mA    |
| V <sub>DROP</sub>                    | Dropout Voltage               | I <sub>O</sub> = 50mA  | –       | –       | 125     | mV    |
| PSRR                                 | Power Supply Ripple Rejection | V <sub>SYS</sub> – V <sub>O</sub> =1V, I <sub>O</sub> = 30mA |         |         |         | dB    |
|                                      |                               | < 200Hz  | –       | > 120   | –       |       |
|                                      |                               | 1kHz   | –       | 120     | –       |       |
|                                      |                               | 10kHz  | –       | 95      | –       |       |
|                                      |                               | 100kHz   | –       | 57      | –       |       |

| Symbol    | Parameter                   | Conditions   | Minimum | Typical | Maximum | Units      |
|-----------|-----------------------------|--|---------|---------|---------|------------|
| $e_n$     | Output Noise Voltage        | $V_o = 1.8V$ , $I_o = 100\mu A$ , Bandwidth = 10Hz to 100kHz | –       | 28      | –       | $\mu VRMS$ |
| $R_{DIS}$ | Output Discharge Resistance |  | –       | 10      |         | $k\Omega$  |
|           | LDO Soft-Start Ramp Rate    |  | –       | 32      | –       | $mV/\mu s$ |

## 7.7 LDO Current Limit Flags

Each linear regulator has a constant current limit behavior with a non-latching over-current flag. If the regulator's output current is above the maximum output current  $I_o$  limit, the flag asserts for the duration of the over-current condition and will de-assert when the current falls below the current limit threshold.

During start up, the maximum output current from the LDO regulator is controlled by the PMIC and gradually increased. After the voltage reaches its set point, the current specified in the "Electrical Characteristics" tables could be sourced (or sinked when LDO5 is used).

**Table 30. LDO Current Limit Flags**

| Register Name | R/W | D7      | D6      | D5      | D4      | D3      | D2      | D1      | D0      | Initial Value     | Address           |
|---------------|-----|---------|---------|---------|---------|---------|---------|---------|---------|-------------------|-------------------|
| LDOF1         | R   | LDO7_SC | LDO6_SC | LDO5_SC | LDO4_SC | LDO3_SC | LDO2_SC | LDO1_SC | LDO0_SC | 00 <sub>HEX</sub> | 9D <sub>HEX</sub> |

## 7.8 Switching Regulators for SoC Core, Graphics, and Memory Rails

DCD0, DCD1, and DCD2 are high-efficiency, synchronous step-down switching regulators capable of delivering up to 5A of peak current.

The output voltage (or boot voltage) can be individually set by OTP. It can be changed from the default setting either via I2C or SVID. The regulators support Dynamic Voltage Scaling (DVS) allowing on-the-fly, slew-rate controlled changes to the output voltage.

The regulators operate with a fixed 2.0MHz oscillator frequency allowing the use of small external components, minimizing cost and real estate. To maximize efficiency under varying load conditions, the regulators offer selectable modes of operation via I2C. Available modes are Forced PWM (FPWM) and Auto-Mode PWM/PFM. Auto-Mode PWM/PFM is selected by default and allows the regulator to switch automatically between PWM and PFM Mode, depending on the load condition. During heavy load, the regulator operates in PWM Mode at a fixed frequency. As the load decreases and the inductor valley current reaches zero, it automatically transitions into PFM Mode maintaining high efficiency under light load conditions. For noise-sensitive applications, the regulator can be forced into PWM Mode by disabling the Auto-Mode PWM/PFM.

The on/off control of the regulators can be accessed either through I2C or by toggling the appropriate SLP\_Sx\_B pins. Other features of the regulators include over-voltage protection, soft-start, and soft-start done flags.

The regulators include an active discharge circuitry to discharge the output capacitor and hold the output voltage at ground after the regulator has turned off.

SVID is the default interface for changing the output voltage setting. For applications not requiring SVID, the SVID interface can be deselected by OTP or via I2C.

The regulators are capable of supporting load currents greater than 5A by connecting additional phases (P9148) to the DIF interface. Each individual P9148 can deliver peak currents of up to 5A with up to four phases in parallel. The communication link between the converter and the P9148 is established by connecting the DCDx\_DIF and DCDx\_DIO pins to the corresponding pins of the P9148. The DIF and DIO interface is running IDT's proprietary communication protocol and controls the attached P9148. If additional phases are not required, the DIO and DIF pins can be used as regular GPIO pins or can be left floating. (Consult the P9148 datasheet for electrical characteristics and the product description.)

The power sequencing of each regulator can be changed by OTP trim. Contact IDT to change the timing and the power rail type.

## 7.9 Switching Regulator DCDO, DCD1

**Table 31. Electrical Characteristics – DCDO, DCD1**

$V_{IN\_DCD} = 5.0V$ ,  $V_o = 1.0V$  (default),  $L = 0.47\mu H$ ,  $C_{IN\_DCD} = 10\mu F$ ,  $C_o = 282\mu F$ ; no DPU (P9148).  $T_J = -40^{\circ}C$  to  $+125^{\circ}C$ , unless otherwise noted. Typical values are at  $+25^{\circ}C$ .

| Symbol                          | Parameter   | Conditions   | Minimum | Typical | Maximum | Units      |
|---------------------------------|---|--|---------|---------|---------|------------|
| $V_{IN\_DCD}$                   | Input Voltage Range   |  | 2.7     | 5.0     | 5.25    | V          |
| $V_o$                           | Output Voltage Range  | SVID enabled   | 0.250   | 1.000   | 1.295   | V          |
|                                 |   | SVID disabled  | 1.100   | –       | 1.890   | V          |
|                                 | Regulation Voltage Accuracy<br>(Set Point Accuracy)                   | $V_o = 0.7$ to $1.295V$                                    | -2.0    | –       | +2.0    | %          |
| $R_{LL(DC)}$                    | DC Load Line  |  | –       | 6       | –       | $m\Omega$  |
| $R_{LL(AC)}$                    | AC Load Line  |  | –       | 10      | –       | $m\Omega$  |
| $\Delta V_{OUT}/\Delta V_{IN}$  | Line Regulation   | $V_{IN\_DCD} = 2.75V$ to $5.25V$                           | –       | 0.03    | –       | %/V        |
| $\Delta V_{OUT}/\Delta I_{OUT}$ | Load Regulation   | $I_{OUT} = 0.5A$ to $4A$ , PWM Mode,<br>load line disabled | –       | 0.3     | –       | $mV/A$     |
| $V_{OFFSET}$                    | Offset Voltage in PFM Mode;<br>$V_{O(PFM)} = V_{O(PWM)} + V_{OFFSET}$ | PFM Mode   | –       | 15      | –       | $mV$       |
| $I_o$                           | Continuous Operating DC Current                                       | $T_J < 115^{\circ}C$ , GBD                                 | 4.0     | –       | –       | A          |
| $I_{PULSE}$                     | Pulsed Load Current   | $t_{Load} < 1ms.$  | –       | 5.0     | –       | A          |
| $I_{SHD(VIN\_DCD)}$             | Shutdown Current  | Regulator disabled   | –       | 1.0     | –       | $\mu A$    |
| $I_{VIN\_DCD}$                  | Power Stage Supply Current  | Forced PWM Mode, no load                                   | –       | 300     | –       | $\mu A$    |
|                                 |   | Forced PFM Mode, no switching                              | –       | 200     | –       | $\mu A$    |
| $R_{(DS)ON}$                    | High-Side Switch On Resistance  | $V_{SYS} = V_{IN\_DCD} = 5V$ , $I_{OUT} = 500mA$           | –       | 48      | 80      | $m\Omega$  |
|                                 | Low-Side Switch On Resistance   | $V_{SYS} = V_{IN\_DCD} = 5V$ , $I_{OUT} = 500mA$           | –       | 28      | 80      | $m\Omega$  |
| $R_{DIS}$                       | Output Discharge Resistance   |  | –       | 280     | 450     | $\Omega$   |
| $f_{SW}$                        | Switching Frequency   | PWM Mode, GBD  | 1.8     | 2.0     | 2.2     | MHz        |
| $t_{ON(MIN)}$                   | Minimum On-Time   |  | –       | 70      | –       | ns         |
| $t_{DCDSSR}$                    | DCD Soft-Start Ramp Rate  | 15% to 90% of $V_o$  | –       | 2.5     | –       | $mV/\mu s$ |
| $\Delta G_{SEN}$                | $G_{SEN}$ Pin Differential Voltage Range                              |  | –       | 250     | –       | $mV$       |
| $Z_{SEN}$                       | $G_{SEN}$ Pin Input Impedance   |  | –       | 1       | –       | $M\Omega$  |

| Symbol                          | Parameter                                   | Conditions    | Minimum | Typical | Maximum | Units |
|---------------------------------|---|---------------|---------|---------|---------|-------|
| I <sub>FB</sub>                 | FB Input Bias Current                       |               | –       | –       | 10      | µA    |
| V <sub>OVP</sub> <sup>[a]</sup> | Over-Voltage Protection Threshold           | SVID enabled  | –       | 1.8     | –       | V     |
|                                 |   | SVID disabled | –       | 2.4     | –       | V     |
|                                 | Over-Voltage Protection Threshold Tolerance | GBD           | -5.0    | –       | +5.0    | %     |

[a] An over-voltage fault response is to shut down the PMIC.

**Table 32. VBOOT Register – DCD0, DCD1**

Note: Green shading indicates that the register values are loaded from the OTP.

Note: At start-up, if VBOOT[7:1] = 00<sub>HEX</sub>, then VBOOT[0] = 0; otherwise VBOOT[0] = 1.

| Register Name | R/W | D7         | D6 | D5 | D4 | D3 | D2 | D1       | D0  | Initial Value     | Address |
|---------------|-----|------------|----|----|----|----|----|----------|-----|-------------------|---------|
| DCD0_VBOOT    | R/W | VBOOT[7:1] |    |    |    |    |    | VBOOT[0] | OTP | BC <sub>HEX</sub> |         |
| DCD1_VBOOT    | R/W | VBOOT[7:1] |    |    |    |    |    | VBOOT[0] | OTP | CC <sub>HEX</sub> |         |

| Bit    | Name       | Function  | Default |
|--------|------------|---|---------|
| D[7:0] | DCDx_VBOOT | VBOOT (refer to Table 46 and Table 47).<br><br>Note: At start-up, if VBOOT[7:1] = 0, then VBOOT[0] = 0; otherwise VBOOT[0] = 1. If VBOOT[7:1] ≠ 0, then VBOOT[0] together with VBOOT[7:1] will follow the SVID command voltage setting. | OTP     |

**Table 33. VID Register – DCD0, DCD1**

| Register Name | R/W | D7       | D6 | D5 | D4 | D3 | D2 | D1                | D0                | Initial Value | Address |
|---------------|-----|----------|----|----|----|----|----|-------------------|-------------------|---------------|---------|
| DCD0_VID      | R/W | VID[7:0] |    |    |    |    |    | 00 <sub>HEX</sub> | BE <sub>HEX</sub> |               |         |
| DCD1_VID      | R/W | VID[7:0] |    |    |    |    |    | 00 <sub>HEX</sub> | CE <sub>HEX</sub> |               |         |

| Bit    | Name     | Function                             | Default           |
|--------|----------|--------------------------------------|-------------------|
| D[7:0] | VID CODE | VID (refer to Table 46 and Table 47) | 00 <sub>HEX</sub> |

**Table 34. I2C Control Register – DCD0, DCD1**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7 | D6   | D5 | D4   | D3 | D2   | D1       | D0      | Initial Value | Address           |
|---------------|-----|----|------|----|------|----|------|----------|---------|---------------|-------------------|
| DCD0_CTL      | R/W |    | RSVD |    | SVID |    | RSVD | DCD0_SEL | DCD0_EN | OTP           | 53 <sub>HEX</sub> |
| DCD1_CTL      | R/W |    | RSVD |    | SVID |    | RSVD | DCD1_SEL | DCD1_EN | OTP           | 54 <sub>HEX</sub> |

| Bit    | Name     | Function   | Default            |
|--------|----------|--|--------------------|
| D[7:5] | RSVD     | Reserved   | 000 <sub>BIN</sub> |
| D[4]   | SVID     | SVID ON/OFF selection bit:<br>0 = SVID disabled.<br>1 = SVID enabled.  | OTP                |
| D[3:2] | RSVD     | Reserved   | 00 <sub>BIN</sub>  |
| D[1]   | DCDx_SEL | ON/OFF selection bit:<br>0 = ON/OFF is controlled by configured device sequence.<br>1 = ON/OFF is controlled by D[0] register. | 0 <sub>BIN</sub>   |
| D[0]   | DCDx_EN  | Enable bit:<br>0 = OFF<br>1 = ON   | 0 <sub>BIN</sub>   |

**Table 35. On/Off Selection Bit Table – DCD0, DCD1**

| D[1] | D[0] | Sequencer Control | DCD0 |
|------|------|-------------------|------|
| 0    | X    | SLP_x signal LOW  | OFF  |
| 0    | X    | SLP_x signal HIGH | ON   |
| 1    | 0    | X                 | OFF  |
| 1    | 1    | X                 | ON   |

**Table 36. I2C Output Voltage Register – DCD0, DCD1**

| Register Name | R/W | D7   | D6 | D5        | D4 | D3   | D2 | D1        | D0 | Initial Value     | Address           |
|---------------|-----|------|----|-----------|----|------|----|-----------|----|-------------------|-------------------|
| DCD0_SLEW     | R/W | RSVD |    | Fast_Rate |    | RSVD |    | Slow_Rate |    | 01 <sub>HEX</sub> | A8 <sub>HEX</sub> |
| DCD1_SLEW     | R/W | RSVD |    | Fast_Rate |    | RSVD |    | Slow_Rate |    | 01 <sub>HEX</sub> | A9 <sub>HEX</sub> |

| Bit    | Name      | Function   | Default           |
|--------|-----------|--|-------------------|
| D[7:6] | RSVD      | Reserved   | 00 <sub>BIN</sub> |
| D[5:4] | Fast_Rate | SetVID fast output voltage slew rate:<br>00 = 10mV/μs      10 = 40mV/μs<br>01 = 20mV/μs      11 = Reserved | 00 <sub>BIN</sub> |
| D[3:1] | RSVD      | Reserved   | 0 <sub>BIN</sub>  |
| D[0]   | Slow_Rate | SetVID slow output voltage slew rate:<br>0 = 2.5mV/μs<br>1 = 5mV/μs  | 1 <sub>BIN</sub>  |

**Table 37. I2C Sequencing Control – DCD0, DCD1**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6 | D5        | D4 | D3         | D2 | D1 | D0 | Initial Value | Address           |
|---------------|-----|------|----|-----------|----|------------|----|----|----|---------------|-------------------|
| DCD0_GRP      | R/W | RSVD |    | DCD0_TYPE |    | DCD0_GROUP |    |    |    | OTP           | E6 <sub>HEX</sub> |
| DCD1_GRP      | R/W | RSVD |    | DCD1_TYPE |    | DCD1_GROUP |    |    |    | OTP           | E7 <sub>HEX</sub> |

| Bit    | Name       | Function   | Default   |
|--------|------------|--|---|
| D[7:6] | RSVD       | Reserved   | 00 <sub>BIN</sub>   |
| D[5:4] | DCDx_TYPE  | Rail type selection bits:<br>00 <sub>BIN</sub> = "A" rail type.<br>01 <sub>BIN</sub> = "U" rail type.<br>10 <sub>BIN</sub> = "S" rail type.<br>11 <sub>BIN</sub> = "SX" rail type.   | OTP   |
| D[3:0] | DCDx_GROUP | Group Delay Bits   | OTP   |
|        |            | 0000 <sub>BIN</sub> = Group 0<br>0001 <sub>BIN</sub> = Group 1<br>0010 <sub>BIN</sub> = Group 2<br>0011 <sub>BIN</sub> = Group 3<br>0100 <sub>BIN</sub> = Group 4<br>0101 <sub>BIN</sub> = Group 5<br>0110 <sub>BIN</sub> = Group 6<br>0111 <sub>BIN</sub> = Group 7 | 1000 <sub>BIN</sub> = Group 8<br>1001 <sub>BIN</sub> = Group 9<br>1010 <sub>BIN</sub> = Group 10<br>1011 <sub>BIN</sub> = Group 11<br>1100 <sub>BIN</sub> = Group 12<br>1101 <sub>BIN</sub> = Group 13<br>1110 <sub>BIN</sub> = Group 14<br>1111 <sub>BIN</sub> = Disable |

**Table 38. I2C Core-Type Exit Control – DCD0, DCD1**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name  | R/W | D7   | D6 | D5 | D4 | D3 | D2 | D1             | D0             | Initial Value     | Address           |
|----------------|-----|------|----|----|----|----|----|----------------|----------------|-------------------|-------------------|
| CORE_TYPE_EXIT | R/W | RSVD |    |    |    |    |    | DCD1_TYPE_EXIT | DCD0_TYPE_EXIT | 00 <sub>HEX</sub> | 10 <sub>HEX</sub> |

| Bit    | Name           | Function   | Default               |
|--------|----------------|--|-----------------------|
| D[7:2] | RSVD           | Reserved   | 000000 <sub>BIN</sub> |
| D[1]   | DCD1_TYPE_EXIT | 0 = Exit sequence disabled. DCD1 follows I2C Sequencing Control for DCD1 in register E7 <sub>HEX</sub> .<br>1 = Exit sequence enabled. DCD1 is powered on as an “A” rail type (DCD1_TYPE = 00 <sub>BIN</sub> ) with the group delay set by DCD1_GRP[3:0]. It maintains an “A” Type (type 00 <sub>BIN</sub> ) until RSMRST_B and PLTRST_B are both asserted.<br><br>Once assertion of both signals is detected, the DCD_TYPE is changed to DCD1_TYPE[5:4], which is programmable via OTP. DCD1_TYPE[5:4] is then used for enabling and disabling DCD1 until the system is reset.    | 0 <sub>BIN</sub>      |
| D[0]   | DCD0_TYPE_EXIT | 0 = Exit sequence disabled. DCD0 follows I2C Sequencing Control for DCD0 in register E6 <sub>HEX</sub> .<br>1 = Exit sequence enabled. DCD0 is powered on as an “A” rail type (DCD0_TYPE = 00 <sub>BIN</sub> ) with the group delay set by DCD0_GRP[3:0]. It maintains an “A” Type (Type 00 <sub>BIN</sub> ) until RSMRST_B and PLTRST_B are both asserted.<br><br>Once assertion of both signals is detected, the DCD_TYPE is changed to DCD0_TYPE[5:4], which is programmable via OTP. DCD0_TYPE[5:4] is then used for enabling and disabling of DCD0 until the system is reset. | 0 <sub>BIN</sub>      |

## 7.10 Switching Regulator DCD2

**Table 39. Electrical Characteristics – DCD2**

$V_{IN\_DCD} = 5.0V$ ,  $V_O = 1.8V$  (default),  $L = 0.47\mu H$ ,  $C_{IN\_DCD} = 10\mu F$ ,  $C_O = 141\mu F$ ; no DPU (P9148).  $T_J = -40^\circ C$  to  $+125^\circ C$ , unless otherwise noted. Typical values are at  $+25^\circ C$ .

| Symbol                          | Parameter  | Conditions   | Minimum | Typical | Maximum | Units     |
|---------------------------------|--|--|---------|---------|---------|-----------|
| $V_{IN\_DCD}$                   | Input Voltage Range  |  | 2.7     | 5.0     | 5.25    | V         |
| $V_O$                           | Output Voltage Range   | SVID enabled   | 0.250   | 1.000   | 1.295   | V         |
|                                 |  | SVID disabled  | 1.100   | –       | 1.890   | V         |
|                                 | Regulation Voltage Accuracy<br>(Set Point Accuracy)                  | $V_O \geq 0.7V$  | -2.0    | –       | +2.0    | %         |
| $R_{LL(DC)}$                    | DC Load Line   |  | –       | 6       | –       | $m\Omega$ |
| $R_{LL(AC)}$                    | AC Load Line   |  | –       | 10      | –       | $m\Omega$ |
| $\Delta V_{OUT}/\Delta V_{IN}$  | Line Regulation  | $V_{IN\_DCD} = 2.75V$ to $5.25V$                           | –       | 0.03    | –       | %/V       |
| $\Delta V_{OUT}/\Delta I_{OUT}$ | Load Regulation  | $I_{OUT} = 0.5A$ to $4A$ , PWM Mode,<br>load line disabled | –       | 0.3     | –       | $mV/A$    |
| $V_{OFFSET}$                    | Offset Voltage in PFM Mode<br>$V_{O(PFM)} = V_{O(PWM)} + V_{OFFSET}$ | PFM Mode   | –       | 15      | –       | mV        |
| $I_O$                           | Continuous Operating DC Current                                      | $T_J < 115^\circ C$ , GBD                                  | 4.0     | –       | –       | A         |

| Symbol                    | Parameter                      | Conditions  | Minimum | Typical | Maximum | Units |
|---------------------------|--------------------------------|---|---------|---------|---------|-------|
| I <sub>PULSE</sub>        | Pulsed Load Current            | t <sub>Load</sub> < 1ms   | –       | 5.0     | –       | A     |
| I <sub>SHD(VIN_DCD)</sub> | Shutdown Current               | Regulator disabled  | –       | 1.0     | –       | µA    |
| I <sub>VIN_DCD</sub>      | Power Stage Supply Current     | Forced PWM Mode, no load  | –       | 300     | –       | µA    |
|                           |                                | Forced PFM Mode, no switching   | –       | 200     | –       | µA    |
| R <sub>(DSON)</sub>       | High-Side Switch On Resistance | V <sub>SYS</sub> = V <sub>IN_DCD</sub> = 5V, I <sub>OUT</sub> = 500mA | –       | 50      | 80      | mΩ    |
|                           | Low-Side Switch On Resistance  | V <sub>SYS</sub> = V <sub>IN_DCD</sub> = 5V, I <sub>OUT</sub> = 500mA | –       | 48      | 80      | mΩ    |
| R <sub>DIS</sub>          | Output Discharge Resistance    |   | –       | 280     | 450     | Ω     |
| f <sub>sw</sub>           | Switching Frequency            | PWM Mode, GBD   | 1.8     | 2.0     | 2.2     | MHz   |
| t <sub>ON(MIN)</sub>      | Minimum On-Time                |   | –       | 70      | –       | ns    |
| t <sub>DCDSSR</sub>       | DCD Soft-Start Ramp Rate       | 15% to 90% of V <sub>O</sub>  | –       | 3.5     | –       | mV/µs |
| I <sub>FB</sub>           | FB Input Bias Current          |   | –       | –       | 10      | µA    |

**Table 40. VBOOT Register – DCD2**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7         | D6 | D5 | D4 | D3 | D2 | D1       | D0  | Initial Value     | Address |
|---------------|-----|------------|----|----|----|----|----|----------|-----|-------------------|---------|
| DCD2_VBOOT    | R/W | VBOOT[7:1] |    |    |    |    |    | VBOOT[0] | OTP | DC <sub>HEX</sub> |         |

| Bit    | Name       | Function   | Default |
|--------|------------|--|---------|
| D[7:0] | DCD2_VBOOT | VBOOT (refer to Table 46 and Table 47)<br><br>Note: At start-up, if VBOOT[7:1] = 0, then VBOOT[0] = 0; otherwise VBOOT[0] = 1. If VBOOT[7:1] ≠ 0, then VBOOT[0] together with VBOOT[7:1] will follow the SVID command voltage setting. | OTP     |

**Table 41. VID Register – DCD2**

| Register Name | R/W | D7       | D6 | D5 | D4 | D3 | D2 | D1                | D0                | Initial Value | Address |
|---------------|-----|----------|----|----|----|----|----|-------------------|-------------------|---------------|---------|
| DCD2_VID      | R/W | VID[7:0] |    |    |    |    |    | 00 <sub>HEX</sub> | DE <sub>HEX</sub> |               |         |

| Bit    | Name     | Function                             | Default           |
|--------|----------|--------------------------------------|-------------------|
| D[7:0] | DCD2_VID | VID (refer to Table 46 and Table 47) | 00 <sub>HEX</sub> |

**Table 42. I2C Control Register – DCD2**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7 | D6   | D5 | D4   | D3 | D2   | D1       | D0      | Initial Value     | Address           |
|---------------|-----|----|------|----|------|----|------|----------|---------|-------------------|-------------------|
| DCD2_CTL      | R/W |    | RSVD |    | SVID |    | RSVD | DCD2_SEL | DCD2_EN | 00 <sub>HEX</sub> | 5F <sub>HEX</sub> |

| Bit    | Name     | Function   | Default            |
|--------|----------|--|--------------------|
| D[7:5] | RSVD     | Reserved   | 000 <sub>BIN</sub> |
| D[4]   | SVID     | SVID ON/OFF selection bit:<br>0 = SVID disabled.<br>1 = SVID enabled.  | 0 <sub>BIN</sub>   |
| D[3:2] | RSVD     | Reserved   | 00 <sub>BIN</sub>  |
| D[1]   | DCD2_SEL | ON/OFF selection bit:<br>0 = ON/OFF is controlled by the configured device sequence.<br>1 = ON/OFF is controlled by the D[0] register. | 0 <sub>BIN</sub>   |
| D[0]   | DCD2_EN  | Enable bit:<br>0 = OFF<br>1 = ON   | 0 <sub>BIN</sub>   |

**Table 43. On/Off Selection Bit Table – DCD2**

| D[1] | D[0] | Sequencer Control | DCD2 |
|------|------|-------------------|------|
| 0    | X    | SLP_x signal LOW  | OFF  |
| 0    | X    | SLP_x signal HIGH | ON   |
| 1    | 0    | X                 | OFF  |
| 1    | 1    | X                 | ON   |

**Table 44. I2C Output Voltage Register – DCD2**

| Register Name | R/W | D7   | D6 | D5        | D4 | D3   | D2 | D1        | D0                | Initial Value     | Address |
|---------------|-----|------|----|-----------|----|------|----|-----------|-------------------|-------------------|---------|
| DCD2_SLEW     | R/W | RSVD |    | Fast_Rate |    | RSVD |    | Slow_Rate | 01 <sub>HEX</sub> | AA <sub>HEX</sub> |         |

| Bit    | Name      | Function  | Default            |
|--------|-----------|---|--------------------|
| D[7:6] | RSVD      | Reserved  | 00 <sub>BIN</sub>  |
| D[5:4] | Fast_Rate | Fast output voltage slew rate:<br>00 = 10mV/μs<br>10 = 40mV/μs<br>01 = 20mV/μs<br>11 = Reserved | 00 <sub>BIN</sub>  |
| D[3:1] | RSVD      | Reserved  | 000 <sub>BIN</sub> |
| D[0]   | Slow_Rate | Slow output voltage slew rate:<br>0 = 2.5mV/μs<br>1 = 5mV/μs                                    | 1                  |

**Table 45. I2C Sequencing Control – DCD2**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6 | D5        | D4 | D3         | D2 | D1 | D0 | Initial Value | Address           |
|---------------|-----|------|----|-----------|----|------------|----|----|----|---------------|-------------------|
| DCD2_GRP      | R/W | RSVD |    | DCD2_TYPE |    | DCD2_GROUP |    |    |    | OTP           | E8 <sub>HEX</sub> |

| Bit    | Name       | Function   | Default   |
|--------|------------|--|---|
| D[7:6] | RSVD       | Reserved   | 00 <sub>BIN</sub>   |
| D[5:4] | DCD2_TYPE  | Rail type selection bits:<br>00 <sub>BIN</sub> = "A" rail type.<br>01 <sub>BIN</sub> = "U" rail type.<br>10 <sub>BIN</sub> = "S" rail type.<br>11 <sub>BIN</sub> = "SX" rail type.   | OTP   |
| D[3:0] | DCD2_GROUP | Group Delay Bits<br>0000 <sub>BIN</sub> = Group 0<br>0001 <sub>BIN</sub> = Group 1<br>0010 <sub>BIN</sub> = Group 2<br>0011 <sub>BIN</sub> = Group 3<br>0100 <sub>BIN</sub> = Group 4<br>0101 <sub>BIN</sub> = Group 5<br>0110 <sub>BIN</sub> = Group 6<br>0111 <sub>BIN</sub> = Group 7 | 1000 <sub>BIN</sub> = Group 8<br>1001 <sub>BIN</sub> = Group 9<br>1010 <sub>BIN</sub> = Group 10<br>1011 <sub>BIN</sub> = Group 11<br>1100 <sub>BIN</sub> = Group 12<br>1101 <sub>BIN</sub> = Group 13<br>1110 <sub>BIN</sub> = Group 14<br>1111 <sub>BIN</sub> = Disable |

**Table 46. Output Voltage Settings – DCD0/DCD1/DCD2, SVID Enabled**

| D7  | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Hexadecimal       | Voltage                    |
|-----|----|----|----|----|----|----|----|-------------------|----------------------------|
| 0   | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 00 <sub>HEX</sub> | OFF / 0.250 <sup>[a]</sup> |
| 0   | 0  | 0  | 0  | 0  | 0  | 0  | 1  | 01 <sub>HEX</sub> | 0.250                      |
| 0   | 0  | 0  | 0  | 0  | 0  | 1  | 0  | 02 <sub>HEX</sub> | 0.255                      |
| 0   | 0  | 0  | 0  | 0  | 0  | 1  | 1  | 03 <sub>HEX</sub> | 0.260                      |
| ... |    |    |    |    |    |    |    |                   |                            |
| 1   | 1  | 0  | 1  | 0  | 0  | 0  | 0  | D0 <sub>HEX</sub> | 1.285                      |
| 1   | 1  | 0  | 1  | 0  | 0  | 0  | 1  | D1 <sub>HEX</sub> | 1.290                      |
| 1   | 1  | 0  | 1  | 0  | 0  | 1  | 0  | D2 <sub>HEX</sub> | 1.295 <sup>[b]</sup>       |
| 1   | 1  | 0  | 1  | 0  | 0  | 1  | 1  | D3 <sub>HEX</sub> | 1.300 <sup>[b]</sup>       |

[a] If bit[1] = 1 in register 7B<sub>HEX</sub> (see Table 97), then the voltage is OFF; if bit[1] = 0, then the voltage is 0.250V. Register 7B<sub>HEX</sub> (VSLEEP) can be configured in OTP.

[b] Maximum default = 1.295V. To allow VID code D3<sub>HEX</sub> (1.30V), the *Vout max* register must be adjusted accordingly (see Table 121).

**Table 47. Output Voltage Settings – DCD0/DCD1/DCD2, SVID Disabled**

| D7  | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Hexadecimal       | Voltage |
|-----|----|----|----|----|----|----|----|-------------------|---------|
| 0   | 0  | 1  | 1  | 0  | 0  | 1  | 1  | 33 <sub>HEX</sub> | 1.100   |
| 0   | 0  | 1  | 1  | 0  | 1  | 0  | 0  | 34 <sub>HEX</sub> | 1.105   |
| 0   | 0  | 1  | 1  | 0  | 1  | 0  | 1  | 35 <sub>HEX</sub> | 1.110   |
| ... |    |    |    |    |    |    |    |                   |         |
| 1   | 1  | 0  | 1  | 0  | 0  | 0  | 0  | D0 <sub>HEX</sub> | 1.885   |
| 1   | 1  | 0  | 1  | 0  | 0  | 0  | 1  | D1 <sub>HEX</sub> | 1.890   |
| 1   | 1  | 0  | 1  | 0  | 0  | 1  | 0  | D2 <sub>HEX</sub> | 1.895   |
| 1   | 1  | 0  | 1  | 0  | 0  | 1  | 1  | D3 <sub>HEX</sub> | 1.900   |

## 7.11 Controllers DCD3, DCD4

DCD3 and DCD4 are step-down controllers and require at least one DPU (P9148) connected to the DIF bus. The regulators have no power stage in the PMIC. The PMIC provides only the control and analog circuitry for the regulators and relies on the external DPU to provide power to the load.

The output voltage is factory set to a default value, but it can be changed from the default setting via I<sub>2</sub>C. (See Table 53 for available voltages.)

The regulators operate with a fixed 2MHz oscillator frequency allowing the use of small external components, minimizing cost and real estate. The mode of operation supported by DCD3/4 is Forced PWM (FPWM) with a maximum output voltage of 3.6V. If power saving is needed, it is recommended to configure the rails for sleep mode (SLP\_) or disabling. The on/off control of DCD3 and DCD4 can be accessed through I<sub>2</sub>C or it will be managed by the programmed sequence.

The controllers must be used in conjunction with P9148s. The communication link between the P91E0 and P9148 is established by connecting the DCD3\_DIF/DCD4\_DIF and DCD3\_DIO/DCD4\_DIO pins to the corresponding pins of the P9148. For each additional phase, the P9148 can deliver peak currents of 5A supporting up to four phases connected in parallel. If the regulators are not used, the DIO and DIF pins can be left floating. (Consult the P9148 datasheet for electrical characteristics and product description.)

**Table 48. Electrical Characteristics – DCD3, DCD4**

V<sub>sys</sub> = 5.0V, V<sub>O</sub> = 3.3V<sub>DCD3</sub>, V<sub>O</sub> = 1.8V<sub>DCD4</sub> (default), T<sub>J</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at +25°C.

Note: DCD3, DCD4 must be used in conjunction with the P9148.

| Symbol                               | Parameter   | Conditions   | Minimum | Typical | Maximum | Units |
|--------------------------------------|---|--|---------|---------|---------|-------|
| V <sub>O</sub>                       | Output Voltage Range  |  | 0.525   | –       | 3.6     | V     |
|                                      | Regulation Voltage Accuracy<br>(set point accuracy)   | For factory programmed V <sub>O</sub> ,<br>test mode | -2.0    | –       | +2.0    | %     |
| ΔV <sub>OUT</sub> /ΔV <sub>IN</sub>  | Line Regulation   | V <sub>IN_P9148</sub> = 4.5V to 8.4V                 | –       | 0.03    | –       | %/V   |
| ΔV <sub>OUT</sub> /ΔI <sub>OUT</sub> | Load Regulation   | I <sub>OUT</sub> = 0.5A to 4A, PWM Mode              | –       | 0.3     | –       | mV/A  |
|                                      | Offset Voltage in PFM Mode<br>V <sub>O(PFM)</sub> = V <sub>O(PWM)</sub> + V <sub>offset</sub> | PFM Mode   | –       | 15      | –       | mV    |
| F <sub>SW</sub>                      | Switching Frequency   | PWM Mode, GBD  | 1.8     | 2.0     | 2.2     | MHz   |
| t <sub>DCDSSR</sub>                  | DCD Soft-Start Ramp Rate  | 15% to 90% of V <sub>O</sub>                         | –       | 2.5     | –       | mV/μs |
| I <sub>FB</sub>                      | Feedback Input Bias Current   | GBD  | –       | –       | 9       | μA    |

**Table 49. I2C Control Register – DCD3, DCD4**

| Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1   | D0       | Initial Value | Address           |
|---------------|-----|----|----|----|----|----|----|------|----------|---------------|-------------------|
| DCD3_CTL      | R/W |    |    |    |    |    |    | RSVD | DCD3_SEL | DCD3_EN       | 00 <sub>HEX</sub> |
| DCD4_CTL      | R/W |    |    |    |    |    |    | RSVD | DCD4_SEL | DCD4_EN       | 00 <sub>HEX</sub> |

| Bit    | Name     | Function   | Default               |
|--------|----------|--|-----------------------|
| D[7:2] | RSVD     | Reserved   | 000000 <sub>BIN</sub> |
| D[1]   | DCDx_SEL | ON/OFF selection bit:<br>0 = ON/OFF is controlled by configured device sequence.<br>1 = ON/OFF is controlled by the D[0] bit of this register. | 0                     |
| D[0]   | DCDx_EN  | Enable bit:<br>0 = OFF<br>1 = ON   | 0                     |

**Table 50. On/Off Selection Bit Table – DCD[3/4]**

| D[1] | D[0] | Sequencer Control | DCD[3/4] |
|------|------|-------------------|----------|
| 0    | X    | SLP_x signal LOW  | OFF      |
| 0    | X    | SLP_x signal HIGH | ON       |
| 1    | 0    | X                 | OFF      |
| 1    | 1    | X                 | ON       |

**Table 51. I2C Output Voltage Setting – DCD3, DCD4**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Initial Value | Address           |
|---------------|-----|----|----|----|----|----|----|----|----|---------------|-------------------|
| DCD3_VOUT     | R/W |    |    |    |    |    |    |    |    | OTP           | A4 <sub>HEX</sub> |
| DCD4_VOUT     | R/W |    |    |    |    |    |    |    |    | OTP           | A5 <sub>HEX</sub> |

| Bit    | Name      | Function   | Default |
|--------|-----------|--|---------|
| D[7:6] | DCDx_RNG  | Output voltage range selection bits:<br>00 <sub>BIN</sub> = 0.5250 to 1.3125 increment of 12.5mV.<br>01 <sub>BIN</sub> = 1.2875 to 2.0750 increment of 12.5mV.<br>10 <sub>BIN</sub> = 2.0500 to 2.8375 increment of 12.5mV.<br>11 <sub>BIN</sub> = 2.8125 to 3.6000 increment of 12.5mV. | OTP     |
| D[5:0] | DCDx_VOUT | DCD3, DCD4 output voltage setting (see Table 53).  | OTP     |

**Table 52. I2C Sequencing Control – DCD3, DCD4**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6 | D5        | D4 | D3         | D2 | D1 | D0 | Initial Value | Address           |
|---------------|-----|------|----|-----------|----|------------|----|----|----|---------------|-------------------|
| DCD3_GRP      | R/W | RSVD |    | DCD3_TYPE |    | DCD3_GROUP |    |    |    | OTP           | E9 <sub>HEX</sub> |
| DCD4_GRP      | R/W | RSVD |    | DCD4_TYPE |    | DCD4_GROUP |    |    |    | OTP           | EA <sub>HEX</sub> |

| Bit    | Name       | Function  |  | Default           |
|--------|------------|---|--|-------------------|
| D[7:6] | RSVD       | Reserved  |  | 00 <sub>BIN</sub> |
| D[5:4] | DCDx_TYPE  | Rail type selection bits:<br>00 <sub>BIN</sub> = "A" rail type.<br>01 <sub>BIN</sub> = "U" rail type.<br>10 <sub>BIN</sub> = "S" rail type.<br>11 <sub>BIN</sub> = "SX" rail type.  |  | OTP               |
| D[3:0] | DCDx_GROUP | Group Delay Bits<br>0000 <sub>BIN</sub> = Group 0<br>0001 <sub>BIN</sub> = Group 1<br>0010 <sub>BIN</sub> = Group 2<br>0011 <sub>BIN</sub> = Group 3<br>0100 <sub>BIN</sub> = Group 4<br>0101 <sub>BIN</sub> = Group 5<br>0110 <sub>BIN</sub> = Group 6<br>0111 <sub>BIN</sub> = Group 7<br><br>1000 <sub>BIN</sub> = Group 8<br>1001 <sub>BIN</sub> = Group 9<br>1010 <sub>BIN</sub> = Group 10<br>1011 <sub>BIN</sub> = Group 11<br>1100 <sub>BIN</sub> = Group 12<br>1101 <sub>BIN</sub> = Group 13<br>1110 <sub>BIN</sub> = Group 14<br>1111 <sub>BIN</sub> = Disable |  | OTP               |

**Table 53. Output Voltage Setting – DCD3, DCD4**

| Range [00] | Range [01] | Range [10] | Range [11] | Decimal | Hexadecimal       | Binary                |
|------------|------------|------------|------------|---------|-------------------|-----------------------|
| 0.5250     | 1.2875     | 2.0500     | 2.8125     | 0       | 00 <sub>HEX</sub> | 000000 <sub>BIN</sub> |
| 0.5375     | 1.3000     | 2.0625     | 2.8250     | 1       | 01 <sub>HEX</sub> | 000001 <sub>BIN</sub> |
| 0.5500     | 1.3125     | 2.0750     | 2.8375     | 2       | 02 <sub>HEX</sub> | 000010 <sub>BIN</sub> |
| ...        |            |            |            |         |                   |                       |
| 1.2875     | 2.0500     | 2.8125     | 3.5750     | 61      | 3D <sub>HEX</sub> | 111101 <sub>BIN</sub> |
| 1.3000     | 2.0625     | 2.8250     | 3.5875     | 62      | 3E <sub>HEX</sub> | 111110 <sub>BIN</sub> |
| 1.3125     | 2.0750     | 2.8375     | 3.6000     | 63      | 3F <sub>HEX</sub> | 111111 <sub>BIN</sub> |

## 7.12 Switching Regulator DCD5, DCD6

DCD5 and DCD6 are high efficiency, synchronous step-down switching regulators capable of delivering up to 2.3A of current.

The regulators operate with a fixed 2.0MHz oscillator frequency allowing the use of small external components, minimizing cost and real estate. To maximize efficiency under varying load conditions, the converter offers selectable modes of operation via I2C. Available modes are Forced PWM (FPWM) and Auto-Mode PWM/PFM. When Auto-Mode PWM/PFM is selected, the regulator switches automatically between PWM and PFM Mode, depending on the load condition. During heavy load conditions, the regulator operates in PWM Mode at a fixed frequency. As the load decreases and the inductor valley current reaches zero, it automatically transitions into PFM Mode maintaining high efficiency under light load conditions. For noise-sensitive applications, the regulator can be forced into PWM Mode by disabling the power-saving PFM Mode. The default mode is set to Auto-Mode PWM/PFM.

The on/off control of DCD5 and DCD6 can be accessed either via I2C, or it will be managed by the programmed sequence.

The regulator includes an active discharge circuitry to discharge the output capacitor and hold the output voltage at ground after the regulator powers off.

**Table 54. Electrical Characteristics – DCD5, DCD6**

Conditions unless otherwise specified:  $V_{IN\_DCD} = 5.0V$ ,  $V_o = 1.05V$  (default),  $L = 1.0\mu H$ ,  $C_{IN\_DCD} = 10\mu F$ ,  $C_O = 94\mu F$ .  $T_J = -40^{\circ}C$  to  $+125^{\circ}C$ , unless otherwise noted. Typical values are at  $+25^{\circ}C$ .

| Symbol                            | Parameter  | Conditions   | Minimum | Typical | Maximum | Units      |
|-----------------------------------|--|--|---------|---------|---------|------------|
| $V_{IN\_DCD}$                     | Input Voltage Range  | $V_o < 1.8V$ for $V_{IN\_DCD} < 3.0V$<br>$V_o > 0.6V$ for $V_{IN\_DCD} > 5.0V$ | 2.70    | 5.0     | 5.25    | V          |
| $V_o$                             | Output Voltage Range   |  | 0.525   | 1.05    | 3.3375  | V          |
|                                   | Regulation Voltage Accuracy  | For factory programmed $V_o$   | -2.0    | -       | +2.0    | %          |
| $\Delta V_{OUT} / \Delta V_{IN}$  | Line Regulation  | $V_{IN\_DCD} = 2.75V$ to $5V$  | -       | 0.03    | -       | %/V        |
| $\Delta V_{OUT} / \Delta I_{OUT}$ | Load Regulation  | $I_{OUT} = 0.5$ to $2A$ , PWM Mode   | -       | 0.3     | -       | mV/A       |
|                                   | Offset Voltage in PFM Mode<br>$V_{O(PFM)} = V_{O(PWM)} + V_{offset}$ | PFM Mode   | -       | 15      | -       | mV         |
| $I_o$                             | Maximum Output Current   | GBD  | 2.0     | -       | -       | A          |
| $I_{PULSE}$                       | Pulsed Load Current  | $t_{load} < 1ms$   | -       | 2.3     | -       | A          |
| $I_{SHD}$                         | Shutdown Current   |  | -       | 1.0     | -       | $\mu A$    |
| $I_{VIN\_DCD}$                    | Power Stage Supply Current   | Forced PWM Mode, no load   | -       | 150     | -       | $\mu A$    |
|                                   |  | Forced PFM Mode, no switching  | -       | 65      | -       | $\mu A$    |
| $R_{(DSON)}$                      | High Side Switch   | $V_{SYS} = V_{IN\_DCD} = 5V$ ; $I_{OUT} = 100mA$                               | -       | 110     | 160     | $m\Omega$  |
|                                   | Low Side Switch  | $V_{SYS} = V_{IN\_DCD} = 5V$ ; $I_{OUT} = 100mA$                               | -       | 57      | 85      | $m\Omega$  |
| $R_{DIS}$                         | Output Discharge Resistance  |  | -       | 850     | 1100    | $\Omega$   |
| $f_{sw}$                          | Switching Frequency  | PWM Mode, GBD  | 1.8     | 2.0     | 2.2     | MHz        |
| $t_{ON(MIN)}$                     | Minimum On-Time  |  | -       | 70      | -       | ns         |
| $t_{DCDSSR}$                      | DCD Soft-Start Ramp Rate   | 15% to 90% of $V_o$  | -       | 2.5     | -       | $mV/\mu s$ |
| $I_{FB}$                          | Feedback Input Bias Current for DCD5 and DCD6.                       |  | -       | 2.0     | -       | $\mu A$    |

**Table 55. DCD5, DCD6 Control Register**

| Register Name | R/W | D7   | D6 | D5 | D4 | D3 | D2 | D1       | D0      | Initial Value     | Address           |
|---------------|-----|------|----|----|----|----|----|----------|---------|-------------------|-------------------|
| DCD5_CTL      | R/W | RSVD |    |    |    |    |    | DCD5_SEL | DCD5_EN | 00 <sub>HEX</sub> | 59 <sub>HEX</sub> |
| DCD6_CTL      | R/W | RSVD |    |    |    |    |    | DCD6_SEL | DCD6_EN | 00 <sub>HEX</sub> | 55 <sub>HEX</sub> |

| Bit    | Name     | Function   | Default               |
|--------|----------|--|-----------------------|
| D[7:2] | RSVD     | Reserved   | 000000 <sub>BIN</sub> |
| D[1]   | DCDx_SEL | ON/OFF selection bit:<br>0 = ON/OFF is controlled by configured device sequence.<br>1 = ON/OFF is controlled by the D[0] bit of this register. | 0 <sub>BIN</sub>      |
| D[0]   | DCDx_EN  | Enable bit:<br>0 = OFF<br>1 = ON   | 0 <sub>BIN</sub>      |

**Table 56. On/Off Selection Bit Table**

| D[1] | D[0] | Sequencer Control | DCDx |
|------|------|-------------------|------|
| 0    | X    | SLP_x signal LOW  | OFF  |
| 0    | X    | SLP_x signal HIGH | ON   |
| 1    | 0    | X                 | OFF  |
| 1    | 1    | X                 | ON   |

**Table 57. I2C Output Voltage Setting**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7       | D6 | D5 | D4 | D3 | D2 | D1        | D0 | Initial Value | Address |
|---------------|-----|----------|----|----|----|----|----|-----------|----|---------------|---------|
| DCD5_VOUT     | R/W | DCD5_RNG |    |    |    |    |    | DCD5_VOUT |    |               | OTP     |
| DCD6_VOUT     | R/W | DCD6_RNG |    |    |    |    |    | DCD6_VOUT |    |               | OTP     |

| Bit    | Name      | Function   | Default |
|--------|-----------|--|---------|
| D[7:6] | DCDx_RNG  | Output voltage range selection bits:<br>00 <sub>BIN</sub> = 0.5250 to 1.3125 increment of 12.5mV [default].<br>01 <sub>BIN</sub> = 1.2000 to 1.9875 increment of 12.5mV.<br>10 <sub>BIN</sub> = 1.8750 to 2.6625 increment of 12.5mV.<br>11 <sub>BIN</sub> = 2.5500 to 3.3375 increment of 12.5mV. | OTP     |
| D[5:0] | DCDx_VOUT | Output voltage setting (see Table 58).   | OTP     |

**Table 58. Output Voltage Setting – DCD5, DCD6**

| Range [00] | Range [01] | Range [10] | Range [11] | Decimal | Hexadecimal       | Binary                |
|------------|------------|------------|------------|---------|-------------------|-----------------------|
| 0.5250     | 1.2000     | 1.8750     | 2.5500     | 0       | 00 <sub>HEX</sub> | 000000 <sub>BIN</sub> |
| 0.5375     | 1.2125     | 1.8875     | 2.5625     | 1       | 01 <sub>HEX</sub> | 000001 <sub>BIN</sub> |
| 0.5500     | 1.2250     | 1.9000     | 2.5750     | 2       | 02 <sub>HEX</sub> | 000010 <sub>BIN</sub> |
| ...        |            |            |            |         |                   |                       |
| 1.2875     | 1.9625     | 2.6375     | 3.3125     | 61      | 3D <sub>HEX</sub> | 111101 <sub>BIN</sub> |
| 1.3000     | 1.9750     | 2.6500     | 3.3250     | 62      | 3E <sub>HEX</sub> | 111110 <sub>BIN</sub> |
| 1.3125     | 1.9875     | 2.6625     | 3.3375     | 63      | 3F <sub>HEX</sub> | 111111 <sub>BIN</sub> |

**Table 59. I2C Sequencing Control – DCD5, DCD6**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6 | D5        | D4 | D3         | D2 | D1 | D0 | Initial Value | Address           |
|---------------|-----|------|----|-----------|----|------------|----|----|----|---------------|-------------------|
| DCD5_GRP      | R/W | RSVD |    | DCD5_TYPE |    | DCD5_GROUP |    |    |    | OTP           | EB <sub>HEX</sub> |
| DCD6_GRP      | R/W | RSVD |    | DCD6_TYPE |    | DCD6_GROUP |    |    |    | OTP           | EC <sub>HEX</sub> |

| Bit    | Name       | Function   |  |  |  |   |  |  |  | Default           |
|--------|------------|--|--|--|--|---|--|--|--|-------------------|
| D[7:6] | RSVD       | Reserved   |  |  |  |   |  |  |  | 00 <sub>BIN</sub> |
| D[5:4] | DCDx_TYPE  | Rail type selection bits:<br>00 <sub>BIN</sub> = "A" rail type.<br>01 <sub>BIN</sub> = "U" rail type.<br>10 <sub>BIN</sub> = "S" rail type.<br>11 <sub>BIN</sub> = "SX" rail type.   |  |  |  |   |  |  |  | OTP               |
| D[3:0] | DCDx_GROUP | Group Delay Bits   |  |  |  |   |  |  |  | OTP               |
|        |            | 0000 <sub>BIN</sub> = Group 0<br>0001 <sub>BIN</sub> = Group 1<br>0010 <sub>BIN</sub> = Group 2<br>0011 <sub>BIN</sub> = Group 3<br>0100 <sub>BIN</sub> = Group 4<br>0101 <sub>BIN</sub> = Group 5<br>0110 <sub>BIN</sub> = Group 6<br>0111 <sub>BIN</sub> = Group 7 |  |  |  | 1000 <sub>BIN</sub> = Group 8<br>1001 <sub>BIN</sub> = Group 9<br>1010 <sub>BIN</sub> = Group 10<br>1011 <sub>BIN</sub> = Group 11<br>1100 <sub>BIN</sub> = Group 12<br>1101 <sub>BIN</sub> = Group 13<br>1110 <sub>BIN</sub> = Group 14<br>1111 <sub>BIN</sub> = Disable |  |  |  |                   |

## 7.13 General Registers for DCDs

### 7.13.1 Forcing PWM Mode for DCDx

DCDs regulators and controllers can be independently forced into the PWM Mode (FPWM Mode) by setting the corresponding bit of the *FPWM* register ( $AD_{HEX}$ ; see Table 60) to 1 via I<sup>2</sup>C communication. Note that in OTP, whichever settings are written to the *FPWM* register's bits D[3] (sets the mode for the DCD3 regulator) and D[5] (sets DCD5) are automatically replicated in D[4] (sets DCD4) and D[6] (sets DCD6) respectively; however, each setting can be changed independently via I<sup>2</sup>C after the OTP is loaded. Refer to section 7.11 for modes of operation supported by DCD3 and DCD4.

**Table 60. Forced PWM Register – DCD0 through DCD6**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6                       | D5        | D4                       | D3        | D2        | D1        | D0        | Initial Value | Address    |
|---------------|-----|------|--------------------------|-----------|--------------------------|-----------|-----------|-----------|-----------|---------------|------------|
| FPWM          | R/W | RSVD | DCD6_FPWM <sup>[a]</sup> | DCD5_FPWM | DCD4_FPWM <sup>[b]</sup> | DCD3_FPWM | DCD2_FPWM | DCD1 FPWM | DCD0_FPWM | OTP           | $AD_{HEX}$ |

[a] This bit is loaded from OTP with the same value as bit DCD5\_FPWM. Then it can be changed via I<sup>2</sup>C to a different value.

[b] This bit is loaded from OTP with the same value as bit DCD3\_FPWM. Then it can be changed via I<sup>2</sup>C to a different value.

| Bit    | Name      | Function   | Default          |
|--------|-----------|--|------------------|
| D[7]   | RSVD      | Reserved   | 0 <sub>BIN</sub> |
| D[6:0] | DCDx_FPWM | Selection bits for Auto PFM/PWM Mode or FPWM Mode:<br>0 = Auto PFM/PWM.<br>1 = FPWM. | OTP              |

### 7.13.2 DC Load-Line Control

**Table 61. DC Load-Line Control**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7 | D6   | D5 | D4 | D3 | D2     | D1     | D0     | Initial Value     | Address           |
|---------------|-----|----|------|----|----|----|--------|--------|--------|-------------------|-------------------|
| DCLL_CTL      | R/W |    | RSVD |    |    |    | DCLL_2 | DCLL_1 | DCLL_0 | 03 <sub>HEX</sub> | 1F <sub>HEX</sub> |

| Bit    | Name     | Function  | Default              |
|--------|----------|---|----------------------|
| D[7:3] | RSVD     | Reserved  | 00000 <sub>BIN</sub> |
| D[2:0] | DCLL_[X] | 0 = Disable DC load line for DCD[X].<br>1 = Enable DC load line for DCD[X]. | 011 <sub>BIN</sub>   |

### 7.13.3 AC Load-Line Control

**Table 62. AC Load-Line Control**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7 | D6   | D5 | D4 | D3 | D2        | D1        | D0        | Initial Value     | Address           |
|---------------|-----|----|------|----|----|----|-----------|-----------|-----------|-------------------|-------------------|
| ACLL_CTL      | R/W |    | RSVD |    |    |    | ACLL_DCD2 | ACLL_DCD1 | ACLL_DCD0 | 03 <sub>HEX</sub> | 25 <sub>HEX</sub> |

| Bit    | Name   | Function  | Default              |
|--------|--------|---|----------------------|
| D[7:3] | RSVD   | Reserved  | 00000 <sub>BIN</sub> |
| D[2:0] | ACLL_x | 0 = Disable AC load line for DCD[X]<br>1 = Enable AC load line for DCD[X] | 011 <sub>BIN</sub>   |

### 7.13.4 DCD Rail Select for DRAMPWROK Monitor

**Table 63. DCD Rail Select for DRAMPWROK Monitor**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7 | D6   | D5 | D4 | D3 | D2           | D1 | D0 | Initial Value     | Address           |
|---------------|-----|----|------|----|----|----|--------------|----|----|-------------------|-------------------|
| DRAMPWROK     | R/W |    | RSVD |    |    |    | DCD_SEL[2:0] |    |    | 02 <sub>HEX</sub> | 7C <sub>HEX</sub> |

| Bit    | Name         | Function   | Default              |
|--------|--------------|--|----------------------|
| D[7:3] | RSVD         | Reserved   | 00000 <sub>BIN</sub> |
| D[2:0] | DCD_SEL[2:0] | Select DCD rail for which DRAMPWROK monitors the voltage:<br>000 = DCD0<br>001 = DCD1<br>010 = DCD2<br>011 = DCD3<br>100 = DCD4<br>101 = DCD5<br>110 = DCD6<br>111 = OFF; DRAMPWROK always stays LOW | 010 <sub>BIN</sub>   |

### 7.13.5 DCDx Internal Soft-Start Complete Status

**Table 64. DCD Internal Soft-Start Complete Status**

| Register Name | R/W | D7   | D6      | D5      | D4      | D3      | D2      | D1      | D0      | Initial Value     | Address           |
|---------------|-----|------|---------|---------|---------|---------|---------|---------|---------|-------------------|-------------------|
| DCD_PG        | R   | RSVD | DCD6_PG | DCD5_PG | DCD4_PG | DCD3_PG | DCD2_PG | DCD1_PG | DCD0_PG | 00 <sub>HEX</sub> | 8F <sub>HEX</sub> |

| Bit    | Name      | Function  | Default                |
|--------|-----------|---|------------------------|
| D[7]   | RSVD      | Reserved  | 0                      |
| D[6:0] | DCD[X]_PG | 0 = Internal soft-start of DCD[x] has not been completed or DCD[x] is disabled.<br>1 = Internal soft-start of DCD[x] is complete. | 0000000 <sub>BIN</sub> |

### 7.13.6 DPS\_IDLE\_CFG Operation

To decrease power consumption in light current load conditions, operate in the Auto PFM/PWM Mode (Idle Mode). For example, to set DCD2 in Auto PFM/PWM Mode, with or without DPUs connected, set bit[2] = 1<sub>BIN</sub> in the *DPS\_IDLE\_CFG* register (7A<sub>HEX</sub>), and set bit [2] = 0<sub>BIN</sub> in the *FPWM* register (AD<sub>HEX</sub>); see tables below.

To control the switching noise at a single frequency, operate in the Forced PWM Mode (FPWM). For example, for DCD2 with or without DPUs connected, set bit[2] = 1<sub>BIN</sub> in the *FPWM* register; see tables below.

**Table 65. DPS\_IDLE\_CFG Operation with DPU**

| DCD[X]_FPWM Bit in FPWM Register (AD <sub>HEX</sub> ) | EN_PS_IDLEx Bit in DPS_IDLE_CFG Register (7A <sub>HEX</sub> ) |   |
|---|---|---|
|   | 0 <sub>BIN</sub> = Idle Mode Disable (FPWM Mode)              | 1 <sub>BIN</sub> = Idle Mode Enable (Auto PFM/PWM Mode) |
| 0 <sub>BIN</sub> = Auto PFM/PWM Mode                  | FPWM  | Auto PFM/PWM  |
| 1 <sub>BIN</sub> = FPWM Mode                          | FPWM  | FPWM  |

**Table 66. DPS\_IDLE\_CFG Operation with No DPU**

| DCD[X]_FPWM Bit in FPWM Register (AD <sub>HEX</sub> ) | EN_PS_IDLEx Bit in DPS_IDLE_CFG Register (7A <sub>HEX</sub> ) |   |
|---|---|---|
|   | 0 <sub>BIN</sub> = Idle Mode Disable (FPWM Mode)              | 1 <sub>BIN</sub> = Idle Mode Enable (Auto PFM/PWM Mode) |
| 0 <sub>BIN</sub> = Auto PFM/PWM Mode                  | Auto PFM/PWM  | Auto PFM/PWM  |
| 1 <sub>BIN</sub> = FPWM Mode                          | FPWM  | FPWM  |

When phase shedding is enabled/disabled, the tables below explain the operation of DCD regulator. See Table 71, Table 72, and Table 73 for phase shedding settings.

**Table 67. Disable Phase Shedding – Example for DCD2: DPS2\_CONFIG Register (1B<sub>HEX</sub>) Bits[1:0] = 11<sub>BIN</sub>**

| DCD[X]_FPWM Bit in FPWM Register (AD <sub>HEX</sub> ) | EN_PS_IDLEx Bit in DPS_IDLE_CFG Register (7A <sub>HEX</sub> ) |   |
|---|---|---|
|   | 0 <sub>BIN</sub> = Idle Mode Disable (FPWM Mode)              | 1 <sub>BIN</sub> = Idle Mode Enable (Auto PFM/PWM Mode) |
| 0 <sub>BIN</sub> = Auto PFM/PWM Mode                  | FPWM  | FPWM  |
| 1 <sub>BIN</sub> = FPWM Mode                          | FPWM  | FPWM  |

**Table 68. Enable Phase Shedding – Example DCD2: DPS2\_CONFIG (1B<sub>HEX</sub>) Bits[1:0] = 00<sub>BIN</sub>, 01<sub>BIN</sub>, or 10<sub>BIN</sub>**

| DCD[X]_FPWM Bit in FPWM Register (AD <sub>HEX</sub> ) | EN_PS_IDLEx Bit in DPS_IDLE_CFG Register (7A <sub>HEX</sub> ) |   |
|---|---|---|
|   | 0 <sub>BIN</sub> = Idle Mode Disable (FPWM Mode)              | 1 <sub>BIN</sub> = Idle Mode Enable (Auto PFM/PWM Mode) |
| 0 <sub>BIN</sub> = Auto PFM/PWM Mode                  | FPWM  | Auto PFM/PWM  |
| 1 <sub>BIN</sub> = FPWM Mode                          | FPWM  | FPWM  |

**Table 69. DPS\_IDLE\_CFG Register**

Note: Idle means operation in Auto PFM/PWM.

| Register Name | R/W | D7 | D6 | D5   | D4 | D3 | D2          | D1          | D0          | Initial Value     | Address           |
|---------------|-----|----|----|------|----|----|-------------|-------------|-------------|-------------------|-------------------|
| DPS_IDLE_CFG  | R/W |    |    | RSVD |    |    | EN_PS_IDLE2 | EN_PS_IDLE1 | EN_PS_IDLE0 | 00 <sub>HEX</sub> | 7A <sub>HEX</sub> |

| Bit    | Name        | Function   | Default              |
|--------|-------------|--|----------------------|
| D[7:3] | RSVD        | Reserved   | 00000 <sub>BIN</sub> |
| D[2]   | EN_PS_IDLE2 | Set Idle Mode for DCD2:<br>0 = Idle Mode Disable (FPWM).<br>1 = Idle Mode Enable (Auto PFM/PWM). | 0 <sub>BIN</sub>     |
| D[1]   | EN_PS_IDLE1 | Set Idle Mode for DCD1:<br>0 = Idle Mode Disable (FPWM).<br>1 = Idle Mode Enable (Auto PFM/PWM). | 0 <sub>BIN</sub>     |
| D[0]   | EN_PS_IDLE0 | Set Idle Mode for DCD0:<br>0 = Idle Mode Disable (FPWM).<br>1 = Idle Mode Enable (Auto PFM/PWM). | 0 <sub>BIN</sub>     |

Note: SVID must be disabled if DPS\_IDLE\_CFG is changed in the register via I2C in order to make changes to EN\_PS\_IDLEx. Changing EN\_PS\_IDLEx from 1 to 0 (Auto PFM/PWM to FPWM) requires powering down and then power up the rail.

### 7.13.7 Active DPU and DPU Count Status

**Table 70. PMSTATUS**

| Register Name | R/W | D7                 | D6 | D5 | D4 | D3 | D2 | D1 | D0                | Initial Value     | Address |
|---------------|-----|--------------------|----|----|----|----|----|----|-------------------|-------------------|---------|
| DPS0_PMSTATUS | R   | DPS0_PMSTATUS[7:0] |    |    |    |    |    |    | 00 <sub>HEX</sub> | 07 <sub>HEX</sub> |         |
| DPS1_PMSTATUS | R   | DPS1_PMSTATUS[7:0] |    |    |    |    |    |    | 00 <sub>HEX</sub> | 0A <sub>HEX</sub> |         |
| DPS2_PMSTATUS | R   | DPS2_PMSTATUS[7:0] |    |    |    |    |    |    | 00 <sub>HEX</sub> | 1C <sub>HEX</sub> |         |
| DPS3_PMSTATUS | R   | DPS3_PMSTATUS[7:0] |    |    |    |    |    |    | 00 <sub>HEX</sub> | 1E <sub>HEX</sub> |         |
| DPS4_PMSTATUS | R   | DPS4_PMSTATUS[7:0] |    |    |    |    |    |    | 00 <sub>HEX</sub> | 24 <sub>HEX</sub> |         |

| Bit    | Name               | Function  | Default                 |
|--------|--------------------|---|-------------------------|
| D[7:0] | DPSx_PMSTATUS[7:0] | <p>PMSTATUS has two modes:</p> <p>MODE1: If the rail is off, the PMSTATUS will report in hexadecimal how many DPUs are available to that rail. Each bit represents a DPU.</p> <ul style="list-style-type: none"> <li>0<sub>HEX</sub> = 0000<sub>BIN</sub> = 0 DPU</li> <li>1<sub>HEX</sub> = 0001<sub>BIN</sub> = 1 DPU available to the rail</li> <li>3<sub>HEX</sub> = 0011<sub>BIN</sub> = 2 DPUs available to the rail</li> <li>7<sub>HEX</sub> = 0111<sub>BIN</sub> = 3 DPUs available to the rail</li> <li>F<sub>HEX</sub> = 1111<sub>BIN</sub> = 4 DPUs available to the rail</li> </ul> <p>MODE2: If the rail is active, the PMSTATUS will report in decimal how many DPUs are active (have switching activity) at that moment:</p> <ul style="list-style-type: none"> <li>0<sub>DEC</sub> = 0 DPU</li> <li>1<sub>DEC</sub> = 1 DPU active (even if <math>\geq 2</math> DPUs are available)</li> <li>2<sub>DEC</sub> = 2 DPUs active</li> <li>3<sub>DEC</sub> = 3 DPUs active</li> <li>4<sub>DEC</sub> = 4 DPUs active</li> </ul> | 00000000 <sub>BIN</sub> |

### 7.13.8 DCD0-2 Compensation and DPU Phase Shedding Control Registers

**Table 71. DCD0-2 Compensation and DPU Phase Shedding Control Registers**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6 | D5  | D4   | D3 | D2   | D1           | D0 | Initial Value     | Address           |
|---------------|-----|------|----|-----|------|----|------|--------------|----|-------------------|-------------------|
| DPS0_CONFIG   | R/W | RSVD |    | GM0 | RSVD |    | RSVD | OFF_DLY[1:0] |    | 20 <sub>HEX</sub> | 06 <sub>HEX</sub> |
| DPS1_CONFIG   | R/W | RSVD |    | GM1 | RSVD |    | RSVD | OFF_DLY[1:0] |    | 20 <sub>HEX</sub> | 09 <sub>HEX</sub> |
| DPS2_CONFIG   | R/W | RSVD |    | GM2 | RSVD |    | RSVD | OFF_DLY[1:0] |    | 20 <sub>HEX</sub> | 1B <sub>HEX</sub> |

| Bit    | Name         | Function   | Default            |
|--------|--------------|--|--------------------|
| D[7]   | RSVD         | Reserved   | 0 <sub>BIN</sub>   |
| D[5]   | GM[x]        | Gain Margin (GM) selection:<br>0 = Set to lower GM gain.<br>1 = Set to normal GM gain.   | 1 <sub>BIN</sub>   |
| D[4:2] | RSVD         | Reserved   | 000 <sub>BIN</sub> |
| D[1:0] | OFF_DLY[1:0] | DPU Phase Shedding Timer (valid only for Auto-Mode PWM/PFM (FPWM=0)):<br>00 = Drop a phase 130µs after load current drops below PFM level.<br>01 = Drop a phase 65µs after load current drops below PFM level.<br>10 = Drop a phase 20µs after load current drops below PFM level.<br>11 = Disable phase-shedding. | 00 <sub>BIN</sub>  |

### 7.13.9 DCD3-4 Compensation and DPU Phase Shedding Control Registers

**Table 72. DCD3-4 Compensation and DPU Phase Shedding Control Registers**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6     | D5  | D4   | D3 | D2   | D1           | D0 | Initial Value     | Address           |
|---------------|-----|------|--------|-----|------|----|------|--------------|----|-------------------|-------------------|
| DPS3_CONFIG   | R/W | RSVD | DAMPB3 | GM3 | RSVD |    | RSVD | OFF_DLY[1:0] |    | 30 <sub>HEX</sub> | 1D <sub>HEX</sub> |
| DPS4_CONFIG   | R/W | RSVD | DAMPB4 | GM4 | RSVD |    | RSVD | OFF_DLY[1:0] |    | 30 <sub>HEX</sub> | 23 <sub>HEX</sub> |

| Bit  | Name     | Function  | Default          |
|------|----------|---|------------------|
| D[7] | RSVD     | Reserved.   | 0 <sub>BIN</sub> |
| D[6] | DAMPB[X] | 0 = Select default compensation.<br>1 = Select alternative compensation.      | 0 <sub>BIN</sub> |
| D[5] | GM       | GM Gain Selection:<br>0 = Set to lower GM gain.<br>1 = Set to normal GM gain. | 1 <sub>BIN</sub> |

| Bit    | Name         | Function  | Default            |
|--------|--------------|---|--------------------|
| D[4:2] | RSVD         | Reserved  | 100 <sub>BIN</sub> |
| D[1:0] | OFF_DLY[1:0] | DPU phase shedding timer:<br>00 <sub>BIN</sub> = Drop a phase 130μs after load current drops below PFM level<br>01 <sub>BIN</sub> = Drop a phase 65μs after load current drops below PFM level<br>10 <sub>BIN</sub> = Drop a phase 0μs after load current drops below PFM level<br>11 <sub>BIN</sub> = Disable phase shedding | 00 <sub>BIN</sub>  |

### 7.13.10 DCD5-6 Compensation Control Registers

**Table 73. DCD5-6 Compensation Control Registers**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7 | D6   | D5 | D4 | D3  | D2  | D1  | D0  | Initial Value     | Address           |
|---------------|-----|----|------|----|----|-----|-----|-----|-----|-------------------|-------------------|
| DPS56_CONFIG  | R/W |    | RSVD |    |    | GM6 | BW6 | GM5 | BW5 | 0A <sub>HEX</sub> | 0D <sub>HEX</sub> |

| Bit    | Name | Function  | Default             |
|--------|------|---|---------------------|
| D[7:4] | RSVD | Reserved  | 0000 <sub>BIN</sub> |
| D[3]   | GM6  | Gain Margin (GM) selection for DCD6:<br>0 = Set to lower GM gain<br>1 = Set to normal GM gain | 1 <sub>BIN</sub>    |
| D[2]   | BW6  | Bandwidth Selection for DCD6:<br>0 = Use normal bandwidth<br>1 = Set to lower bandwidth       | 0 <sub>BIN</sub>    |
| D[1]   | GM5  | Gain Margin (GM) selection for DCD5:<br>0 = Set to lower GM gain<br>1 = Set to normal GM gain | 1 <sub>BIN</sub>    |
| D[0]   | BW5  | Bandwidth Selection for DCD5:<br>0 = Use normal bandwidth<br>1 = Set to lower bandwidth       | 0 <sub>BIN</sub>    |

### 7.13.11 Over-Current (OC) Warning and Over-Current Limit

The DCDs use switch peak current information to compare with the internal thresholds for output current warning and limiting. The DCDs operate in Constant Current Mode during an over-current event.

If the peak current reaches the first threshold over-current warning level (see Table 76), the *DCDx\_OC* warning status bit in the *DCD\_OC* register ( $AE_{HEX}$ ; see Table 74) is set to 1. With  $DCD[x]_ILIM = 1$  and  $DILIM2 = 0$  (the P91EO's default setting), the current limiting feature is activated. The P91EO allows the actual output current to increase and eventually clamps at an average value close to the over-current warning level. For DCD0, DCD1, and DCD2, the limiting action starts if the peak current level exceeds the warning level (8A typical) for a duration of 10 $\mu$ s or 100 $\mu$ s depending on the *DCD\_ILIM* register bit[7] setting ( $A0_{HEX}$ ; see Table 75). For DCD5 and/or DCD6, the limiting action of each DCD at this warning level 2.7A (typical) can be bypassed by setting the corresponding bit in the *DCD[x]\_ILIM* register to 0, or both DCDs can be bypassed by setting  $DILIM2 = 1$ , which can also be done with OTP from the factory.

Recommendation: For DCD5 and DCD6, use the default setting for output current delivery up to 1.3A. DCD5 and DCD6 can achieve 2A DC output current and 2.3A peak across conditions by bypassing the current limit at the OC warning level in combination with proper inductor selection where IDC satisfies considerations for a possible temperature rise and ISAT (inductor saturation current) is chosen based on the expected peak current up to a current limit of 4A peak.

### 7.13.12 DCD Over-Current Warning Status

**Table 74. DCD Over-Current Warning Status**

| Register Name | R/W | D7   | D6      | D5      | D4   | D3 | D2      | D1      | D0      | Initial Value     | Address           |
|---------------|-----|------|---------|---------|------|----|---------|---------|---------|-------------------|-------------------|
| DCD_OC        | R/W | RSVD | DCD6_OC | DCD5_OC | RSVD |    | DCD2_OC | DCD1_OC | DCD0_OC | 00 <sub>HEX</sub> | AE <sub>HEX</sub> |

| Bit    | Name    | Function  | Default           |
|--------|---------|---|-------------------|
| D[7]   | RSVD    | Reserved.   | 0 <sub>BIN</sub>  |
| D[6]   | DCD6_OC | 0 = Peak switch current is below the OC warning level for DCD6.<br>1 = Peak switch current has been above the OC warning level. Write '1' to clear. | 0 <sub>BIN</sub>  |
| D[5]   | DCD5_OC | 0 = Peak switch current is below the OC warning level for DCD5.<br>1 = Peak switch current has been above the OC warning level. Write '1' to clear. | 0 <sub>BIN</sub>  |
| D[4:3] | RSVD    | Reserved.   | 00 <sub>BIN</sub> |
| D[2]   | DCD2_OC | 0 = Peak switch current is below the OC warning level for DCD2.<br>1 = Peak switch current has been above the OC warning level. Write '1' to clear. | 0 <sub>BIN</sub>  |
| D[1]   | DCD1_OC | 0 = Peak switch current is below the OC warning level for DCD1.<br>1 = Peak switch current has been above the OC warning level. Write '1' to clear. | 0 <sub>BIN</sub>  |
| D[0]   | DCD0_OC | 0 = Peak switch current is below the OC warning level for DCD0.<br>1 = Peak switch current has been above the OC warning level. Write '1' to clear. | 0 <sub>BIN</sub>  |

**Table 75. Individual DCD First Over-Current-Limit Level Activation**

| Register Name | R/W | D7        | D6        | D5        | D4 | D3 | D2 | D1 | D0   | Initial Value     | Address           |
|---------------|-----|-----------|-----------|-----------|----|----|----|----|------|-------------------|-------------------|
| DCD_ILIM      | R/W | ILIM100US | DCD6_ILIM | DCD5_ILIM |    |    |    |    | RSVD | 67 <sub>HEX</sub> | A0 <sub>HEX</sub> |

| Bit    | Name      | Function  | Default              |
|--------|-----------|---|----------------------|
| D[7]   | ILIM100US | Sets the duration when the current limit comparator is bypassed (disabled) during a DVS event to allow higher output current for a limited time for DCD0, DCD1, and DCD2. This function is enabled with DCD0_ILIM, DCD1_ILIM, and DCD2_ILIM.<br>0 = Allow 10μs before activating current limit action.<br>1 = Allow 100μs before activating current limit action. | 0 <sub>BIN</sub>     |
| D[6]   | DCD6_ILIM | DCD6 first-level current limit activation.<br>0 = Use current limit function at the second OC level<br>1 = Enable the current limit function when the peak switch current has reached the OC warning level  | 1 <sub>BIN</sub>     |
| D[5]   | DCD5_ILIM | DCD5 first-level current limit activation.<br>0 = Use current limit function at the second OC level<br>1 = Enable the current limit function when the peak switch current has reached the OC warning level  | 1 <sub>BIN</sub>     |
| D[4:0] | RSVD      | Reserved. Always write a 00111 <sub>BIN</sub> to these bits.  | 00111 <sub>BIN</sub> |

**Table 76. DCD Group First Over-Current-Limit Level Activation**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7 | D6 | D5 | D4   | D3 | D2 | D1     | D0   | Initial Value     | Address           |
|---------------|-----|----|----|----|------|----|----|--------|------|-------------------|-------------------|
| DILIM         | R/W |    |    |    | RSVD |    |    | DILIM2 | RSVD | 00 <sub>HEX</sub> | 70 <sub>HEX</sub> |

| Bit    | Name   | Function   | Default               |
|--------|--------|--|-----------------------|
| D[7:2] | RSVD   | Reserved   | 000000 <sub>BIN</sub> |
| D[1]   | DILIM2 | 0 = DCD5 and DCD6 current-limit function uses the setting in the DCD_ILIM register (A0 <sub>HEX</sub> ).<br>1 = Bypass the first-level current-limit function for DCD5/6 independent of the settings in the DCD_ILIM register. This may be redundant to DCD5_ILIM and DCD6_ILIM in DCD_ILIM. | 0 <sub>BIN</sub>      |
| D[0]   | RSVD   | Reserved. Always write a 0 to this bit.  | 0 <sub>BIN</sub>      |

## 7.14 Power Consumption at Light Load Considerations

Power dissipation at light load is predominantly from the current used by internal circuitry through VSYS, current consumption from switching activity of the DCD's switching power supply, and quiescent current of the LDOs. To achieve the greatest power saving, rails can be manually disabled via I<sub>2</sub>C. When DPUs are used with regulators (DCD0, DCD1, and DCD2) or controllers (DCD3 and DCD4), there is additional current consumption used by the DPU's internal logic for performing switching activity. To minimize the power consumption from switching activity, Auto-Mode PWM/PFM can be used. For the DCD0, DCD1, and DCD2 regulators, the internal FETs are performing the switching activity in light load, so there is no switching activity done by the DPU(s); thus there is minimal power dissipation on the DPU(s). For DCD3 and DCD4, the switching activity is always performed by the DPU(s).

Table 77 shows the typical consumption of an example configuration without any output current load and P9148 as the DPU. The Vsys logic is the baseline current with the internal circuitry still operating, while all DCDs and all LDOs, except LDO7, are OFF. The values in the P91E0 I<sub>Q</sub> column represent the additional current into the VSYS pin and DCD\_VIN or LDO\_VIN pin of the respective rail. DCD3 and DCD4 are manually set to Auto-Mode PWM/PFM for the greatest power savings. The power consumption in each state (e.g., SoC-S3, SoC-S4/S5) can be calculated from summing the power loss of the rails that remain active in that state.

**Table 77. Typical Light-Load Power Consumption using the P9148**

V<sub>in</sub> = 5.0V, Temperature = 25°C.

|            | Number of DPUs | V <sub>in</sub> [V] | V <sub>out</sub> [V] | P91E0 I <sub>Q</sub> [mA] | P9148 I <sub>Q</sub> [mA] | Power Loss [mW] |
|------------|----------------|---------------------|----------------------|---------------------------|---------------------------|-----------------|
| Vsys Logic | –              | 5.0                 | –                    | 1.000                     | –                         | 5.00            |
| DCD0       | 4              | 5.0                 | OFF                  | 0.105                     | 0.720                     | 4.13            |
| DCD1       | 0              | 5.0                 | 1.00                 | 0.500                     | –                         | 2.50            |
| DCD2       | 1              | 5.0                 | 1.10                 | 0.500                     | 0.180                     | 3.40            |
| DCD3       | 1              | 5.0                 | 1.05                 | 0.250                     | 0.550                     | 4.00            |
| DCD4       | 1              | 5.0                 | 3.30                 | 0.250                     | 0.550                     | 4.00            |
| DCD5       | –              | 5.0                 | 1.80                 | 0.500                     | –                         | 2.50            |
| DCD6       | –              | 5.0                 | 1.24                 | 0.500                     | –                         | 2.50            |
| LDO0       | –              | 1.8                 | –                    | 0.022                     | –                         | 0.04            |
| LDO1       | –              | 1.8                 | –                    | 0.022                     | –                         | 0.04            |
| LDO2       | –              | 1.8                 | –                    | 0.022                     | –                         | 0.04            |
| LDO3       | –              | 1.8                 | –                    | 0.020                     | –                         | 0.04            |
| LDO4       | –              | 1.8                 | –                    | 0.020                     | –                         | 0.04            |
| LDO5       | –              | 1.1                 | –                    | 0.095                     | –                         | 0.10            |
| LDO6       | –              | 5.0                 | –                    | 0.020                     | –                         | 0.10            |
|            |                |                     |                      |                           |                           | Total: 28.42    |

## 7.15 Enable Pins

All enable signals are open-drain output signals. The polarity is set to active-LOW by default. EN0 to EN4 can be fuse-programmed to be active-HIGH upon PMIC start-up. The on/off control of each regulator is controlled either through the programmed sequence or by I<sup>2</sup>C.

**Table 78. Electrical Characteristics – Enable Pins**

Conditions unless otherwise specified: T<sub>A</sub> = 25°C.

| Symbol              | Parameter                | Conditions              | Minimum | Typical | Maximum | Units |
|---------------------|--------------------------|-------------------------|---------|---------|---------|-------|
| V <sub>pullup</sub> | External Pull-up Voltage | –                       | –       | –       | 5.25    | V     |
| V <sub>OL</sub>     | Output Voltage LOW       | I <sub>OUT</sub> = 10mA | –       | –       | 0.4     | V     |
| I <sub>SNK</sub>    | Current Sink             | V <sub>ENx</sub> = 0.4V | –       | 10      | –       | mA    |
| I <sub>LKG</sub>    | Leakage Current          | –                       | –       | 100     | –       | nA    |

**Table 79. I2C Control Register – EN0 to EN11**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6 | D5 | D4 | D3       | D2       | D1      | D0                | Initial Value     | Address |
|---------------|-----|------|----|----|----|----------|----------|---------|-------------------|-------------------|---------|
| EN0_CTL       | R/W | RSVD |    |    |    | Polarity | EN0_SEL  | EN0_EN  | 00 <sub>HEX</sub> | 56 <sub>HEX</sub> |         |
| EN1_CTL       | R/W | RSVD |    |    |    | Polarity | EN1_SEL  | EN1_EN  | 00 <sub>HEX</sub> | 57 <sub>HEX</sub> |         |
| EN2_CTL       | R/W | RSVD |    |    |    | Polarity | EN2_SEL  | EN2_EN  | 00 <sub>HEX</sub> | 5B <sub>HEX</sub> |         |
| EN3_CTL       | R/W | RSVD |    |    |    | Polarity | EN3_SEL  | EN3_EN  | 00 <sub>HEX</sub> | 5C <sub>HEX</sub> |         |
| EN4_CTL       | R/W | RSVD |    |    |    | Polarity | EN4_SEL  | EN4_EN  | 00 <sub>HEX</sub> | 5D <sub>HEX</sub> |         |
| EN5_CTL       | R/W | RSVD |    |    |    | Polarity | EN5_SEL  | EN5_EN  | 00 <sub>HEX</sub> | 69 <sub>HEX</sub> |         |
| EN6_CTL       | R/W | RSVD |    |    |    | Polarity | EN6_SEL  | EN6_EN  | 00 <sub>HEX</sub> | 68 <sub>HEX</sub> |         |
| EN7_CTL       | R/W | RSVD |    |    |    | Polarity | EN7_SEL  | EN7_EN  | 00 <sub>HEX</sub> | 64 <sub>HEX</sub> |         |
| EN8_CTL       | R/W | RSVD |    |    |    | Polarity | EN8_SEL  | EN8_EN  | 00 <sub>HEX</sub> | 62 <sub>HEX</sub> |         |
| EN9_CTL       | R/W | RSVD |    |    |    | Polarity | EN9_SEL  | EN9_EN  | 00 <sub>HEX</sub> | 6B <sub>HEX</sub> |         |
| EN10_CTL      | R/W | RSVD |    |    |    | Polarity | EN10_SEL | EN10_EN | 00 <sub>HEX</sub> | 6C <sub>HEX</sub> |         |
| EN11_CTL      | R/W | RSVD |    |    |    | Polarity | EN11_SEL | EN11_EN | 00 <sub>HEX</sub> | 6D <sub>HEX</sub> |         |

| Bit    | Name     | Function   | Default              |
|--------|----------|--|----------------------|
| D[7:3] | RSVD     | Reserved   | 00000 <sub>BIN</sub> |
| D[2]   | Polarity | Polarity bit:<br>0 = Active LOW.<br>1 = Active HIGH.   | EN0 to EN4: OTP      |
|        |          |  | EN5 to EN11: 0       |
| D[1]   | ENx_SEL  | ON/OFF selection bit:<br>0 = ON/OFF is controlled by configured device sequence.<br>1 = ON/OFF is controlled by the D[0] bit in this register. | 0 <sub>BIN</sub>     |
| D[0]   | ENx_EN   | Enable bit:<br>0 = OFF<br>1 = ON   | 0 <sub>BIN</sub>     |

**Table 80. On/Off Selection Bit Table – Enable Pins**

| D[1] | D[0] | Sequencer Control | Enable Pin |
|------|------|-------------------|------------|
| 0    | X    | 0                 | HIGH       |
| 0    | X    | 1                 | LOW        |
| 1    | 0    | X                 | HIGH       |
| 1    | 1    | X                 | LOW        |

**Table 81. I2C Sequencing Control – EN0 to EN11**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6 | D5        | D4 | D3         | D2 | D1 | D0 | Initial Value | Address           |
|---------------|-----|------|----|-----------|----|------------|----|----|----|---------------|-------------------|
| EN0_GRP       | R/W | RSVD |    | EN0_TYPE  |    | EN0_GROUP  |    |    |    | OTP           | F4 <sub>HEX</sub> |
| EN1_GRP       | R/W | RSVD |    | EN1_TYPE  |    | EN1_GROUP  |    |    |    | OTP           | F5 <sub>HEX</sub> |
| EN2_GRP       | R/W | RSVD |    | EN2_TYPE  |    | EN2_GROUP  |    |    |    | OTP           | F6 <sub>HEX</sub> |
| EN3_GRP       | R/W | RSVD |    | EN3_TYPE  |    | EN3_GROUP  |    |    |    | OTP           | F7 <sub>HEX</sub> |
| EN4_GRP       | R/W | RSVD |    | EN4_TYPE  |    | EN4_GROUP  |    |    |    | OTP           | F8 <sub>HEX</sub> |
| EN5_GRP       | R/W | RSVD |    | EN5_TYPE  |    | EN5_GROUP  |    |    |    | OTP           | F9 <sub>HEX</sub> |
| EN6_GRP       | R/W | RSVD |    | EN6_TYPE  |    | EN6_GROUP  |    |    |    | OTP           | FA <sub>HEX</sub> |
| EN7_GRP       | R/W | RSVD |    | EN7_TYPE  |    | EN7_GROUP  |    |    |    | OTP           | FB <sub>HEX</sub> |
| EN8_GRP       | R/W | RSVD |    | EN8_TYPE  |    | EN8_GROUP  |    |    |    | OTP           | FC <sub>HEX</sub> |
| EN9_GRP       | R/W | RSVD |    | EN9_TYPE  |    | EN9_GROUP  |    |    |    | OTP           | FD <sub>HEX</sub> |
| EN10_GRP      | R/W | RSVD |    | EN10_TYPE |    | EN10_GROUP |    |    |    | OTP           | FE <sub>HEX</sub> |
| EN11_GRP      | R/W | RSVD |    | EN11_TYPE |    | EN11_GROUP |    |    |    | OTP           | 7D <sub>HEX</sub> |

| Bit    | Name      | Function  | Default          |
|--------|-----------|---|------------------|
| D[7:6] | RSVD      | Reserved  | 0 <sub>BIN</sub> |
| D[5:4] | ENx_TYPE  | Rail type selection bits:<br>00 <sub>BIN</sub> = "A" rail type.<br>01 <sub>BIN</sub> = "U" rail type.<br>10 <sub>BIN</sub> = "S" rail type.<br>11 <sub>BIN</sub> = "SX" rail type.  | OTP              |
| D[3:0] | ENx_GROUP | Group Delay Bits<br>0000 <sub>BIN</sub> = Group 0      1000 <sub>BIN</sub> = Group 8<br>0001 <sub>BIN</sub> = Group 1      1001 <sub>BIN</sub> = Group 9<br>0010 <sub>BIN</sub> = Group 2      1010 <sub>BIN</sub> = Group 10<br>0011 <sub>BIN</sub> = Group 3      1011 <sub>BIN</sub> = Group 11<br>0100 <sub>BIN</sub> = Group 4      1100 <sub>BIN</sub> = Group 12<br>0101 <sub>BIN</sub> = Group 5      1101 <sub>BIN</sub> = Group 13<br>0110 <sub>BIN</sub> = Group 6      1110 <sub>BIN</sub> = Group 14<br>0111 <sub>BIN</sub> = Group 7      1111 <sub>BIN</sub> = Disable | OTP              |

## 7.16 Sequencing Configuration Registers

### 7.16.1 PMIC Sequencing Status

**Table 82. PMIC Sequencing Status**

| Register Name | R/W | D7         | D6            | D5           | D4        | D3             | D2 | D1 | D0 | Initial Value     | Address           |
|---------------|-----|------------|---------------|--------------|-----------|----------------|----|----|----|-------------------|-------------------|
| SEQ_STATUS    | R   | MTEST_MODE | STARTUP_ABORT | STARTUP_DONE | TRIM_DONE | PWR_STATE[3:0] |    |    |    | 00 <sub>HEX</sub> | 63 <sub>HEX</sub> |

| Bit    | Name           | Function  | Default             |
|--------|----------------|---|---------------------|
| D[7]   | MTEST_MODE     | Debug Mode enabled.   | 0 <sub>BIN</sub>    |
| D[6]   | STARTUP_ABORT  | Error occurs during start-up.   | 0 <sub>BIN</sub>    |
| D[5]   | STARTUP_DONE   | Internal initialization status is complete.   | 0 <sub>BIN</sub>    |
| D[4]   | TRIM_DONE      | Trim code is loaded.  | 0 <sub>BIN</sub>    |
| D[3:0] | PWR_STATE[3:0] | Pin status and state (see section 9.3):<br>SoC_G3 = 0000; (All rails off)<br>SoC_S4/S5 = 0001; (A rails active)<br>SoC_S3 = 0011; (A rails and U rails active)<br>SoC_S0Ix = 0111; (A, U, S rails active)<br>SoC_S0 = 1111; (All rails active (A, U, S, SX)). | 0000 <sub>BIN</sub> |

**Table 83. Power Sequence Configuration**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6 | D5           | D4             | D3           | D2 | D1                | D0 | Initial Value     | Address |
|---------------|-----|------|----|--------------|----------------|--------------|----|-------------------|----|-------------------|---------|
| PWRSEQCFG     | R/W | RSVD |    | VCCAPWROKCFG | SUSPWRDNACKCFG | DTPWROK[1:0] |    | 0E <sub>HEX</sub> |    | 2A <sub>HEX</sub> |         |

| Bit    | Name           | Function  | Default             |
|--------|----------------|---|---------------------|
| D[7:4] | RSVD           | Reserved  | 0000 <sub>BIN</sub> |
| D[3]   | VCCAPWROKCFG   | 0 = VCCAPWROK de-asserts in S0Ix state.<br>1 = VCCAPWROK remains asserted in S0Ix state.  | 1 <sub>BIN</sub>    |
| D[2]   | SUSPWRDNACKCFG | 0 = SUSPWRDNACK signal is ignored. The PMIC will not go to G3 when SUSPWRDNACK goes HIGH in the SoC-S4/S5 state.<br>1 = PMIC responses to the SUSPWRDNACK signal.   | 1 <sub>BIN</sub>    |
| D[1:0] | DTPWROK[1:0]   | Delay time between SX14 rail and the first assertion of COREPWROK and VCCAPWROK.<br>Note that the value should not be changed while COREPWROK and VCCAPWROK are asserted HIGH; i.e. in the S0 and S0Ix states.<br>00 = 1ms<br>01 = 10ms<br>10 = 100ms<br>11 = 120ms | 10 <sub>BIN</sub>   |

**Table 84. S0Ix Configuration**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0     | Initial Value     | Address           |
|---------------|-----|----|----|----|----|----|----|----|--------|-------------------|-------------------|
| S0IxCFG       | R/W |    |    |    |    |    |    |    | NOS0Ix | 00 <sub>HEX</sub> | 50 <sub>HEX</sub> |

| Bit    | Name   | Function   | Default          |
|--------|--------|--|------------------|
| D[7:1] | RSVD   | Reserved   | 0 <sub>BIN</sub> |
| D[0]   | NOS0Ix | 0 = S0Ix state is used.<br>1 = S0Ix state is not used. Operation and timing sequence are associated with SX-type rails and the SLP_S0Ix_B signal is ignored. | 0 <sub>BIN</sub> |

## 7.16.2 Group-Delay Timing

Group-delay timing registers define the time delay between two consecutive group-delay indexes and are applicable to LDOs, DCDs, and ENs (LDOx\_GROUP, DCDx\_GROUP, ENx\_GROUP) as they are assigned to a respective rail type (A, U, S, SX). With OTP, the group-delay within each type during turn-on and turn-off are the same.

**Table 85. Group-Delay Timing**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6                                 | D5 | D4   | D3                 | D2 | D1  | D0                | Initial Value | Address |
|---------------|-----|------|------------------------------------|----|------|--------------------|----|-----|-------------------|---------------|---------|
| SEQA_TIM      | R/W | RSVD | DLY_GRP_OFF_A[2:0] <sup>[a]</sup>  |    | RSVD | DLY_GRP_ON_A[2:0]  |    | OTP | C3 <sub>HEX</sub> |               |         |
| SEQU_TIM      | R/W | RSVD | DLY_GRP_OFF_U[2:0] <sup>[a]</sup>  |    | RSVD | DLY_GRP_ON_U[2:0]  |    | OTP | C4 <sub>HEX</sub> |               |         |
| SEQS_TIM      | R/W | RSVD | DLY_GRP_OFF_S[2:0] <sup>[a]</sup>  |    | RSVD | DLY_GRP_ON_S[2:0]  |    | OTP | D3 <sub>HEX</sub> |               |         |
| SEQSX_TIM     | R/W | RSVD | DLY_GRP_OFF_SX[2:0] <sup>[a]</sup> |    | RSVD | DLY_GRP_ON_SX[2:0] |    | OTP | D4 <sub>HEX</sub> |               |         |

[a] These bits are loaded from OTP with the same value as DLY\_GRP\_ON\_xx[2:0]. They can be changed via I2C if a different turn-off timing is needed.

| Bit    | Name               | Function   | Default          |
|--------|--------------------|--|------------------|
| D[7]   | RSVD               | Reserved   | 0 <sub>BIN</sub> |
| D[6:4] | DLY_GRP_OFF_X[2:0] | Group delay when group-type turns off:<br>000 <sub>BIN</sub> = 0.25ms<br>001 <sub>BIN</sub> = 0.50ms<br>010 <sub>BIN</sub> = 1.00ms (default)<br>011 <sub>BIN</sub> = 1.50ms<br>100 <sub>BIN</sub> = 2.00ms<br>101 <sub>BIN</sub> = 2.50ms<br>110 <sub>BIN</sub> = 3.00ms<br>111 <sub>BIN</sub> = 5.00ms | OTP              |
| D[3]   | RSVD               | Reserved   | 0 <sub>BIN</sub> |

| Bit    | Name              | Function  | Default |
|--------|-------------------|---|---------|
| D[2:0] | DLY_GRP_ON_X[2:0] | Group delay when group-type turns on:<br>000 <sub>BIN</sub> = 0.25ms<br>001 <sub>BIN</sub> = 0.50ms<br>010 <sub>BIN</sub> = 1.00ms (default)<br>011 <sub>BIN</sub> = 1.50ms<br>100 <sub>BIN</sub> = 2.00ms<br>101 <sub>BIN</sub> = 2.50ms<br>110 <sub>BIN</sub> = 3.00ms<br>111 <sub>BIN</sub> = 5.00ms | OTP     |

### 7.16.3 Minimum Sleep Time from Group-Delay Timing and the First Rail in a Rail Type

Each rail type (A, U, S, SX) has 14 group members, resulting in a total sequence of each rail type of  $14 \times \text{SEQ}[x]_{\text{TIM}}$  (see Table 85). For the start-up sequence (sleep sequence exit), each rail type starts from index 0 to 14, and for the shut-down sequence (sleep sequence entry), each rail type stops in reverse order. The minimum sleep time (SLP\_ signal = LOW) is equal to the duration that the SLP\_ signal must be LOW from Group 14 to the lowest used index group number with a 20% additional margin recommended.

For example, for the -15 configuration, the following applies:

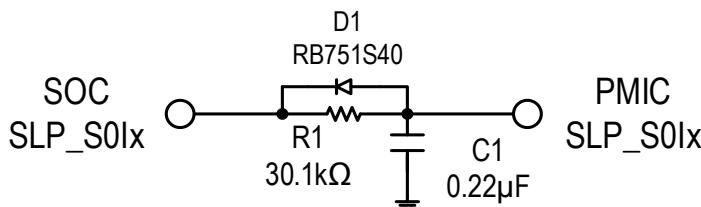
(1) The S-type rail has SEQ\_S\_TIM = 1ms

(2) The SX-type rail has SEQSX\_TIM = 0.25ms with DCD1 = SX07 as the first of this rail type to turn on and DCD0 = SX14 as the last.

The minimum time for SLP\_S0lx to be LOW is  $0.25\text{ms} \times (14 - 7) \times 1.2 = 2.1\text{ms}$ . This minimum sleep time can be satisfied by setting the SoC's Minimum Assertion Width, for example the PMU SLP S3 B Minimum Assertion Width (slp\_s3\_min\_asst\_wdth) can be set to 50ms to ensure that it is longer than  $14 \times 1\text{ms} = 14\text{ms}$ .

In the case that the setting is not available, the application circuit shown in Figure 2 can be used to prolong the SLP\_LOW signal seen by the PMIC. The values of the R1 resistor and C1 capacitor are selected such that the duration of the PMIC\_SLP\_S0lx signal reaching  $V_{IH}$  (1.35V) after exiting S0lx-sleep state is longer than the minimum sleep time (2.1ms in this example) but shorter than the time out delay of the SoC (7ms in this example) with a 3.3V SOC\_SLP\_S0lx push-pull output. The diode D1 is a signal Schottky diode with a forward-voltage below the  $V_{IL}$  of the SLP\_ signals and oriented such that when SOC\_SLP\_S0lx goes LOW, the PMIC\_SLP\_S0lx is pulled LOW immediately and thus quickly enters Sleep Mode but has a time delay created by R1 and C1 when exiting Sleep Mode. When choosing the diode, select a part that has low reverse-leakage current at the minimum and maximum operating temperatures of the system.

**Figure 2. Application Circuit for -15 Configuration for SX-type Minimum Sleep Time:  
2.1ms < SLP\_S0lx < 7ms**



## 7.17 General Purpose IOs

The P91E0 offers 15 general purpose input/output ports (GPIO) divided into two banks. Each bank has a separated power supply input dividing the GPIOs into a 1.8V (VGPI00) and 3.3V (VGPI01) domain. VGPI00 powers GPIO[9:0], the VGPI01 supply input powers GPIO[14:10].

Each GPIO can be configured either as CMOS output, open-drain output or input. Unless specified, all the GPIOs are defaulted as CMOS input with a weak 50kΩ pull down.

**Table 86. Electrical Characteristics – GPIO[9:0]**

Conditions unless otherwise specified:  $T_A = 25^\circ\text{C}$ .

| Symbol                           | Parameter           | Conditions   | Minimum                     | Typical | Maximum                     | Units         |
|----------------------------------|---------------------|--|-----------------------------|---------|-----------------------------|---------------|
| VGPI00                           | Input Power Supply  | $C_{IN} = 1\mu\text{F}$                                    | 1.71                        | 1.8     | 1.89                        | V             |
| <b>Input Configuration</b>       |                     |  |                             |         |                             |               |
| $V_{IL}$                         | Input LOW Voltage   |  | –                           | –       | $0.35 \times \text{VGPI00}$ | V             |
| $V_{IH}$                         | Input HIGH Voltage  |  | $0.65 \times \text{VGPI00}$ | –       | –                           | V             |
| $V_{HYS}$                        | Hysteresis          |  | –                           | 0.33    | –                           | V             |
| $I_{IL}$                         | Input LOW Current   | $V_{IL} = \text{GND}$                                      | –                           | 0       | –                           | $\mu\text{A}$ |
| $I_{IH}$                         | Input HIGH Current  | $V_{IH} = 1.8\text{V}, 50\text{k}\Omega \text{ pull-down}$ | –                           | 36      | –                           | $\mu\text{A}$ |
| <b>CMOS Output Configuration</b> |                     |  |                             |         |                             |               |
| $V_{OL}$                         | Output LOW Voltage  |  | –                           | –       | 0.4                         | V             |
| $V_{OH}$                         | Output HIGH Voltage |  | $\text{VGPI00} - 0.4$       | –       | –                           | V             |
| $I_{OL}$                         | Output LOW Current  |  | –                           | 4       | –                           | $\text{mA}$   |
| $I_{OH}$                         | Output HIGH Current |  | –                           | 4       | –                           | $\text{mA}$   |
| $t_{RISE}$                       | Rise Time           | Load capacitance $C_L = 150\text{pF}$ , 10% to 90%, GBD    | 10                          | –       | 45                          | ns            |
| $t_{FALL}$                       | Fall Time           | $C_L = 150\text{pF}$ , 90% to 10%, GBD                     | 10                          | –       | 45                          | ns            |
| <b>Open Drain Configuration</b>  |                     |  |                             |         |                             |               |
| $V_{OL}$                         | Output LOW Voltage  |  | –                           | –       | 0.40                        | V             |
| $I_{OL}$                         | Output LOW Current  |  | –                           | 12      | –                           | $\text{mA}$   |
| $I_{LKG}$                        | Leakage Current     |  | –                           | 100     | –                           | $\text{nA}$   |

**Table 87. Electrical Characteristics – GPIO[14:10]**Conditions unless otherwise specified:  $T_A = 25^\circ\text{C}$ .

| Symbol                           | Parameter           | Conditions  | Minimum              | Typical | Maximum              | Units         |
|----------------------------------|---------------------|---|----------------------|---------|----------------------|---------------|
| VGPIO1                           | Input Power Supply  | $C_{IN} = 1\mu\text{F}$                                   | 3.0                  | 3.3     | 3.6                  | V             |
| <b>Input Configuration</b>       |                     |   |                      |         |                      |               |
| $V_{IL}$                         | Input LOW Voltage   |   | -                    | -       | $0.35 \times VGPIO1$ | V             |
| $V_{IH}$                         | Input HIGH Voltage  |   | $0.65 \times VGPIO1$ | -       | -                    | V             |
| $V_{HYS}$                        | Hysteresis          |   | -                    | 0.33    | -                    | V             |
| $I_{IL}$                         | Input LOW Current   | $V_{IL} = \text{GND}$                                     | -                    | 0       | -                    | $\mu\text{A}$ |
| $I_{IH}$                         | Input HIGH Current  | $V_{IH} = 3.3\text{V}, 50\text{k}\Omega$ pull-down        | -                    | 66      | -                    | $\mu\text{A}$ |
| <b>CMOS Output Configuration</b> |                     |   |                      |         |                      |               |
| $V_{OL}$                         | Output LOW Voltage  |   | -                    | -       | 0.40                 | V             |
| $V_{OH}$                         | Output HIGH Voltage |   | $VGPIO1 - 0.40$      | -       | -                    | V             |
| $I_{OL}$                         | Output LOW Current  |   | -                    | 4.0     | -                    | mA            |
| $I_{OH}$                         | Output HIGH Current |   | -                    | 4.0     | -                    | mA            |
| $t_{RISE}$                       | Rise Time           | Load capacitance $C_L = 150\text{pF}$ ,<br>10 to 90%, GBD | 10                   | -       | 45                   | ns            |
| $t_{FALL}$                       | Fall Time           | $C_L = 150\text{pF}$ , 90 to 10%, GBD                     | 10                   | -       | 45                   | ns            |
| <b>Open Drain Configuration</b>  |                     |   |                      |         |                      |               |
| $V_{OL}$                         | Output LOW Voltage  |   | -                    | -       | 0.40                 | V             |
| $I_{OL}$                         | Output LOW Current  |   | -                    | 12      | -                    | mA            |
| $I_{LKG}$                        | Leakage Current     |   | -                    | 100     | -                    | nA            |

**Table 88. GPIO Output Configuration Register**

Note: Green shading indicates that the bit values are loaded from the OTP.

Note: Yellow shading indicates that the bit values are paired with bits in other registers for the OTP setting. See the subsequent bit function description table for details.

| Register Name | R/W | D7   | D6       | D5  | D4  | D3  | D2        | D1 | D0   | Initial Value     | Address           |
|---------------|-----|------|----------|-----|-----|-----|-----------|----|------|-------------------|-------------------|
| GPIOCTL00     | R/W | RSVD | ALT_FUNC | DIR | DRV | REN | RVAL[1:0] |    | DOUT | 7C <sub>HEX</sub> | 3B <sub>HEX</sub> |
| GPIOCTL01     | R/W | RSVD | ALT_FUNC | DIR | DRV | REN | RVAL[1:0] |    | DOUT | 7C <sub>HEX</sub> | 3C <sub>HEX</sub> |
| GPIOCTL02     | R/W | RSVD | ALT_FUNC | DIR | DRV | REN | RVAL[1:0] |    | DOUT | 7C <sub>HEX</sub> | 3D <sub>HEX</sub> |
| GPIOCTL03     | R/W | RSVD | ALT_FUNC | DIR | DRV | REN | RVAL[1:0] |    | DOUT | 7C <sub>HEX</sub> | 3E <sub>HEX</sub> |
| GPIOCTL04     | R/W | RSVD | ALT_FUNC | DIR | DRV | REN | RVAL[1:0] |    | DOUT | 7C <sub>HEX</sub> | 3F <sub>HEX</sub> |
| GPIOCTL05     | R/W | RSVD | ALT_FUNC | DIR | DRV | REN | RVAL[1:0] |    | DOUT | 7C <sub>HEX</sub> | 40 <sub>HEX</sub> |
| GPIOCTL06     | R/W | RSVD | ALT_FUNC | DIR | DRV | REN | RVAL[1:0] |    | DOUT | 0C <sub>HEX</sub> | 41 <sub>HEX</sub> |
| GPIOCTL07     | R/W | RSVD | ALT_FUNC | DIR | DRV | REN | RVAL[1:0] |    | DOUT | 0C <sub>HEX</sub> | 42 <sub>HEX</sub> |
| GPIOCTL08     | R/W | RSVD | ALT_FUNC | DIR | DRV | REN | RVAL[1:0] |    | DOUT | 0C <sub>HEX</sub> | 2B <sub>HEX</sub> |

| Register Name | R/W | D7   | D6       | D5  | D4  | D3  | D2        | D1   | D0                | Initial Value     | Address |
|---------------|-----|------|----------|-----|-----|-----|-----------|------|-------------------|-------------------|---------|
| GPIOCTL09     | R/W | RSVD | ALT_FUNC | DIR | DRV | REN | RVAL[1:0] | DOUT | 0C <sub>HEX</sub> | 2C <sub>HEX</sub> |         |
| GPIOCTL10     | R/W | RSVD | ALT_FUNC | DIR | DRV | REN | RVAL[1:0] | DOUT | 0C <sub>HEX</sub> | 2D <sub>HEX</sub> |         |
| GPIOCTL11     | R/W | RSVD | ALT_FUNC | DIR | DRV | REN | RVAL[1:0] | DOUT | 0C <sub>HEX</sub> | 2E <sub>HEX</sub> |         |
| GPIOCTL12     | R/W | RSVD | ALT_FUNC | DIR | DRV | REN | RVAL[1:0] | DOUT | 0C <sub>HEX</sub> | 2F <sub>HEX</sub> |         |
| GPIOCTL13     | R/W | RSVD | ALT_FUNC | DIR | DRV | REN | RVAL[1:0] | DOUT | 0C <sub>HEX</sub> | 30 <sub>HEX</sub> |         |
| GPIOCTL14     | R/W | RSVD | ALT_FUNC | DIR | DRV | REN | RVAL[1:0] | DOUT | 0C <sub>HEX</sub> | 31 <sub>HEX</sub> |         |

| Bit  | Name     | Function   | Default   |
|------|----------|--|---|
| D[7] | RSVD     | Reserved.  | 0 <sub>BIN</sub>  |
| D[6] | ALT_FUNC | Alternative Function:<br>0 = Disabled.<br>1 = Enabled. Note that in OTP, the D[6] settings associated with DIO and DIF for DCDx are paired as follows: GPIOCTL00 with GPIOCTL01, GPIOCTL02 with GPIOCTL03, GPIOCTL04 with GPIOCTL05. The OTP settings for GPIOCTL06 to GPIOCTL014 can be configured independently.<br>Note: These settings can be changed via I2C after the download from OTP. | 1 <sub>BIN</sub> for GPIOCTL00 to GPIOCTL05<br>0 <sub>BIN</sub> for GPIOCTL06 to GPIOCTL014 |
|      |          | Alternative Function Disabled/Enabled  |   |
|      |          | GPIO0 / DCD2_DIO [default DCD2_DIO]  |   |
|      |          | GPIO8 / SLEEP [default GPIO8]  |   |
|      |          | GPIO1 / DCD2_DIF [default DCD2_DIF]  |   |
|      |          | GPIO9 / VDDQSEL [default GPIO9]  |   |
|      |          | GPIO2 / DCD1_DIO [default DCD1_DIO]  |   |
|      |          | GPIO10 / ADC0 [default GPIO10]   |   |
|      |          | GPIO3 / DCD1_DIF [default DCD1_DIF]  |   |
|      |          | GPIO11 / ADC1 [default GPIO11]   |   |
| D[5] | DIR      | GPIO4 / DCD0_DIO [default DCD0_DIO]  | 1 <sub>BIN</sub> for GPIOCTL00 to GPIOCTL05<br>0 <sub>BIN</sub> for GPIOCTL06 to GPIOCTL014 |
|      |          | GPIO12 / ADC2 [default GPIO12]   |   |
| D[4] | DRV      | GPIO5 / DCD0_DIF [default DCD0_DIF]  | 1 <sub>BIN</sub> for GPIOCTL00 to GPIOCTL05<br>0 <sub>BIN</sub> for GPIOCTL06 to GPIOCTL014 |
|      |          | GPIO13 / PANEL_EN [default GPIO13]   |   |
| D[3] | REN      | GPIO6 / PWM0 [default GPIO6]   | 1 <sub>BIN</sub>  |
|      |          | GPIO14 / BACKLIGHT_EN [default GPIO14]   |   |
|      |          | GPIO7 / PWM1 [default GPIO7]   |   |

| Bit    | Name | Function   | Default           |
|--------|------|--|-------------------|
| D[2:1] | RVAL | Internal Pull Up Resistor Value:<br>00 <sub>BIN</sub> = 2kΩ pull down. 10 <sub>BIN</sub> = 50kΩ pull-down.<br>01 <sub>BIN</sub> = 2kΩ pull up. 11 <sub>BIN</sub> = 50kΩ pull-up. | 10 <sub>BIN</sub> |
| D[0]   | DOUT | Pin Output Value:<br>0 = LOW.<br>1 = HIGH or high-Z.   | 0 <sub>BIN</sub>  |

**Table 89. GPIO Input Configuration Register**

| Register Name | R/W | D7   | D6 | D5 | D4       | D3      | D2          | D1 | D0  | Initial Value     | Address           |
|---------------|-----|------|----|----|----------|---------|-------------|----|-----|-------------------|-------------------|
| GPIOCTL10     | R/W | RSVD |    |    | GPIGLBYP | GPIDBNC | INTCNT[1:0] |    | DIN | 00 <sub>HEX</sub> | 43 <sub>HEX</sub> |
| GPIOCTL11     | R/W | RSVD |    |    | GPIGLBYP | GPIDBNC | INTCNT[1:0] |    | DIN | 00 <sub>HEX</sub> | 44 <sub>HEX</sub> |
| GPIOCTL12     | R/W | RSVD |    |    | GPIGLBYP | GPIDBNC | INTCNT[1:0] |    | DIN | 00 <sub>HEX</sub> | 45 <sub>HEX</sub> |
| GPIOCTL13     | R/W | RSVD |    |    | GPIGLBYP | GPIDBNC | INTCNT[1:0] |    | DIN | 00 <sub>HEX</sub> | 46 <sub>HEX</sub> |
| GPIOCTL14     | R/W | RSVD |    |    | GPIGLBYP | GPIDBNC | INTCNT[1:0] |    | DIN | 00 <sub>HEX</sub> | 47 <sub>HEX</sub> |
| GPIOCTL15     | R/W | RSVD |    |    | GPIGLBYP | GPIDBNC | INTCNT[1:0] |    | DIN | 00 <sub>HEX</sub> | 48 <sub>HEX</sub> |
| GPIOCTL16     | R/W | RSVD |    |    | GPIGLBYP | GPIDBNC | INTCNT[1:0] |    | DIN | 00 <sub>HEX</sub> | 49 <sub>HEX</sub> |
| GPIOCTL17     | R/W | RSVD |    |    | GPIGLBYP | GPIDBNC | INTCNT[1:0] |    | DIN | 00 <sub>HEX</sub> | 4A <sub>HEX</sub> |
| GPIOCTL18     | R/W | RSVD |    |    | GPIGLBYP | GPIDBNC | INTCNT[1:0] |    | DIN | 00 <sub>HEX</sub> | 33 <sub>HEX</sub> |
| GPIOCTL19     | R/W | RSVD |    |    | GPIGLBYP | GPIDBNC | INTCNT[1:0] |    | DIN | 00 <sub>HEX</sub> | 34 <sub>HEX</sub> |
| GPIOCTL10     | R/W | RSVD |    |    | GPIGLBYP | GPIDBNC | INTCNT[1:0] |    | DIN | 00 <sub>HEX</sub> | 35 <sub>HEX</sub> |
| GPIOCTL11     | R/W | RSVD |    |    | GPIGLBYP | GPIDBNC | INTCNT[1:0] |    | DIN | 00 <sub>HEX</sub> | 36 <sub>HEX</sub> |
| GPIOCTL12     | R/W | RSVD |    |    | GPIGLBYP | GPIDBNC | INTCNT[1:0] |    | DIN | 00 <sub>HEX</sub> | 37 <sub>HEX</sub> |
| GPIOCTL13     | R/W | RSVD |    |    | GPIGLBYP | GPIDBNC | INTCNT[1:0] |    | DIN | 00 <sub>HEX</sub> | 38 <sub>HEX</sub> |
| GPIOCTL14     | R/W | RSVD |    |    | GPIGLBYP | GPIDBNC | INTCNT[1:0] |    | DIN | 00 <sub>HEX</sub> | 39 <sub>HEX</sub> |

| Bit    | Name     | Function   | Default            |
|--------|----------|--|--------------------|
| D[7:5] | RSVD     | Reserved   | 000 <sub>BIN</sub> |
| D[4]   | GPIGLBYP | Glitch Filter By-Pass Enable:<br>0 = Glitch filter enabled. 1 = Glitch filter by-passed.       | 0 <sub>BIN</sub>   |
| D[3]   | GPIDBNC  | De-Bounce Enable:<br>0 = De-bounce disabled. 1 = De-bounce enabled.                            | 0 <sub>BIN</sub>   |
| D[2:1] | INTCNT   | Interrupt Detect:<br>00 = Disable. 01 = Negative edge.<br>10 = Positive edge. 11 = Both edges. | 00 <sub>BIN</sub>  |
| D[0]   | DIN      | Pin Status:<br>0= Input LOW. 1= Input HIGH.  | 0 <sub>BIN</sub>   |

### 7.17.1 VDDQ Select (VDDQSEL)

If the alternate function of the GPIO[9]/VDDQSEL pin has been selected, the VDDQSEL feature allows using a single OTP configuration to supply different voltages for the VDDQ rail, depending on the type of memory used. This is achieved with a single resistor connected between the GPIO[9]/VDDQSEL pin and either GND or the LDO7\_VO output, as shown in Table 90. The resistor is sensed during start-up, and depending on the value, the DCD2 boot voltage is set according to Table 90. This value overrides the *DCD2\_VBOOT* value (see Table 40). The default configuration for GPIO[9]/VDDQSEL is to act as GPIO[9], so if the VDDQSEL functionality is required, it must be set in the corresponding register (see Table 88) or OTP configuration.

**Table 90. DCD2 Output Voltage vs. VDDQSEL Connection**

| VDDQSEL Connection | DCD2_VBOOT (V) | Memory Type |
|--------------------|----------------|-------------|
| 100Ω to GND [a]    | 1.1            | LPDDR       |
| 100kΩ to GND       | 1.2            | DDR4        |
| 100kΩ to LDO7_VO   | 1.24           | LPDDR3      |
| 100Ω to LDO7_VO    | 1.35           | DDR3L       |

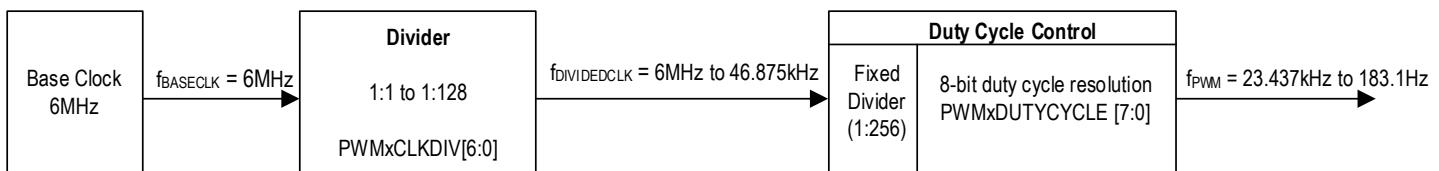
[a] Contact IDT for use of this option. See the last page for contact information.

### 7.17.2 Pulse Width Modulation (PWM) Generator

The P91E0 supports two PWM outputs with programmable frequencies of ~183Hz to a maximum required frequency of ~23.4kHz and duty cycle granularity of 1/256. To use the PWM0 and PWM1, the GPIO[6]/PWM[0] [default GPIO6] and GPIO[7]/PWM[1] [default GPIO7] pins must be set accordingly to enable the alternative functions (see Table 88), and the pin direction must be set to "Output." Both push-pull and open-drain configurations are supported.

Figure 3 shows the PWM block diagram. Each individual PWM output has two control registers to set the clock divider and one to set the duty cycle of each PWM output. See Table 91 for the *PWMxCLKDIV* registers and Table 92 for the *PWMxDUTYCYCLE* registers.

**Figure 3. PWM Block Diagram**



The PWM "Divider" sub-block is clocked by the 6MHz internal oscillator (BASECLK). A 7-bit counter counts from 0 to CLKDIVx[6:0], which is a bit field in the *PWMxCLKDIV* register (see Table 91). When CLKDIVx [6:0] is reached, a 7-bit comparator resets the 7-bit counter to 0. This effectively divides the BASECLK by the 7-bit value CLKDIVx [6:0], giving divider options of 1 (no dividing CLKDIVx[6:0] = 0) to 128 (CLKDIVx[6:0] = 7F<sub>HEX</sub>). The result of this division is the intermediate clock value *f<sub>DIVIDEDCLK</sub>*.

The "Duty Cycle Control" block uses a fixed divider (1/256) to perform an additional frequency reduction to obtain *f<sub>PWM</sub>*, which is the frequency used for the PWM output. The "Duty Cycle Control" block also uses an 8-bit counter responsible for the duty cycle control, which is selected via the DUTYCYCLE bit field in the *PWMxDUTYCYCLE* register (see Table 92). The duty cycle ranges from 0.39% (*DUTYCYCLE*[7:0] = 0) to 100% (*DUTYCYCLE*[7:0]=FF<sub>HEX</sub>) with a 0.39% step. The desired duty cycle of the PWM output is set by *DUTYCYCLE*[7:0] with the following formula: (*DUTYCYCLE*[7:0] + 1)/256. When the 8-bit counter output is less than the value of *DUTYCYCLE*[7:0], the output is HIGH. When the counter value is equal to or greater than the value of *DUTYCYCLE*[7:0], the output is LOW. In the case when *DUTYCYCLE*[7:0] = FF<sub>HEX</sub>, the output always stays HIGH. When the counter value reaches FF<sub>HEX</sub>, the counter is reset to 00<sub>HEX</sub>, and the next PWM period starts. The counter output is buffered before driving the external pin. The buffer's power supply is 1.8V (VGPO0).

Note: The PWM frequency is not intended to change on-the-fly (asynchronously). The PWM output must be first disabled by writing 0 to enable bit [7] in the *PWMxCLKDIV* registers before writing to the *PWMxCLKDIV* registers. The PWM duty cycle however is expected to be changed while the PWM output is enabled.

**Table 91. *PWMxCLKDIV –Clock Divider Registers***

| Register Name | R/W | D7     | D6           | D5 | D4 | D3 | D2 | D1 | D0                | Initial Value     | Address |
|---------------|-----|--------|--------------|----|----|----|----|----|-------------------|-------------------|---------|
| PWM0CLKDIV    | R/W | Enable | CLKDIV0[6:0] |    |    |    |    |    | 00 <sub>HEX</sub> | 4B <sub>HEX</sub> |         |
| PWM1CLKDIV    | R/W | Enable | CLKDIV1[6:0] |    |    |    |    |    | 00 <sub>HEX</sub> | 4C <sub>HEX</sub> |         |

| Bit    | Name         | Function  | Default                |
|--------|--------------|---|------------------------|
| D[7]   | Enable       | 1=PWM output enabled<br>0=PWM output disabled   | 0 <sub>BIN</sub>       |
| D[6:0] | CLKDIVx[6:0] | Clock divider for PWM[x]:<br>00 <sub>HEX</sub> : Pass-through. No divider. $f_{DIVIDEDCLK} = f_{BASECLK}$<br>01 <sub>HEX</sub> to 7F <sub>HEX</sub> : $f_{DIVIDEDCLK} = f_{BASECLK} / (CLKDIVx[6:0] + 1)$<br>$f_{PWM} = f_{DIVIDEDCLK} / 256$ | 0000000 <sub>BIN</sub> |

**Table 92. *PWMxDUTYCYCLE – Duty Cycle Registers***

| Register Name | R/W | D7              | D6 | D5 | D4 | D3 | D2 | D1                | D0                | Initial Value | Address |
|---------------|-----|-----------------|----|----|----|----|----|-------------------|-------------------|---------------|---------|
| PWM0DUTYCYCLE | R/W | DUTYCYCLE0[7:0] |    |    |    |    |    | 00 <sub>HEX</sub> | 4E <sub>HEX</sub> |               |         |
| PWM1DUTYCYCLE | R/W | DUTYCYCLE1[7:0] |    |    |    |    |    | 00 <sub>HEX</sub> | 4F <sub>HEX</sub> |               |         |

| Bit    | Name            | Function  | Default                 |
|--------|-----------------|---|-------------------------|
| D[7:0] | DUTYCYCLEx[7:0] | 00 <sub>HEX</sub> to FF <sub>HEX</sub> : Duty cycle = (DUTYCYCLEx[7:0] + 1)/256 (0.39% to 100%) | 00000000 <sub>BIN</sub> |

**Table 93. *PWM Examples***

| PWMxCLKDIV[6:0]   | PWMxDUTYCYCLE[7:0] | f <sub>PWM</sub> | Duty Cycle             |
|-------------------|--------------------|------------------|------------------------|
| 0 <sub>HEX</sub>  | 0 <sub>HEX</sub>   | 23.437kHz        | 0.39%                  |
| 63 <sub>HEX</sub> | 1 <sub>HEX</sub>   | 0.234kHz         | 0.78%                  |
| 7F <sub>HEX</sub> | A0 <sub>HEX</sub>  | 0.183kHz         | 62.89%                 |
| XX <sub>HEX</sub> | FF <sub>HEX</sub>  | –                | 100.00% <sup>[a]</sup> |

[a] The output pin is constantly ON.

### 7.17.3 BLIGHT\_EN and PANEL\_EN Overview

The P91E0 provides two outputs for display panel controls: BLIGHT\_EN to enable the display backlight and PANEL\_EN to enable the display panel electronics. The functions to control the backlight and display are turned-off by default and must be enabled first. The registers that control the display panel are described in the following tables.

**Table 94. BLIGHT\_EN Output Control Register**

| Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0              | Initial Value     | Address           |
|---------------|-----|----|----|----|----|----|----|----|-----------------|-------------------|-------------------|
| BLIGHT_EN     | R/W |    |    |    |    |    |    |    | BACKLIGHT_ENOUT | 00 <sub>HEX</sub> | 51 <sub>HEX</sub> |

| Bit    | Name            | Function   | Default                |
|--------|-----------------|--|------------------------|
| D[7:1] | RSVD            | Reserved   | 0000000 <sub>BIN</sub> |
| D0     | BACKLIGHT_ENOUT | Enable Pin Output Value:<br>0 = LOW<br>1 = HIGH (CMOS) | 0 <sub>BIN</sub>       |

**Table 95. PANEL\_EN Output Control Register**

| Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0          | Initial Value     | Address           |
|---------------|-----|----|----|----|----|----|----|----|-------------|-------------------|-------------------|
| PANEL_EN      | R/W |    |    |    |    |    |    |    | PANEL_ENOUT | 00 <sub>HEX</sub> | 52 <sub>HEX</sub> |

| Bit    | Name        | Function   | Default                |
|--------|-------------|--|------------------------|
| D[7:1] | RSVD        | Reserved   | 0000000 <sub>BIN</sub> |
| D0     | PANEL_ENOUT | Enable Pin Output Value:<br>0 = LOW<br>1 = HIGH (CMOS) | 0 <sub>BIN</sub>       |

### 7.17.4 SLEEP\_CTL Overview

The PMIC provides control signals for sleep control. The function to control the sleep state is turned-off by default and must be enabled first. The registers that control the sleep state are described in Table 96.

**Table 96. SLEEP\_CTL Output Control Register**

| Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Initial Value     | Address           |
|---------------|-----|----|----|----|----|----|----|----|----|-------------------|-------------------|
| SLEEP_CTL     | R/W |    |    |    |    |    |    |    | EN | 04 <sub>HEX</sub> | 4D <sub>HEX</sub> |

| Bit    | Name | Function                         | Default                |
|--------|------|----------------------------------|------------------------|
| D[7:1] | RSVD | Reserved                         | 0000000 <sub>BIN</sub> |
| D0     | EN   | Enable bit:<br>0 = OFF<br>1 = ON | 0 <sub>BIN</sub>       |

**Table 97. Voltage during Sleep State**

Settings for DCD0, DCD1, and DCD2. Use only if these DCDs are *not* SVID-controlled regulators.

| Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Initial Value     | Address           |
|---------------|-----|----|----|----|----|----|----|----|----|-------------------|-------------------|
| VSLEEP        | R/W |    |    |    |    |    |    |    |    | 47 <sub>HEX</sub> | 7B <sub>HEX</sub> |

| Bit    | Name   | Function  | Default                 |
|--------|--------|---|-------------------------|
| D[7:0] | VSLEEP | Vsleep voltage setting value; use the same table as VBOOT. Refer to Table 47. | 01000111 <sub>BIN</sub> |

### 7.17.5 Sleep State Inputs, Soft-Start-Done, and Reset Signals

**Table 98. Electrical Characteristics – SLP\_S4\_B, SLP\_S3\_B, SLP\_S0Ix\_B, SUSPWRDNACK, PLTRST\_B, THERMTRIP\_B**

Conditions unless otherwise specified:  $T_A = 25^\circ\text{C}$ . Note that these pins can support both the 1.8V and 3.3V SoC interfaces (up to 5.25V).

| Symbol   | Parameter          | Conditions | Minimum | Typical | Maximum | Units |
|----------|--------------------|------------|---------|---------|---------|-------|
| $V_{IL}$ | Input LOW Voltage  | –          | –       | –       | 0.65    | V     |
| $V_{IH}$ | Input HIGH Voltage | –          | 1.35    | –       | –       | V     |

**Table 99. Electrical Characteristics – RSMRST\_B, COREPWROK**

Conditions unless otherwise specified:  $T_A = 25^\circ\text{C}$ .

| Symbol     | Parameter           | Conditions                             | Minimum       | Typical | Maximum | Units |
|------------|---------------------|--|---------------|---------|---------|-------|
| VGPIO1     | Input Power Supply  | $C_{IN} = 1\mu\text{F}$                | 3.0           | 3.3     | 3.6     | V     |
| $V_{OL}$   | Output LOW Voltage  | –                                      | –             | –       | 0.40    | V     |
| $V_{OH}$   | Output HIGH Voltage | –                                      | VGPIO1 – 0.40 | –       | –       | V     |
| $I_{OL}$   | Output LOW Current  | –                                      | –             | 4.0     | –       | mA    |
| $I_{OH}$   | Output HIGH Current | –                                      | –             | 4.0     | –       | mA    |
| $t_{RISE}$ | Rise Time           | $C_L = 150\text{pF}$ , 10% to 90%, GBD | 10            | –       | 45      | ns    |
| $t_{FALL}$ | Fall Time           | $C_L = 150\text{pF}$ , 90% to 10%, GBD | 10            | –       | 45      | ns    |

**Table 100. Electrical Characteristics – VCCAPWROK, DRAMPWROK**

Conditions unless otherwise specified:  $T_A = 25^\circ\text{C}$ . Note that these pins can support an external pull-up voltage up to 5.25V.

| Symbol    | Parameter          | Conditions | Minimum | Typical | Maximum | Units |
|-----------|--------------------|------------|---------|---------|---------|-------|
| $V_{OL}$  | Output LOW Voltage | –          | –       | –       | 0.40    | V     |
| $I_{OL}$  | Output LOW Current | –          | –       | 12      | –       | mA    |
| $I_{LKG}$ | Leakage Current    | –          | –       | 100     | –       | nA    |

**Table 101. Electrical Characteristics – IRQ, SDWN\_B, MODEM\_OFF\_B, PWRBTN\_B**Conditions unless otherwise specified:  $T_A = 25^\circ\text{C}$ .

| Symbol     | Parameter           | Conditions                             | Minimum       | Typical | Maximum | Units |
|------------|---------------------|--|---------------|---------|---------|-------|
| VGPIO0     | Input Power Supply  | $C_{IN} = 1\mu\text{F}$                | 1.71          | 1.8     | 1.89    | V     |
| $V_{OL}$   | Output LOW Voltage  |  | –             | –       | 0.40    | V     |
| $V_{OH}$   | Output HIGH Voltage |  | VGPIO0 – 0.40 | –       | –       | V     |
| $I_{OL}$   | Output LOW Current  |  | –             | 4.0     | –       | mA    |
| $I_{OH}$   | Output HIGH Current |  | –             | 4.0     | –       | mA    |
| $t_{RISE}$ | Rise Time           | $C_L = 150\text{pF}$ , 10% to 90%, GBD | 10            | –       | 45      | ns    |
| $t_{FALL}$ | Fall Time           | $C_L = 150\text{pF}$ , 90% to 10%, GBD | 10            | –       | 45      | ns    |

**Table 102. Electrical Characteristics – PROCHOT\_B**Conditions unless otherwise specified:  $T_A = 25^\circ\text{C}$ .

| Symbol    | Parameter          | Conditions | Minimum | Typical | Maximum | Units |
|-----------|--------------------|------------|---------|---------|---------|-------|
| $V_{OL}$  | Output LOW Voltage |            | –       | –       | 0.40    | V     |
| $I_{OL}$  | Output LOW Current |            | –       | 12      | –       | mA    |
| $I_{LKG}$ | Leakage Current    |            | –       | 100     | –       | nA    |

## 7.18 I2C Interface

The P91E0 is a slave device only. It is designed to operate with a wide frequency range of 100kHz to 3.4MHz (Standard Mode and High-Speed Mode). The PMIC is accessed using a 7-bit addressing scheme. The P91E0 I2C slave is not allowed to stretch the clock and is capable of being multi-mastered in a debugging environment. The I2C bus is only used for non-latency critical register access and communication between the SoC and P91E0 and is active when PLTRST\_B is de-asserted. The I2C pins are open-drain and need pull-up resistors to a voltage in the range from 1.8 to 5.25V.

**Table 103. Electrical Specifications – I2C**Conditions unless otherwise specified  $T_A = 25^\circ\text{C}$ .

| Symbol         | Parameter               | Conditions              | Minimum             | Typical             | Maximum             | Units |
|----------------|-------------------------|-------------------------|---------------------|---------------------|---------------------|-------|
| $V_{DD}$       | Typical Pull-up Voltage |                         | 1.71                | 1.8                 | 1.89                | V     |
| $V_{IL}$       | Input LOW Voltage       |                         | –                   | $0.3 \times V_{DD}$ | –                   | V     |
| $V_{IH}$       | Input HIGH Voltage      |                         | $0.7 \times V_{DD}$ | –                   | –                   | V     |
| $V_{HYS}$      | Hysteresis              |                         | 0.1                 | –                   | –                   | V     |
| $V_{OL}$       | Output LOW Voltage      |                         | –                   | –                   | $0.2 \times V_{DD}$ | V     |
| $C_{PIN}$      | Capacitance             | SDA and SCL pins; GBD   | 2                   | –                   | 5                   | pF    |
| $t_{FALL\_HS}$ | $t_{FALL}$ – High Speed | 3.33Mb/s operation; GBD | 10                  | –                   | 40                  | ns    |
| $t_{FALL\_FS}$ | $t_{FALL}$ – Full Speed | 400Kb/s operation; GBD  | 20                  | –                   | 300                 | ns    |
| $t_R/t_F$      | Rise and Fall Times     | GBD                     | 30                  | –                   | 70                  | %     |

The P91E0 supports the standard I2C read and write functions. The configuration register space is one 256-byte partition. The P91E0 supports four 7-bit device addresses configurable via the PMIC\_ADR\_CONFIG bits[1:0] in the EXP2 register (92<sub>HEX</sub>; see Table 104). The address can be configured as 5E<sub>HEX</sub> (1011110<sub>BIN</sub>), 6E<sub>HEX</sub> (1101110<sub>BIN</sub>), 4F<sub>HEX</sub> (1001111<sub>BIN</sub>), or 77<sub>HEX</sub> (1110111<sub>BIN</sub>) to allow for cases where multiple P91E0s are used on the same board or other I2C address conflicts arise. Note that in 8-bit format (7 bits for the address and 1 bit for R/W), these addresses correspond to BC<sub>HEX</sub>, DC<sub>HEX</sub>, 9E<sub>HEX</sub>, and EE<sub>HEX</sub> for writes, and BD<sub>HEX</sub>, DD<sub>HEX</sub>, 9F<sub>HEX</sub>, and EF<sub>HEX</sub> for reads as shown in Table 105.

**Table 104. I2C Addresses Register**

| Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Initial Value     | Address           |
|---------------|-----|----|----|----|----|----|----|----|----|-------------------|-------------------|
| EXP2          | R/W |    |    |    |    |    |    |    |    | 00 <sub>HEX</sub> | 92 <sub>HEX</sub> |

| Bit    | Name            | Function  | Default               |
|--------|-----------------|---|-----------------------|
| D[7:2] | RSVD            | Reserved  | 000000 <sub>BIN</sub> |
| D[1:0] | PMIC_ADR_CONFIG | 7-bit device address configuration:<br>00 = 5E <sub>HEX</sub><br>01 = 6E <sub>HEX</sub><br>10 = 4F <sub>HEX</sub><br>11 = 77 <sub>HEX</sub> | 00 <sub>BIN</sub>     |

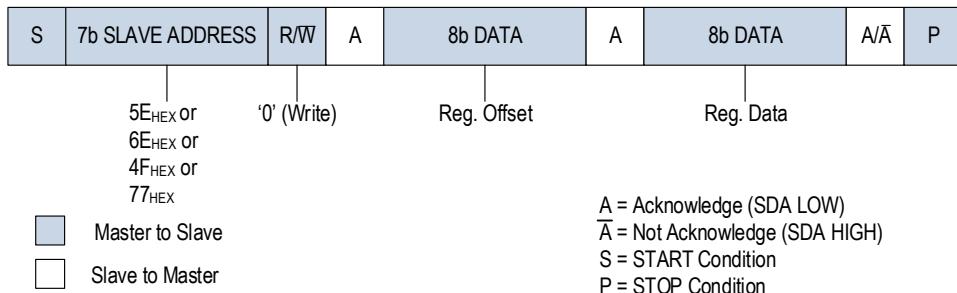
**Table 105. I2C Address Options**

| Address Option Selected by PMIC_ADR_CONFIG Bit Field | 7-Bit             | 8-Bit (Write)     | 8-Bit (Read)      |
|--|-------------------|-------------------|-------------------|
| Device 1   | 5E <sub>HEX</sub> | BC <sub>HEX</sub> | BD <sub>HEX</sub> |
| Device 2   | 6E <sub>HEX</sub> | DC <sub>HEX</sub> | DD <sub>HEX</sub> |
| Device 3   | 4F <sub>HEX</sub> | 9E <sub>HEX</sub> | 9F <sub>HEX</sub> |
| Device 4   | 77 <sub>HEX</sub> | EE <sub>HEX</sub> | EF <sub>HEX</sub> |

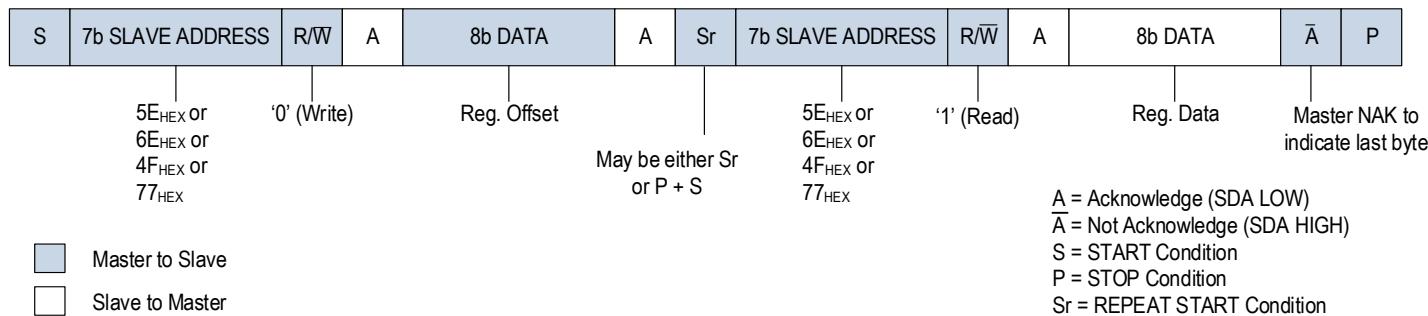
Reading data back from the P91E0 registers follows the “combined protocol” as described in the I2C specification in which the first byte written is the register offset to be read and the first byte read (after a repeat START condition) is the data from that register offset. Refer to Figure 4 and Figure 5 for details.

The following diagrams capture the different high-speed and fast-speed transaction format/protocol. Sequential offset accesses within a single transaction (“burst” reads and writes) are supported by the P91E0’s I2C module.

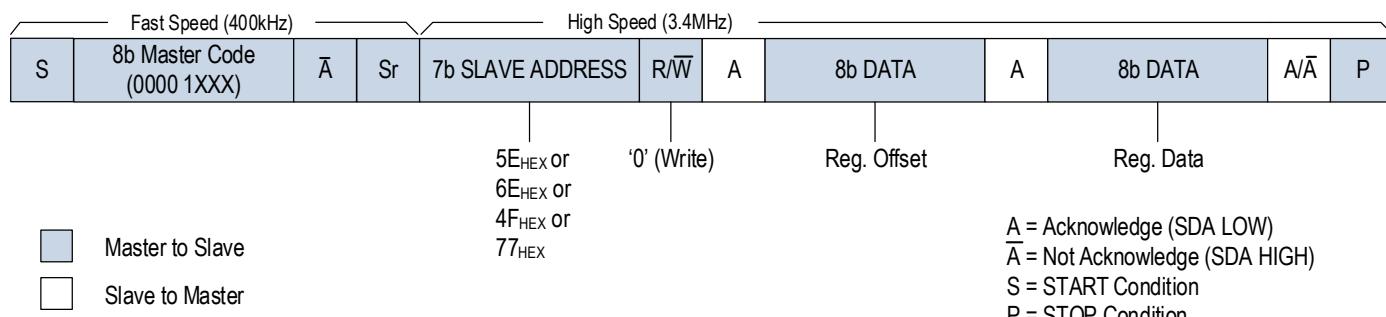
**Figure 4. I2C Fast Speed Write**



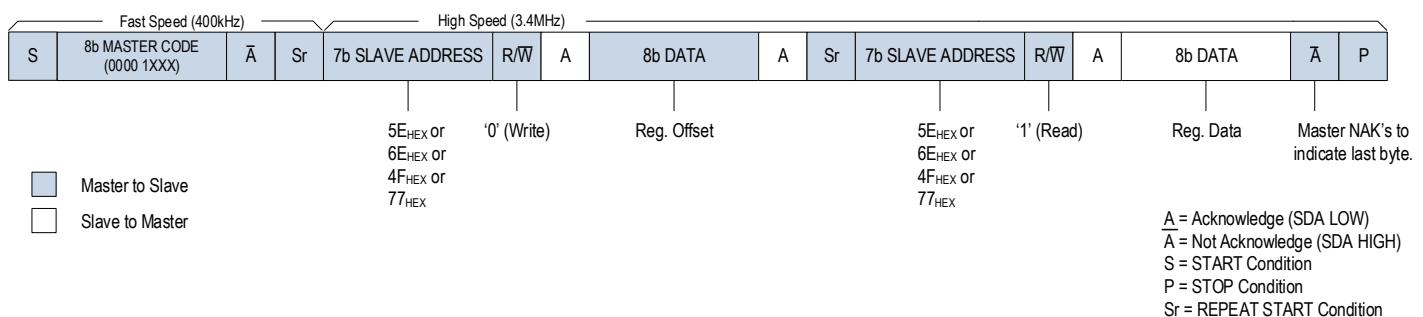
**Figure 5. I2C Fast Speed Read**



**Figure 6. I2C High Speed Write**



**Figure 7. I2C High Speed Read**



### 7.18.1 Register Requirements

Two read-only registers are provided to allow the customer to track the vendor and revision of their P91E0 chip as defined in Table 106 and Table 107.

**Table 106. Vendor Identification Register**

| Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Initial Value     | Address           |
|---------------|-----|----|----|----|----|----|----|----|----|-------------------|-------------------|
| VENDOR_ID     | R   |    |    |    |    |    |    |    |    | 28 <sub>HEX</sub> | 00 <sub>HEX</sub> |

**Table 107. Chip Revision Register**

| Register Name | R/W | D7 | D6   | D5 | D4           | D3 | D2 | D1           | D0 | Initial Value     | Address           |
|---------------|-----|----|------|----|--------------|----|----|--------------|----|-------------------|-------------------|
| REVISION      | R   |    | RSVD |    | MAJREV0[2:0] |    |    | MINREV0[2:0] |    | 02 <sub>HEX</sub> | 01 <sub>HEX</sub> |

| Bit    | Name         | Function   | Default            |
|--------|--------------|--|--------------------|
| D[7:6] | RSVD         | Reserved   | 00 <sub>BIN</sub>  |
| D[5:3] | MAJREV0[2:0] | Major Revision: The first stepping should start with '000' and increment by 1 for each new complete mask stepping.<br><br>000 = A                          100 = E<br>001 = B                          101 = F<br>010 = C                          110 = G<br>011 = D                          111 = H                                       | 000 <sub>BIN</sub> |
| D[2:0] | MINREV0[2:0] | Minor Revision: The first stepping should start with '000' and increment by 1 for each new metal layer stepping. Resets to '000' when MAJREV increments.<br><br>000 = 0                          100 = 4<br>001 = 1                          101 = 5<br>010 = 2                          110 = 6<br>011 = 3                          111 = 7 | 010 <sub>BIN</sub> |

## 7.19 Analog-to-Digital Converter (ADC)

The P91E0 includes a general purpose 10-bit analog-to-digital converter. It is used for measuring system voltages, die temperature, and regulator output currents, and it places the conversion results in the *RSLT* registers. Table 108 summarizes the various channels of the ADC.

**Table 108. ADC Channels**

| Channel | Description           | External Pins   | Signal Range         | RSLTh             | RSLTI             |
|---------|-----------------------|-----------------|----------------------|-------------------|-------------------|
| 1       | P91E0 Die Temperature | Internal        | -30°C to 125°C       | 7E <sub>HEX</sub> | 7F <sub>HEX</sub> |
| 2       | VSYS Voltage          | VSYS            | 3V to 5.525V         | 80 <sub>HEX</sub> | 81 <sub>HEX</sub> |
| 3       | System Voltage 0      | GPIO[10]/ADC[0] | 0 to 1.2V            | 74 <sub>HEX</sub> | 75 <sub>HEX</sub> |
| 4       | System Voltage 1      | GPIO[11]/ADC[1] | 0 to 1.2V            | 76 <sub>HEX</sub> | 77 <sub>HEX</sub> |
| 5       | System Voltage 2      | GPIO[12]/ADC[2] | 0 to 1.2V            | 78 <sub>HEX</sub> | 79 <sub>HEX</sub> |
| 6       | DCD0 Current          | Internal        | DCD0 maximum current | 84 <sub>HEX</sub> | 85 <sub>HEX</sub> |
| 7       | DCD1 Current          | Internal        | DCD1 maximum current | 86 <sub>HEX</sub> | 87 <sub>HEX</sub> |
| 8       | DCD2 Current          | Internal        | DCD2 maximum current | 8C <sub>HEX</sub> | 8D <sub>HEX</sub> |
| 9       | DCD5 Current          | Internal        | DCD5 maximum current | 88 <sub>HEX</sub> | 89 <sub>HEX</sub> |
| 10      | DCD6 Current          | Internal        | DCD6 maximum current | 8A <sub>HEX</sub> | 8B <sub>HEX</sub> |

[a] The alternate function of the pin must be enabled and the direction must be set to use the ADCx function.

### 7.19.1 Current Monitor

The switching regulators DCD0, DCD1, DCD2, DCD5, and DCD6 are monitored for output current. The current sensing is done internally with 100µs filtering. The filtered current is digitalized by using a 10-bit ADC (see section 7.19) and stored in 2 x 8 bits registers for each voltage rail in both SVID and I2C registers shown in 9.11.

**Table 109. Analog-to-Digital Converter Electrical Characteristics**

Conditions unless otherwise specified: T<sub>A</sub> = 25°C.

| Symbol                  | Parameter                 | Conditions             | MIN  | TYP  | MAX  | Units |
|-------------------------|---------------------------|------------------------|------|------|------|-------|
| V <sub>REF</sub>        | ADC Reference Voltage     | Internally provided    | –    | 1.2  | –    | V     |
| I <sub>DD(ADC)</sub>    | Supply Current            | Full-scale current     | –    | 60   | –    | µA    |
| RES                     | ADC Resolution            |                        | –    | 10   | –    | Bits  |
| INL                     | Integral Nonlinearity     | GBD                    | -2   | –    | +2   | LSB   |
| DNL                     | Differential Nonlinearity | GBD                    | -1   | –    | +1   | LSB   |
| Gain                    | Gain Error                | Midscale               | -1.2 | –    | +1.2 | %     |
| V <sub>MEAS(ADC)</sub>  | ADC Input Voltage         | External pins ADC[2:0] | 0    | –    | 1.2  | V     |
|                         |                           | VSYS                   | 0    | –    | 5.6  | V     |
| SF                      | Voltage Scale Factor      | External pins ADC[2:0] | –    | 1.0  | –    | V/V   |
|                         |                           | VSYS                   | –    | 3/14 | –    | V/V   |
| R <sub>IN(ADC[x])</sub> | ADC[2:0] Input Resistance |                        | –    | 10   | –    | MΩ    |

## 7.20 Power Buttons PWRBTNIN\_B and PMIC\_EN

The P91E0 offers two ways to trigger the system to power ON or OFF: the PMIC\_EN and PWRBTNIN\_B pins. It is recommended that only one power ON/OFF method is used, either with PWRBTNIN\_B or PMIC\_EN. If PWRBTNIN\_B is used, PMIC\_EN should be connected to GND. If PMIC\_EN is used to power the P91E0 ON/OFF, the PWRBTNIN\_B pin should be left floating (unconnected). However, the PWRBTNIN\_B pin is still monitored and will pass level changes to the PWRBTN\_B output. When the P91E0 is used with DPU(s), PWRBTNIN\_B (or PMIC\_EN when used) should not be asserted until the DPUs' input voltage is above their UVLO level.

### 7.20.1 PMIC Enable (PMIC\_EN)

PMIC\_EN is an active-HIGH signal and is usually driven by a system controller or power-good signal of a pre-regulator. After the PMIC\_EN pin has been asserted HIGH, the P91E0 powers on without delay and the rails are turned on following the programmed sequence. PMIC\_EN can be asserted HIGH above its  $V_{IH}$  after VSYS has reached a steady-state level and is above VSYSREF<sub>R</sub> (see Table 122). This can be achieved by adding an RC filter (e.g. 10kΩ and 1μF) from VSYS to the PMIC\_EN pin. De-asserting the PMIC\_EN signal initiates a shutdown of all rails, following the programmed shut-down sequence (Cold OFF). When the P91E0 is enabled with PMIC\_EN assertion, a de-assertion is required for the next re-enabled cycle after a shutdown event (due to faults or PWRBTNIN\_B held > 4s). To disable the rails, pull PMIC\_EN below its  $V_{IL}$  for a time equal to the Cold OFF duration. The  $V_{IL}$  and  $V_{IH}$  thresholds for various VSYS input voltages ( $\pm 10\%$  tolerance included) are listed in Table 110.

**Table 110.  $V_{IL}$  and  $V_{IH}$  Levels for PMIC\_EN for Various VSYS Input Voltages**

| VSYS Input Voltage (V) | PMIC_EN $V_{IL}$ (V) | PMIC_EN $V_{IH}$ (V) |
|------------------------|----------------------|----------------------|
| 3.3                    | 0.60                 | 1.35                 |
| 4.0                    | 0.70                 | 1.50                 |
| 5.0                    | 0.80                 | 1.70                 |

### 7.20.2 Power Button Input (PWRBTNIN\_B) and Power Button Output (PWRBTN\_B)

The power button pin (PWRBTNIN\_B) is an active-LOW input to the P91E0. It is internally connected to VSYS through a weak pull-up current source (50μA,  $\pm 10\%$ ). It includes a 30ms de-bouncing circuit to ensure that spurious transitions are not logged while the switch contacts bounce on initial contact. The output of the de-bouncing circuit enters the edge-detect circuits. A falling edge below  $V_{IL}$  can trigger a transition out of the SoC-G3 State. This pin is usually connected through a push-button switch to ground (below  $V_{IL}$ ). Pressing the PWRBTNIN\_B button longer than 36ms (30ms typical) will turn on the P91E0. If the P91E0 is powered-on, holding down the power button for longer than 4.24 seconds (for the default setting of 4 seconds) will force a Cold OFF. The LOW ( $V_{IL}$ ) and HIGH ( $V_{IH}$ ) thresholds of PWRBTNIN\_B depend on VSYS for the Normal Power Mode of operation as shown in Table 111 with the thresholds for the Debug Mode (special entry mode before rails are powered up).

**Table 111.  $V_{IL}$  and  $V_{IH}$  Levels for PWRBTNIN\_B**

| Operating Mode    | PWRBTNIN_B $V_{IL}$ (V) | PWRBTNIN_B $V_{IH}$ (V) |
|-------------------|-------------------------|-------------------------|
| Normal Power Mode | $0.19 \times V_{SYS}$   | $0.81 \times V_{SYS}$   |
| Debug Mode        | $0.69 \times V_{SYS}$   | $0.81 \times V_{SYS}$   |

The output of the de-bouncing circuit also goes to the timer logic block that measures the length of time that the power button has been held down, and this value can be read from the hold time field (PBHT[3:0]) in the PBSTATUS register (see Table 113). The P91E0 always passes the power button information via the output signal PWRBTN\_B to the SoC. The PWRBTN\_B pin is a level-shifted copy of PWRBTNIN\_B after the 30ms de-bouncing circuit. PWRBTN\_B is valid when control signal RSMRST\_B = 1 (de-asserted).

If the system is off (SoC-G3 state), pressing the power button by itself for greater than 36ms (30ms typical) will cause the PMIC to turn on all the "A" type rails, de-assert RSMRST\_B (PWRBTN\_B should be HIGH before this), and pass the power button information to the SoC. If the system is on (SoC-S4/S5, SoC-S3, SoC-S0lx, and SoC-S0 states), pressing this button will cause the P91E0 to pass a level-shifted copy of PWRBTNIN\_B (via PWRBTN\_B) after the 30ms de-bouncing circuit to the SoC, which will initiate actions for the P91E0 to perform.

### 7.20.3 Forcing a Cold OFF using the Power Button

The signal from the power button is fed into a fault timer which measures the time from when the button is pressed until it is released. This duration (in half-seconds) can be read from the hold time bit field, PBHT[3:0]. The timer retains this value until the next time both buttons are pressed simultaneously, or if the timer logic is reset by the CLRHT bit in the PBCONFIG register (see Table 112).

The P91E0 triggers a Cold OFF if the fault timer exceeds the duration set in the fault time field (FLT[3:0]) in the PBCONFIG register with a default setting of 4 seconds (4.24 seconds to include margin). If enabled (FLT is not equal to 0<sub>HEX</sub>), the power-down logic compares the hold time bits to the fault time bits and forces a Cold OFF upon a match.

If software control is desired, FLT can be set to 0<sub>HEX</sub> during the P91E0 initialization, but this default will allow a forced power-down if for some reason the software cannot boot properly. Software must set the CLRHT bit in PBCONFIG before updating FLT to prevent the fault condition from possibly triggering immediately from a previous value.

### 7.20.4 Configuration Registers

**Table 112. Power Button Configuration Register**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6 | D5    | D4     | D3       | D2 | D1 | D0 | Initial Value     | Address           |
|---------------|-----|------|----|-------|--------|----------|----|----|----|-------------------|-------------------|
| PBCONFIG      | R/W | RSVD |    | CLRHT | CLRFLT | FLT[3:0] |    |    |    | 08 <sub>HEX</sub> | 26 <sub>HEX</sub> |

| Bit    | Name     | Function   | Default             |
|--------|----------|--|---------------------|
| D[7:6] | RSVD     | Reserved   | 00 <sub>BIN</sub>   |
| D[5]   | CLRHT    | This bit is self-clearing and always reads 0:<br>0 = No action performed.<br>1 = Reset the HT timer logic.   | 0 <sub>BIN</sub>    |
| D[4]   | CLRFLT   | This bit is self-clearing and always reads 0:<br>0 = No action performed.<br>1 = Reset the FLT timer logic.  | 0 <sub>BIN</sub>    |
| D[3:0] | FLT[3:0] | Time that the power button has to be held down, in half-second intervals, before a system shut-down is triggered. Recommendation: Hold down the power button with an additional time duration of 6% from the setting.<br>0000 = Disabled.<br>0001 = 0.5 second.<br>0010 = 1.0 seconds.<br>0011 = 1.5 seconds.<br>0100 = 2 seconds.<br>...<br>1111 = 7.5 seconds. | 1000 <sub>BIN</sub> |

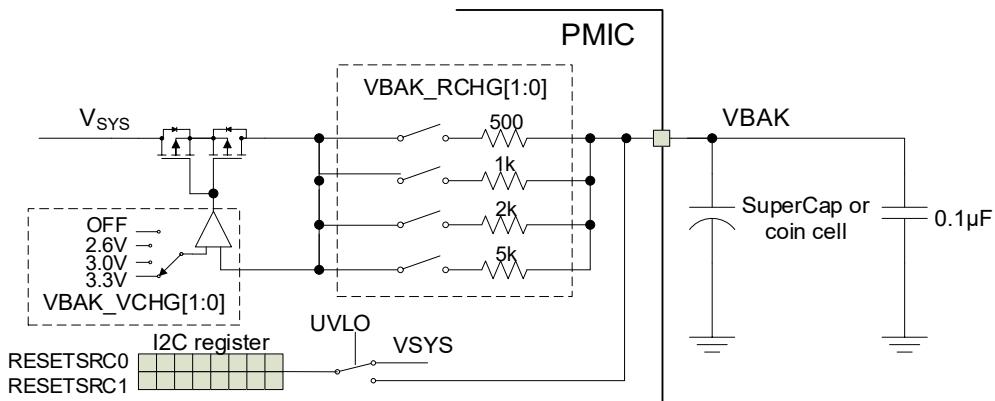
**Table 113. Power Button Status Register**

| Register Name | R/W | D7 | D6   | D5 | D4    | D3 | D2        | D1 | D0 | Initial Value     | Address           |
|---------------|-----|----|------|----|-------|----|-----------|----|----|-------------------|-------------------|
| PBSTATUS      | R/W |    | RSVD |    | PBLVL |    | PBHT[3:0] |    |    | 10 <sub>HEX</sub> | 27 <sub>HEX</sub> |

| Bit    | Name  | Function   | Default             |
|--------|-------|--|---------------------|
| D[7:5] | RSVD  | Reserved   | 000 <sub>BIN</sub>  |
| D[4]   | PBLVL | 0 = Power button pressed.<br>1 = Power button released.  | 1 <sub>BIN</sub>    |
| D[3:0] | PBHT  | Time that the power button has been held down, in half-second intervals:<br>0000 = 0 seconds.<br>0001 = 0.5 second.<br>0010 = 1.0 seconds.<br>0011 = 1.5 seconds.<br>0100 = 2 seconds.<br>...<br>1111 = 7.5 seconds. | 0000 <sub>BIN</sub> |

## 7.21 VBAK Charger

The P91E0 is capable of charging an external super cap or coin cell. The charger output is on the VBAK pin. The VBAK voltage domain powers two PMIC-internal registers which store system events, such as over-temperature shutdown or UVLO shutdown, and the charger configuration VBAK\_VCHG and VBAK\_RCHG. See Table 140.

**Figure 8. VBAK Charger Block Diagram**

If VSYS is disconnected and below the UVLO threshold, VBAK is powered by the SuperCap or coin cell and will retain information until the battery or SuperCap voltage on VBAK drops below 0.8V and stored data is reset.

The charger output remains active after the P91E0 enters SoC-G3 state; however, after the system exits SoC-G3 via PWRBTNIN\_B, the charger registers VBAK\_VCHG and VBAK\_RCHG are reset and must be re-enabled via I2C.

**Table 114. Electrical Characteristics – VBAK**

$V_{SYS} = 5.0V$ ,  $C_O = 1\mu F$ ,  $T_J = -40^{\circ}C$  to  $+125^{\circ}C$ , unless otherwise noted. Typical values are at  $+25^{\circ}C$ .

| Symbol         | Parameter                   | Conditions  | MIN  | TYP      | MAX | Units    |    |
|----------------|-----------------------------|---|------|----------|-----|----------|----|
| $V_{O(BAK)}$   | Output Voltage Setting      | VBAK_VCHG[1:0] = 00<br>in the RESETSRC1 register<br>(see Table 140)               |      | Disabled |     | V        |    |
|                |                             | VBAK_VCHG[1:0] = 01   |      | 2.6      |     |          |    |
|                |                             | VBAK_VCHG[1:0] = 10   |      | 3.0      |     |          |    |
|                |                             | VBAK_VCHG[1:0] = 11   |      | 3.3      |     |          |    |
| $I_{SHDN}$     | Shutdown Current            |   |      | 790      |     | $\mu A$  |    |
|                | Regulation Voltage Accuracy |   | -2   |          | +2  | %        |    |
| $R_{CHG(BAK)}$ | Internal Series Resistance  | VBAK_RCHG[1:0] = 00<br>in the RESETSRC1 register<br>(see Table 140)               |      | 500      |     | $\Omega$ |    |
|                |                             | VBAK_RCHG[1:0] = 01   |      | 1k       |     |          |    |
|                |                             | VBAK_RCHG[1:0] = 10   |      | 2k       |     |          |    |
|                |                             | VBAK_RCHG[1:0] = 11   |      | 5k       |     |          |    |
| $I_{LIM(BAK)}$ | Maximum Output Current      | VBAK_VCHG[1:0]<br>( $V_{SYS} = 3.5V$ to $5.25V$<br>$VBAK_RCHG[1:0] = 500\Omega$ ) | 2.6V | 0.95     | 1.1 | 1.25     | mA |
|                |                             |   | 3.0V | 1.65     | 1.9 | 2.15     |    |
|                |                             |   | 3.3V | 2.15     | 2.5 | 2.85     |    |

## 8. Theory of Operation

Also see section 6 for an overview of P91E0 PMIC operation.

### 8.1 Control Signals

#### 8.1.1 RSMRST\_B

The resume reset is an output signal. When all A-rails are switched on and are in regulation, the RSMRST\_B pin is pulled HIGH to VGPIO1 (3.3V). RSMRST\_B is pulled LOW when the A-rails regulators are powered down and the device enters SoC-G3 State.

#### 8.1.2 DRAMPWROK

DRAMPWROK is an open-drain output signal. The DRAMPWROK pin is pulled HIGH when DCD2 (SOC VDDQ rail) is above 90% of its regulating voltage during the soft-start process. DRAMPWROK is logic LOW when DCD2 is shutdown.

#### 8.1.3 VCCAPWROK

VCCAPWROK is an active-HIGH open-drain output signal. The VCCAPWROK pin asserts when the soft-start sequences for all the voltage rails assigned to be on in the S0Ix and S0 groups are completed with the delay defined by the DTPWROK bit field in the *PWRSEQCFG* register (2A<sub>HEX</sub>; see Table 83) from the first assertion of the last event defined in the SX group (i.e., timing group number 14). VCCAPWROK de-asserts without delay in the S3 state. The nominal voltage of VCCAPWROK is HIGH when asserted and 0V when de-asserted.

#### 8.1.4 COREPWROK

COREPWROK is an active-HIGH dedicated output signal. The COREPWROK pin asserts when the soft-start sequences for all the voltage rails assigned to be on in the S0Ix and S0 groups are completed with the delay defined by the DTPWROK bit field in the *PWRSEQCFG* register (2A<sub>HEX</sub>; see Table 83) from the first assertion of the last event defined in the SX group (i.e., timing group number 14). COREPWROK de-asserts without delay in the S3 state. The nominal voltage of COREPWROK is VGPIO1 (3.3V) when asserted, 0V when de-asserted. COREPWROK does not de-assert in the S0Ix state.

#### 8.1.5 Shallow Sleep State (SLP\_S0Ix\_B)

SLP\_S0Ix\_B is an input signal from the SoC indicating Shallow Sleep State. When the SLP\_S0Ix\_B pin is pulled LOW, the SoC launches the Shallow Sleep State entry task list. All the active SX-type switching regulators are placed in the Power Save Mode as defined for the S0Ix state. Prior to initiating the Shallow Sleep State entry, the SoC will program exit VID values for VCC over SVID and communicate Standby State information to the PMIC over I2C.

#### 8.1.6 Sleep State 3 (SLP\_S3\_B)

SLP\_S3\_B is a dedicated input pin for enabling and disabling the low-power Sleep State 3. When SLP\_S3\_B is pulled LOW, Sleep State 3 is initiated, and all S-type rails are turned off according the timing diagram. Prior to activating this sleep state, the SoC will program the exit VID values for VCC/VNN over SVID and communicate standby state information to the P91E0 via I2C. It is valid when RSMRST\_B = 1 (i.e., de-asserted) regardless of the SLP\_S0Ix\_B state. In the previous SoC and PMIC generations, SLP\_S0Ix\_B is required to be asserted before asserting SLP\_S3\_B LOW. For P91E0 if SLP\_S3\_B=0 (asserted) while SLP\_S0Ix\_B=1 (de-asserted), then the SX-type rails will be sequenced off first followed by the S-type rails.

#### 8.1.7 Deep Sleep State (SLP\_S4\_B)

SLP\_S4\_B is a dedicated input pin for enabling and disabling the Deep Sleep State. When pulled LOW, Deep Sleep State is initiated, and all U-type rails are turned off according the timing diagram. Prior to activating the Deep Sleep State, the SoC will program exit VID values for VCC/VNN via SVID and communicate Standby State information to the P91E0 via I2C. SLP\_S4\_B is valid when the pins RSMRST\_B = 1 (de-asserted) and SLP\_S3\_B = 0 (asserted). If SoC asserts SLP\_S# signals simultaneously, P91E0 will operate in sequential order following the configuration setting.

### 8.1.8 Platform Reset (PLTRST\_B)

Platform reset pin is an input signal from the SoC that indicates the SoC has already come out of reset upon de-assertion (PLTRST\_B = 1). The nominal voltage of the PLTRST\_B pin is 0V when asserted, 1.8V when de-asserted.

### 8.1.9 Suspend Power-Down Acknowledgement (SUSPWRDNACK)

Suspend Power-Down Acknowledgement is an input signal from the SoC on the SUSPWRDNACK pin telling the PMIC to turn off all A-type rails. It is valid when RSMRST\_B = 1 (de-asserted) and SLP\_S4 = 0 (asserted). The nominal voltage of SUSPWRDNACK is 1.8V when asserted and 0V when de-asserted.

### 8.1.10 Interrupt Request (IRQ)

The interrupt request is an output signal generating interrupts to the SoC. It is pulled HIGH when at least one unmasked interrupt bit is set in the *IRQLVL1* level 1 interrupt register (02<sub>HEX</sub>; see Table 142). It is valid when RSMRST\_B = 1 (de-asserted). IRQ is pulled HIGH to VPGIO0 (1.8V nominal) and 0V when pulled LOW. The maximum latency from the IRQ detection to the assertion of the IRQ line is 1ms. Refer to section 9.6 for further details.

### 8.1.11 Thermal Trip (THERMTRIP\_B)

THERMTRIP\_B is an active-LOW dedicated input signal that notifies the P91E0 of an SoC thermal event. The THERMTRIP\_B pin status is valid when RSMRST\_B = 1 and PLTRST\_B = 1 (de-asserted). The nominal voltage of THERMTRIP\_B is 0V when asserted, 1.8V when de-asserted. Upon sensing that the THERMTRIP\_B signal has transitioned LOW, the P91E0 must shut down all rails immediately (hard shutdown, not executing a Cold-Off task list). To avoid spurious detection during power sequencing, the THERMTRIP\_B signal is only to be sampled if PLTRST\_B is de-asserted.

### 8.1.12 Processor HOT (PROCHOT\_B)

PROCHOT\_B is an active-LOW, open-drain output signal used to notify the SoC of a thermal event affecting the P91E0, battery, or system. The PROCHOT\_B pin will be asserted when the P91E0 temperature, battery temperature, or system temperature has crossed the alert thresholds defined in the thermal monitoring section. It is valid when RSMRST\_B = 1 and PLTRST\_B = 1 (de-asserted). The nominal voltage of PROCHOT\_B is 0V when asserted and 1.8V when de-asserted. The SoC must go into a lower power state until the P91E0 thermal event is cleared and the pin is de-asserted.

### 8.1.13 Shutdown Warning (SDWN\_B)

The shut-down warning is an output signal sent from P91E0 to the modem as a warning that a system shut-down event is about to take place. During power down task lists, the SDWN\_B pin is pulled to ground. If the power-down is not initiated, the output signal is pulled HIGH (1.8V).

If the P91E0 enters a catastrophic shutdown condition that would normally bypass a Cold OFF Task List being run, the SDWN\_B pin is asserted a minimum of 90μs prior to this catastrophic shutdown commencing.

The nominal voltage of SDWN\_B is 0V when asserted and pulled HIGH to VPGIO0 (1.8V) when de-asserted.

## 8.2 SVID Interface

**Table 115. Electrical Characteristics – SVID\_CLK, SVID\_DIO, SVID\_ALERT\_B**

Conditions unless otherwise specified:  $T_A = 25^\circ\text{C}$ .

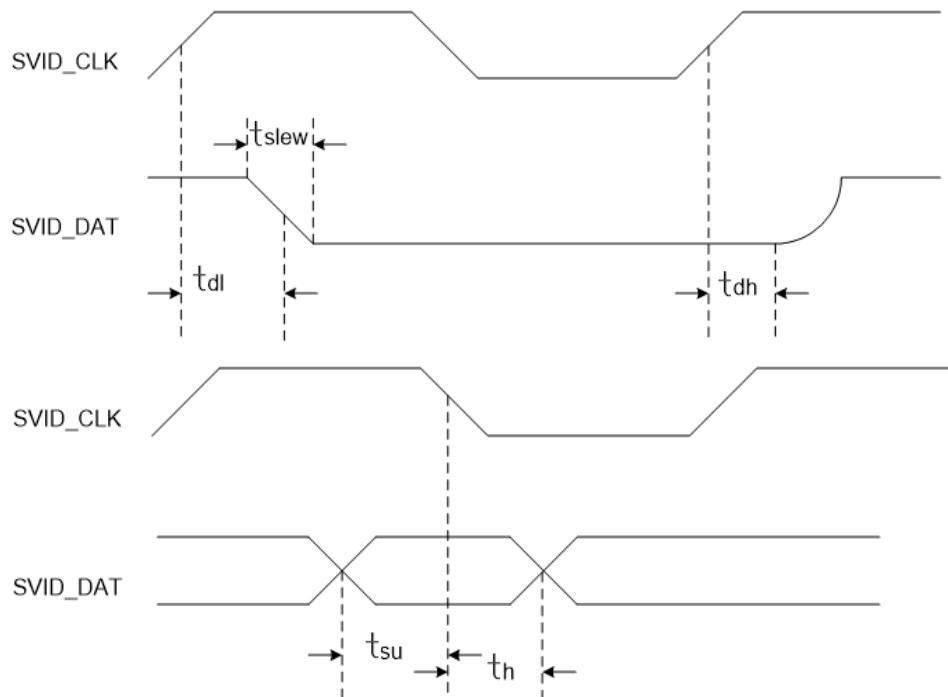
| Symbol           | Parameter          | Conditions                      | MIN    | TYP  | MAX   | Units |
|------------------|--------------------|---------------------------------|--------|------|-------|-------|
| V <sub>CC</sub>  | I/O Voltage        | –                               | 1.0    | 1.05 | 1.1   | V     |
| V <sub>OL</sub>  | Output Voltage LOW | ILOAD = 3mA                     | –      | –    | 0.367 | V     |
| V <sub>IL</sub>  | Input LOW Voltage  | V <sub>CC</sub> = 1.05V nominal | –      | –    | 0.451 | V     |
| V <sub>IH</sub>  | Input HIGH Voltage | V <sub>CC</sub> = 1.05V nominal | 0.6825 | –    | –     | V     |
| I <sub>LKG</sub> | Leakage Current    | V <sub>CC</sub> = 1.08V         | –      | 100  | –     | nA    |

**Table 116. SVID Signal Group AC Specification**

Note: Measure at  $0.5 \times V_{CC}$ , with  $30\text{pF}$  test load,  $R_{PU} = 85\Omega$ , and series  $R = 20\Omega$ .

| Symbol            | Parameter                             | MIN | TYP | MAX | Units |
|-------------------|---------------------------------------|-----|-----|-----|-------|
| t <sub>slew</sub> | TX pad Slew Rate                      | 2.9 | 2.9 | 3.1 | ns    |
| t <sub>dl</sub>   | Tx Rising Clock to Data Output Delay  | 3.2 | 6.7 | 7.3 | ns    |
| t <sub>dh</sub>   | Tx Falling Clock to Data Output Delay | 5.5 | 5.7 | 5.8 | ns    |
| t <sub>su</sub>   | Rx Data Setup Time to CLK Rising Edge | 6   | –   | –   | ns    |
| t <sub>h</sub>    | Rx Data Hold Time to CLK Rising Edge  | 4   | –   | –   | ns    |

**Figure 9. Tx Timing (SVID)**



### 8.2.1 Serial Voltage Identification (SVID)

To dynamically adjust the voltage settings of the SoC rails, the SoC communicates with the P91E0 through the SVID interface. The SVID commands comprise 9 bits: 4 MSBs determine the address and 5 LSBs are the command bits. The P91E0 supports 3 SVID-controlled voltage regulators: DCD0, DCD1, and DCD2. The SVID address of each voltage regulator can be changed via OTP setting or an I2C register write.

**Table 117. SVID\_EN – SVID EN Setting for DCD0/DCD1/DCD2**

| Register Name | R/W | D7 | D6   | D5 | D4 | D3        | D2        | D1        | D0                | Initial           | Address |
|---------------|-----|----|------|----|----|-----------|-----------|-----------|-------------------|-------------------|---------|
| S0Ix_EN       | R/W |    | RSVD |    |    | S0Ix_DCD2 | S0Ix_DCD1 | S0Ix_DCD0 | 00 <sub>HEX</sub> | AB <sub>HEX</sub> |         |

| Bit    | Name      | Function  | Default              |
|--------|-----------|---|----------------------|
| D[7:3] | RSVD      | Reserved  | 00000 <sub>BIN</sub> |
| D[2]   | S0Ix_DCD2 | SVID=0:<br>0 = No Sleep Mode support<br>1 = Rail slews to lower voltage in Sleep Mode<br>SVID=1:<br>0 = No S0Ix Mode support<br>1 = Rail slews to lower voltage defined in VID_S0Ix (SVID domain) | 0 <sub>BIN</sub>     |
| D[1]   | S0Ix_DCD1 | SVID=0:<br>0 = No Sleep Mode support<br>1 = Rail slews to lower voltage in Sleep Mode<br>SVID=1:<br>0 = No S0Ix Mode support<br>1 = Rail slews to lower voltage defined in VID_S0Ix (SVID domain) | 0 <sub>BIN</sub>     |
| D[0]   | S0Ix_DCD0 | SVID=0:<br>0 = No Sleep Mode support<br>1 = Rail slews to lower voltage in Sleep Mode<br>SVID=1:<br>0 = No S0Ix Mode support<br>1 = Rail slews to lower voltage defined in VID_S0Ix (SVID domain) | 0 <sub>BIN</sub>     |

**Table 118. SVID\_ID – SVID ID Setting for DCD0/DCD1/DCD2**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7   | D6 | D5           | D4           | D3           | D2 | D1 | D0 | Initial Value     | Address |
|---------------|-----|------|----|--------------|--------------|--------------|----|----|----|-------------------|---------|
| SVID_ID       | R/W | RSVD |    | SVID_ID_DCD2 | SVID_ID_DCD1 | SVID_ID_DCD0 |    | 00 |    | AC <sub>HEX</sub> |         |

| Bit    | Name         | Function   | Default           |
|--------|--------------|--|-------------------|
| D[7:6] | RSVD         | Reserved   | 00 <sub>BIN</sub> |
| D[5:4] | SVID_ID_DCD2 | DCD2 SVID address:<br>00 <sub>BIN</sub> = 2 <sub>HEX</sub> (default)<br>01 <sub>BIN</sub> = 0 <sub>HEX</sub><br>10 <sub>BIN</sub> = 1 <sub>HEX</sub><br>11 <sub>BIN</sub> = 3 <sub>HEX</sub> | 00 <sub>BIN</sub> |
| D[3:2] | SVID_ID_DCD1 | DCD1 SVID address:<br>00 <sub>BIN</sub> = 1 <sub>HEX</sub> (default)<br>01 <sub>BIN</sub> = 0 <sub>HEX</sub><br>10 <sub>BIN</sub> = 2 <sub>HEX</sub><br>11 <sub>BIN</sub> = 5 <sub>HEX</sub> | 00 <sub>BIN</sub> |
| D[1:0] | SVID_ID_DCD0 | DCD0 SVID address:<br>00 <sub>BIN</sub> = 0 <sub>HEX</sub> (default)<br>01 <sub>BIN</sub> = 1 <sub>HEX</sub><br>10 <sub>BIN</sub> = 3 <sub>HEX</sub><br>11 <sub>BIN</sub> = 4 <sub>HEX</sub> | 00 <sub>BIN</sub> |

### 8.2.2 Serial Voltage Identification (SVID) Command Set

DCD0, DCD1, and DCD2 implement the VR12.1/IMVP8 SVID protocol. Table 119 lists the SVID command set supported by the P91E0.

Note: Refer to Intel's Serial VID (SVID) protocol specification for details.

**Table 119. Serial Voltage Identification (SVID) Command Set**

| #                 | Command   | Master Payload Contents                              | Slave Payload Contents      | Description  |
|-------------------|---|--|-----------------------------|--|
| 01 <sub>HEX</sub> | SetVID-fast (individual address and all call addresses)     | VID code   | NA                          | Applicable for DCD0, DCD1 and DCD2. This command sets the new VID target; the voltage regulator (VR) jumps to the new VID target with a controlled (up or down) slew rate programmed by the VR. When the VR receives a VID command to increase the voltage, it will exit all low-power states and enter the normal state to ensure the fastest slew rate to the new voltage.<br>The VR sets the VR_settled bit [D0] in the <i>Status_1</i> register for SVID (see Table 121) and issues an alert when the VR has reached the new VID target. |
| 02 <sub>HEX</sub> | SetVID-slow (individual address and all call addresses)     | VID code   | NA                          | Applicable for DCD0, DCD1 and DCD2. This command sets the VID target; the VR jumps to the new VID target with a controlled slew rate (up or down) programmed by the VR. When VR receives a VID command to increase the voltage, it will exit all low-power states and enter the normal state. The VR sets the VR_settled bit and issues an alert when VR has reached the new VID target. An SVID read back of the Slow_Rate bit field in the <i>Slew Rate Slow</i> register (25 <sub>HEX</sub> ) (see Table 120) is always 2.5mV/μs.         |
| 03 <sub>HEX</sub> | SetVID-decay (individual address and all call addresses)    | VID code   | NA                          | Applicable for DCD0, DCD1 and DCD2. This command sets the VID target; the VR jumps to the new VID target but <i>does not</i> control the slew rate. The output voltage decays at a rate proportional to the load current. SetVID-decay is only used in the VID down direction and implies VR enters the PS2 State. The VR sets the VR_settled bit [D0] in the <i>Status_1</i> SVID register, and the SVID_ALERT_B pin is asserted for SetVID-decay.  |
| 04 <sub>HEX</sub> | SetPS   | Byte indicating the power status of the voltage rail | NA                          | Applicable for DCD0, DCD1 and DCD2. The SoC uses this command to set the power state of the VR according to the core P-state and C-state so that the VR controller can be configured to improve efficiency, especially at light loads.   |
| 05 <sub>HEX</sub> | SetRegADR (individual address only; NAK all call addresses) | Address of the index in the data table               | NA                          | Sets the address pointer in the data register table. Typically the next command, SetRegDAT, is the payload that gets loaded into this address. However for multiple writes to the same address, only one SetRegADR is needed.  |
| 06 <sub>HEX</sub> | SetRegDAT (individual address only; NAK all call addresses) | New data register contents                           | NA                          | Writes the contents to the data register that was previously identified by the address pointer with SetRegADR.   |
| 07 <sub>HEX</sub> | GetReg (individual address only; NAK all call addresses)    | Define which register                                | Specified register contents | Slave returns the contents of the specified register as the payload. The majority of the VR monitoring data is accessed through the GetReg command.  |

### 8.2.3 VR 12.1 Compatibility

The P91E0 has been developed according to the VR12.0 specification but does support the VR12.1 extension with the IMVP8 features required for the Intel® “Apollo Lake” SoC. Table 120 documents the implementation.

**Table 120. VR12.1 Compliance**

Note: In the following table, R = required, O = optional, Yes = supported, and No = not supported.

| Feature   | VR12.1                   | P91E0          | Notes   |
|---|--------------------------|----------------|---|
| VID 0.25-1.52V                                  | R                        | 0.25V to 1.30V | 0.5V to 1.30V according to the Apollo Lake Specification.   |
| Dynamic VID Fast                                | R                        | Yes            | Minimum or target slew rate.  |
| Dynamic VID Slow                                | R                        | Yes            | Minimum or target slew rate.  |
| Decay Slew Rate                                 | R                        | Yes            |   |
| Voltage Settled                                 | R                        | Yes            |   |
| PS0/PS1 VR Power States                         | R                        | Yes            | Normal Power Mode.  |
| PS2 - VR Power State                            | R                        | Yes            | Very Low Power Mode.  |
| PS3 - VR Power State                            | R                        | Yes            | Ultra-Low Power State.  |
| PS4 - VR Power State                            | R                        | Yes            | Near Off Mode.  |
| Temperature Maximum                             | O                        | Yes            | OTP or pin programmed; read by master; supports temperature zones and the VR_HOT trip point (the VR_HOT pin is equivalent to the PROCHOT_B pin on the P91E0).                               |
| Temperature Sensor Input                        | R                        | Yes            | Rails that support turbo must have temperature sensor inputs.   |
| DCLL  | R                        | Yes            | Register support for OTP programming of DCLL is optional. However, DCLL programmability is required.  |
| Enable  | R                        | Yes            | VR enable.  |
| VR Ready  | R                        | Yes            | Single-phase output ready.  |
| VR_Hot#   | R                        | Yes            | Active-LOW thermal monitor output, utilizing either temperature sensor input.   |
| Address   | R                        | Yes            | OTP or pin programmed.  |
| Capability (06 <sub>HEX</sub> )                 | 1xxx xxx1 <sub>BIN</sub> | Yes            |   |
| Icc_Max (21 <sub>HEX</sub> )                    | R                        | Yes            | Must be programmed by the platform designer to reflect the capability of the platform. The default 00 <sub>HEX</sub> indicates this value is not programmed and the platform will not boot. |
| Temp_Max (22 <sub>HEX</sub> )                   | O                        | No             |   |
| Slew Rate Fast (24 <sub>HEX</sub> )             | R                        | Yes            | Indicate the slew-rate fast capability of the VR.   |
| Slew Rate Slow (25 <sub>HEX</sub> )             | R                        | Yes            | Indicate the slew-rate slow capability of the VR.   |
| Vboot (26 <sub>HEX</sub> )                      | R                        | Yes            | OTP or pin programmed; not read by the master. The PWM must support various VBOOT levels.   |
| VR Tolerance (27 <sub>HEX</sub> )               | O                        | No             | Optional read by master.  |
| Current Calibration Offset (28 <sub>HEX</sub> ) | O                        | No             | OTP or pin programmed; not read by master; used in PWM only.  |

| Feature                                   | VR12.1 | P91E0 | Notes  |
|---|--------|-------|--|
| Temp Calibration (29 <sub>HEX</sub> )     | O      | No    | OTP or pin programmed; not read by master; used in PWM only. |
| Vout Max (30 <sub>HEX</sub> )             | R      | Yes   | Programmed by master.  |
| Voltage Offset (33 <sub>HEX</sub> )       | R      | Yes   | Programmed by master.  |
| Iout (15 <sub>HEX</sub> )                 | R      | Yes   | Read by master.  |
| VR Temperature (17 <sub>HEX</sub> ) (ADC) | O      | No    | Read by master.  |
| Output Voltage (16 <sub>HEX</sub> ) (ADC) | O      | No    | Read by master.  |
| Output Power (18 <sub>HEX</sub> ) (ADC)   | O      | No    | Read by master.  |
| Temperature Zone (12 <sub>HEX</sub> )     | R      | Yes   | Read by master.  |
| Multi VR Config (34 <sub>HEX</sub> )      | R      | Yes   |  |

Table 121 lists the SVID register set and the corresponding I2C register supported by the P91E0 for DCD0, DCD1, and DCD2.

For details of SVID specification, refer to Intel's specification.

**Table 121. Serial Voltage Identification (SVID) Register Set**

Note: See important notes at the end of the table.

| SVID Register     | I2C Register   | Register         | Description  | Access (SOC) | Default           |
|-------------------|--|------------------|--|--------------|-------------------|
| 00 <sub>HEX</sub> | 00 <sub>HEX</sub>  | Vendor ID        | Uniquely identifies the VR vendor (IDT). The vendor ID is assigned by Intel. This register is mandatory and the VR must return the assigned vendor ID. | Read Only    | 28 <sub>HEX</sub> |
| 01 <sub>HEX</sub> | B3 <sub>HEX</sub>  | Product ID       | Uniquely identifies the VR product. The VR vendor assigns this number.   | Read Only    | 00 <sub>HEX</sub> |
| 02 <sub>HEX</sub> | 01 <sub>HEX</sub>  | Product Revision | Uniquely identifies the revision or stepping of the VR control IC. The vendor assigns this data.   | Read Only    | 02 <sub>HEX</sub> |
| 05 <sub>HEX</sub> | B4 <sub>HEX</sub>  | PROTOCOL_ID      | Supported SVID protocol: 5 <sub>HEX</sub> = IMVP8.   | Read Only    | 05 <sub>HEX</sub> |
| 06 <sub>HEX</sub> | B5 <sub>HEX</sub> <sup>[a]</sup><br>C5 <sub>HEX</sub> <sup>[b]</sup><br>D5 <sub>HEX</sub> <sup>[c]</sup> | Capability       | Supported SVID features.<br>C1 <sub>HEX</sub> indicates that I <sub>MAX</sub> is full scale and temperature and Iout reporting are supported           | Read Only    | C1 <sub>HEX</sub> |
| 10 <sub>HEX</sub> | B6 <sub>HEX</sub> <sup>[a]</sup><br>C6 <sub>HEX</sub> <sup>[b]</sup><br>D6 <sub>HEX</sub> <sup>[c]</sup> | Status_1         | Data register read after the active-LOW SVID_ALERT_B pin is asserted, which gives the status of the VR.  | Read Only    | 00 <sub>HEX</sub> |
| 11 <sub>HEX</sub> | B7 <sub>HEX</sub> <sup>[a]</sup><br>C7 <sub>HEX</sub> <sup>[b]</sup><br>D7 <sub>HEX</sub> <sup>[c]</sup> | Status_2         | Data register for the Status_2 data, which is the status of the SVID bus.  | Read Only    | 00 <sub>HEX</sub> |

| SVID Register     | I2C Register   | Register                                      | Description   | Access (SOC) | Default                                 |
|-------------------|--|---|---|--------------|---|
| 15 <sub>HEX</sub> | 84 <sub>HEX</sub> <sup>[a]</sup><br>86 <sub>HEX</sub> <sup>[b]</sup><br>8C <sub>HEX</sub> <sup>[c]</sup> | DCD0/DCD1/DCD2<br>Output Current,<br>Iout (H) | Running update of the conversion results from the 10-bit ADC.<br>The upper 8 MSB of the ADC output is stored in this register.  | Read Only    | 00 <sub>HEX</sub>                       |
| 1C <sub>HEX</sub> | B8 <sub>HEX</sub> <sup>[a]</sup><br>C8 <sub>HEX</sub> <sup>[b]</sup><br>D8 <sub>HEX</sub> <sup>[c]</sup> | Status2_last read                             | This register contains a copy of the Status_2 data that was last read with the GetReg (Status_2) command (see Table 119). In the case of a communications error or parity error, when the VR is sending the payload back to the master, the master can read the Status2_lastread register so the alert data is not lost.  | Read Only    | 00 <sub>HEX</sub>                       |
| 21 <sub>HEX</sub> | B9 <sub>HEX</sub> <sup>[a]</sup><br>C9 <sub>HEX</sub> <sup>[b]</sup><br>D9 <sub>HEX</sub> <sup>[c]</sup> | ICC_MAX                                       | Defines full scale for digital current reporting (in Amps). OC should be ~20% above. Use ICC_MAX = 5A + (6A × num dpu)  | Read Only    | 05 <sub>HEX</sub>                       |
| 24 <sub>HEX</sub> | BA <sub>HEX</sub> <sup>[a]</sup><br>CA <sub>HEX</sub> <sup>[b]</sup><br>DA <sub>HEX</sub> <sup>[c]</sup> | SR_FAST                                       | Reading this register returns the slew rate from SetVID Fast in the DCDXSLEW register   | Read Only    | 14 <sub>HEX</sub>                       |
| 25 <sub>HEX</sub> | BB <sub>HEX</sub> <sup>[a]</sup><br>CB <sub>HEX</sub> <sup>[b]</sup><br>DB <sub>HEX</sub> <sup>[c]</sup> | SR_SLOW                                       | Reading this register returns the slew rate from SetVID Slow in the DCDXSLEW register   | Read Only    | 02 <sub>HEX</sub>                       |
| 26 <sub>HEX</sub> | BC <sub>HEX</sub> <sup>[a]</sup><br>CC <sub>HEX</sub> <sup>[b]</sup><br>DC <sub>HEX</sub> <sup>[c]</sup> | DCD0_VBOOT<br>DCD1_VBOOT<br>DCD2_VBOOT        | Data register containing VBOOT voltage, which is OTP programmed, in the VR12.1 VID format; for example, 97 <sub>HEX</sub> = 1.0V.   | Read Only    | 97 <sub>HEX</sub>                       |
| 30 <sub>HEX</sub> | BD <sub>HEX</sub> <sup>[a]</sup><br>CD <sub>HEX</sub> <sup>[b]</sup><br>DD <sub>HEX</sub> <sup>[c]</sup> | Vout max                                      | This register is programmable by the master and sets the maximum VID that the VR will support. If a higher VID code is received, the VR should respond with the "Reject, not supported" acknowledge. VR12.1 VID data format.<br><b>Important:</b> Vout max must be programmed by the master during the boot up sequence if a value other than the default is selected. Offset (33 <sub>HEX</sub> ) does not affect Vout_max; i.e. VID setting + Offset can be > Vout_max. | Read/Write   | D2 <sub>HEX</sub><br>(setting = 1.295V) |
| 31 <sub>HEX</sub> | BE <sub>HEX</sub> <sup>[a]</sup><br>CE <sub>HEX</sub> <sup>[b]</sup><br>DE <sub>HEX</sub> <sup>[c]</sup> | VID setting                                   | Data register containing the currently programmed VID voltage in the VID data format. The default is 00 <sub>HEX</sub> ; i.e., zero volts out, VR off.  | Read/Write   | 00 <sub>HEX</sub>                       |
| 32 <sub>HEX</sub> | BF <sub>HEX</sub> <sup>[a]</sup><br>CF <sub>HEX</sub> <sup>[b]</sup><br>DF <sub>HEX</sub> <sup>[c]</sup> | PWR state                                     | Register containing the current programmed power state. The default is 00 <sub>HEX</sub> = Normal Power Mode.   | Read/Write   | 00 <sub>HEX</sub>                       |

| SVID Register     | I2C Register   | Register    | Description   | Access (SOC) | Default           |
|-------------------|--|-------------|---|--------------|-------------------|
| 33 <sub>HEX</sub> | C0 <sub>HEX</sub> <sup>[a]</sup><br>D0 <sub>HEX</sub> <sup>[b]</sup><br>E0 <sub>HEX</sub> <sup>[c]</sup> | Offset      | This register sets the offset in VID steps added to the VID setting for the voltage margining. Bit 7 is the sign bit: 0 = positive margin, 1 = negative margin. Remaining 7 bits are the number of VID steps for the margin 2's complement.<br><br>00 <sub>HEX</sub> = no margin.<br>01 <sub>HEX</sub> = +1 VID step<br>02 <sub>HEX</sub> = +2 VID steps<br>FF <sub>HEX</sub> = -1 VID step | Read/Write   | 00 <sub>HEX</sub> |
| 34 <sub>HEX</sub> | C1 <sub>HEX</sub> <sup>[a]</sup><br>D1 <sub>HEX</sub> <sup>[b]</sup><br>E1 <sub>HEX</sub> <sup>[c]</sup> | Multi_VR    | This register is programmable by the master. Lock slave to current VID and power state setting, reject AllCall commands.  | Read/Write   | 00 <sub>HEX</sub> |
| 35 <sub>HEX</sub> | C2 <sub>HEX</sub> <sup>[a]</sup><br>D2 <sub>HEX</sub> <sup>[b]</sup><br>E2 <sub>HEX</sub> <sup>[c]</sup> | SET_REG_ADR | Scratch pad register for temporary storage of the SetRegADR pointer register (see Table 119)  | Read/Write   | 00 <sub>HEX</sub> |

[a] For DCD0.

[b] For DCD1.

[c] For DCD2.

## 9. Control and Monitoring

### 9.1.1 State Machine

The P91E0 implements a state machine that interprets a very limited “instruction set.” Its purpose is to execute basic power sequencing and thermal monitoring tasks from code stored locally without requiring intervention by the hardware or software. This section outlines the functions that the state machine performs.

In the P91E0, power-state transition (power sequencing) related tasks and general purpose analog-to-digital converter tasks are handled concurrently. The intention is to ensure that power sequencing tasks are always handled in a time-deterministic manner (that is, they cannot be delayed by other tasks being requested of the ADC, etc.).

### 9.1.2 Execution

On power-up, the state machine begins in the Idle State. When an event occurs (the Cold Boot event is set by default), execution of tasks associated with that event are started automatically. Once the end of the task list is reached, the state machine will cease execution and return to the Idle State.

## 9.2 Input Power Source Detection

The P91E0 supports only analog detection of VSYS. The P91E0 can operate with a VSYS rising slew rate up to 5V/ms (measured between 10% and 90% of the target voltage), and rails with DPUs can be enabled when the DPUs’ input voltage exceeds their UVLO level.

### 9.2.1 System Voltage (VSYS) Detection Threshold

A voltage comparator is used to compare the VSYS voltage level to a reference voltage in order to determine whether VSYS is up and valid. The output of the comparator is used to inform the P91E0 of a power state transition between the G3 and SoC-G3 states.

#### VSYS Rising

When the VSYS level at the comparator rises higher than the reference voltage (including the rising-edge hysteresis), VSYS is considered valid.

#### VSYS Falling

When the VSYS level at the comparator falls lower than the reference voltage (including the falling-edge hysteresis), VSYS is considered invalid.

The requirements of the VSYSREF analog reference voltage used as the threshold for a valid VSYS are detailed in Table 122. When the P91E0 shuts down due to VSYS falling below VSYSREF<sub>F</sub>, i.e., an under-voltage lockout (UVLO) event occurs, the PVIN of the DPUs should be brought below the DPU.UVLO falling level (see the datasheet for the DPU) for a proper restart.

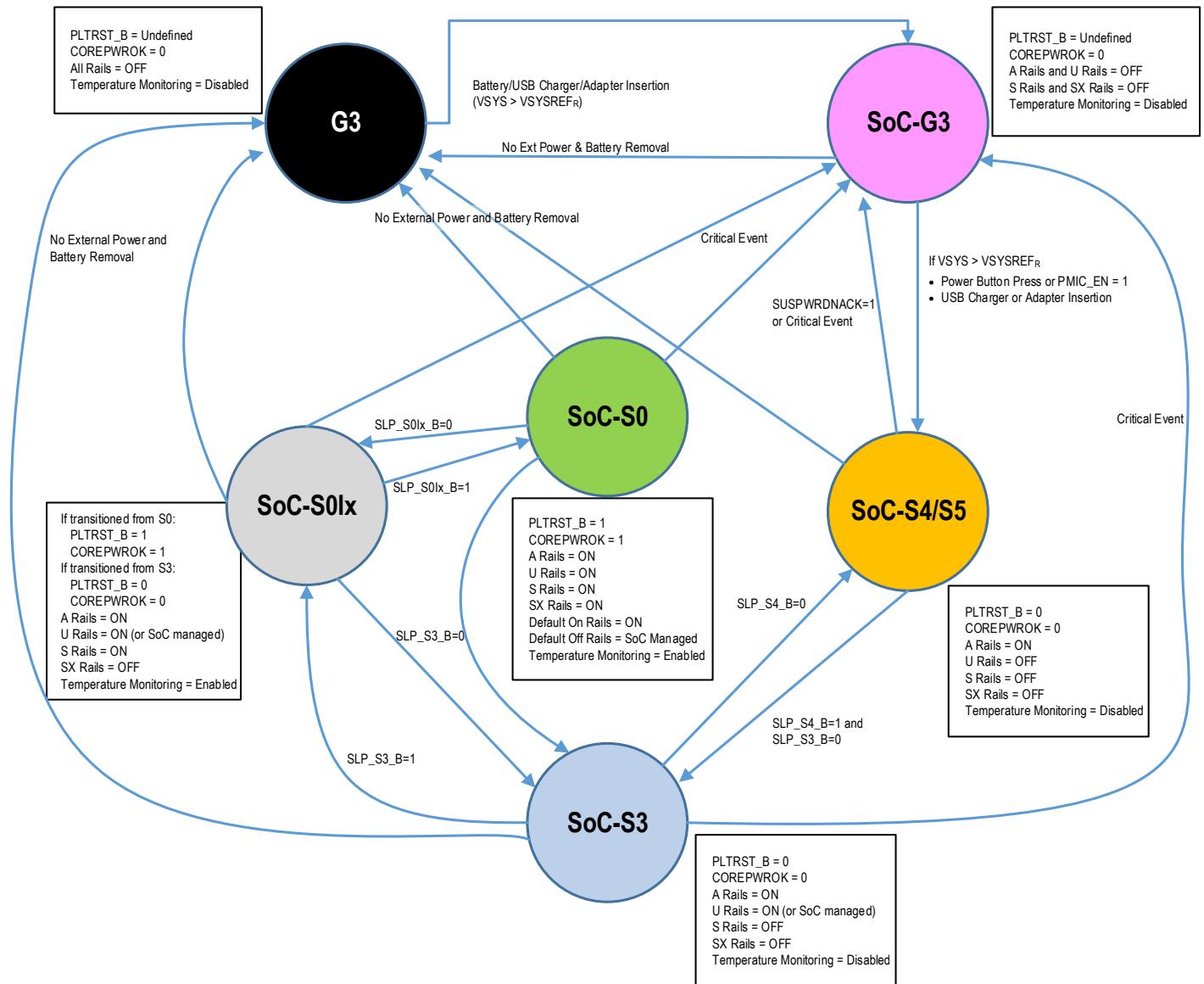
**Table 122. VSYSREF Definition**

| Parameter            | Description            | Min | Typical | Max | Unit |
|----------------------|------------------------|-----|---------|-----|------|
| VSYSREF <sub>R</sub> | VSYS Rising Threshold  | –   | 2.90    | –   | V    |
| VSYSREF <sub>F</sub> | VSYS Falling Threshold | –   | 2.50    | –   | V    |

### 9.3 Power States

The PMIC has six defined states that are characterized by the behavior of the platform power rails, SoC sideband signals (COREPWROK, PLTRST\_B, SLP\_Sx\_B), and internal state machine modes. Below is the description of each of the states. See Figure 10 for an illustration.

- G3 State:
  - No valid platform power sources are on.
  - VBAT and VBAK are below VSYSREF<sub>F</sub> (see Table 122) for the P91E0's internal logic power rail VPL.
  - This is a true "G3" state. No power is consumed in this state.
- SoC-G3 State:
  - The P91E0's internal logic power rail VPL is powered, either from the RTC backup battery (VBAK > VSYSREF<sub>F</sub>), main battery, or an adapter (VSYS > VSYSREF<sub>R</sub>).
  - The P91E0 can enter this state with sequential shutdown via Cold OFF events or with immediate shutdown due to critical events. Critical events are DCD0/DCD1 over-voltage events, THERMTRIP events, P91E0 critical temperature shutdowns, and input voltage UVLO events.
- SoC-S0 State:
  - All SoC rails have been powered up.
  - COREPWROK is asserted (LOW to HIGH) by the P91E0. Then PLTRST\_B is de-asserted (LOW to HIGH) by the SoC. The SoC has begun code execution.
  - The SoC can choose to power up/down any of the "Default Off" rails as software demands.
- SoC-S0Ix State:
  - This is a low-power platform state that is entered and exited as controlled by the sleep state signal SLP\_S0Ix\_B.
  - PLTRST\_B is de-asserted. COREPWROK is asserted.
  - The temperature monitoring state machine enters the Standby Mode with reduced frequency of temperature measurements.
- SoC-S3 State:
  - This is a low-power platform state that is entered and exited as controlled by the sleep state signal SLP\_S3\_B.
  - PLTRST\_B is asserted. COREPWROK is de-asserted.
- SoC-S4 and Soc-S5 States:
  - These are low-power platform states that are entered and exited as controlled by the sleep state signal SLP\_S4\_B.
  - PLTRST\_B is asserted. COREPWROK is de-asserted.
  - The SoC-S4 and SoC-S5 states are identical from a power perspective. The differentiation is that S4 is software determined.

**Figure 10. P91E0 PMIC Power State Diagram**

### 9.3.1 G3 State

In the “G3” state, the P91E0 is completely powered off, and no valid power sources are available on the platform. To enter this state, all power sources (battery and adapter) must have been removed from the system.

In this state, no rails are in regulation. No P91E0 logic is active. In this state, the device appears to be “off” to the user.

Exiting from this state is triggered by the application of a valid power source. Transitions out of this state are summarized in Table 123.

**Table 123. G3 State Transition Table**

| Event Trigger               | Conditions (all must be met) | Next State | Notes  |
|-----------------------------|------------------------------|------------|--|
| Main Battery Insertion      | VSYS > VSYSREF <sub>R</sub>  | SoC-G3     | When the VSYS input voltage is sufficiently high (above VSYSREF <sub>R</sub> ), the P91E0 waits for PWRBTNIN_B or PMIC_EN to be pressed/toggled.<br>The I2C register map is reset to defaults. |
| Main Battery Becomes Valid  |                              |            |  |
| USB or DC Adapter Insertion |                              |            |  |

### 9.3.2 SoC-G3 State

By default, in the SoC-G3 State, the only system rail present is VPL, which is an internal standby rail powering the battery-backed logic.

The events causing a transition out of the SoC-G3 State are shown in Table 124.

**Table 124. SoC-G3 State Transition Table**

| Event Trigger                                | Conditions (all must be satisfied) | Next State | Notes   |
|--|------------------------------------|------------|---|
| Main Battery Removal / Depletion             | VSYS < VSYSREF <sub>F</sub>        | G3         | VPL-powered logic loses state and resets to defaults. |
| Adapter Removal                              |                                    |            |   |
| Power Button Pressed or PMIC_EN toggles HIGH | VSYS > VSYSREF <sub>R</sub>        | SoC-S4/S5  | Start Cold Boot sequence to boot platform.            |

### 9.3.3 SoC-S0 State

In the SoC-S0 State, the P91E0 has completed bringing up the platform and released the SoC from reset. In this state, the behavior of the P91E0 state machines can be directly modified and controlled by the SoC via commands issued over the I2C and SVID interfaces. In this state, the device will appear “on” to the user.

The events causing a transition out of the SoC-S0 State are shown in Table 125.

**Table 125. SoC-S0 State Transition Table**

| Event Trigger              | Conditions (all must be met)                       | Next State         | Notes   |
|----------------------------|--|--------------------|---|
| Power Source Removal       | VSYS < VSYSREF <sub>F</sub>                        | G3                 | VPL-powered logic loses state and resets to defaults.   |
| Thermal Critical Events    |  | SoC-G3             | Hardware-enforced shut-down of rails.   |
| Non-Thermal Critical Event |  | SoC-G3             | Execute Cold Off Task List.   |
| Power Button Held          | Power button fault timer exceeded                  | SoC-S3             | The P91E0 passes PWRBTNIN_B information to the SoC.<br>The SoC has the option to toggle SLP_S3_B=0 then SLP_S4_B=0, then SUSPWRDNACK=1 to finally enter SoC-G3.<br>This is determined by the SoC.   |
| Power Button Held          | Power button fault timer has not yet been exceeded | SoC-S0lx or SoC-S3 | PMIC passes PWRBTNIN_B information to SoC. The SoC has these options: <ul style="list-style-type: none"><li>▪ Toggle SLP_S0lx_B = 0 enter SoC-S0lx or</li><li>▪ Toggle SLP_S3_B = 0 then SLP_S4_B = 0, then SUSPWRDNACK = 1 to enter the SoC-G3 state as the final state</li></ul> This is determined by the SoC. |
| Warm Reset                 | PLTRST_B = 0                                       | SoC-S0             | Resets I2C and SVID.  |
| SLP_S0lx                   | SLP_S0lx_B = 0                                     | SoC-S0lx           | Enter S0lx task list.   |

### 9.3.4 Shallow Sleep State (SoC-S0Ix)

The P91E0 supports three possible standby states: SoC-S0Ix (Shallow Sleep State), SoC-S3 (Sleep State), and SoC-S4/S5 (Deep Sleep State). Each of these states represents a different level of SoC standby, with SoC-S0Ix being the “shallowest” sleep state (highest consumed power) and SoC-S4/S5 being the “deepest” sleep state (lowest consumed power). Each of these three sub-states has its own entry task list, required because of the different states of power rails in each.

Entering and exiting each SoC-S0Ix state is controlled by a signal that is delivered to the P91E0 by the SoC via a dedicated physical pin SLP\_S0Ix\_B.

- Rails that are on:
  - Rails that are on are shown in the power sequencing diagrams (see Figure 11 )
  - Switching regulators can be placed in Power-Save Mode (PFM)
  - Internal PMIC rails are on
- Interfaces available:
  - SVID is ON in SoC-S0Ix State
  - I2C is ON in SoC-S0Ix State
- Input source comparators and interrupts are active.
- All P91E0 registers are powered with states retained.
- Thermal monitoring of the P91E0 is disabled.

The events causing a transition out of the SoC-S0Ix state are shown in Table 126.

**Table 126. SoC-S0Ix State Transition Table**

| Event Trigger              | Conditions (all must be met)                       | Next State                      | Notes   |
|----------------------------|--|---------------------------------|---|
| Power Source Removal       | VSYS < VSYSREF <sub>F</sub>                        | G3                              | VPL-powered logic loses state; resets to defaults.  |
| Thermal Critical Event     |  | SoC-G3                          | Hardware-enforced shutdown of rails (no Task List).   |
| Non-Thermal Critical Event |  | SoC-G3                          | Execute Cold Off Task List.   |
| Power Button Held          | Power button fault timer exceeded                  | SoC-S3<br>Determined by the SoC | PMIC passes PWRBTNIN_B information via the PWRBTN_B to the SoC. The SoC can toggle SLP_S3_B = 0 then SLP_S4_B = 0, then SUSPWRDNACK = 1 to enter SoC-G3 as the final state.<br>This is determined by the SoC. |
| Power Button Held          | Power button fault timer has not yet been exceeded | SoC-S0<br>Determined by the SoC | The P91E0 passes PWRBTNIN_B information via the PWRBTN_B to the SoC as a wake event. The SoC can toggle SLP_S0Ix_B = 1 to go to SoC-S0.<br>or<br>The SoC can determine the state.                             |
|                            |  | SoC-S3<br>Determined by the SoC | PMIC passes PWRBTNIN_B information via PWRBTN_B to the SoC. Toggle SLP_S3_B = 0 then SLP_S4_B = 0, then SUSPWRDNACK = 1 to enter the SoC-G3 state as the final state.   |

| Event Trigger                                       | Conditions (all must be met) | Next State | Notes   |
|---|------------------------------|------------|---|
| PMIC_EN is LOW<br>(if enabled with HIGH on PMIC_EN) |                              | SoC-G3     | The P91E0 will enter the Cold OFF task list and SoC-G3 State regardless of the SLP_x signals and SUSPWRDNACK state. |
| Warm Reset  | PLTRST_B = 0                 | SoC-S0Ix   | Resets I2C and SVID.  |
| SLP_S0Ix  | SLP_S0Ix_B = 1               | SoC-S0     | Exit the sequence for the S0Ix task list.   |
| SLP_S3  | SLP_S3_B = 0                 | SoC-S3     | Enter the sequence for the S3 task list.  |

### 9.3.5 Sleep Mode State (SoC-S3)

The entering and exiting of each of the SoC-S3 states is controlled by a signal that is delivered to the P91E0 by the SoC via a dedicated physical pin SLP\_S3\_B.

- Rails that are on:
  - Rails that are on are shown in the power sequencing diagrams (see Figure 11)
  - Switching regulators can be placed in Power-Save Mode (PFM)
  - Internal PMIC rails are on
- Interfaces available:
  - SVID is OFF in SoC-S3 State.
  - I2C is OFF in SoC-S3 State.
- Input source comparators and interrupts are active.
- All registers are powered with states retained.
- Thermal monitoring of the PMIC is disabled.

The events causing a transition out of the SoC-S3 State are shown in Table 127.

**Table 127. SoC-S3 State Transition Table**

| Event Trigger              | Conditions (All must be met)      | Next State | Notes   |
|----------------------------|-----------------------------------|------------|---|
| Power Source Removal       | VSYS < VSYSREF <sub>F</sub>       | G3         | VPL-powered logic loses state and resets to defaults.   |
| Thermal Critical Event     |                                   | SoC-G3     | Hardware-enforced shutdown of rails (no Task List).   |
| Non-Thermal Critical Event |                                   | SoC-G3     | Execute Cold Off Task List.   |
| Power Button Held          | Power button fault timer exceeded | SoC-S4/S5  | PMIC passes PWRBTNIN_B information to the SoC. The SoC can toggle SLP_S4_B = 0 then SUSPWRDNACK = 1 to enter SoC-G3 as the final state.<br>This is determined by the SoC. |

| Event Trigger     | Conditions<br>(All must be met)                | Next State                                   | Notes  |
|-------------------|--|--|--|
| Power Button Held | Power button fault timer has not been exceeded | SoC-S0<br>Determined by the SoC              | The P91E0 passes PWRBTNIN_B information to the SoC as a wake event. The SoC toggles SLP_S3_B = 1 and SLP_S0lx_B = 1 to go to the SoC-S0 State.<br>or<br>The SoC can determine the state. |
|                   |  | SoC-S4/S5<br>Determined by the SoC           | The P91E0 passes PWRBTNIN_B information to the SoC to wake to the SoC-S0 State and then to transition to the SoC-S4/S5 State: SLP_S0lx_B = 0 (if available), SLP_S3_B = 0, SLP_S4_B = 0. |
| SLP_S3            | SLP_S3_B = 1                                   | SoC-S0lx<br>or SoC-S0<br>(if S0lx is unused) | Exit the sequence for the S3 task list.  |
| SLP_S4            | SLP_S4_B = 0                                   | SoC-S4/S5                                    | Enter the sequence for the SoC-S4/S5 task list.  |

### 9.3.6 Deep Sleep State (SoC-S4/S5 State)

Entering and exiting each of the SoC-S4/S5 states is controlled by a signal that is delivered to the P91E0 by the SoC via the dedicated physical pin SLP\_S4\_B.

- Rails that are on:
  - Rails that are on are shown in the power sequencing diagrams (see Figure 11)
  - Switching regulators can be placed in Power-Save Mode (PFM)
  - Internal PMIC rails are on
- Interfaces available:
  - SVID is OFF in SoC-S4/S5 State.
  - I2C is OFF in SoC-S4/S5.
- Interrupts are active.
- All registers are powered with states retained.
- Thermal monitoring of the PMIC is disabled.

The events causing a transition out of the SoC-S4/S5 State are shown in Table 128.

**Table 128. Deep Sleep Mode (SoC-S4/S5) State Transition Table**

| Event Trigger              | Conditions<br>(All must be met) | Next State | Notes   |
|----------------------------|---------------------------------|------------|---|
| Power Source Removal       | VSYS < VSYSREF                  | G3         | VPL-powered logic loses state and resets to defaults. |
| SUSPWRDNACK                | SUSPWRDNACK = 1                 | SoC-G3     | Cold OFF task list                                    |
| Thermal Critical Event     |                                 | SoC-G3     | Hardware-enforced shutdown of rails (no Task List).   |
| Non-Thermal Critical Event |                                 | SoC-G3     | Execute Cold Off Task List.                           |

| Event Trigger     | Conditions (All must be met)                   | Next State | Notes  |
|-------------------|--|------------|--|
| Power Button Held | Power button fault timer has been exceeded     | SoC-G3     | PMIC passes PWRBTNIN_B information to the SoC. The SoC can set SUSPWRDNACK = 1 to enter SoC-G3. This is determined by the SoC                              |
| Power Button Held | Power button fault timer has not been exceeded | SoC-S3     | PMIC passes PWRBTNIN_B information to the SoC. Toggle SLP_S4_B = 1 to exit SoC-S4/S5. This is determined by the SoC.                                       |
|                   |  | SoC-G3     | PMIC passes PWRBTNIN_B information to the SoC. Toggle SLP_S4_B = 0 then SUSPWRDNACK = 1 to enter SoC-G3 as the final state. This is determined by the SoC. |
| SLP_S4            | SLP_S4_B = 1                                   | SoC-S3     | Exit the sequence for the SoC-S4/S5 task list.   |

## 9.4 Power State Transitions

The following is a summary of the 10 power state transitions defined for the P91E0-I5 as an example. The P91E0-I5 is OTP-configured for the Intel® Leaf Hill CRB.

- Cold Boot
- Warm Reset
- Enter Standby SoC-S0Ix
- Exit Standby SoC-S0Ix
- Enter Standby SoC-S3
- Exit Standby SoC-S3
- Enter Standby SoC-S4/S5
- Exit Standby SoC-S4/S5
- Cold OFF
- Modem Reset

Some of these state transitions are triggered by hardware events, such as the power button being pressed or power source insertion. Other transitions are gated by signals such as SLP\_S0Ix\_B, SLP\_S3\_B, SLP\_S4\_B and SUSPWRDNACK, usually connected to the SoC.

The behaviors associated with each of these state transitions are stored in the P91E0's power sequencing state machine. The following sections discuss the trigger sources of each transition and the default sequencing behavior during each.

The voltage rails are classified in the following categories, which are used to simplify the power state transition (power sequencing) diagrams:

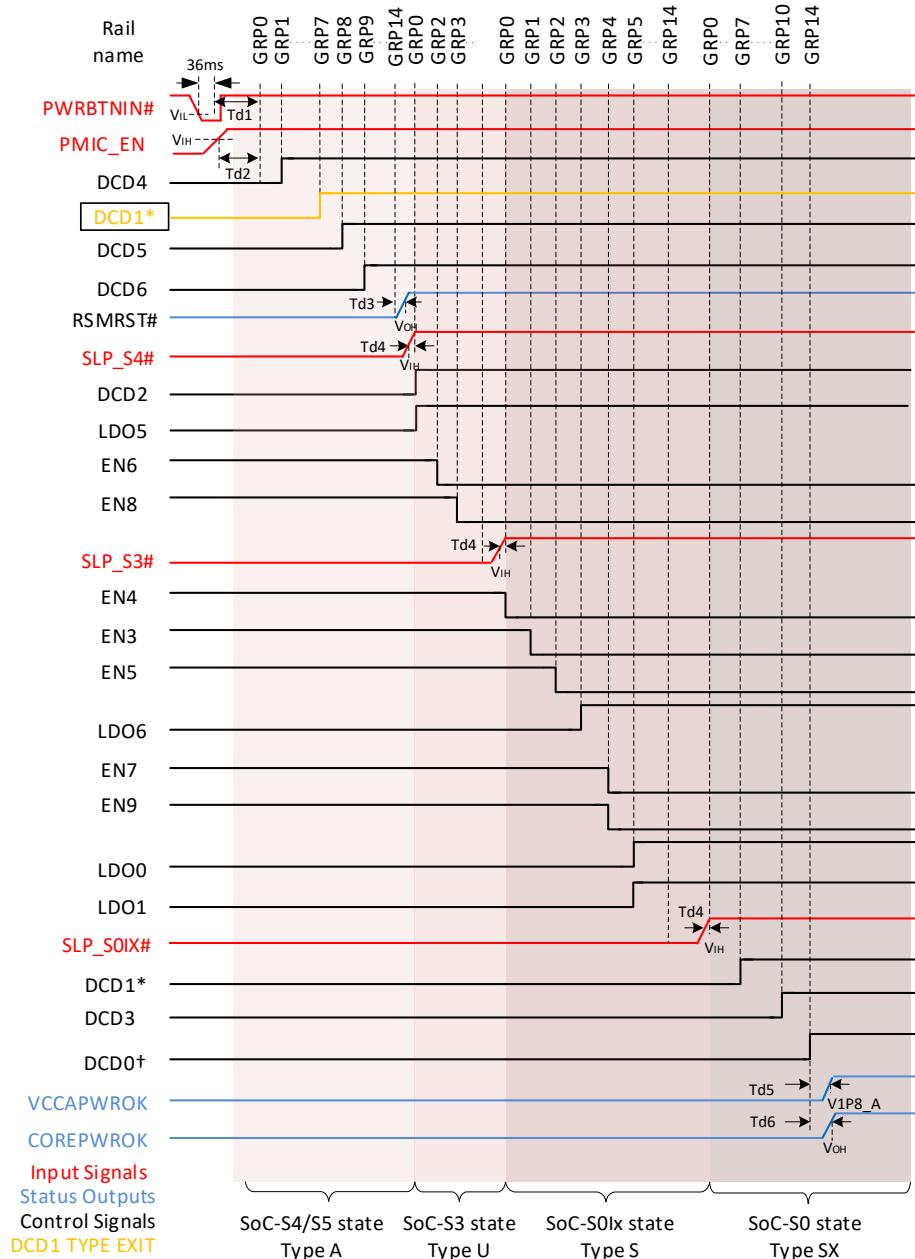
- SUS rails (A rails): DCD4 (3.3V), DCD1\* (1.0V), DCD5 (1.8V), and DCD6 (V1.25A). They remain on in the SoC-S4/S5 state. They are turned off in the SoC-G3 state.
- U rails: DCD2 (VDDQ), LDO5 (VTT). This rail remains on in SoC-S3 state and is turned off in SoC-S4/S5 state.
- S rails: These include LDO6 (2.8V), LDO0 (1.2V), and LDO1 (1.2V). They remain on in the SoC-S0Ix state. They are turned off in the SoC-S3 state.
- SX rails: DCD1\* (1.0V), DCD3 (1.05V), and DCD0† (0V). It is on in SoC-S0 state, and it is turned off in the SoC-S0Ix state.

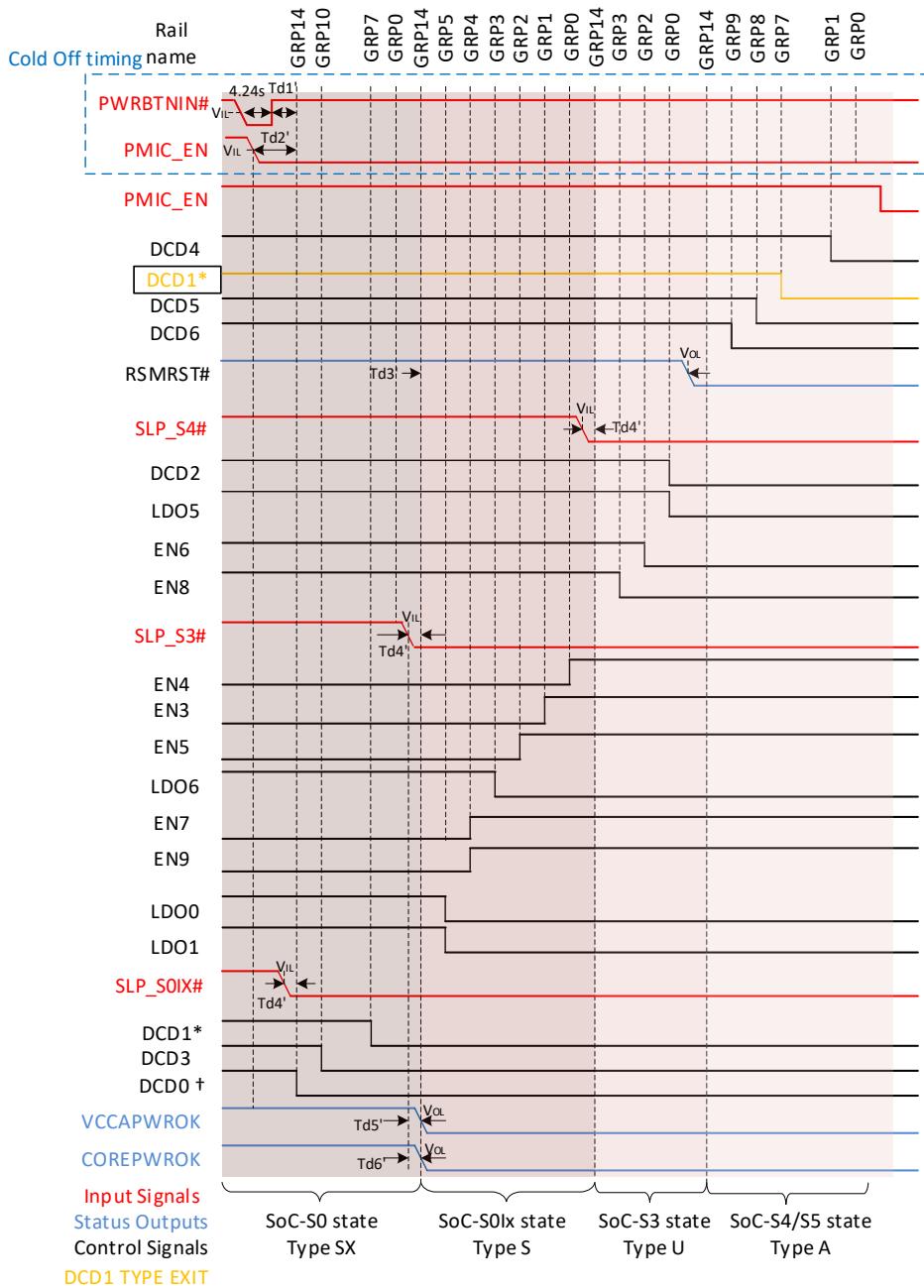
\* Note that register 10<sub>HEX</sub> bit[1] (DCD1\_TYPE\_EXIT) is set to 1 to enable the exit sequence. DCD1 starts as an A-type rail and remains as an A-type rail until RSMRST\_B and PLTRST\_B are both asserted. Once assertion of both signals is detected, DCD1 changes to an SX-type rail and remains as an SX-type rail until the system is reset.

† Note that DCD0's VBOOT is set to 0V and the output voltage is expected to change according to the DCD0\_VID command through SVID or I2C.

- Default ON rails: VRs that are turned on during the COLD BOOT by the power sequencing state machine.
- Defaults OFF rails: VRs that are not turned on during the COLD BOOT by the power sequencing state machine. They are managed by the SoC. Their on/off status depends on a platform device or other conditions.
- The accuracy of the built-in timer is +/-20%.

**Figure 11. Power-Up Sequence Timing Diagram for P91E0-I5 Rev. H**



**Figure 12. Power-Down Sequence Timing Diagram for P91E0-I5 Rev. H**

#### 9.4.1 Cold Boot

A Cold Boot sequence is followed whenever the P91E0 is fully turning on the system from a powered-down state. As such, a Cold Boot sequence begins at the SoC-G3 State and terminates at the SoC-S0 State. Once all of the rails are on, the COREPWROK signal will assert and the PLTRST\_B will de-assert. This will effectively turn on the SoC in order for it to begin executing code and controlling the system.

During this state transition, one or more of the sleep signals (SLP\_Sx\_B) could be asserted at some point in time. The VRs that are turned on during the transition should not be put in low-power mode even if some of the sleep signals may still be asserted since the end state of cold boot is SoC-S0 state.

During this state transition, the SoC rails are sequenced in an order critical to SoC operation. In addition, the rails are turned on one at a time in a ramp-rate controlled manner (voltage slew rate limited) in order to avoid battery in-rush current situations that could cause shut-down events.

All the triggers listed in Table 129 will cause the P91E0 to bring up the SUS rails (A rails). After that, signals from the SoC (SLP\_S4\_B, SLP\_S3\_B, SLP\_S0Ix\_B) are needed for the P91E0 to complete the Cold Boot sequence.

**Table 129. Cold Boot Triggers**

| Event                | Conditions (all must be met) |
|----------------------|------------------------------|
| Power Button Pressed | VSYS > VSYSREF <sub>R</sub>  |

#### 9.4.2 Warm Reset

A Warm Reset resets the SoC as well as the I2C and SVID interfaces in the P91E0. Configuration registers are not reset to defaults (unless explicitly defined otherwise).

During a Warm Reset, only the PLTRST\_B pin from the SoC is toggled. All rails remain in regulation during the reset.

**Table 130. Warm Reset Triggers**

| Event              | Conditions (all must be met) |
|--------------------|------------------------------|
| Warm Reset Request | SoC toggles the PLTRST_B = 0 |

#### 9.4.3 Shallow Sleep State S0Ix (SLP\_S0Ix\_B)

SLP\_S0Ix\_B is an input signal from the SoC initiating the Shallow Sleep State. In this mode, the P91E0 consumes the highest power among the sleep states. When SLP\_S0Ix\_B is pulled LOW, the SoC launches the Shallow Sleep State entry task list and the SX-type rails are turned off. Prior to initiating the Sleep Mode entry, the SoC will program the exit VID values for VCC (DCD0) via SVID and communicate Standby State information to the PMIC via I2C.

When SLP\_S0Ix\_B is pulled HIGH (with SLP\_S3\_B, SLP\_S4\_B, and RSMRST\_B already HIGH), the P91E0 exits the Shallow Sleep State. The SX-type rails are turned on. The VCC rail will be turned on by SVID commands (not by SLP\_S0Ix\_B). During the Cold Boot sequence or waking from deeper sleep modes, an SLP\_S0Ix\_B HIGH signal is valid if both the SLP\_S3\_B pin and the SLP\_S4\_B pin are connected to logic HIGH. It is valid when the RSMRST\_B pin = 1.

**Table 131. Enter and Exit SoC-S0Ix Triggers**

| Event                  | Conditions (all must be met)                              |
|------------------------|---|
| Enter SoC-S0Ix Request | SLP_S0Ix_B = 0  |
| Exit SoC-S0Ix Request  | SLP_S0Ix_B = 1 (SLP_S3_B = 1, SLP_S4_B = 1, RSMRST_B = 1) |

#### 9.4.4 Sleep Mode State S3 (SLP\_S3\_B)

SLP\_S3\_B is a dedicated input pin for enabling and disabling the low-power Sleep Mode State. When SLP\_S3\_B is pulled LOW, Sleep State is initiated and all the S-type power rails are turned off according to the programmed timing. If SLP\_S0Ix\_B is HIGH when SLP\_S3\_B is pulled LOW, the SX-type rails will turn off prior to the S-type rails turning off. Prior to activating the Sleep Mode, the SoC will program exit VID values for VCC/VNN over SVID and communicate standby state information to the P91E0 via I2C.

When SLP\_S3\_B is pulled HIGH (with SLP\_S4\_B and RSMRST\_B already HIGH), the P91E0 exits the low-power Sleep Mode State. The S-type rails are turned on. During the Cold Boot sequence or waking from deeper sleep modes, an SLP\_S3\_B HIGH signal is valid if SLP\_S4\_B is connected to logic HIGH. It is valid when the RSMRST\_B pin = 1.

**Table 132. Low-Power Sleep Mode State Entry and Exit**

| Event                | Conditions (all must be met)              |
|----------------------|---|
| Enter SoC-S3 Request | SLP_S3_B = 0 (optional: SLP_S0Ix_B = LOW) |
| Exit SoC-S3 Request  | SLP_S3_B = 1 (SLP_S4_B = 1, RSMRST_B = 1) |

#### 9.4.5 Deep Sleep State S4/S5 (SLP\_S4\_B)

SLP\_S4\_B is a dedicated input pin for enabling and disabling the Deep Sleep State. When SLP\_S4\_B is pulled LOW (with SLP\_S3\_B already LOW), Deep Sleep State is initiated, and all the U-type rails are turned off according to the programmed timing sequence. Prior to activating the deep sleep mode, the SoC will program exit VID values for VCC/VNN over SVID and communicate standby state information to the P91E0 via I2C. It is valid when the RSMRST\_B pin = 1 (de-asserted) and SLP\_S3\_B=0 (asserted).

When SLP\_S4\_B is pulled HIGH (with RSMRST\_B already HIGH), the P91E0 exits the Deep Sleep State. The U-type rails are turned on. During the Cold Boot sequence or waking from deeper sleep modes, an SLP\_S4\_B HIGH signal is valid when the RSMRST\_B pin = 1 (de-asserted).

**Table 133. Deep Sleep State Entry and Exit**

| Event                   | Conditions (all must be met)                          |
|-------------------------|---|
| Enter SoC-S4/S5 Request | SLP_S4_B = 0 (SLP_S3_B = 0; optional: SLP_S0Ix_B = 0) |
| Exit SoC-S4/S5 Request  | SLP_S4_B = 1 (RSMRST_B = 1)                           |

#### 9.4.6 Cold OFF

A Cold OFF, through either a SoC request or a system event, puts the P91E0 in the “Mechanical Off” state. The system remains in this state until the power button is pressed, PMIC\_EN is pulled HIGH, or VSYS is removed.

**Table 134. Cold OFF Triggers**

| Event   | Conditions (all must be met)  |
|---|---|
| Non-Thermal Critical Event                    | VSYS removal<br>SUSPWRDNACK = 1 and SLP_S4_B = 0 and RSMRST_B = 1   |
| Power Button Held                             | Power button fault timer exceeded<br>SUSPWRDNACK = 1<br>RSMRST_B = 1<br>SLP_S4_B = 0  |
| Power Button Held                             | Power button pressed for a defined length (up to SoC to define the length)<br>SUSPWRDNACK = 1 and SLP_S4_B = 0 and RSMRST_B = 1 |
| PMIC_EN LOW<br>(if enabled with PMIC_EN HIGH) | RSMRST_B = 1  |

#### 9.4.7 Modem Reset

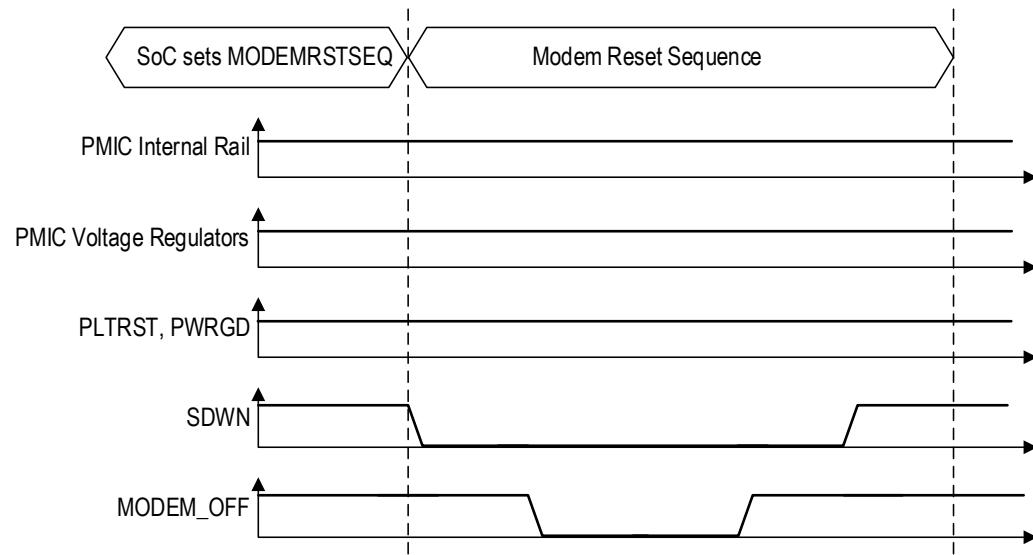
A Modem Reset task list is initiated by setting the MODEMRSTSEQ bit in the *MODEMCTRL* register (see Table 138). (The MODEMOFF bit in the same register directly controls the status of the MODEM\_OFF\_B output pin, but does not launch this task list.)

**Table 135. Modem Reset Triggers**

| Event               | Conditions (all must be met)  |
|---------------------|---|
| Modem Reset Request | SoC writes to the MODEMRSTSEQ bit in the <i>MODEMCTRL</i> register. |

The Modem Reset task list toggles the Shutdown Warning (SDWN\_B pin) and MODEM\_OFF\_B pins, implementing appropriate (modem-specific) delay timings. The default behavior for the Modem Reset task list is illustrated in Figure 13.

**Figure 13. Modem Reset Sequence Timing Diagram**



Notes:

- SDWN\_B LOW to MODEM\_OFF\_B LOW delay time: 400µs to 800µs.
- MODEM\_OFF\_B LOW duration > 14ms.
- MODEM\_OFF\_B HIGH to SDWN\_B HIGH delay time > 5ms.

## 9.5 PMIC Resets

The following table summarizes the reset sources for the P91E0.

**Table 136. PMIC Reset Sources**

| Reset Source             | Reset Trigger  | Reset Type / Sequence   |
|--------------------------|--|---|
| SoC Request              | PLTRST_B   | Warm Reset  |
| External Button          | PWRBTNIN_B held longer than the time defined in FLT[3:0] (bit field in the PBCONFIG register (see Table 112) | Cold Off  |
| Critical Event           | PMICTEMP   | Hard shutdown of all VRs; return to SoC-G3 (do not wait for SLP_Sx from SoC). |
|                          | THERMTRIP  |   |
| Wake Event from Cold Off | PWRBTNIN_B pressed   | Cold Boot   |

### 9.5.1 Mode

The *Mode* register can be written to by the SoC to manually control the P91E0's critical turn off and reset.

**Table 137. Mode – Mode Control Register**

| Register Name | R/W | D7   | D6 | D5       | D4 | D3   | D2 | D1           | D0         | Initial           | Address           |
|---------------|-----|------|----|----------|----|------|----|--------------|------------|-------------------|-------------------|
| MODE          | R/W | RSVD |    | CHG_STAT |    | RSVD |    | TURNOFF_CRIT | RESET_CRIT | 00 <sub>HEX</sub> | 82 <sub>HEX</sub> |

| Bit    | Name         | Function  | Default            |
|--------|--------------|---|--------------------|
| D[7:5] | RSVD         | Reserved  | 000 <sub>BIN</sub> |
| D[4]   | CHG_STAT     | This is a read only status bit<br>0 = Charger OFF<br>1 = Charger ON   | 0 <sub>BIN</sub>   |
| D[3:2] | RSVD         | Reserved  | 00 <sub>BIN</sub>  |
| D[1]   | TURNOFF_CRIT | 0 = Default<br>1 = Enable critical event due to I2C set<br>Rails turn off and follow the power-down sequence  | 0 <sub>BIN</sub>   |
| D[0]   | RESET_CRIT   | 0 = Default<br>1 = Enable critical reset event due to I2C set<br>Rails turn off and follow the power down sequence, then turn back on, and follow power-on sequence | 0 <sub>BIN</sub>   |

### 9.5.2 MODEMCTRL

The MODEMCTRL register can be written to by the SoC to manually control the MODEM\_OFF\_B pin or to launch a Modem Reset task list.

**Table 138. MODEMCTRL – Modem Control Register**

Note: A write must only set one bit. Action is taken immediately.

| Register Name | R/W | D7 | D6 | D5 | D4   | D3 | D2 | D1           | D0        | Initial Value     | Address           |
|---------------|-----|----|----|----|------|----|----|--------------|-----------|-------------------|-------------------|
| MODEMCTRL     | R/W |    |    |    | RSVD |    |    | MODEM RSTSEQ | MODEM OFF | 00 <sub>HEX</sub> | 29 <sub>HEX</sub> |

| Bit    | Name        | Function   | Default               |
|--------|-------------|--|-----------------------|
| D[7:2] | RSVD        | Reserved   | 000000 <sub>BIN</sub> |
| D[1]   | MODEMRSTSEQ | This bit is self-clearing and always reads 0:<br>0 = No action.<br>1 = Initiate a Modem Reset task list.   | 0 <sub>BIN</sub>      |
| D[0]   | MODEMOFF    | Controls the state of the MODEM_OFF_B pin:<br>0 = MODEM_OFF_B driven to logic LOW (asserted).<br>1 = MODEM_OFF_B driven to logic HIGH (de-asserted).<br>If the MODEM_OFF_B pin state is modified by the task list processor's IO_CTL command, this bit updates to reflect the pin's current state. | 0 <sub>BIN</sub>      |

### 9.5.3 Reset Source Indicators

The PMIC contains two registers that are intended to store the cause of a shutdown or reset for FW to interrogate on next startup. These registers are backed up by the backup battery so that on the next boot, software can determine the cause of the previous shutdown even if the battery was removed and replaced. These bits are write-1-to-clear.

If the RESETSRC registers are not cleared by the SoC, stale bits (from past resets) will auto-clear. This is to ensure that between RESETSRC0 and RESETSRC1, only the most recent reset reason is flagged for SW.

**Table 139. Reset Source Register 0**

| Register Name | R/W | D7        | D6        | D5        | D4   | D3   | D2      | D1        | D0         | Initial Value     | Address           |
|---------------|-----|-----------|-----------|-----------|------|------|---------|-----------|------------|-------------------|-------------------|
| RESETSRC0     | R/W | RSYSTEMP2 | RSYSTEMP1 | RSYSTEMP0 | RI2C | RSVD | RPWRBTN | RPMICTEMP | RTHERMTRIP | 00 <sub>HEX</sub> | 20 <sub>HEX</sub> |

| Bit  | Name      | Function  | Default          |
|------|-----------|---|------------------|
| D[7] | RSYSTEMP2 | 0 = Default.<br>1 = Previous shut-down was due to an over-temperature condition on ADC channel 2. | 0 <sub>BIN</sub> |
| D[6] | RSYSTEMP1 | 0 = Default.<br>1 = Previous shut-down was due to an over-temperature condition on ADC channel 1. | 0 <sub>BIN</sub> |
| D[5] | RSYSTEMP0 | 0 = Default.<br>1 = Previous shut-down was due to an over-temperature condition on ADC channel 0. | 0 <sub>BIN</sub> |
| D[4] | RI2C      | 0 = Default.<br>1 = Previous shut-down was due to an I2C (software) initiated reset.              | 0 <sub>BIN</sub> |

| Bit  | Name       | Function   | Default          |
|------|------------|--|------------------|
| D[3] | RSVD       | Reserved.  | 0 <sub>BIN</sub> |
| D[2] | RPWRBTN    | 0 = Default.<br>1 = Previous shut-down was due to a Power Button initiated reset.                                | 0 <sub>BIN</sub> |
| D[1] | RPMICTEMP  | 0 = Default.<br>1 = Previous shut-down was due to a PMIC internal over-temperature event. (P91E0 sets this bit.) | 0 <sub>BIN</sub> |
| D[0] | RTHERMTRIP | 0 = Default.<br>1 = Previous shut-down was due to the SoC asserting THERMTRIP. (P91E0 sets this bit).            | 0 <sub>BIN</sub> |

**Table 140. Reset Source Register 1**

Note: Green shading indicates that the register values are loaded from the OTP.

| Register Name | R/W | D7    | D6   | D5   | D4    | D3        | D2 | D1        | D0 | Initial Value | Address           |
|---------------|-----|-------|------|------|-------|-----------|----|-----------|----|---------------|-------------------|
| RESETSRC1     | R/W | RVSYS | ROV1 | ROV0 | RNORM | RCHG[1:0] |    | VCHG[1:0] |    | OTP           | 21 <sub>HEX</sub> |

| Bit    | Name           | Function   | Default |
|--------|----------------|--|---------|
| D[7]   | RVSYS          | 0 = Default.<br>1 = Previous shut-down was due to the user removing VSYS during operation.                                       | OTP     |
| D[6]   | ROV1           | 0 = Default.<br>1 = Previous shut-down was due to an over-voltage condition on DCD1.   | OTP     |
| D[5]   | ROV0           | 0 = Default.<br>1 = Previous shut-down was due to an over-voltage condition on DCD0.   | OTP     |
| D[4]   | RNORM          | 0 = Default.<br>1 = Previous shut-down was due to a normal turn-off after SUSPWRDNO.   | OTP     |
| D[3:2] | VBAK_RCHG[1:0] | Coin cell charger series resistor setting:<br>00 = 0.5kΩ                    10 = 2kΩ<br>01 = 1kΩ                    11 = 5kΩ     | OTP     |
| D[1:0] | VBAK_VCHG[1:0] | Coin cell charger output voltage setting:<br>00 = Charger is turned-off      10 = 3.0V<br>01 = 2.6V                    11 = 3.3V | OTP     |

### 9.5.4 Wake Source Indicator

The P91E0 has a register for storing the cause of a wake event, so that the software can determine why the system was awoken from Cold OFF. These bits are write-1-to-clear.

If the WAKESRC register is not cleared by the SoC, stale bits (from past wakes) will auto-clear. This is to ensure that only the most recent wake reason is flagged for software.

**Table 141. Wake Source Register**

| Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0       | Initial Value     | Address           |
|---------------|-----|----|----|----|----|----|----|----|----------|-------------------|-------------------|
| WAKESRC       | R/W |    |    |    |    |    |    |    | WAKEPBTN | 00 <sub>HEX</sub> | 22 <sub>HEX</sub> |

| Bit    | Name     | Function  | Default                |
|--------|----------|---|------------------------|
| D[7:1] | RSVD     | Reserved.   | 0000000 <sub>BIN</sub> |
| D[0]   | WAKEPBTN | 0 = Default.<br>1 = Wake was triggered by user pressing the power button. | 0                      |

## 9.6 Interrupting the SoC

See section 8.1.10 for a general description of the interrupt request.

When the P91E0 needs to interrupt the SoC, it asserts the IRQ line. The following sequence illustrates the interrupt handling flow:

1. A P91E0 event occurs, which sets the level 2 (see Table 144) and level 1 (IRQLVL1; see Table 142) I2C register flags. In response to an unmasked flag being set in IRQLVL1, the P91E0 interrupts the SoC by asserting the IRQ line. This IRQ line is connected to an interruptible GPIO pin at the SoC.
2. Because the IRQ was set, the SoC reads the P91E0's level 1 and level 2 interrupt registers via I2C, determining the cause of the interrupt.
3. The SoC clears the interrupt event in the P91E0 via a register write to the level 2 interrupt register via I2C.
4. If IRQLVL1 has all unmasked interrupts cleared, the P91E0 de-asserts the IRQ signal, signaling that the interrupt has been handled.
5. The maximum latency from the IRQ detection to the assertion of the IRQ line is 1ms.

The P91E0 may assert the IRQ line due to two separate events occurring simultaneously. It is the responsibility of the SoC to read all the interrupt registers and assign proper priority to handling the events.

## 9.7 Interrupt Request (IRQ) Control Unit

The interrupt control unit maintains the state of the level 1 IRQ tree and is responsible for asserting and de-asserting the P91E0's IRQ pin to the application SoC. It contains status bits for interrupts from all the second-level sub-blocks as well as the power button.

### 9.7.1 Interrupt Descriptions

If unmasked, the level 2 interrupts will propagate to the appropriate level 1 interrupt bit, as described below. If the level 1 interrupt is unmasked, it will propagate to the IRQ pin, which will remain HIGH as long as unmasked interrupts have not been cleared.

### 9.7.2 Level 1 Interrupts (IRQLVL1)

The IRQ interrupt indicator to the SoC, IRQ, is transmitted from the IRQ pin of the P91E0 to a GPIO pin of the SoC. Causes of the interrupts are investigated by the SoC by reading the IRQ status registers via I2C. The P91E0 interrupt scheme contains two levels. The level 1 interrupt register contains 7 IRQ bits and indicates which P91E0 sub-block triggered the interrupt. One bit is dedicated to each of the interrupt-causing PMIC sub-blocks. For all units, the level 2 interrupt registers indicate the specific interrupt triggers for each sub-block. A masking system is provided to enable or disable specific interrupt handlers.

If any bits are set in the first-level IRQ mask, the assertion of an interrupt from the masked sub-block(s) will not cause an assertion of the IRQ signal, nor will it set the associated level 1 IRQ bit. By limiting the level 1 IRQ bits set to only those that are unmasked, this disambiguates the dispatching of interrupts.

Level 1 IRQ bits cannot be directly cleared; they are implicitly cleared by clearing all unmasked level 2 IRQ bits. When all unmasked level 1 IRQ bits are implicitly cleared (all unmasked level 2 interrupts are directly cleared), the IRQ pin is de-asserted.

**Table 142. IRQLVL1 – Level 1 Interrupt Register**

| Register Name | R/W | D7   | D6 | D5   | D4   | D3  | D2   | D1   | D0   | Initial Value     | Address           |
|---------------|-----|------|----|------|------|-----|------|------|------|-------------------|-------------------|
| IRQLVL1       | R/W | RSVD | VR | GPIO | RSVD | ADC | RSVD | THRM | RSVD | 00 <sub>HEX</sub> | 02 <sub>HEX</sub> |

| Bit | Name | Function   | Default          |
|-----|------|--|------------------|
| D7  | RSVD | Reserved.  | 0 <sub>BIN</sub> |
| D6  | VR   | 0 = VR IRQ not asserted.<br>1 = VR IRQ asserted; write '1' to clear.                                   | 0 <sub>BIN</sub> |
| D5  | GPIO | 0 = GPIO IRQ not asserted.<br>1 = GPIO IRQ asserted; write '1' to clear.                               | 0 <sub>BIN</sub> |
| D4  | RSVD | Reserved.  | 0 <sub>BIN</sub> |
| D3  | ADC  | 0 = ADC IRQ not asserted.<br>1 = ADC IRQ asserted; write '1' to clear.                                 | 0 <sub>BIN</sub> |
| D2  | RSVD | Reserved.  | 0 <sub>BIN</sub> |
| D1  | THRM | 0 = THRM (Thermal Unit) IRQ not asserted.<br>1 = THRM (Thermal Unit) IRQ asserted; write '1' to clear. | 0 <sub>BIN</sub> |
| D0  | RSVD | Reserved.  | 0 <sub>BIN</sub> |

**Table 143. MIRQLVL1 – Level 1 Interrupt Mask Register**

| Register Name | R/W | D7   | D6  | D5    | D4   | D3   | D2   | D1    | D0   | Initial Value     | Address           |
|---------------|-----|------|-----|-------|------|------|------|-------|------|-------------------|-------------------|
| MIRQLVL1      | R/W | RSVD | MVR | MGPIO | RSVD | MADC | RSVD | MTHRM | RSVD | 6A <sub>HEX</sub> | 0E <sub>HEX</sub> |

| Bit | Name  | Function   | Default          |
|-----|-------|--|------------------|
| D7  | RSVD  | Reserved.  | 0 <sub>BIN</sub> |
| D6  | MVR   | 0 = VR IRQ unmasked.<br>1 = VR IRQ masked.                                   | 1 <sub>BIN</sub> |
| D5  | MGPIO | 0 = GPIO IRQ unmasked.<br>1 = GPIO IRQ masked.                               | 1 <sub>BIN</sub> |
| D4  | RSVD  | Reserved.  | 0 <sub>BIN</sub> |
| D3  | MADC  | 0 = ADC IRQ unmasked.<br>1 = ADC IRQ masked.                                 | 1 <sub>BIN</sub> |
| D2  | RSVD  | Reserved   | 0 <sub>BIN</sub> |
| D1  | MTHRM | 0 = THRM (Thermal Unit) IRQ unmasked.<br>1 = THRM (Thermal Unit) IRQ masked. | 1 <sub>BIN</sub> |
| D0  | RSVD  | Reserved.  | 0 <sub>BIN</sub> |

## 9.8 Second-Level Interrupts

While level 1 interrupt bits inform the interrupt handler of which sub-block interrupted, level 2 interrupt registers/bits provide the interrupt handler with the specific nature of the block's interrupt event.

If any bits are set in a level 2 interrupt mask, then the appropriate level 2 interrupt bit is prevented from asserting the level 1 interrupt bit for the corresponding sub-block, nor will the bit become set. (Only unmasked level 2 interrupt bits can be set).

Interrupt bits are write-1-to-clear. This includes all level 2 interrupt register locations and the power-button interrupt bit. The IRQ signal will not be de-asserted until all unmasked interrupt bits are cleared.

**Table 144. Level 2 Interrupt Registers**

| INT Name | Register | Source               | First-Level Interrupt | Related Status Bit | DESCRIPTION  |
|----------|----------|----------------------|-----------------------|--------------------|--|
| VSYS     | VSYSIRQ  | ADC                  | ADC                   | –                  | This indicates that VSYS is out of range ("invalid").  |
| VRFAULT  | VRIRQ    | ADC                  | VR                    | –                  | This indicates that a VR over-voltage or over-current fault has occurred.<br>The VR fault interrupt will reset to 0 on Cold OFF.   |
| PMICALRT | THRMIRQ  | Thermal Control Unit | THRM                  | –                  | Set by the thermal state machine when a PMIC die temperature thermal alert occurs.   |
| ADC2ALRT | ADCIRQ   | ADC                  | ADC                   | –                  | Set by the thermal state machine when a system voltage 2 alert occurs.   |
| ADC1ALRT | ADCIRQ   | ADC                  | ADC                   | –                  | Set by the thermal state machine when a system voltage 1 alert occurs.   |
| ADC0ALRT | ADCIRQ   | ADC                  | ADC                   | –                  | Set by the thermal state machine when a system voltage 0 alert occurs.   |
| SYSTEMP  | ADCIRQ   | ADC                  | ADC                   | –                  | Bit is set when a SYSTEMP conversion completes and the GPADCREQ:IRQEN bit (see Table 149) was set when the request was made.   |
| GPIO     | GPIOIRQ  | GPIO                 | GPIO                  | DIN                | Each GPIO pin can be configured as an input with a programmable interrupt edge for rise, falling, or both. See the <i>GPIOCTL<sub>x</sub></i> registers (see Table 89) for INTCNT settings.<br>This interrupt is triggered when the conditions set in the <i>GPIOCTL<sub>x</sub></i> registers have been met.<br>The status of the GPIO input can be verified by reading the DIN bit from the <i>GPIOCTL<sub>x</sub></i> register. |

## 9.9 GPIO IRQ Registers

**Table 145. GPIO0 Interrupt Register**

| Register Name | R/W | D7   | D6     | D5     | D4     | D3     | D2     | D1    | D0    | Initial Value     | Address           |
|---------------|-----|------|--------|--------|--------|--------|--------|-------|-------|-------------------|-------------------|
| GPIO0IRQ      | R/W | RSVD | GPIO14 | GPIO13 | GPIO12 | GPIO11 | GPIO10 | GPIO9 | GPIO8 | 00 <sub>HEX</sub> | 0B <sub>HEX</sub> |

| Bit  | Name   | Function  | Default          |
|------|--------|---|------------------|
| D[7] | RSVD   | Reserved.   | 0 <sub>BIN</sub> |
| D[6] | GPIO14 | 0 = No interrupt pending.<br>1 = Interrupt pending. | 0 <sub>BIN</sub> |
| D[5] | GPIO13 | 0 = No interrupt pending.<br>1 = Interrupt pending. | 0 <sub>BIN</sub> |
| D[4] | GPIO12 | 0 = No interrupt pending.<br>1 = Interrupt Pending. | 0 <sub>BIN</sub> |
| D[3] | GPIO11 | 0 = No interrupt pending.<br>1 = Interrupt pending. | 0 <sub>BIN</sub> |
| D[2] | GPIO10 | 0 = No interrupt pending.<br>1 = Interrupt pending. | 0 <sub>BIN</sub> |
| D[1] | GPIO9  | 0 = No interrupt pending.<br>1 = Interrupt pending. | 0 <sub>BIN</sub> |
| D[0] | GPIO8  | 0 = No interrupt pending.<br>1 = Interrupt pending. | 0 <sub>BIN</sub> |

**Table 146. GPIO1 Interrupt Register**

| Register Name | R/W | D7    | D6    | D5    | D4    | D3    | D2    | D1    | D0    | Initial Value     | Address           |
|---------------|-----|-------|-------|-------|-------|-------|-------|-------|-------|-------------------|-------------------|
| GPIO1IRQ      | R/W | GPIO7 | GPIO6 | GPIO5 | GPIO4 | GPIO3 | GPIO2 | GPIO1 | GPIO0 | 00 <sub>HEX</sub> | 0C <sub>HEX</sub> |

| Bit  | Name  | Function  | Default          |
|------|-------|---|------------------|
| D[7] | GPIO7 | 0 = No interrupt pending.<br>1 = Interrupt pending. | 0 <sub>BIN</sub> |
| D[6] | GPIO6 | 0 = No interrupt pending.<br>1 = Interrupt pending. | 0 <sub>BIN</sub> |
| D[5] | GPIO5 | 0 = No interrupt pending.<br>1 = Interrupt pending. | 0 <sub>BIN</sub> |
| D[4] | GPIO4 | 0 = No interrupt pending.<br>1 = Interrupt pending. | 0 <sub>BIN</sub> |
| D[3] | GPIO3 | 0 = No interrupt pending.<br>1 = Interrupt pending. | 0 <sub>BIN</sub> |

| Bit  | Name  | Function  | Default          |
|------|-------|---|------------------|
| D[2] | GPIO2 | 0 = No interrupt pending.<br>1 = Interrupt pending. | 0 <sub>BIN</sub> |
| D[1] | GPIO1 | 0 = No interrupt pending.<br>1 = Interrupt pending. | 0 <sub>BIN</sub> |
| D[0] | GPIO0 | 0 = No interrupt pending.<br>1 = Interrupt pending. | 0 <sub>BIN</sub> |

**Table 147. GPIO0 Interrupt Mask Register**

| Register Name | R/W | D7   | D6      | D5      | D4      | D3      | D2      | D1     | D0     | Initial Value     | Address           |
|---------------|-----|------|---------|---------|---------|---------|---------|--------|--------|-------------------|-------------------|
| MGPIO0IRQ     | R/W | RSVD | MGPIO14 | MGPIO13 | MGPIO12 | MGPIO11 | MGPIO10 | MGPIO9 | MGPIO8 | 7F <sub>HEX</sub> | 19 <sub>HEX</sub> |

| Bit  | Name    | Function                            | Default          |
|------|---------|-------------------------------------|------------------|
| D[7] | RSVD    | RSVD                                | 0 <sub>BIN</sub> |
| D[6] | MGPIO14 | 0 = No Mask.<br>1 = Mask Interrupt. | 1 <sub>BIN</sub> |
| D[5] | MGPIO13 | 0 = No Mask.<br>1 = Mask Interrupt. | 1 <sub>BIN</sub> |
| D[4] | MGPIO12 | 0 = No Mask.<br>1 = Mask Interrupt. | 1 <sub>BIN</sub> |
| D[3] | MGPIO11 | 0 = No Mask.<br>1 = Mask Interrupt. | 1 <sub>BIN</sub> |
| D[2] | MGPIO10 | 0 = No Mask.<br>1 = Mask Interrupt. | 1 <sub>BIN</sub> |
| D[1] | MGPIO9  | 0 = No Mask<br>1 = Mask Interrupt   | 1 <sub>BIN</sub> |
| D[0] | MGPIO8  | 0 = No Mask<br>1 = Mask Interrupt   | 1 <sub>BIN</sub> |

**Table 148. GPIO1 Interrupt Mask Register**

| Register Name | R/W | D7     | D6     | D5     | D4     | D3     | D2     | D1     | D0     | Initial Value     | Address           |
|---------------|-----|--------|--------|--------|--------|--------|--------|--------|--------|-------------------|-------------------|
| MGPIO1IRQ     | R/W | MGPIO7 | MGPIO6 | MGPIO5 | MGPIO4 | MGPIO3 | MGPIO2 | MGPIO1 | MGPIO0 | FF <sub>HEX</sub> | 1A <sub>HEX</sub> |

| Bit  | Name   | Function                          | Default          |
|------|--------|-----------------------------------|------------------|
| D[7] | MGPIO7 | 0 = No Mask<br>1 = Mask Interrupt | 1 <sub>BIN</sub> |
| D[6] | MGPIO6 | 0 = No Mask<br>1 = Mask Interrupt | 1 <sub>BIN</sub> |

| Bit  | Name   | Function                          | Default          |
|------|--------|-----------------------------------|------------------|
| D[5] | MGPIO5 | 0 = No Mask<br>1 = Mask Interrupt | 1 <sub>BIN</sub> |
| D[4] | MGPIO4 | 0 = No Mask<br>1 = Mask Interrupt | 1 <sub>BIN</sub> |
| D[3] | MGPIO3 | 0 = No Mask<br>1 = Mask Interrupt | 1 <sub>BIN</sub> |
| D[2] | MGPIO2 | 0 = No Mask<br>1 = Mask Interrupt | 1 <sub>BIN</sub> |
| D[1] | MGPIO1 | 0 = No Mask<br>1 = Mask Interrupt | 1 <sub>BIN</sub> |
| D[0] | MGPIO0 | 0 = No Mask<br>1 = Mask Interrupt | 1 <sub>BIN</sub> |

## 9.10 General Purpose ADC (GPADC)

The general purpose ADC (referred to as GPADC or ADC) is used for die temperature, current, and voltage measurements. It is managed at a hardware level by the ADC state machine, similar to how rail transitions sequences are handled. The state machine performs ADC operations (regular readings of the die temperature, currents, and voltages, which are programmed in registers) and may be modified by the SoC after boot and initialization. The state machine for the GPADC is distinct from any other state machine (such as the one for power sequence controlling boot flow). This prevents the management of lengthy ADC transactions from blocking time-critical power sequencing tasks.

The GPADC can perform the following task lists:

- Repeated (on-going) VR current acquisition (initiated via timer defined by VRIMONCTL; see Table 171)
- SoC-requested die temperature acquisition (initiated via GPADCREQ; see Table 149)
- SoC-requested VR current acquisition (initiated via GPADCREQ)
- SoC-requested voltage measurements on ADC[2:0] inputs

The following section describes the interaction between the I2C control registers, ADC state machine, SRAM, and ADC hardware to perform temperature monitoring and GPADC acquisition.

### 9.10.1 GPADC Read Requests

The SoC can manually add GPADC read requests to the ADC queue whenever there is free instruction space in the queue and the BUSY bit in the GPADCREQ register is cleared (see Table 149). Manual GPADC requests are initiated by setting the appropriate bit in the GPADCREQ register. In response to this bit being set, the corresponding tasks are performed in the ADC.

When the queue fills, the BUSY bit is set, and the SoC cannot trigger any additional ADC task lists until the queue has room. The P91E0 hardware enforces that no additional commands are written by ignoring any requests from the SoC.

If the SoC sets the IRQEN bit in the GPADCREQ register, the PMIC will interrupt the SoC when the requested ADC task list is complete (via the ADCIRQ register; see Table 150).

When using the IRQ functionality with the ADC measurements, it is recommended to start only one type of measurement with the GPADCREQ register: VSYS, VRI, or ADC. The corresponding mask bit in the MADCI/RQ register (see Table 151) must be unmasked (cleared), while all other flags must be masked (set).

The GPADCREQ register is defined in Table 149.

**Table 149. GPADC Conversion Request Register**

| Register Name | R/W | D7   | D6  | D5   | D4   | D3  | D2   | D1    | D0   | Initial Value     | Address           |
|---------------|-----|------|-----|------|------|-----|------|-------|------|-------------------|-------------------|
| GPADCREQ      | R/W | VSYS | VRI | RSVD | RSVD | ADC | RSVD | IRQEN | BUSY | 00 <sub>HEX</sub> | 72 <sub>HEX</sub> |

| Bit  | Name  | Function  | Default          |
|------|-------|---|------------------|
| D[7] | VSYS  | Set to 1 for capturing VSYS.<br>Bit automatically clears after it is set.   | 0 <sub>BIN</sub> |
| D[6] | VRI   | Set to 1 for capturing VR current of all 5 VR current channels.<br>Bit automatically clears after it is set.  | 0 <sub>BIN</sub> |
| D[5] | RSVD  | Reserved.   | 0 <sub>BIN</sub> |
| D[4] | RSVD  | Reserved.   | 0 <sub>BIN</sub> |
| D[3] | ADC   | Set to 1 for capturing ADC0, ADC1, and ADC2.<br>Bit automatically clears after it is set.   | 0 <sub>BIN</sub> |
| D[2] | RSVD  | Reserved.   | 0 <sub>BIN</sub> |
| D[1] | IRQEN | If this bit is set to 1, the GPADC conversion requested generates an SoC interrupt when complete.<br>Bit automatically clears after it is set.  | 0 <sub>BIN</sub> |
| D[0] | BUSY  | The GPADC state machine sets this read-only bit to 1 when there is no more room in the ADC instruction queue. Software should check that this bit is clear before setting GPADCREQ [7:3]. GPADC requests issued while BUSY = 1 will be ignored. | 0 <sub>BIN</sub> |

**Table 150. GPADC Interrupt Register**

| Register Name | R/W | D7   | D6  | D5   | D4  | D3   | D2   | D1   | D0   | Initial Value     | Address           |
|---------------|-----|------|-----|------|-----|------|------|------|------|-------------------|-------------------|
| ADCIRQ        | R/W | VSYS | VRI | RSVD | ADC | RSVD | RSVD | RSVD | RSVD | 00 <sub>HEX</sub> | 08 <sub>HEX</sub> |

| Bit    | Name | Function  | Default            |
|--------|------|---|--------------------|
| D[7]   | VSYS | Bit is set when a VSYS conversion completes (and the GPADCREQ:IRQEN bit was set when the request was made).<br>Bit is cleared by writing a '1'. | 0 <sub>BIN</sub>   |
| D[6]   | VRI  | Bit is set when a VRI conversion completes (and the GPADCREQ:IRQEN bit was set when the request was made).<br>Bit is cleared by writing a '1'.  | 0 <sub>BIN</sub>   |
| D[5:4] | RSVD | Reserved.   | 00 <sub>BIN</sub>  |
| D[3]   | ADC  | Bit is set when a ADC conversion completes (and the GPADCREQ:IRQEN bit was set when the request was made).<br>Bit is cleared by writing a '1'.  | 0 <sub>BIN</sub>   |
| D[2:0] | RSVD | Reserved.   | 000 <sub>BIN</sub> |

**Table 151. GPADC Interrupt Mask Register**

| Register Name | R/W | D7   | D6  | D5   | D4   | D3 | D2   | D1 | D0 | Initial Value     | Address           |
|---------------|-----|------|-----|------|------|----|------|----|----|-------------------|-------------------|
| MADCIRQ       | R/W | MVSY | MVR | RSVD | MADC |    | RSVD |    |    | C8 <sub>HEX</sub> | 15 <sub>HEX</sub> |

| Bit    | Name | Function                              | Default            |
|--------|------|---------------------------------------|--------------------|
| D[7]   | MVSY | 0 = No Mask.<br>1 = Interrupt Masked. | 1 <sub>BIN</sub>   |
| D[6]   | MVR  | 0 = No Mask.<br>1 = Interrupt Masked. | 1 <sub>BIN</sub>   |
| D[5:4] | RSVD | Reserved.                             | 00 <sub>BIN</sub>  |
| D[3]   | MADC | 0 = No Mask.<br>1 = Interrupt Masked. | 1 <sub>BIN</sub>   |
| D[2:0] | RSVD | Reserved.                             | 000 <sub>BIN</sub> |

When a GPADC conversion is performed, results are stored in a series of registers which are dedicated to specific channels. (\*RSLT registers). These result registers are detailed in Table 152. To enable the DOUT for GPIO10, GPIO11, and GPIO12, write 41<sub>HEX</sub> to registers 2D<sub>HEX</sub>, 2E<sub>HEX</sub>, and 2F<sub>HEX</sub>.

**Table 152. ADC and Monitoring Registers – Upper Register**

| Register Name | R/W | D7   | D6 | D5 | D4 | D3 | D2 | D1 | D0        | Initial Value     | Address           |
|---------------|-----|------|----|----|----|----|----|----|-----------|-------------------|-------------------|
| ADCRSLT0H     | R   | RSVD |    |    |    |    |    |    | ADC0[9:8] | 00 <sub>HEX</sub> | 74 <sub>HEX</sub> |
| ADCRSLT1H     | R   | RSVD |    |    |    |    |    |    | ADC1[9:8] | 00 <sub>HEX</sub> | 76 <sub>HEX</sub> |
| ADCRSLT2H     | R   | RSVD |    |    |    |    |    |    | ADC2[9:8] | 00 <sub>HEX</sub> | 78 <sub>HEX</sub> |

| Bit    | Name      | Function  | Default               |
|--------|-----------|---|-----------------------|
| D[7:2] | RSVD      | Reserved.   | 000000 <sub>BIN</sub> |
| D[1:0] | ADCx[9:8] | Upper 2 bits of the ADC conversion result from respective ADC[x] input. | 00 <sub>BIN</sub>     |

**Table 153. ADC and Monitoring Registers – Lower Register**

| Register Name | R/W | D7        | D6 | D5 | D4 | D3 | D2 | D1 | D0                | Initial Value     | Address |
|---------------|-----|-----------|----|----|----|----|----|----|-------------------|-------------------|---------|
| ADCRSLT0L     | R   | ADC0[7:0] |    |    |    |    |    |    | 00 <sub>HEX</sub> | 75 <sub>HEX</sub> |         |
| ADCRSLT1L     | R   | ADC1[7:0] |    |    |    |    |    |    | 00 <sub>HEX</sub> | 77 <sub>HEX</sub> |         |
| ADCRSLT2L     | R   | ADC2[7:0] |    |    |    |    |    |    | 00 <sub>HEX</sub> | 79 <sub>HEX</sub> |         |

| Bit    | Name      | Function  | Default                 |
|--------|-----------|---|-------------------------|
| D[7:0] | ADCx[7:0] | Lower 8 bits of the ADC conversion result from respective ADC[x] input. | 00000000 <sub>BIN</sub> |

**Table 154. System Thermal Alert Register ADC0 – Upper Register**

| Register Name   | R/W | D7         | D6      | D5 | D4                  | D3 | D2 | D1             | D0 | Initial           | Address           |
|-----------------|-----|------------|---------|----|---------------------|----|----|----------------|----|-------------------|-------------------|
| ADC0_THRMA_LRTH | R/W | PROCHOT_EN | ALRT_EN |    | ADC0_ALRT_HYS [3:0] |    |    | ADC0_ALRT[9:8] |    | E7 <sub>HEX</sub> | 94 <sub>HEX</sub> |

| Bit    | Name                | Function  | Default             |
|--------|---------------------|---|---------------------|
| D[7]   | PROCHOT_EN          | Processor hot enable.<br>1= Enable, 0= Disable.           | 1 <sub>BIN</sub>    |
| D[6]   | ALRT_EN             | System thermal alert enable.<br>1= Enable, 0= Disable.    | 1 <sub>BIN</sub>    |
| D[5:2] | ADC0_ALRT_HYS [3:0] | Hysteresis value for ADC0_ALRT.                           | 1001 <sub>BIN</sub> |
| D[1:0] | ADC0_ALRT[9:8]      | Upper 2 bits of the ADC0_ALRT for the system temperature. | 11 <sub>BIN</sub>   |

**Table 155. System Thermal Alert Register ADC0 – Lower Register**

| Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0             | Initial           | Address           |
|---------------|-----|----|----|----|----|----|----|----|----------------|-------------------|-------------------|
| ADC0_THRMLRTL | R/W |    |    |    |    |    |    |    | ADC0_ALRT[7:0] | 58 <sub>HEX</sub> | 95 <sub>HEX</sub> |

| Bit    | Name      | Function  | Default                 |
|--------|-----------|---|-------------------------|
| D[7:0] | ADC0_ALRT | Lower 8 bits of the ADC0_ALRT for the system temperature. | 01011000 <sub>BIN</sub> |

**Table 156. System Thermal Reset Register ADC0**

| Register Name   | R/W | D7            | D6 | D5 | D4 | D3 | D2 | D1 | D0                   | Initial           | Address           |
|-----------------|-----|---------------|----|----|----|----|----|----|----------------------|-------------------|-------------------|
| ADC0_THRMR_ESET | R/W | ADC0_RESET_EN |    |    |    |    |    |    | ADC0_RESET_OFS [6:0] | 00 <sub>HEX</sub> | 97 <sub>HEX</sub> |

| Bit    | Name           | Function  | Default                |
|--------|----------------|---|------------------------|
| D[7]   | ADC0_RESET_EN  | 0 = Disable ADC0_RESET.<br>1 = Enable ADC0_RESET.     | 0 <sub>BIN</sub>       |
| D[6:0] | ADC0_RESET_OFS | Defines the offset above or below the ADC1 threshold. | 0000000 <sub>BIN</sub> |

**Table 157. System Thermal Alert Register ADC1 – Upper Register**

| Register Name      | R/W | D7         | D6      | D5                  | D4 | D3 | D2 | D1             | D0 | Initial           | Address           |
|--------------------|-----|------------|---------|---------------------|----|----|----|----------------|----|-------------------|-------------------|
| ADC1_THRMA<br>LRTH | R/W | PROCHOT_EN | ALRT_EN | ADC1_ALRT_HYS [3:0] |    |    |    | ADC1_ALRT[9:8] |    | E7 <sub>HEX</sub> | 99 <sub>HEX</sub> |

| Bit    | Name                | Function  | Default             |
|--------|---------------------|---|---------------------|
| D[7]   | PROCHOT_EN          | Processor hot enable.<br>1= Enable, 0= Disable.           | 1 <sub>BIN</sub>    |
| D[6]   | ALRT_EN             | System thermal alert enable.<br>1= Enable, 0= Disable.    | 1 <sub>BIN</sub>    |
| D[5:2] | ADC1_ALRT_HYS [3:0] | Hysteresis value for ADC1_ALRT.                           | 1001 <sub>BIN</sub> |
| D[1:0] | ADC1_ALRT[9:8]      | Upper 2 bits of the ADC1_ALRT for the system temperature. | 11 <sub>BIN</sub>   |

**Table 158. System Thermal Alert Register ADC1 – Lower Register**

| Register Name  | R/W | D7             | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Initial           | Address           |
|----------------|-----|----------------|----|----|----|----|----|----|----|-------------------|-------------------|
| ADC1_THRMALRTL | R/W | ADC1_ALRT[7:0] |    |    |    |    |    |    |    | 58 <sub>HEX</sub> | 9A <sub>HEX</sub> |

| Bit    | Name      | Function  | Default                 |
|--------|-----------|---|-------------------------|
| D[7:0] | ADC1_ALRT | Lower 8 bits of the ADC1_ALRT for the system temperature. | 01011000 <sub>BIN</sub> |

**Table 159. System Thermal Reset Register ADC1**

| Register Name  | R/W | D7            | D6                   | D5 | D4 | D3 | D2 | D1 | D0 | Initial | Address           |
|----------------|-----|---------------|----------------------|----|----|----|----|----|----|---------|-------------------|
| ADC1_THRMRESET | R/W | ADC1_RESET_EN | ADC1_RESET_OFS [6:0] |    |    |    |    |    |    |         | 00 <sub>HEX</sub> |

| Bit    | Name           | Function  | Default                |
|--------|----------------|---|------------------------|
| D[7]   | ADC1_RESET_EN  | 0 = Disable ADC1_RESET.<br>1 = Enable ADC1_RESET.     | 0 <sub>BIN</sub>       |
| D[6:0] | ADC1_RESET_OFS | Defines the offset above or below the ADC1 threshold. | 0000000 <sub>BIN</sub> |

**Table 160. System Thermal Alert Register ADC2 – Upper Register**

| Register Name      | R/W | D7         | D6      | D5                  | D4 | D3             | D2 | D1                | D0                | Initial | Address |
|--------------------|-----|------------|---------|---------------------|----|----------------|----|-------------------|-------------------|---------|---------|
| ADC2_THRMA<br>LRTH | R/W | PROCHOT_EN | ALRT_EN | ADC2_ALRT_HYS [3:0] |    | ADC2_ALRT[9:8] |    | E7 <sub>HEX</sub> | 9E <sub>HEX</sub> |         |         |

| Bit    | Name                | Function  | Default             |
|--------|---------------------|---|---------------------|
| D[7]   | PROCHOT_EN          | Processor hot enable.<br>1= Enable, 0= Disable.           | 1 <sub>BIN</sub>    |
| D[6]   | ALRT_EN             | System thermal alert enable.<br>1= Enable, 0= Disable.    | 1 <sub>BIN</sub>    |
| D[5:2] | ADC2_ALRT_HYS [3:0] | Hysteresis value for ADC2_ALRT.                           | 1001 <sub>BIN</sub> |
| D[1:0] | ADC2_ALRT[9:8]      | Upper 2 bits of the ADC2_ALRT for the system temperature. | 11 <sub>BIN</sub>   |

**Table 161. System Thermal Alert Register ADC2 – Lower Register**

| Register Name       | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Initial           | Address           |
|---------------------|-----|----|----|----|----|----|----|----|----|-------------------|-------------------|
| ADC2_THERMAL<br>RTL | R/W |    |    |    |    |    |    |    |    | 58 <sub>HEX</sub> | 9F <sub>HEX</sub> |

| Bit    | Name      | Function  | Default                 |
|--------|-----------|---|-------------------------|
| D[7:0] | ADC2_ALRT | Lower 8 bits of the ADC2_ALRT for the system temperature. | 01011000 <sub>BIN</sub> |

**Table 162. System Thermal Reset Register ADC2**

| Register Name  | R/W | D7            | D6                   | D5 | D4 | D3 | D2 | D1 | D0 | Initial           | Address           |
|----------------|-----|---------------|----------------------|----|----|----|----|----|----|-------------------|-------------------|
| ADC2_THRMRESET | R/W | ADC2_RESET_EN | ADC2_RESET_OFS [6:0] |    |    |    |    |    |    | 00 <sub>HEX</sub> | A1 <sub>HEX</sub> |

| Bit    | Name           | Function  | Default                |
|--------|----------------|---|------------------------|
| D[7]   | ADC2_RESET_EN  | 0 = Disable ADC2_RESET.<br>1 = Enable ADC2_RESET.     | 0 <sub>BIN</sub>       |
| D[6:0] | ADC2_RESET_OFS | Defines the offset above or below the ADC2 threshold. | 0000000 <sub>BIN</sub> |

**Table 163. THRM\_STAT\_CFG – Thermal Status Configuration**

| Register Name | R/W | D7   | D6       | D5       | D4       | D3         | D2      | D1      | D0      | Initial           | Address           |
|---------------|-----|------|----------|----------|----------|------------|---------|---------|---------|-------------------|-------------------|
| THRM_STAT_CFG | R/W | RSVD | PTC_ADC2 | PTC_ADC1 | PTC_ADC0 | DIETEMP_EN | ADC2_EN | ADC1_EN | ADC0_EN | 08 <sub>HEX</sub> | 90 <sub>HEX</sub> |

| Bit  | Name       | Function   | Default          |
|------|------------|--|------------------|
| D[7] | RSVD       | Reserved.  | 0 <sub>BIN</sub> |
| D[6] | PTC_ADC2   | PTC_ADCx = 1 <sub>BIN</sub> .<br>Clear alert once ADC reading < ADCx_ALRT – ADCx_ALRT_HYS value. | 0 <sub>BIN</sub> |
| D[5] | PTC_ADC1   | PTC_ADCx = 0 <sub>BIN</sub> .<br>Clear alert once ADC reading > ADCx_ALRT – ADCx_ALRT_HYS value. | 0 <sub>BIN</sub> |
| D[4] | PTC_ADC0   | Die temperature enable.<br>1= Enable, 0= Disable.  | 0 <sub>BIN</sub> |
| D[3] | DIETEMP_EN | ADC2 enable.<br>1= Enable, 0= Disable.   | 1 <sub>BIN</sub> |
| D[2] | ADC2_EN    | ADC1 enable.<br>1= Enable, 0= Disable.   | 0 <sub>BIN</sub> |
| D[1] | ADC1_EN    | ADC0 enable.<br>1= Enable, 0= Disable.   | 0 <sub>BIN</sub> |
| D[0] | ADC0_EN    | 1= Enable, 0= Disable.   | 0 <sub>BIN</sub> |

**Table 164. THRMRSLTH – Thermal Result Register High (MSB)**

| Register Name | R/W | D7   | D6 | D5 | D4 | D3 | D2 | D1           | D0 | Initial Value       | Address           |
|---------------|-----|------|----|----|----|----|----|--------------|----|---------------------|-------------------|
| THRMRSLTH     | R   | RSVD |    |    |    |    |    | DIETEMP[9:8] |    | See note [a] below. | 7E <sub>HEX</sub> |

[a] The value depends on the operating conditions.

| Bit    | Name         | Function  | Default               |
|--------|--------------|---|-----------------------|
| D[7:2] | RSVD         | Reserved.   | 000000 <sub>BIN</sub> |
| D[1:0] | DIETEMP[9:8] | Upper 2 bits of the temperature result for P91E0 die temperature (DIETEMP). | –                     |

**Table 165. THRMRSLTL – Thermal Result Register Low (LSB)**

| Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Initial Value       | Address           |
|---------------|-----|----|----|----|----|----|----|----|----|---------------------|-------------------|
| THRMRSLTL     | R   |    |    |    |    |    |    |    |    | See note [a] below. | 7F <sub>HEX</sub> |

[a] The value depends on the operating conditions.

| Bit    | Name         | Function  | Default |
|--------|--------------|---|---------|
| D[7:0] | DIETEMP[7:0] | Lower 8 bits of the temperature result for the P91E0 die temperature (DIETEMP). | –       |

The die temperature of the PMIC is calculated using Equation 1.

#### T<sub>J</sub> conversion formula

$$T_J = DIETEMP[9:0] \times \left(\frac{180}{143}\right) - 154.6, ^\circ\text{C}$$
**Equation 1**

**Table 166. VSYSRSLTH – VSYS Result Register High (MSB)**

| Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Initial Value     | Address           |
|---------------|-----|----|----|----|----|----|----|----|----|-------------------|-------------------|
| VSYSRSLTH     | R   |    |    |    |    |    |    |    |    | 00 <sub>HEX</sub> | 80 <sub>HEX</sub> |

| Bit    | Name      | Function   | Default               |
|--------|-----------|--|-----------------------|
| D[7:2] | RSVD      | Reserved.  | 000000 <sub>BIN</sub> |
| D[1:0] | VSYS[9:8] | Upper 2 bits of the ADC result for VSYS voltage. | 00 <sub>BIN</sub>     |

**Table 167. VSYSRSLTL – VSYS Result Register Low (LSB)**

| Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Initial Value     | Address           |
|---------------|-----|----|----|----|----|----|----|----|----|-------------------|-------------------|
| VSYSRSLTL     | R   |    |    |    |    |    |    |    |    | 00 <sub>HEX</sub> | 81 <sub>HEX</sub> |

| Bit    | Name      | Function   | Default                 |
|--------|-----------|--|-------------------------|
| D[7:0] | VSYS[7:0] | Lower 8 bits of the ADC result for VSYS voltage. | 00000000 <sub>BIN</sub> |

The actual VSYS voltage is calculated as follows:

#### VSYS Conversion Formula

$$VSYS = VSYS[9:0] \times \left(\frac{14}{3}\right) \times \left(\frac{1.2}{1024}\right) \text{ in V}$$
**Equation 2**

## 9.11 VR Current Monitoring

The P91E0 monitors DCD0, DCD1, DCD2, DCD5, and DCD6 switching regulator output currents and the corresponding I<sub>C</sub> and SVID registers for current readings are shown below in volts. The output current reading of a regulator is valid and is proportion to the output current when it operates in PWM Mode and is calibrated for the number of DPUs, inductance value, and input/output voltages.

**Table 168. Voltage Rails and Corresponding Result Register**

| Voltage Rails | I <sub>C</sub> Register |                    | SVID Rails Address | SVID Register          |
|---------------|-------------------------|--------------------|--------------------|------------------------|
|               | I <sub>OUT_H</sub>      | I <sub>OUT_L</sub> |                    | I <sub>OUT</sub> (hex) |
| DCD0          | 84 <sub>HEX</sub>       | 85 <sub>HEX</sub>  | SVID_ID_DCD0       | 15 <sub>HEX</sub> [a]  |
| DCD1          | 86 <sub>HEX</sub>       | 87 <sub>HEX</sub>  | SVID_ID_DCD1       | 15 <sub>HEX</sub> [a]  |
| DCD2          | 8C <sub>HEX</sub>       | 8D <sub>HEX</sub>  | SVID_ID_DCD2       | 15 <sub>HEX</sub> [a]  |
| DCD5          | 88 <sub>HEX</sub>       | 89 <sub>HEX</sub>  | N/A                | N/A                    |
| DCD6          | 8A <sub>HEX</sub>       | 8B <sub>HEX</sub>  | N/A                | N/A                    |

[a] The reading of the output current (I<sub>OUT</sub>) of DCD0, DCD1, and DCD2 using SVID is done by reading the SVID register 15<sub>HEX</sub> (see Table 121). Which regulator is read is determined by the SVID address, which is part of the SVID command.

**Table 169. I<sub>OUT\_H</sub> – Current Result Register High (MSB)**

| Register Name      | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Initial Value     | Address       |
|--------------------|-----|----|----|----|----|----|----|----|----|-------------------|---------------|
| I <sub>OUT_H</sub> | R   |    |    |    |    |    |    |    |    | 00 <sub>HEX</sub> | See Table 168 |

| Bit    | Name                   | Function   | Default                 |
|--------|------------------------|--|-------------------------|
| D[7:0] | I <sub>OUT</sub> [9:2] | Upper 8-bits of the current result for DCDx (I <sub>OUT</sub> ). | 00000000 <sub>BIN</sub> |

**Table 170. I<sub>OUT\_L</sub> – Current Result Register Low (LSB)**

| Register Name      | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Initial Value     | Address       |
|--------------------|-----|----|----|----|----|----|----|----|----|-------------------|---------------|
| I <sub>OUT_L</sub> | R   |    |    |    |    |    |    |    |    | 00 <sub>HEX</sub> | See Table 168 |

| Bit    | Name                   | Function  | Default           |
|--------|------------------------|---|-------------------|
| D[7:2] | RSVD                   | Reserved.   | –                 |
| D[1:0] | I <sub>OUT</sub> [1:0] | Lower 2-bits of the current result for DCDx (I <sub>OUT</sub> ). Always reads 00 <sub>BIN</sub> . | 00 <sub>BIN</sub> |

Normally, the regulators defined above are monitored in the SoC-S0 State. The output current is filtered and measured every 0.5ms (default). In sleep modes (standby modes), the frequency of measurement is set by VRIFRQS[1:0] bit field in the VRIMONCTL register (see Table 171). The VRIMONCTL control register provides the flexibility to enable/disable this function, define Active/Standy Mode, and set the measurement frequency.

**Table 171. VR Current Monitor Control Register**

| Register Name | R/W | D7   | D6 | D5   | D4           | D3           | D2 | D1     | D0                | Initial Value     | Address |
|---------------|-----|------|----|------|--------------|--------------|----|--------|-------------------|-------------------|---------|
| VRIMONCTL     | R/W | RSVD |    | MODE | VRIFRQS[1:0] | VRIFRQA[1:0] |    | VRIMEN | 2B <sub>HEX</sub> | 71 <sub>HEX</sub> |         |

| Bit    | Name         | Function   | Default           |
|--------|--------------|--|-------------------|
| D[7:6] | RSVD         | Reserved.  | 00 <sub>BIN</sub> |
| D[5]   | MODE         | Resets the two current monitoring timers based on the durations specified in VRIFRQS/VRIFRQA.<br>0 = Active Mode. VRIFRQA durations are used.<br>1 = Standby Mode. VRIFRQS durations are used.<br>Read only bit. Active versus Standby selection set via VRI_TYPE. | 1 <sub>BIN</sub>  |
| D[4:3] | VRIFRQS[1:0] | Specifies the frequency at which VR current measurements are initiated while in standby mode (MODE=1).<br>Values:<br>00 = Disabled<br>01 = 1ms (Default)<br>10 = 5ms<br>11 = 10ms  | 01 <sub>BIN</sub> |
| D[2:1] | VRIFRQA[1:0] | Specifies the frequency at which VR current measurements are initiated while in active mode (MODE=0).<br>Values:<br>00 = 0.25s<br>01 = 0.5ms (Default)<br>10 = 1ms<br>11 = 3ms   | 01 <sub>BIN</sub> |
| D[0]   | VRIMEN       | Setting this bit enables ADC-based current monitoring timers. Current monitoring timers are reset when this bit is set to 1.   | 1 <sub>BIN</sub>  |

The result registers for VR current measurements can be defined in the same manner as the other result registers in the previous section. They are listed in the GPADC register requirements table.

**Table 172. VR Current Monitor Mode Set Register**

| Register Name | R/W | D7   | D6 | D5             | D4 | D3   | D2 | D1   | D0 | Initial           | Address           |
|---------------|-----|------|----|----------------|----|------|----|------|----|-------------------|-------------------|
| VRI_MODE      | R/W | RSVD |    | VRI_TYPE [1:0] |    | RSVD |    | RSVD |    | 30 <sub>HEX</sub> | E3 <sub>HEX</sub> |

| Bit    | Name     | Function  | Default             |
|--------|----------|---|---------------------|
| D[7:6] | RSVD     | Reserved.   | 00 <sub>BIN</sub>   |
| D[5:4] | VRI_TYPE | Selects the power states in which current monitoring by the ADC block is enabled:<br>00 <sub>BIN</sub> – Active = SoC-S0, SoC-S0Ix, SoC-S3, SoC-S4/S5. Standby = NA.<br>01 <sub>BIN</sub> – Active = SoC-S0, SoC-S0Ix, SoC-S3. Standby = SoC-S4/S5.<br>10 <sub>BIN</sub> – Active = SoC-S0, SoC-S0Ix. Standby= SoC-S3, SoC-S4/S5.<br>11 <sub>BIN</sub> – Active = S0. Standby= SoC-S0Ix, SoC-S3, SoC-S4/S5. | 11 <sub>BIN</sub>   |
| D[3:0] | RSVD     | Reserved.   | 0000 <sub>BIN</sub> |

## 9.12 Thermal Monitoring

The P91E0 is capable of monitoring the PMIC die temperature via an internal temperature measurement circuit. To provide flexibility, the *THRMMONCTL* control register is defined (see Table 173) to let the user enable/disable this function, define Active/Standby Mode, and set the measurement frequency.

The *THRMMONCTL* register is the master control for the timer-based thermal monitoring state machine.

**Table 173. Thermal Monitor Control Register**

| Register Name | R/W | D7   | D6 | D5   | D4       | D3            | D2     | D1                | D0                | Initial Value | Address |
|---------------|-----|------|----|------|----------|---------------|--------|-------------------|-------------------|---------------|---------|
| THRMMONCTL    | R/W | RSVD |    | MODE | TEMPFRQS | TEMPFRQA[1:0] | THRMEN | 15 <sub>HEX</sub> | 8E <sub>HEX</sub> |               |         |

| Bit    | Name     | Function   | Default            |
|--------|----------|--|--------------------|
| D[7:5] | RSVD     | Reserved.  | 000 <sub>BIN</sub> |
| D[4]   | MODE     | Resets the two thermal monitoring timers based on the durations specified in the TEMPFRQS/TEMPFRQA bits.<br>0 = Active Mode. TEMPFRQA durations used.<br>1 = Standby Mode. TEMPFRQS durations used.<br>Read only bit. Active vs. Standby selection set via THR_M_TYPE. | 0 <sub>BIN</sub>   |
| D[3]   | TEMPFRQS | Specifies the frequency at which die temperature measurements are initiated while in Standby Mode (MODE bit = 1).<br>Values:<br>0 = Disabled (Default).<br>1 = 30s.  | 0 <sub>BIN</sub>   |

| Bit    | Name          | Function  | Default           |
|--------|---------------|---|-------------------|
| D[2:1] | TEMPFRQA[1:0] | Specifies the frequency at which die temperature measurements are initiated while in Active Mode (MODE bit = 0).<br><br>Values:<br>00 = Disabled<br>01 = 5s<br>10 = 10s (Default)<br>11 = 30s   | 10 <sub>BIN</sub> |
| D[0]   | THRMEN        | Setting this bit enables the ADC-based thermal monitoring timers. Thermal monitoring timers are reset when this bit is set to 1.<br><br>The P91E0 must still shut down if the die temperature exceeds its critical limit when this bit is set to 0. | 1 <sub>BIN</sub>  |

**Table 174. Thermal Monitor Mode Register**

| Register Name | R/W | D7   | D6 | D5              | D4 | D3   | D2 | D1   | D0 | Initial Value     | Address           |
|---------------|-----|------|----|-----------------|----|------|----|------|----|-------------------|-------------------|
| THR_M_MODE    | R/W | RSVD |    | THR_M_TYPE[1:0] |    | RSVD |    | RSVD |    | 30 <sub>HEX</sub> | E4 <sub>HEX</sub> |

| Bit    | Name            | Function   | Default             |
|--------|-----------------|--|---------------------|
| D[7:6] | RSVD            | Reserved.  | 00 <sub>BIN</sub>   |
| D[5:4] | THR_M_TYPE[1:0] | Defines sleep state(s) corresponding to the Active and Standby Mode for temperature measurement:<br><br>00 <sub>BIN</sub> : Active= SoC-S0, SoC-S0lx, SoC-S3, SoC-S4/S5. Standby= NA.<br>01 <sub>BIN</sub> : Active= SoC-S0, SoC-S0lx, SoC-S3. Standby= SoC-S4/S5.<br>10 <sub>BIN</sub> : Active= SoC-S0, SoC-S0lx. Standby= SoC-S3, SoC-S4/S5.<br>11 <sub>BIN</sub> : Active= SoC-S0. Standby= SoC-S0lx, SoC-S3, SoC-S4/S5. | 11 <sub>BIN</sub>   |
| D[3:0] | RSVD            | Reserved.  | 0000 <sub>BIN</sub> |

## 9.13 Thermal Alerts

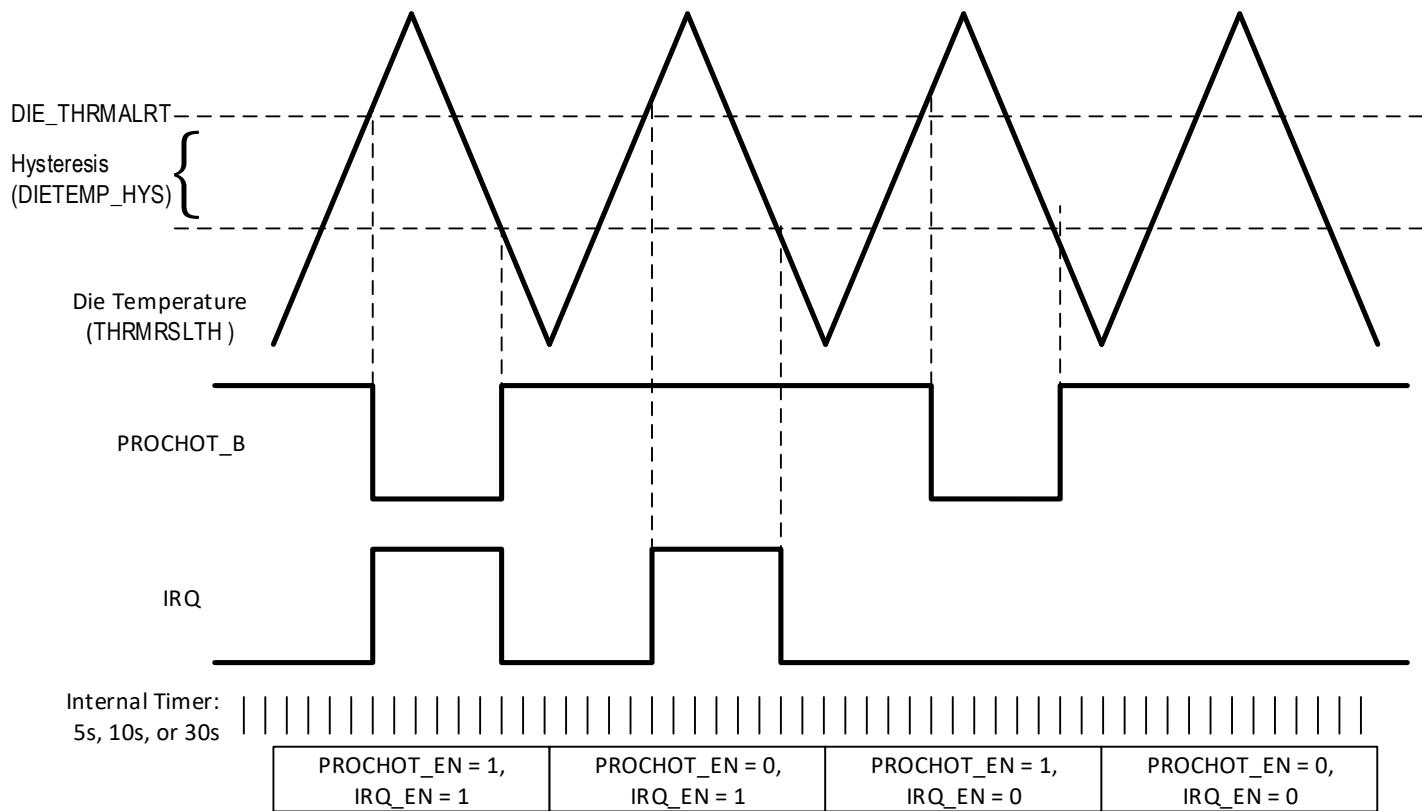
The P91E0 supports the capability to alert the SoC if the die temperature measurement value in D[1:0] of the *THRMRSLTH* register (two most-significant bits; see Table 164) combined with the *THRMRSLTL* register (lower 8 bits; see Table 165) is more than or equal to the configurable threshold value set by D[1:0] in the *DIE\_THRMALRTH* register (two most-significant bits; see Table 175) combined with the *DIE\_THRMALRTL* register (lower 8 bits; see Table 176). Depending on the settings in the *THRMMONCTL* control register (see Table 173), an internal timer initiates a die temperature measurement every 5, 10, or 30 seconds. After each measurement, the value is compared with the threshold setting. If the measured value is more than the threshold value, an alert condition has been detected. There are two actions that the P91E0 could initiate:

- Assert the PROCHOT\_B pin (from HIGH to LOW). This pin notifies the SoC of a thermal event affecting the P91E0. This functionality is enabled by setting the PROCHOT\_EN bit D[7] to 1 in the *DIE\_THRMALRTH* register. When this enable bit is LOW, the PROCHOT\_B pin remains HIGH, even if the die temperature exceeds the threshold value.
- Generate an interrupt request by asserting the IRQ pin (from LOW to HIGH). The IRQ\_EN bit in the PMIC Die Temperature Threshold Register High (see Table 175) must be set to 1 and the interrupts must be enabled by the SoC or other device clearing the corresponding bits in the first-level IRQ mask (*MIRQLVL1* register; see Table 143) and the second-level *MTHRMIRQ* register (see Table 180). The IRQ pin stays asserted, even if the alert condition is no longer present. The SoC must clear the second-level interrupt register by writing logic 1 to the PMICALRT bit in *THRMMIRQ* (see Table 179). The *STHRMMIRQ* thermal monitor status register (see Table 181) is updated according to the current measured die temperature and is automatically cleared once the die temperature is outside the alert zone.

To avoid multiple assertions of the PROCHOT\_B and the IRQ pins, when the die temperature is close to the threshold value, there is a configurable hysteresis, which determines the lower end of the alert zone. The upper end is determined by the die threshold value. The DIETEMP\_HYS[3:0] bit field is located in the *DIE\_THRMALRTH* register.

The operation of the thermal alerts of the P91E0 is shown in Figure 14.

**Figure 14. Thermal Alerts**



In addition to prescribing the ADC threshold for triggering an alert, there is also a register to set a die temperature threshold (*DIE\_THRMALRTH*), and it can be configured to assert PROCHOT\_B if the die temperature equals or exceeds the set temperature. The *DIE\_THRMALRTH* register (see Table 175) includes a 4-bit field hysteresis (DIETEMP\_HYS[5:2]), which defines hysteresis for the thermal alert. A hysteresis value is used to avoid spurious interrupt assertions when temperatures hover near the alert threshold.

When a thermal event is triggered for a particular sensor, the P91E0 takes the following actions:

- Sets the appropriate bit in the 2nd level thermal interrupt register (THRMRIRQ)
- Setting this bit, in turn, sets the 1st level interrupt bit, triggering an interrupt to the SoC over the INT pin.
- Sets or clears (depending on ADC count) the appropriate status register in the STHRMRIRQ status register.

The level 2 interrupt register for the thermal monitoring state machine, *THRMRIRQ*, is defined in Table 179.

**Table 175. PMIC Die Temperature Alert Threshold Register High**

| Register Name | R/W | D7         | D6 | D5               | D4 | D3 | D2 | D1                | D0 | Initial Value     | Address           |
|---------------|-----|------------|----|------------------|----|----|----|-------------------|----|-------------------|-------------------|
| DIE_THRMALRTH | R/W | PROCHOT_EN | EN | DIETEMP_HYS[3:0] |    |    |    | DIETEMP_ALRT[9:8] |    | E4 <sub>HEX</sub> | AF <sub>HEX</sub> |

| Bit    | Name              | Function  | Default             |
|--------|-------------------|---|---------------------|
| D[7]   | PROCHOT_EN        | Die Temperature Policy Action Enable.<br>When set to 1, any crossover of the die temperature will assert PROCHOT_B and any cross below DIETEMP_HYST will de-assert PROCHOT_B. | 1 <sub>BIN</sub>    |
| D[6]   | ALERT_EN          | Die Measurement Enable:<br>1 = Enabled<br>0 = Disabled  | 1 <sub>BIN</sub>    |
| D[5:2] | DIETEMP_HYS[3:0]  | Hysteresis value for die temperature.<br>$T_{HYS} = DIETEMP\_HYS[3:0] \times 180/143$   | 1001 <sub>BIN</sub> |
| D[1:0] | DIETEMP_ALRT[9:8] | Upper 2 bits of the temperature alert threshold for the die temperature. See Table 176 for remaining bits.  | 00 <sub>BIN</sub>   |

**Table 176. PMIC Die Temperature Alert Threshold Register Low**

| Register Name | R/W | D7                | D6 | D5 | D4 | D3 | D2 | D1 | D0                               | Initial Value     | Address |
|---------------|-----|-------------------|----|----|----|----|----|----|----------------------------------|-------------------|---------|
| DIE_THRMALRTL | R/W | DIETEMP_ALRT[7:0] |    |    |    |    |    |    | D1 <sub>HEX</sub> <sup>[a]</sup> | B0 <sub>HEX</sub> |         |

[a] The value D1<sub>HEX</sub> = 11010001<sub>BIN</sub> corresponds to alert threshold 108°C (see Equation 1 for the relationship between the register value and temperature).

| Bit    | Name              | Function  | Default                 |
|--------|-------------------|---|-------------------------|
| D[7:0] | DIETEMP_ALRT[7:0] | Lower 8 bits of the temperature alert threshold for the die temperature.<br>See Table 175 for upper two bits. | 11010001 <sub>BIN</sub> |

**Table 177. PMIC Die Temperature Warning Threshold Register High**

| Register Name | R/W | D7       | D6      | D5                | D4 | D3 | D2 | D1                | D0 | Initial           | Address           |
|---------------|-----|----------|---------|-------------------|----|----|----|-------------------|----|-------------------|-------------------|
| DIE_THRMWARNH | R/W | SALRT_EN | WARN_EN | DIETEMP_HYS [3:0] |    |    |    | DIETEMP_WARN[9:8] |    | E4 <sub>HEX</sub> | B1 <sub>HEX</sub> |

| Bit    | Name              | Function   | Default             |
|--------|-------------------|--|---------------------|
| D[7]   | SALRT_EN          |  | 1 <sub>BIN</sub>    |
| D[6]   | WARN_EN           | Enable for warning for die over-temperature condition.<br>1= Enable, 0 = Disable.                      | 1 <sub>BIN</sub>    |
| D[5:2] | DIETEMP_HYS[3:0]  | Hysteresis value for die over-temperature condition.<br>$T_{HYS} = DIETEMP\_HYS[3:0] \times 180/143$ . | 1001 <sub>BIN</sub> |
| D[1:0] | DIETEMP_WARN[9:8] | Upper 2 bits of the temperature warning threshold for the die temperature.                             | 00 <sub>BIN</sub>   |

**Table 178. PMIC Die Temperature Warning Threshold Register Low**

| Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Initial           | Address           |
|---------------|-----|----|----|----|----|----|----|----|----|-------------------|-------------------|
| DIE_THRMWARNL | R/W |    |    |    |    |    |    |    |    | D1 <sub>HEX</sub> | B2 <sub>HEX</sub> |

| Bit    | Name              | Function   | Default                 |
|--------|-------------------|--|-------------------------|
| D[7:0] | DIETEMP_WARN[7:0] | Lower 8 bits of temperature warning threshold for the die temperature. | 11010001 <sub>BIN</sub> |

**Table 179. Thermal Monitor Interrupt Register**

| Register Name | R/W | D7 | D6 | D5 | D4 | D3   | D2       | D1       | D0       | Initial Value | Address           |
|---------------|-----|----|----|----|----|------|----------|----------|----------|---------------|-------------------|
| THRMIRQ       | RW  |    |    |    |    | RSVD | PMICALRT | ADC2ALRT | ADC1ALRT | ADC0ALRT      | 00 <sub>HEX</sub> |

| Bit    | Name     | Function  | Default             |
|--------|----------|---|---------------------|
| D[7:4] | RSVD     | Reserved.   | 0000 <sub>BIN</sub> |
| D[3]   | PMICALRT | Set by the thermal state machine when the P91E0 die temperature thermal alert occurs. Write 1 to clear. | 0 <sub>BIN</sub>    |
| D[2]   | ADC2ALRT | Set by the state machine when an ADC2 temperature thermal alert occurs.                                 | 0 <sub>BIN</sub>    |
| D[1]   | ADC1ALRT | Set by the state machine when an ADC1 temperature thermal alert occurs.                                 | 0 <sub>BIN</sub>    |
| D[0]   | ADC0ALRT | Set by the state machine when an ADC0 temperature thermal alert occurs.                                 | 0 <sub>BIN</sub>    |

**Table 180. Thermal Monitor Interrupt Mask Register**

| Register Name | R/W | D7 | D6 | D5 | D4 | D3   | D2        | D1        | D0        | Initial Value | Address           |
|---------------|-----|----|----|----|----|------|-----------|-----------|-----------|---------------|-------------------|
| MTHRMIRQ      | R/W |    |    |    |    | RSVD | MPMICALRT | MADC2ALRT | MADC1ALRT | MADC0ALRT     | 0F <sub>HEX</sub> |

| Bit    | Name      | Function   | Default             |
|--------|-----------|--|---------------------|
| D[7:4] | RSVD      | Reserved.  | 0000 <sub>BIN</sub> |
| D[3]   | MPMICALRT | Set by the thermal state machine when a PMIC die temperature thermal alert occurs.<br>0 = MPMICALRT IRQ unmasked.<br>1 = MPMICALRT IRQ masked. | 1 <sub>BIN</sub>    |
| D[2]   | MADC2ALRT | Set by the state machine if an ADC2 temperature thermal alert occurs.  | 1 <sub>BIN</sub>    |
| D[1]   | MADC1ALRT | Set by the state machine if an ADC1 temperature thermal alert occurs.  | 1 <sub>BIN</sub>    |
| D[0]   | MADC0ALRT | Set by the state machine if an ADC0 temperature thermal alert occurs.  | 1 <sub>BIN</sub>    |

The thermal interrupt status register, STHRMIRQ is defined in Table 181. If an alert condition is removed, the status bit will clear. However, the interrupt generated (D[3] in the *THRMIRQ* second-level interrupt register; see Table 179) will persist until cleared by the SoC.

**Table 181. Thermal Monitor Status Register**

| Register Name | R/W | D7 | D6   | D5 | D4 | D3        | D2        | D1        | D0        | Initial Value     | Address           |
|---------------|-----|----|------|----|----|-----------|-----------|-----------|-----------|-------------------|-------------------|
| STHRMIRQ      | R/W |    | RSVD |    |    | SPMICALRT | SADC2ALRT | SADC1ALRT | SADC0ALRT | 00 <sub>HEX</sub> | 05 <sub>HEX</sub> |

| Bit    | Name      | Function   | Default             |
|--------|-----------|--|---------------------|
| D[7:4] | RSVD      | Reserved.  | 0000 <sub>BIN</sub> |
| D[3]   | SPMICALRT | Set to 1 by the thermal state machine if a P91E0 die temperature thermal alert is occurring. | 0 <sub>BIN</sub>    |
| D[2]   | SADC2ALRT | Set to 1 by the state machine if an ADC2 temperature thermal alert is occurring.             | 0 <sub>BIN</sub>    |
| D[1]   | SADC1ALRT | Set to 1 by the state machine if an ADC1 temperature thermal alert is occurring.             | 0 <sub>BIN</sub>    |
| D[0]   | SADC0ALRT | Set to 1 by the state machine if an ADC0 temperature thermal alert is occurring.             | 0 <sub>BIN</sub>    |

## 10. Register Map

Note: Addresses 03<sub>HEX</sub>, 0F<sub>HEX</sub>, 32<sub>HEX</sub>, 3A<sub>HEX</sub>, 6E<sub>HEX</sub>, 6F<sub>HEX</sub>, 73<sub>HEX</sub>, 83<sub>HEX</sub>, 91<sub>HEX</sub>, 92<sub>HEX</sub>, 93<sub>HEX</sub>, 96<sub>HEX</sub>, 98<sub>HEX</sub>, 9B<sub>HEX</sub>, A2<sub>HEX</sub>, A3<sub>HEX</sub>, E5<sub>HEX</sub>, and FF<sub>HEX</sub> are registers for internal debug use.

| Register Name  | R/W | D7        | D6        | D5        | D4                  | D3                                    | D2                  | D1           | D0         | Address (HEX) |
|----------------|-----|-----------|-----------|-----------|---------------------|---------------------------------------|---------------------|--------------|------------|---------------|
| VENDOR_ID      | R   |           |           |           |                     | VENDOR_ID[7:0]                        |                     |              |            | 00            |
| REVISION       | R   | RSVD      |           | RSVD      | MAJREV0[2:0]        |                                       | MINREV0[2:0]        |              |            | 01            |
| IRQLVL1        | R/W | RSVD      | VR        | GPIO      | RSVD                | ADC                                   | RSVD                | THR M        | RSVD       | 02            |
| THRMIRQ        | R/W |           | RSVD      |           | PMICALRT            | ADC2ALRT                              | ADC1ALRT            | ADC0ALRT     |            | 04            |
| STHRMIRQ       | R/W |           | RSVD      |           | SPMICALRT           | SADC2ALRT                             | SADC1ALRT           | SADC0ALRT    |            | 05            |
| DPS0_CONFIG    | R/W | RSVD      |           | GM0       |                     | RSVD                                  |                     | OFF_DLY[1:0] |            | 06            |
| DPS0_PMSTATUS  | R   |           |           |           | DPS0_PMSTATUS[7:0]  |                                       |                     |              |            | 07            |
| ADCIRQ         | R/W | VSYS      | VR        | RSVD      | RSVD                | ADC                                   |                     | RSVD         |            | 08            |
| DPS1_CONFIG    | R/W | RSVD      |           | GM1       |                     | RSVD                                  |                     | OFF_DLY[1:0] |            | 09            |
| DPS1_PMSTATUS  | R   |           |           |           | DPS1_PMSTATUS[7:0]  |                                       |                     |              |            | 0A            |
| GPIO0IRQ       | R/W | RSVD      | GPIO14    | GPIO13    | GPIO12              | GPIO11                                | GPIO10              | GPIO9        | GPIO8      | 0B            |
| GPIO1IRQ       | R/W | GPIO7     | GPIO6     | GPIO5     | GPIO4               | GPIO3                                 | GPIO2               | GPIO1        | GPIO0      | 0C            |
| DPS56_CONFIG   | R/W |           | RSVD      |           | GM6                 | BW6                                   | GM5                 | BW5          |            | 0D            |
| MIRQLVL1       | R/W | RSVD      | MVR       | MGPIO     | RSVD                | MADC                                  | RSVD                | MTHRM        | RSVD       | 0E            |
| CORE_TYPE_EXIT | R/W |           |           | RSVD      |                     |                                       | DCD1EXIT            | DCD0EXIT     |            | 10            |
| MTHRMIRQ       | R/W |           | RSVD      |           | MPMICALRT           | MADC2ALRT                             | MADC1ALRT           | MADC0ALRT    |            | 11            |
| LDO0_VOUT      | R/W |           | RSVD      |           |                     | Output Voltage Setting (see Table 12) |                     |              |            | 12            |
| LDO1_VOUT      | R/W |           | RSVD      |           |                     | Output Voltage Setting (see Table 12) |                     |              |            | 13            |
| LDO2_VOUT      | R/W |           | RSVD      |           |                     | Output Voltage Setting (see Table 12) |                     |              |            | 14            |
| MADCIRQ        | R/W | MVSYS     | MVR       | RSVD      | MADC_TEMP           |                                       | RSVD                |              |            | 15            |
| LDO3_VOUT      | R/W |           | RSVD      |           |                     | Output Voltage Setting (see Table 12) |                     |              |            | 16            |
| LDO4_VOUT      | R/W |           | RSVD      |           |                     | Output Voltage Setting (see Table 12) |                     |              |            | 17            |
| LDO6_VOUT      | R/W |           | RSVD      |           |                     | Output Voltage Setting (see Table 12) |                     |              |            | 18            |
| MGPIO0IRQ      | R/W | RSVD      | MGPIO14   | MGPIO13   | MGPIO12             | MGPIO11                               | MGPIO10             | MGPIO9       | MGPIO8     | 19            |
| MGPIO1IRQ      | R/W | RSVD      | VR        | GPIO      | RSVD                | ADC                                   | RSVD                | THR M        | RSVD       | 1A            |
| DPS2_CONFIG    | R/W | RSVD      |           | GM2       |                     | RSVD                                  |                     | OFF_DLY[1:0] |            | 1B            |
| DPS2_PMSTATUS  | R   |           |           |           | DPS2_PMSTATUS [7:0] |                                       |                     |              |            | 1C            |
| DPS3_CONFIG    | R/W | RSVD      | DAMPB3    | GM3       |                     | BW [2:0]                              |                     | OFF_DLY[1:0] |            | 1D            |
| DPS3_PMSTATUS  | R   |           |           |           | DPS3_PMSTATUS [7:0] |                                       |                     |              |            | 1E            |
| DCLL_CTL       | R/W |           |           | RSVD      |                     |                                       | DC_LL[2:0]          |              |            | 1F            |
| RESETSRC0      | R/W | RSYSTEMP2 | RSYSTEMP1 | RSYSTEMPO | I2C_RESET           | RSVD                                  | RPWRBTIN            | RPMICTEMP    | RTHERMTRIP | 20            |
| RESETSRC1      | R/W | RVSYSUVP  | DCD1_OV   | DCD0_OV   | SUSPWRDNAK          |                                       | VBAK_RCHG/VBAK_VCHG |              |            | 21            |
| WAKESRC        | R   |           |           | RSVD      |                     |                                       |                     | WAKEPBTN     |            | 22            |

| Register Name | R/W | D7                  | D6       | D5      | D4               | D3                 | D2          | D1           | D0   | Address (HEX) |  |  |
|---------------|-----|---------------------|----------|---------|------------------|--------------------|-------------|--------------|------|---------------|--|--|
| DPS4_CONFIG   | R/W | RSVD                | DAMPB4   | GM4     | BW [2:0]         |                    |             | OFF_DLY[1:0] |      | 23            |  |  |
| DPS4_PMSTATUS | R   | DPS4_PMSTATUS [7:0] |          |         |                  |                    |             |              |      |               |  |  |
| ACLL_CTL      | R/W | RSVD                |          |         |                  | AC_LL              |             |              |      |               |  |  |
| PBCONFIG      | R/W | RSVD                | CLRHT    | CLRFLT  | FLT              |                    |             |              |      | 26            |  |  |
| PBSTATUS      | R   | RSVD                | PBLVL    | PBHT    |                  |                    |             |              | 27   |               |  |  |
| RSMRSTCFG     | R/W | RSVD                |          |         |                  |                    |             |              |      |               |  |  |
| MODEMCTRL     | R/W | RSVD                |          |         |                  |                    | MODEMRSTSEQ | MODEM_OFF    | 29   |               |  |  |
| PWRSEQQCFG    | R/W | RSVD                |          |         | VCCAPWROK<br>CFG | SUSPWRDNACK<br>CFG | DTPWROK     |              |      | 2A            |  |  |
| GPIOCTL08     | R/W | RSVD                | ALT_FUNC | DIR     | DRV              | REN                | RVAL        |              | DOUT | 2B            |  |  |
| GPIOCTL09     | R/W | RSVD                | ALT_FUNC | DIR     | DRV              | REN                | RVAL        |              | DOUT | 2C            |  |  |
| GPIOCTL010    | R/W | RSVD                | ALT_FUNC | DIR     | DRV              | REN                | RVAL        |              | DOUT | 2D            |  |  |
| GPIOCTL011    | R/W | RSVD                | ALT_FUNC | DIR     | DRV              | REN                | RVAL        |              | DOUT | 2E            |  |  |
| GPIOCTL012    | R/W | RSVD                | ALT_FUNC | DIR     | DRV              | REN                | RVAL        |              | DOUT | 2F            |  |  |
| GPIOCTL013    | R/W | RSVD                | ALT_FUNC | DIR     | DRV              | REN                | RVAL        |              | DOUT | 30            |  |  |
| GPIOCTL014    | R/W | RSVD                | ALT_FUNC | DIR     | DRV              | REN                | RVAL        |              | DOUT | 31            |  |  |
| GPIOCTL18     | R/W | RSVD                |          |         | GPIGLBYP         | GPIDBNC            | INTCNT      |              | DIN  | 33            |  |  |
| GPIOCTL19     | R/W | RSVD                |          |         | GPIGLBYP         | GPIDBNC            | INTCNT      |              | DIN  | 34            |  |  |
| GPIOCTL110    | R/W | RSVD                |          |         | GPIGLBYP         | GPIDBNC            | INTCNT      |              | DIN  | 35            |  |  |
| GPIOCTL111    | R/W | RSVD                |          |         | GPIGLBYP         | GPIDBNC            | INTCNT      |              | DIN  | 36            |  |  |
| GPIOCTL112    | R/W | RSVD                |          |         | GPIGLBYP         | GPIDBNC            | INTCNT      |              | DIN  | 37            |  |  |
| GPIOCTL113    | R/W | RSVD                |          |         | GPIGLBYP         | GPIDBNC            | INTCNT      |              | DIN  | 38            |  |  |
| GPIOCTL114    | R/W | RSVD                |          |         | GPIGLBYP         | GPIDBNC            | INTCNT      |              | DIN  | 39            |  |  |
| GPIOCTL00     | R/W | RSVD                | ALT_FUNC | DIR     | DRV              | REN                | RVAL[1:0]   |              | DOUT | 3B            |  |  |
| GPIOCTL01     | R/W | RSVD                | ALT_FUNC | DIR     | DRV              | REN                | RVAL[1:0]   |              | DOUT | 3C            |  |  |
| GPIOCTL02     | R/W | RSVD                | ALT_FUNC | DIR     | DRV              | REN                | RVAL[1:0]   |              | DOUT | 3D            |  |  |
| GPIOCTL03     | R/W | RSVD                | ALT_FUNC | DIR     | DRV              | REN                | RVAL[1:0]   |              | DOUT | 3E            |  |  |
| GPIOCTL04     | R/W | RSVD                | ALT_FUNC | DIR     | DRV              | REN                | RVAL[1:0]   |              | DOUT | 3F            |  |  |
| GPIOCTL05     | R/W | RSVD                | ALT_FUNC | DIR     | DRV              | REN                | RVAL[1:0]   |              | DOUT | 40            |  |  |
| GPIOCTL06     | R/W | RSVD                | ALT_FUNC | DIR     | DRV              | REN                | RVAL[1:0]   |              | DOUT | 41            |  |  |
| GPIOCTL07     | R/W | RSVD                | ALT_FUNC | DIR     | DRV              | REN                | RVAL[1:0]   |              | DOUT | 42            |  |  |
| GPIOCTL10     | R/W | RSVD                |          |         | GPIGLBYP         | GPIDBNC            | INTCNT      |              | DIN  | 43            |  |  |
| GPIOCTL11     | R/W | RSVD                |          |         | GPIGLBYP         | GPIDBNC            | INTCNT      |              | DIN  | 44            |  |  |
| GPIOCTL12     | R/W | RSVD                |          |         | GPIGLBYP         | GPIDBNC            | INTCNT      |              | DIN  | 45            |  |  |
| GPIOCTL13     | R/W | RSVD                |          |         | GPIGLBYP         | GPIDBNC            | INTCNT      |              | DIN  | 46            |  |  |
| GPIOCTL14     | R/W | RSVD                |          |         | GPIGLBYP         | GPIDBNC            | INTCNT      |              | DIN  | 47            |  |  |
| GPIOCTL15     | R/W | RSVD                |          |         | GPIGLBYP         | GPIDBNC            | INTCNT      |              | DIN  | 48            |  |  |
| GPIOCTL16     | R/W | RSVD                | GPIGLBYP | GPIDBNC | INTCNT           | DIN                |             |              | RSVD | 49            |  |  |

| Register Name | R/W | D7     | D6   | D5       | D4      | D3         | D2      | D1       | D0            | Address (HEX) |
|---------------|-----|--------|------|----------|---------|------------|---------|----------|---------------|---------------|
| GPIOCTL17     | R/W | RSVD   |      | GPIGLBYP | GPIDBNC | INTCNT     | DIN     |          | RSVD          | 4A            |
| PWM0CLKDIV    | R/W | ENABLE |      |          |         | CLKDIV0    |         |          |               | 4B            |
| PWM1CLKDIV    | R/W | ENABLE |      |          |         | CLKDIV0    |         |          |               | 4C            |
| SLEEP_CTL     | R/W |        | RSVD |          |         | POL        | SEL     | EN       |               | 4D            |
| PWM0DUTYCYLE  | R/W |        |      |          |         | DUTYCYLE0  |         |          |               | 4E            |
| PWM1DUTYCYLE  | R/W |        |      |          |         | DUTYCYLE1  |         |          |               | 4F            |
| S0IxCFG       | R/W |        |      |          |         | RSVD       |         |          | NOS0Ix        | 50            |
| BLIGHT_EN     | R/W |        |      |          |         | RSVD       |         |          | BKLIGHT_ENOUT | 51            |
| PANEL_EN      | R/W |        |      |          |         | RSVD       |         |          | PANEL_ENOUT   | 52            |
| DCD0_CTL      | R/W | RSVD   |      | SVID     |         | RSVD       |         | RAIL_SEL | RAIL_EN       | 53            |
| DCD1_CTL      | R/W | RSVD   |      | SVID     |         | RSVD       |         | RAIL_SEL | RAIL_EN       | 54            |
| DCD6_CTL      | R/W |        |      | RSVD     |         |            |         | RAIL_SEL | RAIL_EN       | 55            |
| EN0_CTL       | R/W |        | RSVD |          |         | POLARITY   |         | RAIL_SEL | RAIL_EN       | 56            |
| EN1_CTL       | R/W |        | RSVD |          |         | POLARITY   |         | RAIL_SEL | RAIL_EN       | 57            |
| LDO5_CTL      | R/W |        | RSVD |          |         |            |         | RAIL_SEL | RAIL_EN       | 58            |
| DCD5_CTL      | R/W |        | RSVD |          |         |            |         | RAIL_SEL | RAIL_EN       | 59            |
| DCD4_CTL      | R/W |        | RSVD |          |         |            |         | RAIL_SEL | RAIL_EN       | 5A            |
| EN2_CTL       | R/W |        | RSVD |          |         | POLARITY   |         | RAIL_SEL | RAIL_EN       | 5B            |
| EN3_CTL       | R/W |        | RSVD |          |         | POLARITY   |         | RAIL_SEL | RAIL_EN       | 5C            |
| EN4_CTL       | R/W |        | RSVD |          |         | POLARITY   |         | RAIL_SEL | RAIL_EN       | 5D            |
| LDO3_CTL      | R/W |        | RSVD |          |         |            |         | RAIL_SEL | RAIL_EN       | 5E            |
| DCD2_CTL      | R/W | RSVD   |      | SVID     |         | RSVD       |         | RAIL_SEL | RAIL_EN       | 5F            |
| LDO4_CTL      | R/W |        | RSVD |          |         |            |         | RAIL_SEL | RAIL_EN       | 60            |
| LDO1_CTL      | R/W |        | RSVD |          |         |            |         | RAIL_SEL | RAIL_EN       | 61            |
| EN8_CTL       | R/W |        | RSVD |          |         | POLARITY   |         | RAIL_SEL | RAIL_EN       | 62            |
| SEQ_STATUS    | R   |        |      |          |         | SEQ_STATUS |         |          |               | 63            |
| EN7_CTL       | R/W |        | RSVD |          |         | POLARITY   |         | RAIL_SEL | RAIL_EN       | 64            |
| LDO0_CTL      | R/W |        | RSVD |          |         |            |         | RAIL_SEL | RAIL_EN       | 65            |
| LDO2_CTL      | R/W |        | RSVD |          |         |            |         | RAIL_SEL | RAIL_EN       | 66            |
| DCD3_CTL      | R/W |        | RSVD |          |         |            |         | RAIL_SEL | RAIL_EN       | 67            |
| EN6_CTL       | R/W |        | RSVD |          |         | POLARITY   |         | RAIL_SEL | RAIL_EN       | 68            |
| EN5_CTL       | R/W |        | RSVD |          |         | POLARITY   |         | RAIL_SEL | RAIL_EN       | 69            |
| LDO6_CTL      | R/W |        | RSVD |          |         |            |         | RAIL_SEL | RAIL_EN       | 6A            |
| EN9_CTL       | R/W |        | RSVD |          |         | POLARITY   |         | RAIL_SEL | RAIL_EN       | 6B            |
| EN10_CTL      | R/W |        | RSVD |          |         | POLARITY   |         | RAIL_SEL | RAIL_EN       | 6C            |
| EN11_CTL      | R/W |        | RSVD |          |         | POLARITY   |         | RAIL_SEL | RAIL_EN       | 6D            |
| DILIM         | R/W |        | RSVD |          |         |            |         | DILIM2   | DILIM1        | 70            |
| VRIMONCTL     | R/W | RSVD   | MODE |          | VRIFRQS |            | VRIFRQA |          | VRIM_EN       | 71            |

| Register Name  | R/W | D7             | D6                  | D5                 | D4              | D3          | D2             | D1              | D0      | Address (HEX) |  |  |  |  |
|----------------|-----|----------------|---------------------|--------------------|-----------------|-------------|----------------|-----------------|---------|---------------|--|--|--|--|
| GRADCREQ       | R/W | VSYS           | VRI                 | RSVD               |                 | ADC_TEMP    | RSVD           | IRQ_EN          | BUSY    | 72            |  |  |  |  |
| ADCRSLT0H      | R   | RSVD           |                     |                    |                 |             |                | ADC0[9:8]       | 74      |               |  |  |  |  |
| ADCRSLT0L      | R   | ADC0[7:0]      |                     |                    |                 |             |                | 75              |         |               |  |  |  |  |
| ADCRSLT1H      | R   | RSVD           |                     |                    |                 |             |                | ADC1[9:8]       | 76      |               |  |  |  |  |
| ADCRSLT1L      | R   | ADC1[7:0]      |                     |                    |                 |             |                | 77              |         |               |  |  |  |  |
| ADCRSLT2H      | R   | RSVD           |                     |                    |                 |             |                | ADC2[9:8]       | 78      |               |  |  |  |  |
| ADCRSLT2L      | R   | ADC2[7:0]      |                     |                    |                 |             |                | 79              |         |               |  |  |  |  |
| DPS_IDLE_CFG   | R/W | RSVD           |                     |                    |                 | EN_PS_IDLE2 | EN_PS_IDLE1    | EN_PS_IDLE0     | 7A      |               |  |  |  |  |
| VSLEEP         | R/W | VSLEEP[7:0]    |                     |                    |                 |             |                | 7B              |         |               |  |  |  |  |
| DRAMPWROK      | R/W | RSVD           |                     |                    |                 | DCD_SEL     |                |                 | 7C      |               |  |  |  |  |
| EN11_GPR       | R/W | RSVD           | EN11_TYPE[1:0]      |                    | EN11_GROUP[3:0] |             |                |                 |         | 7D            |  |  |  |  |
| DIETEMPRSLTH   | R   | RSVD           |                     |                    |                 |             | DIETEMP[9:8]   | RSVD            |         | 7E            |  |  |  |  |
| DIETEMPRSLTL   | R   | DIETEMP[7:0]   |                     |                    |                 |             |                | 7F              |         |               |  |  |  |  |
| DIETEMPRSLTH   | R   | RSVD           |                     |                    |                 |             | VSYS[9:8]      | RSVD            |         | 80            |  |  |  |  |
| DIETEMPRSLTL   | R   | VSYs[7:0]      |                     |                    |                 |             |                | 81              |         |               |  |  |  |  |
| MODE           | R/W | RSVD           |                     | CHG_STAT           | RSVD            | RSVD        | TURNOFF_CRIT   | RESET_CRIT      | 82      |               |  |  |  |  |
| IOUT_H (DCD0)  | R   | RSVD           |                     |                    |                 |             | DCD0_IOUT[9:8] | RSVD            |         | 84            |  |  |  |  |
| IOUT_L (DCD0)  | R   | DCD0_IOUT[7:0] |                     |                    |                 |             |                | 85              |         |               |  |  |  |  |
| IOUT_H (DCD1)  | R   | RSVD           |                     |                    |                 |             | DCD1_IOUT[9:8] | RSVD            |         | 86            |  |  |  |  |
| IOUT_L (DCD1)  | R   | DCD1_IOUT[7:0] |                     |                    |                 |             |                | 87              |         |               |  |  |  |  |
| IOUT_H (DCD5)  | R   | RSVD           |                     |                    |                 |             | DCD5_IOUT[9:8] | RSVD            |         | 88            |  |  |  |  |
| IOUT_L (DCD5)  | R   | DCD5_IOUT[7:0] |                     |                    |                 |             |                | 89              |         |               |  |  |  |  |
| IOUT_H (DCD6)  | R   | RSVD           |                     |                    |                 |             | DCD6_IOUT[9:8] | RSVD            |         | 8A            |  |  |  |  |
| IOUT_L (DCD6)  | R   | DCD6_IOUT[7:0] |                     |                    |                 |             |                | 8B              |         |               |  |  |  |  |
| IOUT_H (DCD2)  | R   | RSVD           |                     |                    |                 |             | DCD2_IOUT[9:8] | RSVD            |         | 8C            |  |  |  |  |
| IOUT_L (DCD2)  | R   | DCD2_IOUT[7:0] |                     |                    |                 |             |                | 8D              |         |               |  |  |  |  |
| THRIMMONCTL    | R/W | RSVD           |                     |                    | MODE            | TEMPFRQS    | TEMPFRQA[1:0]  | THR_M_EN        | 8E      |               |  |  |  |  |
| DCD_PG         | R   | RSVD           | DCD_PG[6:0]         | RSVD               |                 |             |                |                 |         | 8F            |  |  |  |  |
| THR_M_STAT_CFG | R/W | RSVD           | PTC_ADC2            | PTC_ADC1           | PTC_ADC0        | DIETEMP_EN  | ADC2_EN        | ADC1_EN         | ADC0_EN | 90            |  |  |  |  |
| EXP2           | R/W | RSVD           |                     |                    |                 |             |                | PMIC_ADR_CONFIG |         | 92            |  |  |  |  |
| ADC0_THRMALRTH | R/W | PROCHOT_EN     | ALRT_EN             | ADC0_ALRT_HYS[3:0] |                 |             |                | ADC0_ALRT[9:8]  |         | 94            |  |  |  |  |
| ADC0_THRMALRTL | R/W | ADC0_ALRT[7:0] |                     |                    |                 |             |                | 95              |         |               |  |  |  |  |
| ADC0_THRMRESET | R/W | ADC0_RESET_EN  | ADC0_RESET_OFS[6:0] |                    |                 |             |                |                 | 97      |               |  |  |  |  |
| ADC1_THRMALRTH | R/W | PROCHOT_EN     | ALRT_EN             | ADC1_ALRT_HYS[3:0] |                 |             |                | ADC1_ALRT[9:8]  |         | 99            |  |  |  |  |
| ADC1_THRMALRTL | R/W | ADC1_ALRT[7:0] |                     |                    |                 |             |                | 9A              |         |               |  |  |  |  |

| Register Name     | R/W | D7   | D6                  | D5                 | D4        | D3           | D2        | D1                | D0        | Address (HEX) |  |  |  |  |  |  |  |  |
|-------------------|-----|--|---------------------|--------------------|-----------|--------------|-----------|-------------------|-----------|---------------|--|--|--|--|--|--|--|--|
| ADC1_THRMRESET    | R/W | ADC1_RESET_EN  | ADC1_RESET_OFS[6:0] |                    |           |              |           |                   |           | 9C            |  |  |  |  |  |  |  |  |
| LDOFI             | R   | LDO7_SC  | LDO6_SC             | LDO5_SC            | LDO4_SC   | LDO3_SC      | LDO2_SC   | LDO1_SC           | LDO0_SC   | 9D            |  |  |  |  |  |  |  |  |
| ADC2_THRMALRTH    | R/W | PROCHOT_EN   | ALRT_EN             | ADC2_ALRT_HYS[3:0] |           |              |           | ADC2_ALRT[9:8]    |           | 9E            |  |  |  |  |  |  |  |  |
| ADC2_THRMALRTL    | R/W | ADC2_ALRT[7:0]   |                     |                    |           |              |           |                   |           | 9F            |  |  |  |  |  |  |  |  |
| DCD_ILIM          | R/W | ILIM100US  | DCD6_ILIM           | DCD5_ILIM          | RSVD      |              | DCD2_ILIM | DCD1_ILIM         | DCD0_ILIM | A0            |  |  |  |  |  |  |  |  |
| ADC2_THRMRESET    | R/W | ADC2_RESET_EN  | ADC2_RESET_OFS[6:0] |                    |           |              |           |                   |           | A1            |  |  |  |  |  |  |  |  |
| DCD3_VOUT         | R/W | DCD3_RNG[1:0]  |                     | DCD3_VOUT[5:0]     |           |              |           |                   |           | A4            |  |  |  |  |  |  |  |  |
| DCD4_VOUT         | R/W | DCD4_RNG[1:0]  |                     | DCD4_VOUT[5:0]     |           |              |           |                   |           | A5            |  |  |  |  |  |  |  |  |
| DCD5_VOUT         | R/W | DCD5_RNG[1:0]  |                     | DCD5_VOUT[5:0]     |           |              |           |                   |           | A6            |  |  |  |  |  |  |  |  |
| DCD6_VOUT         | R/W | DCD6_RNG[1:0]  |                     | DCD6_VOUT[5:0]     |           |              |           |                   |           | A7            |  |  |  |  |  |  |  |  |
| DCD0_SLEW         | R/W | RSVD   |                     | FAST_RATE[1:0]     | RSVD      |              |           |                   | SLOW_RATE | A8            |  |  |  |  |  |  |  |  |
| DCD1_SLEW         | R/W | RSVD   |                     | FAST_RATE[1:0]     | RSVD      |              |           |                   | SLOW_RATE | A9            |  |  |  |  |  |  |  |  |
| DCD2_SLEW         | R/W | RSVD   |                     | FAST_RATE[1:0]     | RSVD      |              |           |                   | SLOW_RATE | AA            |  |  |  |  |  |  |  |  |
| S0Ix_EN           | R/W | RSVD   |                     |                    |           | S0Ix_DCD2    | S0Ix_DCD1 | S0Ix_DCD0         |           | AB            |  |  |  |  |  |  |  |  |
| S0Ix_ID           | R/W | RSVD   |                     | S0Ix_ID_DC_D2      | RSVD      | S0Ix_ID_DCD2 | RSVD      | S0Ix_ID_DCD2      | RSVD      | AC            |  |  |  |  |  |  |  |  |
| FPWM              | R/W | RSVD   | DCD6_FPWM           | DCD5_FPWM          | DCD4_FPWM | DCD3_FPWM    | DCD2_FPWM | DCD1_FPWM         | DCD0_FPWM | AD            |  |  |  |  |  |  |  |  |
| DCD_OC            | R/W | RSVD   | DCD6_OC             | DCD5_OC            | RSVD      |              | DCD2_OC   | DCD1_OC           | DCD0_OC   | AE            |  |  |  |  |  |  |  |  |
| DIE_THRMALRTH     | R/W | PROCHOT_EN   | ALRT_EN             | DIETEMP_HYS[3:0]   |           |              |           | DIETEMP_ALRT[9:8] |           | AF            |  |  |  |  |  |  |  |  |
| DIE_THRMALRTL     | R/W | DIETEMP_ALRT[7:0]  |                     |                    |           |              |           |                   |           | B0            |  |  |  |  |  |  |  |  |
| DIE_THRMWARNH     | R/W | SALRT_EN   | WARN_EN             | DIETEMP_HYS[3:0]   |           |              |           | DIETEMP_ALRT[9:8] |           | B1            |  |  |  |  |  |  |  |  |
| DIE_THRMWARNL     | R/W | DIETEMP_WARN[7:0]  |                     |                    |           |              |           |                   |           | B2            |  |  |  |  |  |  |  |  |
| PROD_ID           | R   | PROD_ID [7:0]  |                     |                    |           |              |           |                   |           | B3            |  |  |  |  |  |  |  |  |
| PROTOCOL_ID       | R   | PROTOCOL [7:0]   |                     |                    |           |              |           |                   |           | B4            |  |  |  |  |  |  |  |  |
| CAPABILITY (DCD0) | R   | CAPABILITY [7:0]   |                     |                    |           |              |           |                   |           | B5            |  |  |  |  |  |  |  |  |
| STATUS_1          | R   | STATUS_1 [7:0]   |                     |                    |           |              |           |                   |           | B6            |  |  |  |  |  |  |  |  |
| STATUS_2          | R   | STATUS_2 [7:0]   |                     |                    |           |              |           |                   |           | B7            |  |  |  |  |  |  |  |  |
| STATUS2_PREV      | R   | STATUS2_PREV [7:0]   |                     |                    |           |              |           |                   |           | B8            |  |  |  |  |  |  |  |  |
| ICC_MAX (DCD0)    | R   | ICC_MAX [7:0] (Default 05h: 5A) - Part configurations at power up based on the number of DPUs used |                     |                    |           |              |           |                   |           | B9            |  |  |  |  |  |  |  |  |
| SR_FAST (DCD0)    | R   | Reading this returns the slew rate from SetVID Fast in the DCD0SLEW register                       |                     |                    |           |              |           |                   |           | BA            |  |  |  |  |  |  |  |  |
| SR_SLOW (DCD0)    | R   | Reading this returns the slew rate from SetVID SLOW in the DCD0SLEW register                       |                     |                    |           |              |           |                   |           | BB            |  |  |  |  |  |  |  |  |
| VBOOT (DCD0)      | R/W | VBOOT[7:1]   |                     |                    |           |              |           | VBOOT[0]          |           | BC            |  |  |  |  |  |  |  |  |
| VOUT_MAX (DCD0)   | R/W | VOUT_MAX [7:0]   |                     |                    |           |              |           |                   |           | BD            |  |  |  |  |  |  |  |  |

| Register Name       | R/W | D7   | D6                  | D5   | D4   | D3                 | D2         | D1      | D0 | Address (HEX) |  |  |  |
|---------------------|-----|--|---------------------|------|------|--------------------|------------|---------|----|---------------|--|--|--|
| VID (DCD0)          | R/W | VID [7:1]  |                     |      |      |                    |            | VID [0] | BE |               |  |  |  |
| PWR_ST (DCD0)       | R/W | PWR_STATE[1:0]   |                     | RSVD |      |                    |            |         |    | BF            |  |  |  |
| VOFS (DCD0)         | R/W | VOFS [7:0]   |                     |      |      |                    |            |         |    |               |  |  |  |
| MULTI_VR (DCD0)     | R/W | RSVD   |                     |      |      |                    | LCK_VID_PS | VRDY_0V | C1 |               |  |  |  |
| SET_REG_ADDR (DCD0) | R   | SET_REG_ADDR [7:0]   |                     |      |      |                    |            |         |    |               |  |  |  |
| SEQA_TIM            | R/W | RSVD   | DLY_GRP_OFF_A[2:0]  |      | RSVD | DLY_GRP_ON_A[2:0]  |            |         |    |               |  |  |  |
| SEQU_TIM            | R/W | RSVD   | DLY_GRP_OFF_U[2:0]  |      | RSVD | DLY_GRP_ON_U[2:0]  |            |         |    |               |  |  |  |
| CAPABILITY (DCD1)   | R   | CAPABILITY [7:0]   |                     |      |      |                    |            |         |    |               |  |  |  |
| STATUS_1            | R   | STATUS_1 [7:0]   |                     |      |      |                    |            |         |    |               |  |  |  |
| STATUS_2            | R   | STATUS_2 [7:0]   |                     |      |      |                    |            |         |    |               |  |  |  |
| STATUS2_PREV        | R   | STATUS2_PREV [7:0]   |                     |      |      |                    |            |         |    |               |  |  |  |
| ICC_MAX (DCD1)      | R   | ICC_MAX [7:0] (Default 05h: 5A) - Part configurations at power up based on the number of DPUs used |                     |      |      |                    |            |         |    |               |  |  |  |
| SR_FAST (DCD1)      | R   | Reading this returns the slew rate from SetVID Fast in the DCD1SLEW register                       |                     |      |      |                    |            |         |    |               |  |  |  |
| SR_SLOW (DCD1)      | R   | Reading this returns the slew rate from SetVID SLOW in the DCD1SLEW register                       |                     |      |      |                    |            |         |    |               |  |  |  |
| VBOOT (DCD1)        | R/W | VBOOT[7:1]   |                     |      |      |                    | VBOOT[0]   |         |    |               |  |  |  |
| VOUT_MAX (DCD1)     | R/W | VOUT_MAX [7:0]   |                     |      |      |                    |            |         |    |               |  |  |  |
| VID (DCD1)          | R/W | VID [7:1]  |                     |      |      |                    | VID [0]    |         |    |               |  |  |  |
| PWR_ST (DCD1)       | R/W | PWR_STATE[1:0]   |                     | RSVD |      |                    |            |         |    | CF            |  |  |  |
| VOFS (DCD1)         | R/W | VOFS [7:0]   |                     |      |      |                    |            |         |    |               |  |  |  |
| MULTI_VR (DCD1)     | R/W | RSVD   |                     |      |      |                    | LCK_VID_PS | VRDY_0V | D1 |               |  |  |  |
| SET_REG_ADDR (DCD1) | R   | SET_REG_ADDR [7:0]   |                     |      |      |                    |            |         |    |               |  |  |  |
| SEQS_TIM            | R/W | RSVD   | DLY_GRP_OFF_S[2:0]  |      | RSVD | DLY_GRP_ON_S[2:0]  |            |         |    |               |  |  |  |
| SEQSX_TIM           | R/W | RSVD   | DLY_GRP_OFF_SX[2:0] |      | RSVD | DLY_GRP_ON_SX[2:0] |            |         |    |               |  |  |  |
| CAPABILITY (DCD2)   | R   | CAPABILITY [7:0]   |                     |      |      |                    |            |         |    |               |  |  |  |
| STATUS_1            | R   | STATUS_1 [7:0]   |                     |      |      |                    |            |         |    |               |  |  |  |
| STATUS_2            | R   | STATUS_2 [7:0]   |                     |      |      |                    |            |         |    |               |  |  |  |
| STATUS2_PREV        | R   | STATUS2_PREV [7:0]   |                     |      |      |                    |            |         |    |               |  |  |  |
| ICC_MAX (DCD2)      | R   | ICC_MAX [7:0] (Default 05h: 5A) – Part configurations at power up based on the number of DPUs used |                     |      |      |                    |            |         |    |               |  |  |  |
| SR_FAST (DCD2)      | R   | Reading this returns the slew rate from SetVID Fast in the DCD2SLEW register                       |                     |      |      |                    |            |         |    |               |  |  |  |
| SR_SLOW (DCD2)      | R   | Reading this returns the slew rate from SetVID SLOW in the DCD2SLEW register                       |                     |      |      |                    |            |         |    |               |  |  |  |
| VBOOT (DCD2)        | R/W | VBOOT[7:1]   |                     |      |      |                    | VBOOT[0]   |         |    |               |  |  |  |
| VOUT_MAX (DCD2)     | R/W | VOUT_MAX [7:0]   |                     |      |      |                    |            |         |    |               |  |  |  |
| VID (DCD2)          | R/W | VID [7:1]  |                     |      |      |                    | VID [0]    |         |    |               |  |  |  |
| PWR_ST (DCD2)       | R/W | PWR_STATE[1:0]   |                     | RSVD |      |                    |            |         |    | DF            |  |  |  |
| VOFS (DCD2)         | R/W | VOFS [7:0]   |                     |      |      |                    |            |         |    |               |  |  |  |
| MULTI_VR (DCD2)     | R/W | RSVD   |                     |      |      |                    | LCK_VID_PS | VRDY_0V | E1 |               |  |  |  |

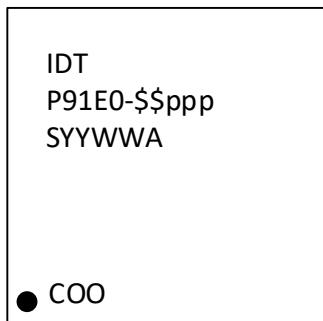
| Register Name       | R/W | D7                  | D6             | D5 | D4              | D3 | D2 | D1 | D0 | Address (HEX) |    |
|---------------------|-----|---------------------|----------------|----|-----------------|----|----|----|----|---------------|----|
| SET_REG_ADDR (DCD2) | R   | SET_REG_ADDR [7:0]  |                |    |                 |    |    |    |    |               | E2 |
| VRI_MODE            | R/W | RSVD                | VRI_TYPE[1:0]  |    | RSVD            |    |    |    |    |               | E3 |
| THRM_MODE           | R/W | RSVD                | THRM_TYPE[1:0] |    | RSVD            |    |    |    |    |               | E4 |
| DCD0_GRP            | R/W | DCD0_TYPE_EXIT[1:0] | DCD0_TYPE[1:0] |    | DCD0_GROUP[3:0] |    |    |    |    |               | E6 |
| DCD1_GRP            | R/W | DCD0_TYPE_EXIT[1:0] | DCD1_TYPE[1:0] |    | DCD1_GROUP[3:0] |    |    |    |    |               | E7 |
| DCD2_GRP            | R/W | RSVD                | DCD2_TYPE[1:0] |    | DCD2_GROUP[3:0] |    |    |    |    |               | E8 |
| DCD3_GRP            | R/W | RSVD                | DCD3_TYPE[1:0] |    | DCD3_GROUP[3:0] |    |    |    |    |               | E9 |
| DCD4_GRP            | R/W | RSVD                | DCD4_TYPE[1:0] |    | DCD4_GROUP[3:0] |    |    |    |    |               | EA |
| DCD5_GRP            | R/W | RSVD                | DCD5_TYPE[1:0] |    | DCD5_GROUP[3:0] |    |    |    |    |               | EB |
| DCD6_GRP            | R/W | RSVD                | DCD6_TYPE[1:0] |    | DCD6_GROUP[3:0] |    |    |    |    |               | EC |
| LDO0_GRP            | R/W | RSVD                | LDO0_TYPE[1:0] |    | LDO0_GROUP[3:0] |    |    |    |    |               | ED |
| LDO1_GRP            | R/W | RSVD                | LDO1_TYPE[1:0] |    | LDO1_GROUP[3:0] |    |    |    |    |               | EE |
| LDO2_GRP            | R/W | RSVD                | LDO2_TYPE[1:0] |    | LDO2_GROUP[3:0] |    |    |    |    |               | EF |
| LDO3_GRP            | R/W | RSVD                | LDO3_TYPE[1:0] |    | LDO3_GROUP[3:0] |    |    |    |    |               | F0 |
| LDO4_GRP            | R/W | RSVD                | LDO4_TYPE[1:0] |    | LDO4_GROUP[3:0] |    |    |    |    |               | F1 |
| LDO5_GRP            | R/W | RSVD                | LDO5_TYPE[1:0] |    | LDO5_GROUP[3:0] |    |    |    |    |               | F2 |
| LDO6_GRP            | R/W | RSVD                | LDO6_TYPE[1:0] |    | LDO6_GROUP[3:0] |    |    |    |    |               | F3 |
| EN0_GRP             | R/W | RSVD                | EN0_TYPE[1:0]  |    | EN0_GROUP[3:0]  |    |    |    |    |               | F4 |
| EN1_GRP             | R/W | RSVD                | EN1_TYPE[1:0]  |    | EN1_GROUP[3:0]  |    |    |    |    |               | F5 |
| EN2_GRP             | R/W | RSVD                | EN2_TYPE[1:0]  |    | EN2_GROUP[3:0]  |    |    |    |    |               | F6 |
| EN3_GRP             | R/W | RSVD                | EN3_TYPE[1:0]  |    | EN3_GROUP[3:0]  |    |    |    |    |               | F7 |
| EN4_GRP             | R/W | RSVD                | EN4_TYPE[1:0]  |    | EN4_GROUP[3:0]  |    |    |    |    |               | F8 |
| EN5_GRP             | R/W | RSVD                | EN5_TYPE[1:0]  |    | EN5_GROUP[3:0]  |    |    |    |    |               | F9 |
| EN6_GRP             | R/W | RSVD                | EN6_TYPE[1:0]  |    | EN6_GROUP[3:0]  |    |    |    |    |               | FA |
| EN7_GRP             | R/W | RSVD                | EN7_TYPE[1:0]  |    | EN7_GROUP[3:0]  |    |    |    |    |               | FB |
| EN8_GRP             | R/W | RSVD                | EN8_TYPE[1:0]  |    | EN8_GROUP[3:0]  |    |    |    |    |               | FC |
| EN9_GRP             | R/W | RSVD                | EN9_TYPE[1:0]  |    | EN9_GROUP[3:0]  |    |    |    |    |               | FD |
| EN10_GRP            | R/W | RSVD                | EN10_TYPE[1:0] |    | EN10_GROUP[3:0] |    |    |    |    |               | FE |

## 11. Package Outline Drawings

The package outline drawings are appended at the end of this document and are accessible from the link below. The package information is the most current data available.

<https://www.idt.com/document/psc/100-qgfn-package-outline-drawing-90-x-90-x-085-mm-body-epad-510-x-510-mm-05065mm-pitch-nhq100p1>

## 12. Marking Diagram



Line 1: IDT

Line 2: Part number

- “-\$” = specific configuration
- “ppp” = package type

Line 3:

- “S” = device stepping
- “YYWW” is the last digit of the year and week that the part was assembled.
- “A” = assembly location

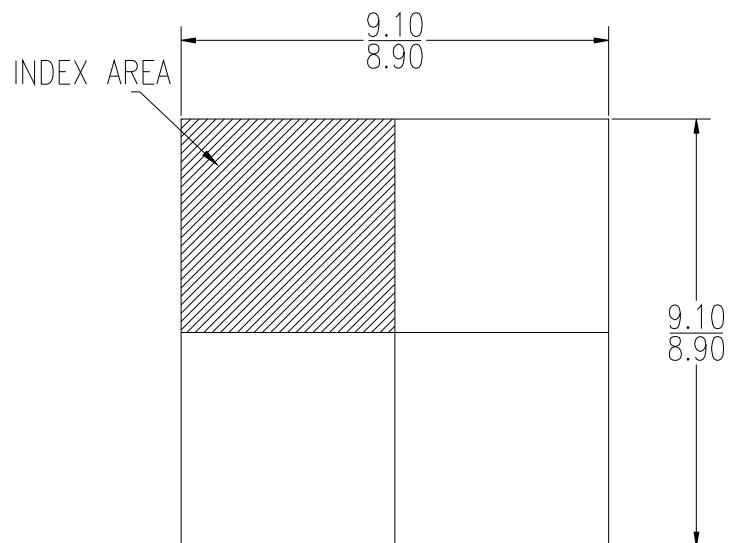
Line 4: COO denotes the lot number.

## 13. Ordering Information

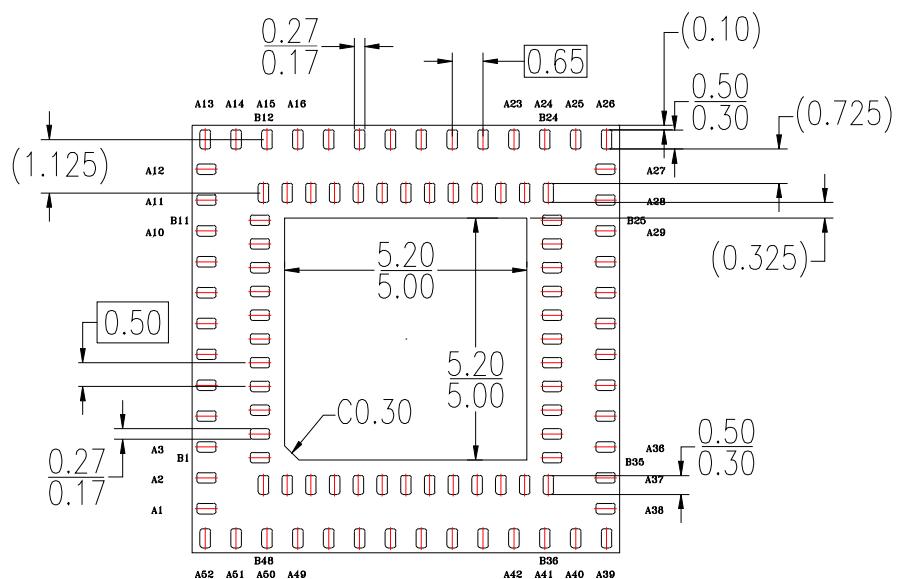
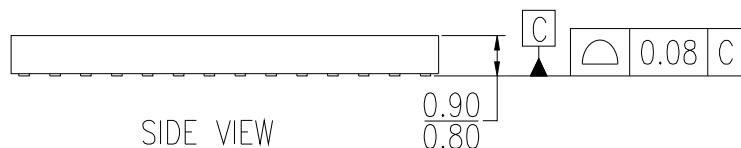
| Orderable Part Number | Description and Package  | MSL Rating | Carrier Type | Temperature    |
|-----------------------|--|------------|--------------|----------------|
| P91E0-I5NHGI          | P91E0 IC packaged in a thermally-enhanced 9.0 × 9.0 × 0.85 mm 100-VFQFPN | 3          | Tray         | -40°C to +85°C |
| P91E0-I5NHGI8         | P91E0 IC packaged in a thermally-enhanced 9.0 × 9.0 × 0.85 mm 100-VFQFPN | 3          | Reel         | -40°C to +85°C |

## 14. Revision History

| Revision Date      | Description of Change  |
|--------------------|--|
| November 2, 2018   | <ul style="list-style-type: none"><li>▪ Corrections for Table 168.</li><li>▪ Minor edits</li></ul> |
| September 26, 2018 | Initial release.   |

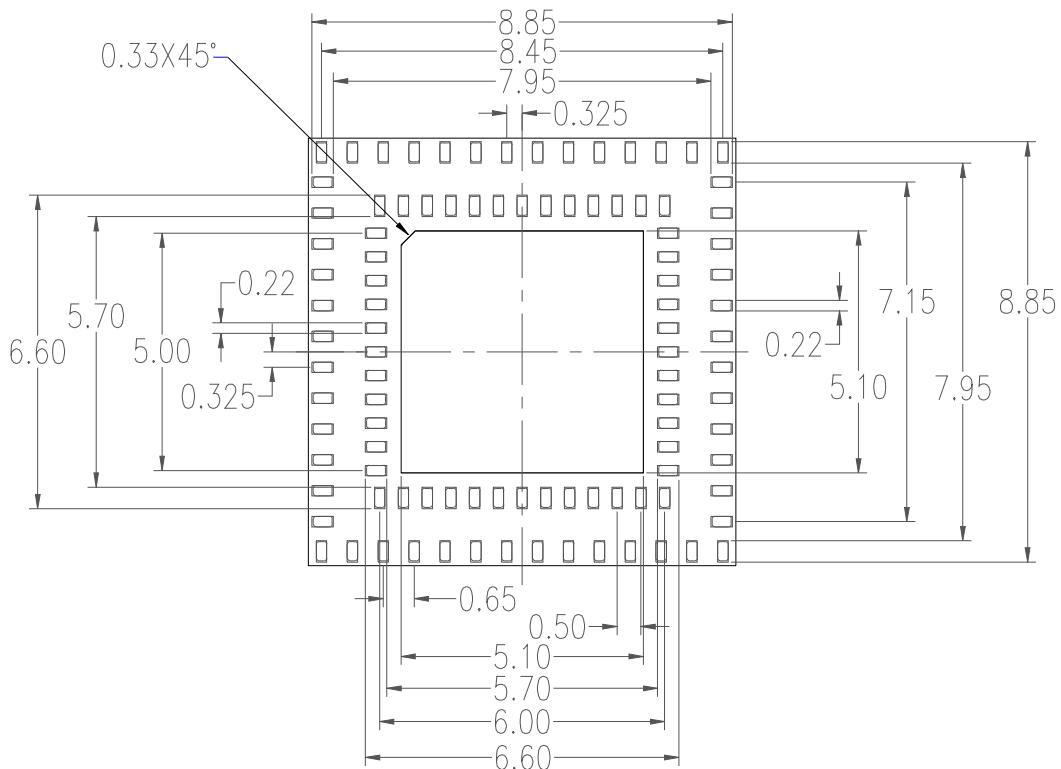


TOP VIEW



BOTTOM VIEW

NOTE: ALL DIMENSIONS IN MM.

**RECOMMENDED LAND PATTERN DIMENSION****NOTES:**

1. ALL DIMENSIONS ARE IN MM. ANGLES IN DEGREES.
2. TOP DOWN VIEW. AS VIEWED ON PCB.
3. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

| Package Revision History |         |                                       |
|--------------------------|---------|---------------------------------------|
| Date Created             | Rev No. | Description                           |
| Sept 6, 2018             | Rev 01  | New Format, Add GQFN Package Category |
| March 17, 2020           | Rev 02  | Add Coplanarity Tolerance             |

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(Rev.1.0 Mar 2020)

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